

This document includes all four modules of the Spartan™-3 FPGA data sheet.

**Module 1:
Introduction and Ordering Information**

DS099-1 (v1.1) April 24, 2003
6 pages

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DS099-2 (v1.2) July 11, 2003
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DS099-3 (v1.1) July 11, 2003
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IMPORTANT NOTE: *The Spartan-3 1.2V FPGA data sheet is created and published in separate modules. This complete version is provided for easy downloading and searching of the complete document. Page, figure, and table numbers begin at 1 for each module, and each module has its own Revision History at the end. Use the PDF "Bookmarks" for easy navigation in this volume.*

Introduction

The 1.2V Spartan™-3 family of Field-Programmable Gate Arrays is specifically designed to meet the needs of high volume, cost-sensitive consumer electronic applications. The eight-member family offers densities ranging from 50,000 to five million system gates, as shown in [Table 1](#).

The Spartan-3 family builds on the success of the earlier Spartan-II family by increasing the amount of logic resources, the capacity of internal RAM, the total number of I/Os, and the overall level of performance as well as by improving clock management functions. Numerous enhancements derive from state-of-the-art Virtex™-II technology. These Spartan-3 enhancements, combined with advanced process technology, deliver more functionality and bandwidth per dollar than was previously possible, setting new standards in the programmable logic industry.

Because of their exceptionally low cost, Spartan-3 FPGAs are ideally suited to a wide range of consumer electronics applications, including broadband access, home networking, display/projection and digital television equipment.

The Spartan-3 family is a superior alternative to mask programmed ASICs. FPGAs avoid the high initial cost, the lengthy development cycles, and the inherent inflexibility of conventional ASICs. Also, FPGA programmability permits design upgrades in the field with no hardware replacement necessary, an impossibility with ASICs.

Features

- Revolutionary 90-nanometer process technology
- Very low cost, high-performance logic solution for high-volume, consumer-oriented applications

- Densities as high as 74,880 logic cells
- 326 MHz system clock rate
- Three separate power supplies for the core (1.2V), I/Os (1.2V to 3.3V), and special functions (2.5V)
- SelectIO™ signaling
 - Up to 784 I/O pins
 - 622 Mb/s data transfer rate per I/O
 - Seventeen single-ended signal standards
 - Six differential signal standards including LVDS
 - Termination by Digitally Controlled Impedance
 - Signal swing ranging from 1.14V to 3.45V
 - Double Data Rate (DDR) support
- Logic resources
 - Abundant, flexible logic cells with registers
 - Wide multiplexers
 - Fast look-ahead carry logic
 - Dedicated 18 x 18 multipliers
 - JTAG logic compatible with IEEE 1149.1/1532 standards
- SelectRAM™ hierarchical memory
 - Up to 1,872 Kbits of total block RAM
 - Up to 520 Kbits of total distributed RAM
- Digital Clock Manager (up to four DCMs)
 - Clock skew elimination
 - Frequency synthesis
 - High resolution phase shifting
- Eight global clock lines and abundant routing
- Fully supported by Xilinx ISE development system
 - Synthesis, mapping, placement and routing

Table 1: Summary of Spartan-3 FPGA Attributes

| Device | System Gates | Logic Cells | CLB Array (One CLB = Four Slices) | | | Distributed RAM (bits ¹) | Block RAM (bits ¹) | Dedicated Multipliers | DCMs | Maximum User I/O | Maximum Differential I/O Pairs |
|----------|--------------|-------------|--------------------------------------|---------|------------|--------------------------------------|--------------------------------|-----------------------|------|------------------|--------------------------------|
| | | | Rows | Columns | Total CLBs | | | | | | |
| XC3S50 | 50K | 1,728 | 16 | 12 | 192 | 12K | 72K | 4 | 2 | 124 | 56 |
| XC3S200 | 200K | 4,320 | 24 | 20 | 480 | 30K | 216K | 12 | 4 | 173 | 76 |
| XC3S400 | 400K | 8,064 | 32 | 28 | 896 | 56K | 288K | 16 | 4 | 264 | 116 |
| XC3S1000 | 1M | 17,280 | 48 | 40 | 1,920 | 120K | 432K | 24 | 4 | 391 | 175 |
| XC3S1500 | 1.5M | 29,952 | 64 | 52 | 3,328 | 208K | 576K | 32 | 4 | 487 | 221 |
| XC3S2000 | 2M | 46,080 | 80 | 64 | 5,120 | 320K | 720K | 40 | 4 | 565 | 270 |
| XC3S4000 | 4M | 62,208 | 96 | 72 | 6,912 | 432K | 1,728K | 96 | 4 | 712 | 312 |
| XC3S5000 | 5M | 74,880 | 104 | 80 | 8,320 | 520K | 1,872K | 104 | 4 | 784 | 344 |

Notes:

1. By convention, one Kb is equivalent to 1,024 bits.

Architectural Overview

The Spartan-3 family architecture consists of five fundamental programmable functional elements:

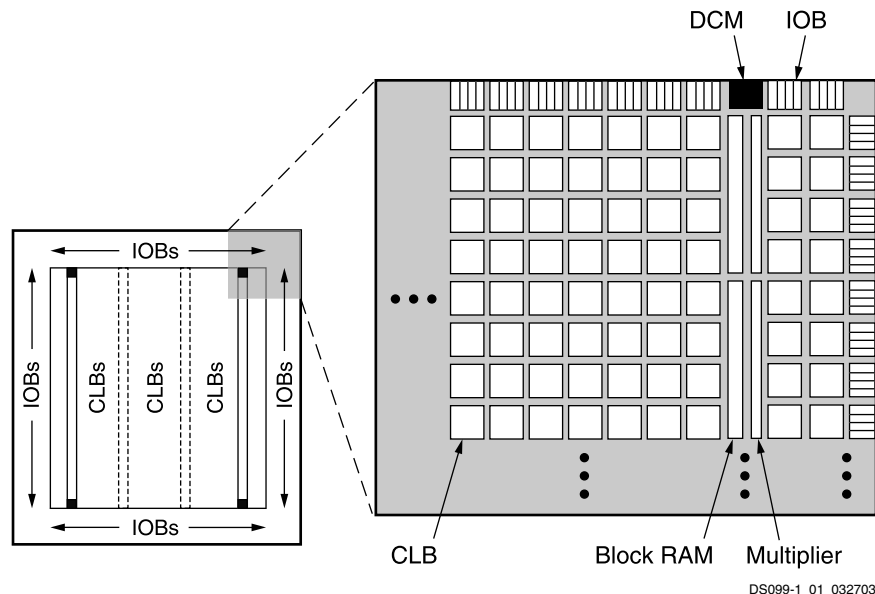
- Configurable Logic Blocks (CLBs) contain RAM-based Look-Up Tables (LUTs) to implement logic and storage elements that can be used as flip-flops or latches. CLBs can be programmed to perform a wide variety of logical functions as well as to store data.
- Input/Output Blocks (IOBs) control the flow of data between the I/O pins and the internal logic of the device. Each IOB supports bidirectional data flow plus 3-state operation. Twenty-three different signal standards, including six high-performance differential standards, are available as shown in [Table 2](#). Double Data-Rate (DDR) registers are included. The Digitally Controlled Impedance (DCI) feature provides automatic on-chip terminations, simplifying board designs.
- Block RAM provides data storage in the form of 18-Kbit dual-port blocks.
- Multiplier blocks accept two 18-bit binary numbers as

inputs and calculate the product.

- Digital Clock Manager (DCM) blocks provide self-calibrating, fully digital solutions for distributing, delaying, multiplying, dividing, and phase shifting clock signals.

These elements are organized as shown in [Figure 1](#). A ring of IOBs surrounds a regular array of CLBs. The XC3S50 has a single column of block RAM embedded in the array. Those devices ranging from the XC3S200 to the XC3S2000 have two columns of block RAM. The XC3S4000 and XC3S5000 devices have four RAM columns. Each column is made up of several 18K-bit RAM blocks; each block is associated with a dedicated multiplier. The DCMs are positioned at the ends of each block RAM column.

The Spartan-3 family features a rich network of traces and switches that interconnect all five functional elements, transmitting signals among them. Each functional element has an associated switch matrix that permits multiple connections to the routing.



Notes:

1. The two additional block RAM columns of the XC3S4000 and XC3S5000 devices are shown with dashed lines. The XC3S50 has only the block RAM column on the far left.

Figure 1: Spartan-3 Family Architecture

Configuration

Spartan-3 FPGAs are programmed by loading configuration data into robust static memory cells that collectively control all functional elements and routing resources. Before powering on the FPGA, configuration data is stored externally in a PROM or some other nonvolatile medium either on or off the board. After applying power, the configuration data is written to the FPGA using any of five different modes: Master Parallel, Slave Parallel, Master Serial, Slave Serial and Boundary Scan (JTAG). The Master and Slave Parallel modes use an 8-bit wide SelectMAP™ Port.

The recommended memory for storing the configuration data is the low-cost Xilinx Platform Flash PROM family, which includes XCF00S PROMs for serial configuration and XCF00P PROMs for parallel configuration.

I/O Capabilities

The SelectIO feature of Spartan-3 devices supports 17 single-ended standards and six differential standards as listed in Table 2. Table 3 shows the number of user I/Os as well as the number of differential I/O pairs available for each device/package combination.

Table 2: Signal Standards Supported by the Spartan-3 Family

| Standard Category | Description | V _{CCO} (V) | Class | Symbol |
|-------------------|--|----------------------|---------------|-------------|
| Single-Ended | | | | |
| GTL | Gunning Transceiver Logic | N/A | Terminated | GTL |
| | | | Plus | GTLP |
| HSTL | High-Speed Transceiver Logic | 1.5 | I | HSTL_I |
| | | | III | HSTL_III |
| | | 1.8 | I | HSTL_I_18 |
| | | | II | HSTL_II_18 |
| | | | III | HSTL_III_18 |
| LVCMOS | Low-Voltage CMOS | 1.2 | N/A | LVCMOS12 |
| | | 1.5 | N/A | LVCMOS15 |
| | | 1.8 | N/A | LVCMOS18 |
| | | 2.5 | N/A | LVCMOS25 |
| | | 3.3 | N/A | LVCMOS33 |
| LVTTL | Low-Voltage Transistor-Transistor Logic | 3.3 | N/A | LVTTL |
| PCI | Peripheral Component Interconnect | 3.0 | 33 MHz | PCI33_3 |
| SSTL | Stub Series Terminated Logic | 1.8 | N/A | SSTL18_I |
| | | 2.5 | I | SSTL2_I |
| | | | II | SSTL2_II |
| Differential | | | | |
| LDT | Lightning Data Transport (HyperTransport™) | 2.5 | N/A | LDT_25 |
| LVDS | Low Voltage Differential Signaling | | Standard | LVDS_25 |
| | | | Bus | BLVDS_25 |
| | | | Extended Mode | LVDSEXT_25 |
| | | Ultra | ULVDS_25 | |
| RSDS | Reduced-Swing Differential Signaling | 2.5 | N/A | RSDS_25 |

Table 3: Spartan-3 User I/O Chart

| Device | Available User I/Os and Differential (Diff) I/O Pairs | | | | | | | | | | | | | | | |
|----------|---|------|-------|------|-------|------|-------|------|-------|------|-------|------|-------|------|--------|------|
| | VQ100 | | TQ144 | | PQ208 | | FT256 | | FG456 | | FG676 | | FG900 | | FG1156 | |
| | User | Diff | User | Diff | User | Diff | User | Diff | User | Diff | User | Diff | User | Diff | User | Diff |
| XC3S50 | 63 | 29 | 97 | 46 | 124 | 56 | - | - | - | - | - | - | - | - | - | - |
| XC3S200 | 63 | 29 | 97 | 46 | 141 | 62 | 173 | 76 | - | - | - | - | - | - | - | - |
| XC3S400 | - | - | 97 | 46 | 141 | 62 | 173 | 76 | 264 | 116 | - | - | - | - | - | - |
| XC3S1000 | - | - | - | - | - | - | 173 | 76 | 333 | 149 | 391 | 175 | - | - | - | - |
| XC3S1500 | - | - | - | - | - | - | - | - | 333 | 149 | 487 | 221 | - | - | - | - |
| XC3S2000 | - | - | - | - | - | - | - | - | - | - | 489 | 221 | 565 | 270 | - | - |
| XC3S4000 | - | - | - | - | - | - | - | - | - | - | - | - | 633 | 300 | 712 | 312 |
| XC3S5000 | - | - | - | - | - | - | - | - | - | - | - | - | 633 | 300 | 784 | 344 |

Notes:

1. All device options listed in a given package column are pin-compatible.

Product Ordering and Availability

Table 4 shows all valid device ordering combinations of device density, speed grade, package, and temperature range parameters for the Spartan-3 family as well as the availability status of those combinations.

Table 4: Spartan-3 Device Availability

| Package Type: | VQFP | TQFP | PQFP | FTBGA | FBGA | | | |
|-----------------------|--------|--------|--------|--------|--------|--------|--------|--------|
| No. of Pins: | 100 | 144 | 208 | 256 | 456 | 676 | 900 | 1156 |
| Code: | VQ100 | TQ144 | PQ208 | FT256 | FG456 | FG676 | FG900 | FG1156 |
| Device ⁽¹⁾ | | | | | | | | |
| XC3S50 | (C, I) | (C, I) | (C, I) | - | - | - | - | - |
| XC3S200 | (C, I) | (C, I) | (C, I) | (C, I) | - | - | - | - |
| XC3S400 | - | (C, I) | (C, I) | (C, I) | (C, I) | - | - | - |
| XC3S1000 | - | - | - | (C, I) | (C, I) | (C, I) | - | - |
| XC3S1500 | - | - | - | - | (C, I) | (C, I) | - | - |
| XC3S2000 | - | - | - | - | - | (C, I) | (C, I) | - |
| XC3S4000 | - | - | - | - | - | - | (C, I) | (C, I) |
| XC3S5000 | - | - | - | - | - | - | (C, I) | (C, I) |

Notes:

1. Commercial devices are offered in the -4 and -5 speed grades; industrial devices are only in the -4 speed grade.
2. C = Commercial, $T_J = 0^\circ$ to $+85^\circ$ C; I = Industrial, $T_J = -40^\circ$ C to $+100^\circ$ C.
3. Parentheses indicate that a given device is not yet released to production. Contact your local sales office for availability information.

Ordering Information

Example: **XC3S50 -4 PQ208 C**

Device Type _____ Temperature Range _____
Speed Grade _____ Package Type / Number of Pins _____

| Device | Speed Grade | | Package Type / Number of Pins | | Temperature Range (T _J) | |
|----------|-------------|----------------------|-------------------------------|--|-------------------------------------|-----------------------------|
| XC3S50 | -4 | Standard Performance | VQ100 | 100-pin Very Thin Quad Flat Pack (VQFP) | C | Commercial (0°C to 85°C) |
| XC3S200 | -5 | High Performance | TQ144 | 144-pin Thin Quad Flat Pack (TQFP) | I | Industrial (–40°C to 100°C) |
| XC3S400 | | | PQ208 | 208-pin Plastic Quad Flat Pack (PQFP) | | |
| XC3S1000 | | | FT256 | 256-ball Fine-Pitch Thin Ball Grid Array (FTBGA) | | |
| XC3S1500 | | | FG456 | 456-ball Fine-Pitch Ball Grid Array (FBGA) | | |
| XC3S2000 | | | FG676 | 676-ball Fine-Pitch Ball Grid Array (FBGA) | | |
| XC3S4000 | | | FG900 | 900-ball Fine-Pitch Ball Grid Array (FBGA) | | |
| XC3S5000 | | | FG1156 | 1156-ball Fine-Pitch Ball Grid Array (FBGA) | | |

Revision History

| Date | Version No. | Description |
|----------|-------------|---|
| 04/11/03 | 1.0 | Initial Xilinx release. |
| 04/24/03 | 1.1 | Updated block RAM, DCM, and multiplier counts for the XC3S50. |

The Spartan-3 Family Data Sheet

DS099-1, *Spartan-3 1.2V FPGA Family: Introduction and Ordering Information* (Module 1)

DS099-2, *Spartan-3 1.2V FPGA Family: **Functional Description*** (Module 2)

DS099-3, *Spartan-3 1.2V FPGA Family: **DC and Switching Characteristics*** (Module 3)

DS099-4, *Spartan-3 1.2V FPGA Family: **Pinout Descriptions*** (Module 4)

IOBs

IOB Overview

The Input/Output Block (IOB) provides a programmable, bidirectional interface between an I/O pin and the FPGA's internal logic.

A simplified diagram of the IOB's internal structure appears in [Figure 1](#). There are three main signal paths within the IOB: the output path, input path, and 3-state path. Each path has its own pair of storage elements that can act as either registers or latches. For more information, see the Storage Element Functions section. The three main signal paths are as follows:

- The input path carries data from the pad, which is bonded to a package pin, through an optional programmable delay element directly to the I line. After the delay element, there are alternate routes through a pair of storage elements to the IQ1 and IQ2 lines. The IOB outputs I, IQ1, and IQ2 all lead to the FPGA's internal logic. The delay element can be set to ensure a hold time of zero.
- The output path, starting with the O1 and O2 lines, carries data from the FPGA's internal logic through a multiplexer and then a three-state driver to the IOB pad. In addition to this direct path, the multiplexer provides the option to insert a pair of storage elements.
- The 3-state path determines when the output driver is high impedance. The T1 and T2 lines carry data from

the FPGA's internal logic through a multiplexer to the output driver. In addition to this direct path, the multiplexer provides the option to insert a pair of storage elements.

- All signal paths entering the IOB, including those associated with the storage elements, have an inverter option. Any inverter placed on these paths is automatically absorbed into the IOB.

Storage Element Functions

There are three pairs of storage elements in each IOB, one pair for each of the three paths. It is possible to configure each of these storage elements as an edge-triggered D-type flip-flop (FD) or a level-sensitive latch (LD).

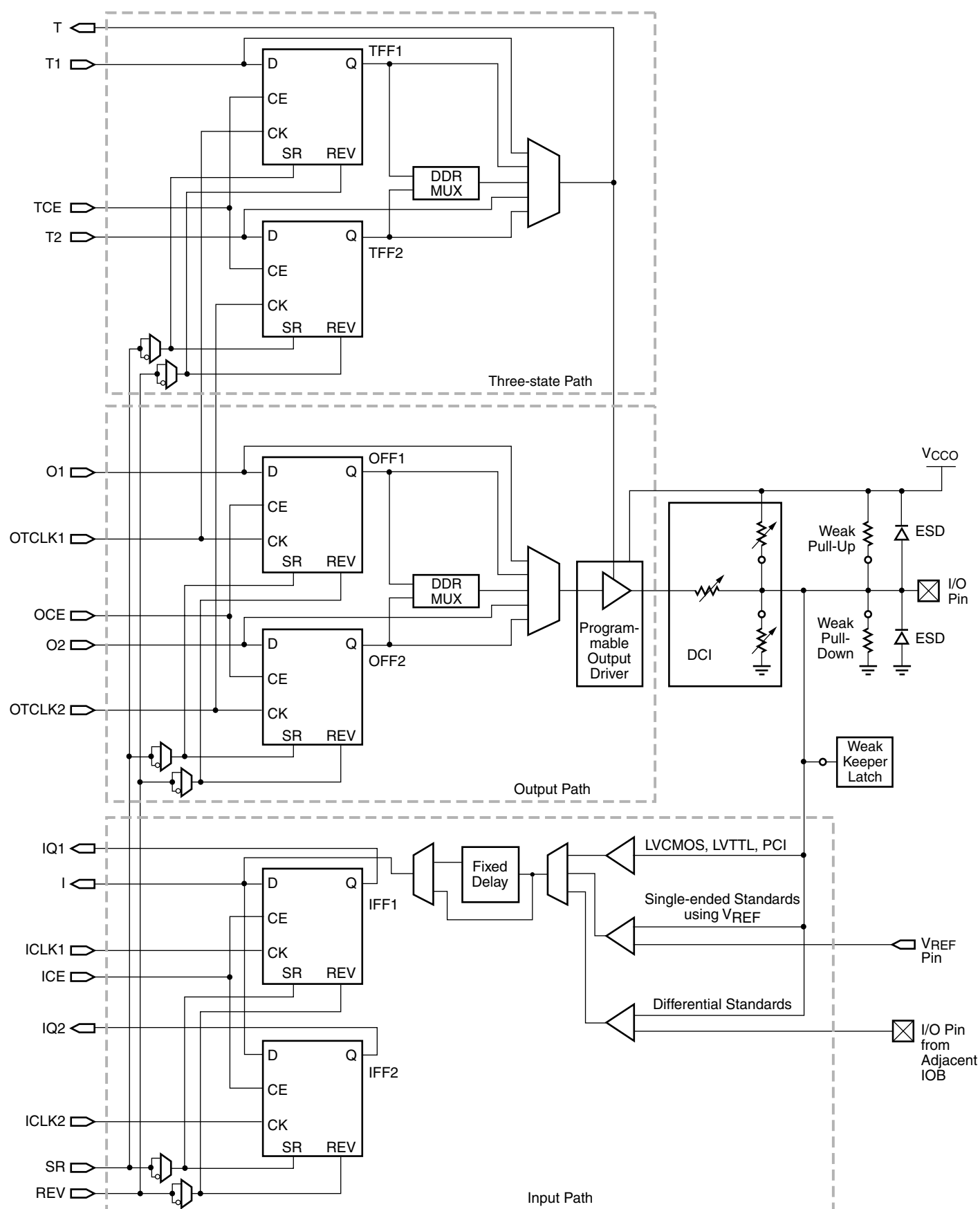
The storage-element-pair on either the Output path or the Three-State path can be used together with a special multiplexer to produce Double-Data-Rate (DDR) transmission. This is accomplished by taking data synchronized to the clock signal's rising edge and converting them to bits synchronized on both the rising and the falling edge. The combination of two registers and a multiplexer is referred to as a Double-Data-Rate D-type flip-flop (FDDR).

See [Double-Data-Rate Transmission](#), [page 3](#) for more information.

The signal paths associated with the storage element are described in [Table 1](#).

Table 1: Storage Element Signal Description

| Storage Element Signal | Description | Function |
|------------------------|--------------------|--|
| D | Data input | Data at this input is stored on the active edge of CK enabled by CE. For latch operation when the input is enabled, data passes directly to the output Q. |
| Q | Data output | The data on this output reflects the state of the storage element. For operation as a latch in transparent mode, Q will mirror the data at D. |
| CK | Clock input | A signal's active edge on this input with CE asserted, loads data into the storage element. |
| CE | Clock Enable input | When asserted, this input enables CK. If not connected, CE defaults to the asserted state. |
| SR | Set/Reset | Forces storage element into the state specified by the SRHIGH/SRLOW attributes. The SYNC/ASYNC attribute setting determines if the SR input is synchronized to the clock or not. |
| REV | Reverse | Used together with SR. Forces storage element into the state opposite from what SR does. |



Note: All IOB signals communicating with the FPGA's internal logic have the option of inverting polarity.

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Figure 1: Simplified IOB Diagram

According to [Figure 1](#), the clock line OTCLK1 connects the CK inputs of the upper registers on the output and three-state paths. Similarly, OTCLK2 connects the CK inputs for the lower registers on the output and three-state paths. The upper and lower registers on the input path have independent clock lines: ICLK1 and ICLK2.

The enable line OCE connects the CE inputs of the upper and lower registers on the output path. Similarly, TCE connects the CE inputs for the register pair on the three-state

path and ICE does the same for the register pair on the input path.

The Set/Reset (SR) line entering the IOB is common to all six registers, as is the Reverse (REV) line.

Each storage element supports numerous options in addition to the control over signal polarity described in the IOB Overview section. These are described in [Table 2](#).

Table 2: Storage Element Options

| Option Switch | Function | Specificity |
|---------------|--|---|
| FF/Latch | Chooses between an edge-sensitive flip-flop or a level-sensitive latch | Independent for each storage element. |
| SYNC/ASYN | Determines whether SR is synchronous or asynchronous | Independent for each storage element. |
| SRHIGH/SRLOW | Determines whether SR acts as a Set, which forces the storage element to a logic "1" (SRHIGH) or a Reset, which forces a logic "0" (SRLOW). | Independent for each storage element, except when using FDDR. In the latter case, the selection for the upper element (OFF1 or TFF2) will apply to both elements. |
| INIT1/INIT0 | In the event of a Global Set/Reset, after configuration or upon activation of the GTS net, this switch decides whether to set or reset a storage element. By default, choosing SRLOW also selects INIT0; choosing SRHIGH also selects INIT1. | Independent for each storage element, except when using FDDR. In the latter case, selecting INIT0 for one element applies to both elements (even though INIT1 is selected for the other). |

Double-Data-Rate Transmission

Double-Data-Rate (DDR) transmission describes the technique of synchronizing signals to both the rising and falling edges of the clock signal. Spartan-3 devices use register-pairs in all three IOB paths to perform DDR operations.

The pair of storage elements on the IOB's Output path (OFF1 and OFF2), used as registers, combine with a special multiplexer to form a DDR D-type flip-flop (FDDR). This primitive permits DDR transmission where output data bits are synchronized to both the rising and falling edges of a clock. It is possible to access this function by placing either an FDDRSE or an FDDRCPE component or symbol into the design. DDR operation requires two clock signals (50% duty cycle), one the inverted form of the other. These signals trigger the two registers in alternating fashion, as shown in [Figure 2](#). Commonly, the Digital Clock Manager (DCM) generates the two clock signals by mirroring an incoming signal, then shifting it 180 degrees. This approach ensures minimal skew between the two signals.

The storage-element-pair on the Three-State path (TFF1 and TFF2) can also be combined with a local multiplexer to form an FDDR primitive. This permits synchronizing the output enable to both the rising and falling edges of a clock. This DDR operation is realized in the same way as for the output path.

The storage-element-pair on the input path (IFF1 and IFF2) allows an I/O to receive a DDR signal. An incoming DDR clock signal triggers one register and the inverted clock signal triggers the other register. In this way, the registers take turns capturing bits of the incoming DDR data signal.

Aside from high bandwidth data transfers, DDR can also be used to reproduce, or "mirror", a clock signal on the output. This approach is used to transmit clock and data signals together. A similar approach is used to reproduce a clock signal at multiple outputs. The advantage for both approaches is that skew across the outputs will be minimal.

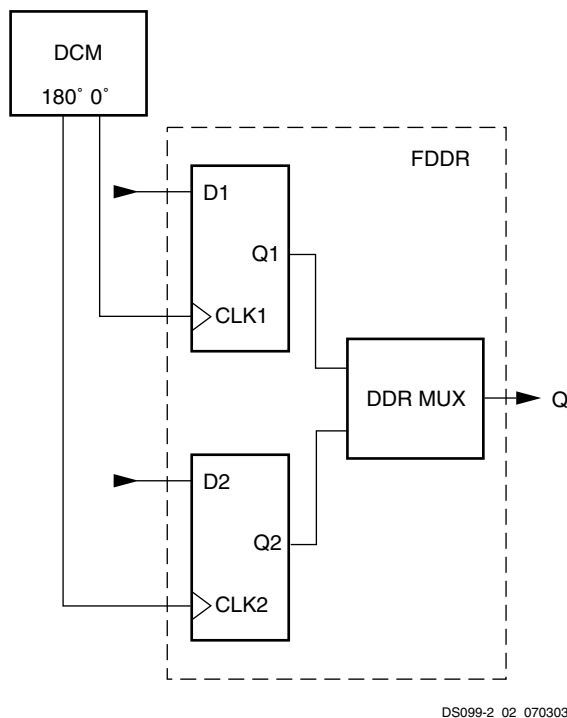


Figure 2: Clocking the DDR Register

Pull-Up and Pull-Down Resistors

The optional pull-up and pull-down resistors are intended to establish High and Low levels, respectively, at unused I/Os. The weak pull-up resistor optionally connects each IOB pad to V_{CCO} . A weak pull-down resistor optionally connects each pad to GND. These resistors are placed in a design using the PULLUP and PULLDOWN symbols in a schematic, respectively. They can also be instantiated as components, set as constraints or passed as attributes in HDL code. These resistors can also be selected for all unused I/O using the Bitstream Generator (BitGen) option Unused-Pin. A Low logic level on HSWAP_EN activates the pull-up resistors on all I/Os during configuration.

Weak-Keeper Circuit

Each I/O has an optional weak-keeper circuit that retains the last logic level on a line after all drivers have been turned off. This is useful to keep bus lines from floating when all connected drivers are in a high-impedance state. This function is placed in a design using the KEEPER symbol. Pull-up and pull-down resistors override the weak-keeper circuit.

ESD Protection

Clamp diodes protect all device pads against damage from Electro-Static Discharge (ESD) as well as excessive voltage transients. Each I/O has two clamp diodes: One diode extends P-to-N from the pad to V_{CCO} and a second diode extends N-to-P from the pad to GND. During operation, these diodes are normally biased in the off state. These

clamp diodes are always connected to the pad, regardless of the signal standard selected. The presence of diodes limits the ability of Spartan-3 I/Os to tolerate high signal voltages. The V_{IN} absolute maximum rating in Table 1 in Module 3: **DC and Switching Characteristics** specifies the voltage range that I/Os can tolerate.

Slew Rate Control and Drive Strength

Two options, FAST and SLOW, control the output slew rate. The FAST option supports output switching at a high rate. The SLOW option reduces bus transients. These options are only available when using one of the LVCMOS or LVTTTL standards, which also provide up to seven different levels of current drive strength: 2, 4, 6, 8, 12, 16, and 24 mA. Choosing the appropriate drive strength level is yet another means to minimize bus transients.

Table 3 shows the drive strengths that the LVCMOS and LVTTTL standards support. The Fast option is indicated by appending an "F" attribute after the output buffer symbol OBUF or the bidirectional buffer symbol IOBUF. The Slow option appends an "S" attribute. The drive strength in milliamperes follows the slew rate attribute. For example, OBUF_LVCMOS18_S_6 or IOBUF_LVCMOS25_F_16.

Table 3: Programmable Output Drive Current

| Signal Standard | Current Drive (mA) | | | | | | |
|-----------------|--------------------|---|---|---|----|----|----|
| | 2 | 4 | 6 | 8 | 12 | 16 | 24 |
| LVCMOS12 | ✓ | ✓ | ✓ | - | - | - | - |
| LVCMOS15 | ✓ | ✓ | ✓ | ✓ | ✓ | - | - |
| LVCMOS18 | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | - |
| LVCMOS25 | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ |
| LVCMOS33 | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ |
| LVTTTL | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ |

Boundary-Scan Capability

All Spartan-3 IOBs support boundary-scan testing compatible with IEEE 1149.1 standards. See **Boundary-Scan (JTAG) Mode**, page 36 for more information.

SelectIO Signal Standards

The IOBs support 17 different single-ended signal standards, as listed in Table 4. Furthermore, the majority of IOBs can be used in specific pairs supporting any of six differential signal standards, as shown in Table 5. The desired standard is selected by placing the appropriate I/O library symbol or component into the FPGA design. For example, the symbol named IOBUF_LVCMOS15_F_8 represents a bidirectional I/O to which the 1.5V LVCMOS signal standard has been assigned. The slew rate and current drive are set to Fast and 8 mA, respectively.

Together with placing the appropriate I/O symbol, two externally applied voltage levels, V_{CCO} and V_{REF} select the desired signal standard. The V_{CCO} lines provide current to the output driver. The voltage on these lines determines the

output voltage swing for all standards except GTL and GTLP.

All single-ended standards except the LVCMOS modes require a Reference Voltage (V_{REF}) to bias the input-switching threshold. Once a configuration data file is loaded into the FPGA that calls for the I/Os of a given bank to use such a signal standard, a few specifically reserved I/O pins on the same bank automatically convert to V_{REF} inputs. When using one of the LVCMOS standards, these pins remain I/Os because the V_{CCO} voltage biases the input-switching threshold, so there is no need for V_{REF} . Select the V_{CCO} and V_{REF} levels to suit the desired single-ended standard according to [Table 4](#).

Differential standards employ a pair of signals, one the opposite polarity of the other. The noise canceling (e.g., Common-Mode Rejection) properties of these standards permit exceptionally high data transfer rates. This section introduces the differential signaling capabilities of Spartan-3 devices.

Each device-package combination designates specific I/O pairs that are specially optimized to support differential standards. A unique “L-number”, part of the pin name, identifies the line-pairs associated with each bank (see [Module 4: Pinout Descriptions](#)). For each pair, the letters “P” and “N” designate the true and inverted lines, respectively. For example, the pin names IO_L43P_7 and IO_L43N_7 indicate the true and inverted lines comprising the line pair L43 on Bank 7. The differential Output Voltage (V_{OD}) parameter measures the voltage difference the High and Low logic levels that a pair of differential outputs drive. The V_{OD} range for each of the differential standards is listed in [Table 5](#). The V_{CCO} lines provide current to the outputs. The V_{REF} lines are not used. Select the V_{CCO} level to suit the desired differential standard according to [Table 5](#).

Table 4: Single-Ended I/O Standards (Values in Volts)

| Signal Standard | V_{CCO} | | V_{REF} for Inputs ⁽¹⁾ | Board Termination Voltage (V_{TT}) |
|-----------------|-------------|------------|-------------------------------------|--|
| | For Outputs | For Inputs | | |
| GTL | Note 2 | Note 2 | 0.8 | 1.2 |
| GTLP | Note 2 | Note 2 | 1 | 1.5 |
| HSTL_I | 1.5 | - | 0.75 | 0.75 |
| HSTL_III | 1.5 | - | 0.9 | 1.5 |
| HSTL_I_18 | 1.8 | - | 0.9 | 0.9 |
| HSTL_II_18 | 1.8 | - | 0.9 | 0.9 |
| HSTL_III_18 | 1.8 | - | 1.1 | 1.8 |
| LVCMOS12 | 1.2 | 1.2 | - | - |
| LVCMOS15 | 1.5 | 1.5 | - | - |
| LVCMOS18 | 1.8 | 1.8 | - | - |
| LVCMOS25 | 2.5 | 2.5 | - | - |
| LVCMOS33 | 3.3 | 3.3 | - | - |
| LVTTTL | 3.3 | 3.3 | - | - |

Table 4: Single-Ended I/O Standards (Values in Volts)

| Signal Standard | V_{CCO} | | V_{REF} for Inputs ⁽¹⁾ | Board Termination Voltage (V_{TT}) |
|-----------------|-------------|------------|-------------------------------------|--|
| | For Outputs | For Inputs | | |
| PCI33_3 | 3.0 | 3.0 | - | - |
| SSTL18_I | 1.8 | - | 0.9 | 0.9 |
| SSTL2_I | 2.5 | - | 1.25 | 1.25 |
| SSTL2_II | 2.5 | - | 1.25 | 1.25 |

Notes:

1. Banks 4 and 5 of any Spartan-3 device in a VQ100 package do not support signal standards using V_{REF} .
2. The V_{CCO} level used for the GTL and GTLP standards must be no lower than the termination voltage (V_{TT}), nor can it be lower than the voltage at the I/O pad.
3. See [Table 6](#) for a listing of the single-ended DCI standards.

Table 5: Differential I/O Standards

| Signal Standard | V_{CCO} (Volts) | | V_{REF} for Inputs (Volts) | V_{OD} ⁽¹⁾ (mV) | |
|-----------------|-------------------|------------|------------------------------|------------------------------|------|
| | For Outputs | For Inputs | | Min. | Max. |
| LDT_25 | 2.5 | - | - | 430 | 670 |
| LVDS_25 | 2.5 | - | - | 250 | 400 |
| BLVDS_25 | 2.5 | - | - | 250 | 450 |
| LVDSEXT_25 | 2.5 | - | - | 330 | 700 |
| ULVDS_25 | 2.5 | - | - | 430 | 670 |
| RSDS_25 | 2.5 | - | - | 100 | 400 |

Notes:

1. Measured with a termination resistor value (R_T) of 100 Ohms.
2. See [Table 6](#) for a listing of the differential DCI standards.

The need to supply V_{REF} and V_{CCO} imposes constraints on which standards can be used in the same bank. See [The Organization of IOBs into Banks](#) section for additional guidelines concerning the use of the V_{CCO} and V_{REF} lines.

Digitally Controlled Impedance (DCI)

When the round-trip delay of an output signal — i.e., from output to input and back again — exceeds rise and fall times, it is common practice to add termination resistors to the line carrying the signal. These resistors effectively match the impedance of a device’s I/O to the characteristic impedance of the transmission line, thereby preventing reflections that adversely affect signal integrity. However, with the high I/O counts supported by modern devices, adding resistors requires significantly more components and board area. Furthermore, for some packages — e.g., ball grid arrays — it may not always be possible to place resistors close to pins.

DCI answers these concerns by providing two kinds of on-chip terminations: Parallel terminations make use of an integrated resistor network. Series terminations result from controlling the impedance of output drivers. DCI actively adjusts both parallel and series terminations to accurately

match the characteristic impedance of the transmission line. This adjustment process compensates for differences in I/O impedance that can result from normal variation in the ambient temperature, the supply voltage and the manufacturing process. When the output driver turns off, the series termination, by definition, approaches a very high impedance; in contrast, parallel termination resistors remain at the targeted values.

DCI is available only for certain I/O standards, as listed in Table 6. DCI is selected by applying the appropriate I/O standard extensions to symbols or components. There are five basic ways to configure terminations, as shown in Table 7. The DCI I/O standard determines which of these terminations is put into effect.

Table 6: DCI I/O Standards

| Category of Signal Standard | Signal Standard | V _{CCO} (V) | | V _{REF} for Inputs (V) | Termination Type | |
|-------------------------------------|-----------------|----------------------|------------|---------------------------------|---------------------------------------|----------------------------|
| | | For Outputs | For Inputs | | At Output | At Input |
| Single-Ended | | | | | | |
| Gunning Transceiver Logic | GTL_DCI | 1.2 | 1.2 | 0.8 | Single | Single |
| | GTLP_DCI | 1.5 | 1.5 | 1.0 | | |
| High-Speed Transceiver Logic | HSTL_I_DCI | 1.5 | 1.5 | 0.75 | None | Split |
| | HSTL_III_DCI | 1.5 | 1.5 | 0.9 | None | Single |
| | HSTL_I_DCI_18 | 1.8 | 1.8 | 0.9 | None | Split |
| | HSTL_II_DCI_18 | 1.8 | 1.8 | 0.9 | Split | |
| | HSTL_III_DCI_18 | 1.8 | 1.8 | 1.1 | None | Single |
| | | | | | | |
| Low-Voltage CMOS | LVDCI_15 | 1.5 | 1.5 | - | Controlled impedance driver | None |
| | LVDCI_18 | 1.8 | 1.8 | - | | |
| | LVDCI_25 | 2.5 | 2.5 | - | | |
| | LVDCI_33 | 3.3 | 3.3 | - | | |
| | LVDCI_DV2_15 | 1.5 | 1.5 | - | Controlled driver with half-impedance | |
| | LVDCI_DV2_18 | 1.8 | 1.8 | - | | |
| | LVDCI_DV2_25 | 2.5 | 2.5 | - | | |
| | LVDCI_DV2_33 | 3.3 | 3.3 | - | | |
| Stub Series Terminated Logic | SSTL18_I_DCI | 1.8 | 1.8 | 0.9 | 25-Ohm driver | Split |
| | SSTL2_I_DCI | 2.5 | 2.5 | 1.25 | 25-Ohm driver | |
| | SSTL2_II_DCI | 2.5 | 2.5 | 1.25 | Split with 25-Ohm driver | |
| Differential | | | | | | |
| Low-Voltage Differential Signalling | LVDS_25_DCI | 2.5 | 2.5 | - | None | Split on each line of pair |
| | LVDSEXT_25_DCI | 2.5 | 2.5 | - | | |

Notes:

1. Bank 5 of any Spartan-3 device in a VQ100 or TQ144 package does not support DCI signal standards.

Table 7: DCI Terminations

| Termination | Schematic ⁽¹⁾ | I/O Standards |
|---|--------------------------|--|
| Controlled impedance output driver | | LVDCI_15 LVDCI_18 LVDCI_25 LVDCI_33 |
| Controlled output driver with half impedance | | LVDCI_DV2_15 LVDCI_DV2_18 LVDCI_DV2_25 LVDCI_DV2_33 |
| Single resistor | | GTL_DCI GTLP_DCI HSTL_III_DCI ⁽²⁾ HSTL_III_DCI_18 ⁽²⁾ |
| Split resistors | | HSTL_I_DCI ⁽²⁾ HSTL_I_DCI_18 ⁽²⁾ HSTL_II_DCI_18 LVDS_25_DCI LVDSEXT_25_DCI |
| Split resistors with output driver impedance fixed to 25Ω | | SSTL18_I_DCI ⁽³⁾ SSTL2_I_DCI ⁽³⁾ SSTL2_II_DCI |

Notes:

1. The value of R is equivalent to the characteristic impedance of the line connected to the I/O. It is also equal to half the value of R_{REF} for the DV2 standards and R_{REF} for all other DCI standards.
2. For DCI using HSTL Classes I and III, terminations only go into effect at inputs (not at outputs).
3. For DCI using SSTL Class I, the split termination only goes into effect at inputs (not at outputs).

The DCI feature operates independently for each of the device's eight banks. Each bank has an "N" reference pin (VRN) and a "P" reference pin, (VRP), to calibrate driver and termination resistance. Only when using a DCI standard on a given bank do these two pins function as VRN and VRP. When not using a DCI standard, the two pins function as user I/Os. As shown in [Figure 3](#), add an external reference resistor to pull the VRN pin up to V_{CCO} and another reference resistor to pull the VRP pin down to GND. Both resistors have the same value — commonly 50 Ohms — with one-percent tolerance, which is either the characteristic impedance of the line or twice that, depending on the DCI standard in use. Standards having a symbol name that contains the letters "DV2" use a reference resistor value that is twice the line impedance. DCI adjusts the output driver impedance to match the reference resistors' value or half that, according to the standard. DCI always adjusts the on-chip termination resistors to directly match the reference resistors' value.

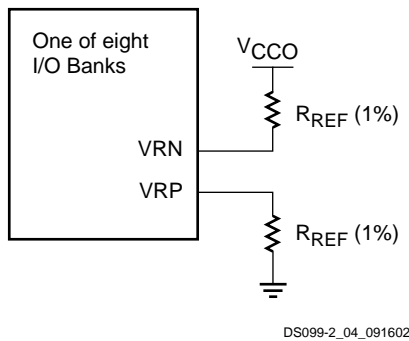


Figure 3: Connection of Reference Resistors (R_{REF})

The rules guiding the use of DCI standards on banks are as follows:

1. No more than one DCI I/O standard with a Single Termination is allowed per bank.
2. No more than one DCI I/O standard with a Split Termination is allowed per bank.
3. Single Termination, Split Termination, Controlled-Impedance Driver, and Controlled-Impedance Driver with Half Impedance can co-exist in the same bank.

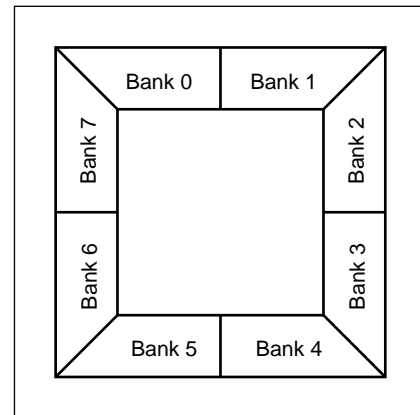
See also [The Organization of IOBs into Banks](#), page 8.

The Organization of IOBs into Banks

IOBs are allocated among eight banks, so that each side of the device has two banks, as shown in [Figure 4](#). For all packages, each bank has independent V_{REF} lines. For example, V_{REF} Bank 3 lines are separate from the V_{REF} lines going to all other banks.

For the Very Thin Quad Flat Pack (VQ), Plastic Quad Flat Pack (PQ), Fine Pitch Thin Ball Grid Array (FT), and Fine Pitch Ball Grid Array (FG) packages, each bank has dedicated V_{CCO} lines. For example, the V_{CCO} Bank 7 lines are separate from the V_{CCO} lines going to all other banks. Thus,

Spartan-3 devices in these packages support eight independent V_{CCO} supplies.



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Figure 4: Spartan-3 I/O Banks (top view)

In contrast, the 144-pin Thin Quad Flat Pack (TQ144) package ties V_{CCO} together internally for the pair of banks on each side of the device. For example, the V_{CCO} Bank 0 and the V_{CCO} Bank 1 lines are tied together. The interconnected bank-pairs are 0/1, 2/3, 4/5, and 6/7. As a result, Spartan-3 devices in the TQ144 package support four independent V_{CCO} supplies.

Spartan-3 Compatibility

Within the Spartan-3 family, all devices are pin-compatible by package. When the need for future logic resources outgrows the capacity of the Spartan-3 device in current use, a larger device in the same package can serve as a direct replacement. Larger devices may add extra V_{REF} and V_{CCO} lines to support a greater number of I/Os. In the larger device, more pins can convert from user I/Os to V_{REF} lines. Also, additional V_{CCO} lines are bonded out to pins that were "not connected" in the smaller device. Thus, it is important to plan for future upgrades at the time of the board's initial design by laying out connections to the extra pins.

The Spartan-3 family is not pin-compatible with any previous Xilinx FPGA family.

Rules Concerning Banks

When assigning I/Os to banks, it is important to follow the following V_{CCO} rules:

1. Leave no V_{CCO} pins unconnected on the FPGA.
2. Set all V_{CCO} lines associated with the (interconnected) bank to the same voltage level.
3. The V_{CCO} levels used by all standards assigned to the I/Os of the (interconnected) bank(s) must agree. The Xilinx development software checks for this. Tables [4](#), [5](#), and [6](#) describe how different standards use the V_{CCO} supply.

4. If none of the standards assigned to the I/Os of the (interconnected) bank(s) use V_{CCO} , tie all associated V_{CCO} lines to 2.5V.
5. In general, apply 2.5V to V_{CCO} Bank 4 from power-on to the end of configuration. Apply the same voltage to V_{CCO} Bank 5 during parallel configuration or a Readback operation. For information on how to program the FPGA using 3.3V signals and power, see the **3.3V-Tolerant Configuration Interface** section.

If any of the standards assigned to the Inputs of the bank use V_{REF} then observe the following additional rules:

1. Leave no V_{REF} pins unconnected on any bank.
2. Set all V_{REF} lines associated with the bank to the same voltage level.
3. The V_{REF} levels used by all standards assigned to the Inputs of the bank must agree. The Xilinx development software checks for this. Tables 4 and 6 describe how different standards use the V_{REF} supply.

If none of the standards assigned to the Inputs of a bank use V_{REF} for biasing input switching thresholds, all associated V_{REF} pins function as User I/Os.

Exceptions to Banks Supporting I/O Standards

Bank 5 of any Spartan-3 device in a VQ100 or TQ144 package does not support DCI signal standards. In this case, bank 5 has neither VRN nor VRP pins.

Furthermore, banks 4 and 5 of any Spartan-3 device in a VQ100 package do not support signal standards using V_{REF} (see Table 4). In this case, the two banks do not have any V_{REF} pins.

Supply Voltages for the IOBs

Three different supplies power the IOBs:

1. The V_{CCO} supplies, one for each of the FPGA's I/O banks, power the output drivers, except when using the GTL and GTLP signal standards. The voltage on the V_{CCO} pins determines the voltage swing of the output signal.
2. V_{CCINT} is the main power supply for the FPGA's internal logic.
3. The V_{CCAUX} is an auxiliary source of power, primarily to optimize the performance of various FPGA functions such as I/O switching.

The I/Os During Power-On, Configuration, and User Mode

With no power applied to the FPGA, all I/Os are in a high-impedance state. The V_{CCINT} (1.2V), V_{CCAUX} (2.5V), and V_{CCO} supplies may be applied in any order. Before power-on can finish, V_{CCINT} , V_{CCO} Bank 4, and V_{CCAUX} must have reached their respective minimum recommended operating levels (see Table 2 in Module 3: **DC and Switching Characteristics**). At this time, all I/O drivers also will be in a high-impedance state. V_{CCO} Bank 4, V_{CCINT} , and V_{CCAUX} serve as inputs to the internal Power-On Reset circuit (POR).

A Low level applied to HSWAP_EN input enables weak pull-up resistors on User I/Os from power-on throughout configuration. A High level on HSWAP_EN disables the pull-up resistors, allowing the I/Os to float. As soon as power is applied, the FPGA begins initializing its configuration memory. At the same time, the FPGA internally asserts the Global Set-Reset (GSR), which asynchronously resets all IOB storage elements to a Low state.

Upon the completion of initialization, INIT_B goes High, sampling the M0, M1, and M2 inputs to determine the configuration mode. At this point, the configuration data is loaded into the FPGA. The I/O drivers remain in a high-impedance state (with or without pull-up resistors, as determined by the HSWAP_EN input) throughout configuration.

The Global Three State (GTS) net is released during Start-Up, marking the end of configuration and the beginning of design operation in the User mode. At this point, those I/Os to which signals have been assigned go active while all unused I/Os remain in a high-impedance state. The release of the GSR net, also part of Start-up, leaves the IOB registers in a Low state by default, unless the loaded design reverses the polarity of their respective RS inputs.

In User mode, all weak, internal pull-up resistors on the I/Os are disabled and HSWAP_EN becomes a "don't care" input. If it is desirable to have weak pull-up or pull-down resistors on I/Os carrying signals, the appropriate symbol — e.g., PULLUP, PULLDOWN — must be placed at the appropriate pads in the design. The Bitstream Generator (Bitgen) option UnusedPin available in the Xilinx development software determines whether unused I/Os collectively have pull-up resistors, pull-down resistors, or no resistors in User mode.

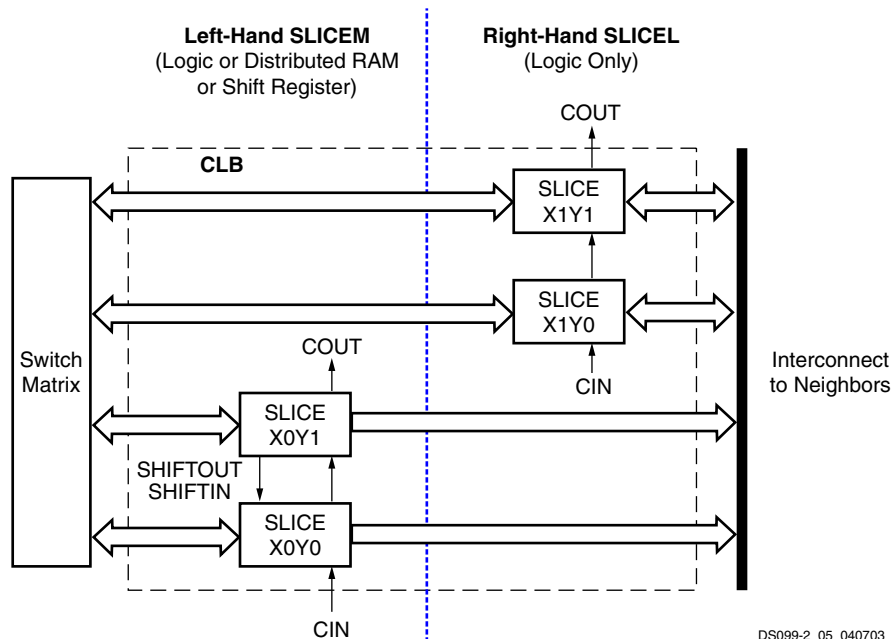


Figure 5: Arrangement of Slices within the CLB

CLB Overview

The Configurable Logic Blocks (CLBs) constitute the main logic resource for implementing synchronous as well as combinatorial circuits. Each CLB comprises four interconnected slices, as shown in Figure 5. These slices are grouped in pairs. Each pair is organized as a column with an independent carry chain.

The nomenclature that the FPGA Editor — part of the Xilinx development software — uses to designate slices is as follows: The letter "X" followed by a number identifies columns of slices. The "X" number counts up in sequence from the left side of the die to the right. The letter "Y" followed by a number identifies the position of each slice in a pair as well as indicating the CLB row. The "Y" number counts slices starting from the bottom of the die according to the sequence: 0, 1, 0, 1 (the first CLB row); 2, 3, 2, 3 (the second CLB row); etc. Figure 5 shows the CLB located in the lower left-hand corner of the die. Slices X0Y0 and X0Y1 make up the column-pair on the left where as slices X1Y0 and X1Y1 make up the column-pair on the right. For each CLB, the term "left-hand" (or SLICEM) is used to indicate the pair of slices labeled with an even "X" number, such as X0, and the term "right-hand" (or SLICEL) designates the pair of slices with an odd "X" number, e.g., X1.

Elements Within a Slice

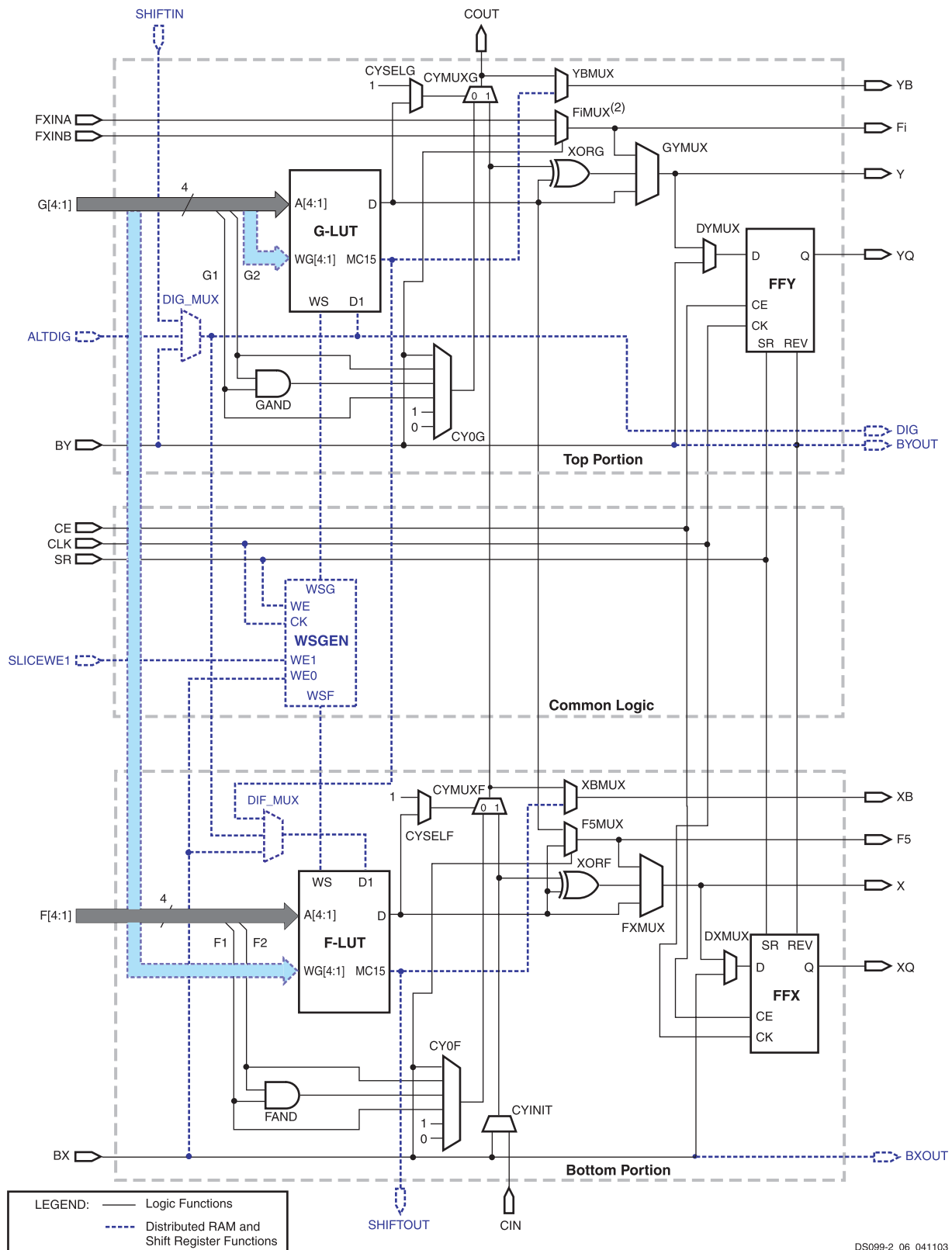
All four slices have the following elements in common: two logic function generators, two storage elements, wide-function multiplexers, carry logic, and arithmetic gates, as shown in Figure 6. Both the left-hand and right-hand slice pairs use these elements to provide logic, arithmetic, and

ROM functions. Besides these, the left-hand pair supports two additional functions: storing data using Distributed RAM and shifting data with 16-bit registers. Figure 6 is a diagram of the left-hand slice; therefore, it represents a superset of the elements and connections to be found in all slices. See [Function Generator](#), page 12 for more information.

The RAM-based function generator — also known as a Look-Up Table or LUT — is the main resource for implementing logic functions. Furthermore, the LUTs in each left-hand slice pair can be configured as Distributed RAM or a 16-bit shift register. For information on the former, see [XAPP464: Using Look-Up Tables as Distributed RAM in Spartan-3 FPGAs](#); for information on the latter, refer to [XAPP465: Using Look-Up Tables as Shift Registers \(SRL16\) in Spartan-3 FPGAs](#). The function generators located in the upper and lower portions of the slice are referred to as the "G" and "F", respectively.

The storage element, which is programmable as either a D-type flip-flop or a level-sensitive latch, provides a means for synchronizing data to a clock signal, among other uses. The storage elements in the upper and lower portions of the slice are called FFY and FFX, respectively.

Wide-function multiplexers effectively combine LUTs in order to permit more complex logic operations. Each slice has two of these multiplexers with F5MUX in the lower portion of the slice and FXMUX in the upper portion. Depending on the slice, FXMUX takes on the name F6MUX, F7MUX, or F8MUX. For more details on the multiplexers, see [XAPP466: Using Dedicated Multiplexers in Spartan-3 FPGAs](#).



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Notes:

- Options to invert signal polarity as well as other options that enable lines for various functions are not shown.
- The index *i* can be 6, 7, or 8, depending on the slice. In this position, the upper right-hand slice has an F8MUX, and the upper left-hand slice has an F7MUX. The lower right-hand and left-hand slices both have an F6MUX.

Figure 6: Simplified Diagram of the Left-Hand SLICEM

The carry chain, together with various dedicated arithmetic logic gates, support fast and efficient implementations of math operations. The carry chain enters the slice as CIN and exits as COUT. Five multiplexers control the chain: CYINIT, CY0F, and CYMUXF in the lower portion as well as CY0G and CYMUXG in the upper portion. The dedicated arithmetic logic includes the exclusive-OR gates XORF and XORG (upper and lower portions of the slice, respectively) as well as the AND gates GAND and FAND (upper and lower portions, respectively).

Main Logic Paths

Central to the operation of each slice are two nearly identical data paths, distinguished using the terms *top* and *bottom*. The description that follows uses names associated with the bottom path. (The top path names appear in parentheses.) The basic path originates at an interconnect-switch matrix outside the CLB. Four lines, F1 through F4 (or G1 through G4 on the upper path), enter the slice and connect directly to the LUT. Once inside the slice, the lower 4-bit path passes through a function generator "F" (or "G") that performs logic operations. The function generator's Data output, "D", offers five possible paths:

1. Exit the slice via line "X" (or "Y") and return to interconnect.
2. Inside the slice, "X" (or "Y") serves as an input to the DXMUX (DYMUX) which feeds the data input, "D", of the FFY (FFX) storage element. The "Q" output of the storage element drives the line XQ (or YQ) which exits the slice.
3. Control the CYMUXF (or CYMUXG) multiplexer on the carry chain.
4. With the carry chain, serve as an input to the XORF (or XORG) exclusive-OR gate that performs arithmetic operations, producing a result on "X" (or "Y").
5. Drive the multiplexer F5MUX to implement logic functions wider than four bits. The "D" outputs of both the F-LUT and G-LUT serve as data inputs to this multiplexer.

In addition to the main logic paths described above, there are two bypass paths that enter the slice as BX and BY. Once inside the FPGA, BX in the bottom half of the slice (or BY in the top half) can take any of several possible branches:

1. Bypass both the LUT and the storage element, then exit the slice as BXOUT (or BYOUT) and return to interconnect.
2. Bypass the LUT, then pass through a storage element via the D input before exiting as XQ (or YQ).
3. Control the wide function multiplexer F5MUX (or F6MUX).
4. Via multiplexers, serve as an input to the carry chain.

5. Drives the DI input of the LUT. See Distributed RAM section.
6. BY can control the REV inputs of both the FFY and FFX storage elements. See Storage Element Section.
7. Finally, the DIG_MUX multiplexer can switch BY onto to the DIG line, which exits the slice.

Other slice signals shown in [Figure 6, page 11](#) are discussed in the sections that follow.

Function Generator

Each of the two LUTs (F and G) in a slice have four logic inputs (A1-A4) and a single output (D). This permits any four-variable Boolean logic operation to be programmed into them. Furthermore, wide function multiplexers can be used to effectively combine LUTs within the same CLB or across different CLBs, making logic functions with still more input variables possible.

The LUTs in both the right-hand and left-hand slice-pairs not only support the logic functions described above, but also can function as ROM that is initialized with data at the time of configuration.

The LUTs in the left-hand slice-pair (even-numbered columns such as X0 in [Figure 5](#)) of each CLB support two additional functions that the right-hand slice-pair (odd-numbered columns such as X1) do not.

First, it is possible to program the "left-hand LUTs" as distributed RAM. This type of memory affords moderate amounts of data buffering anywhere along a data path. One left-hand LUT stores 16 bits. Multiple left-hand LUTs can be combined in various ways to store larger amounts of data. A dual port option combines two LUTs so that memory access is possible from two independent data lines. A Distributed ROM option permits pre-loading the memory with data during FPGA configuration. For more information, see the Distributed RAM section.

Second, it is possible to program each left-hand LUT as a 16-bit shift register. Used in this way, each LUT can delay serial data anywhere from one to 16 clock cycles. The four left-hand LUTs of a single CLB can be combined to produce delays up to 64 clock cycles. The SHIFTIN and SHIFTOUT lines cascade LUTs to form larger shift registers. It is also possible to combine shift registers across more than one CLB. The resulting programmable delays can be used to balance the timing of data pipelines.

Block RAM Overview

All Spartan-3 devices support block RAM, which is organized as configurable, synchronous 18Kbit blocks. Block RAM stores relatively large amounts of data more efficiently than the distributed RAM feature described earlier. (The latter is better suited for buffering small amounts of data anywhere along signal paths.) This section describes basic Block RAM functions. For more information, see [XAPP463: Using Block RAM in Spartan-3 FPGAs](#).

The aspect ratio — i.e., width vs. depth — of each block RAM is configurable. Furthermore, multiple blocks can be cascaded to create still wider and/or deeper memories.

A choice among primitives determines whether the block RAM functions as dual- or single-port memory. A name of the form RAM16_S[w_A][w_B] calls out the dual-port primitive, where the integers w_A and w_B specify the total data path width at ports w_A and w_B, respectively. Thus, a RAM16_S9_S18 is a dual-port RAM with a 9-bit-wide Port A and an 18-bit-wide Port B. A name of the form RAM16_S[w] identifies the single-port primitive, where the integer w specifies the total data path width of the lone port. A RAM16_S18 is a single-port RAM with an 18-bit-wide port. Other memory functions — e.g., FIFOs, data path width conversion, ROM, etc. — are readily available using the CORE Generator™ system, part of the Xilinx development software.

Arrangement of RAM Blocks on Die

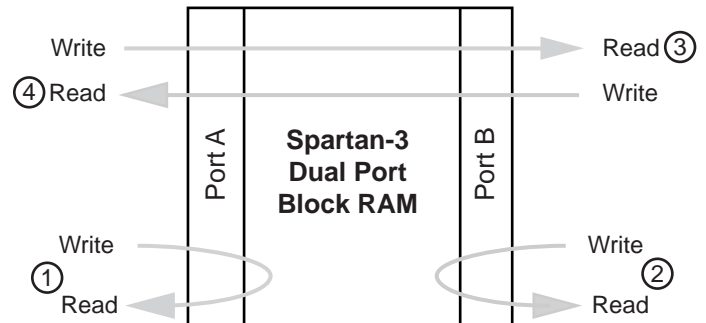
The XC3S50 has one column of block RAM. The Spartan-3 devices ranging from the XC3S200 to XC3S2000 have two columns of block RAM. The XC3S4000 and XC3S5000 have four columns. The position of the columns on the die is shown in Figure 1 in Module 1: **Introduction and Ordering Information**. For a given device, the total available RAM blocks are distributed equally among the columns. Table 8 shows the number of RAM blocks, the data storage capacity, and the number of columns for each device.

Table 8: Number of RAM Blocks by Device

| Device | Total Number of RAM Blocks | Total Addressable Locations (bits) | Number of Columns |
|----------|----------------------------|------------------------------------|-------------------|
| XC3S50 | 4 | 73,728 | 1 |
| XC3S200 | 12 | 221,184 | 2 |
| XC3S400 | 16 | 294,912 | 2 |
| XC3S1000 | 24 | 442,368 | 2 |
| XC3S1500 | 32 | 589,824 | 2 |
| XC3S2000 | 40 | 737,280 | 2 |
| XC3S4000 | 96 | 1,769,472 | 4 |
| XC3S5000 | 104 | 1,916,928 | 4 |

The Internal Structure of the Block RAM

The block RAM has a dual port structure. The two identical data ports called A and B permit independent access to the common RAM block, which has a maximum capacity of 18,432 bits — or 16,384 bits when no parity lines are used. Each port has its own dedicated set of data, control and clock lines for synchronous read and write operations. There are four basic data paths, as shown in Figure 7: (1) write to and read from Port A, (2) write to and read from Port B, (3) data transfer from Port A to Port B, and (4) data transfer from Port B to Port A.

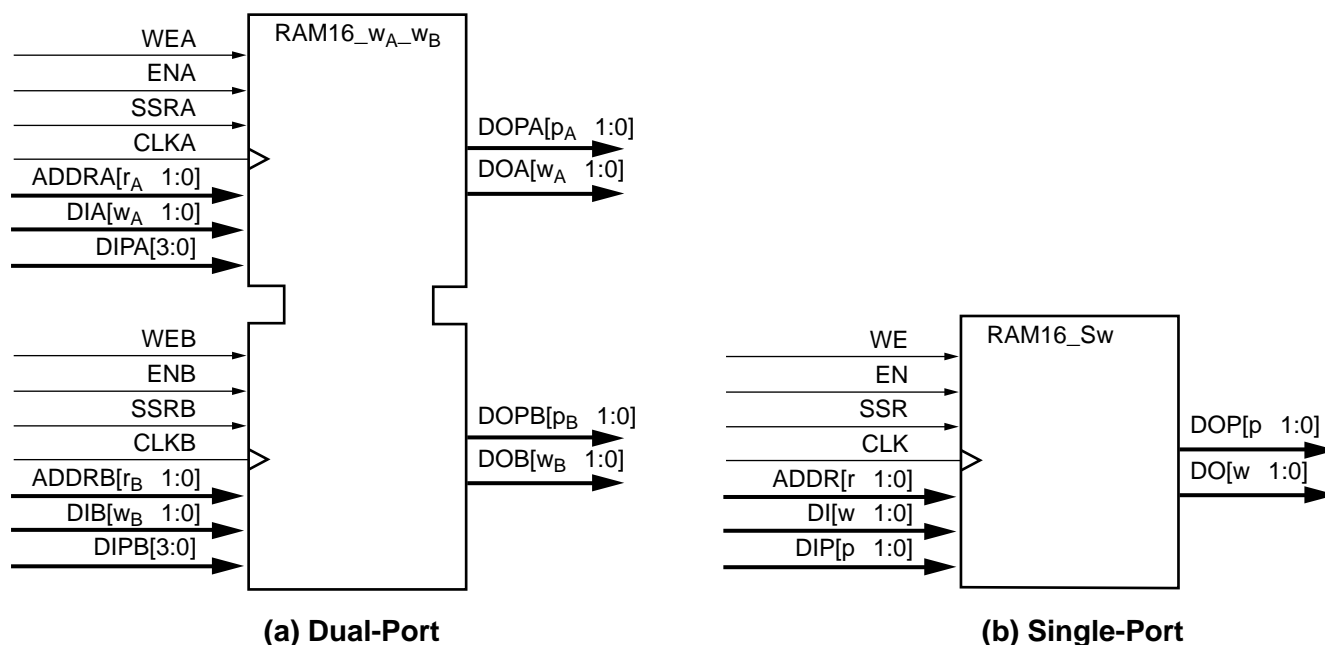


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Figure 7: Block RAM Data Paths

Block RAM Port Signal Definitions

Representations of the dual-port primitive RAM16_S[w_A][w_B] and the single-port primitive RAM16_S[w] with their associated signals are shown in Figure 8a and Figure 8b, respectively. These signals are defined in Table 9.



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Notes:

1. w_A and w_B are integers representing the total data path width (i.e., data bits plus parity bits) at ports A and B, respectively.
2. p_A and p_B are integers that indicate the number of data path lines serving as parity bits.
3. r_A and r_B are integers representing the address bus width at ports A and B, respectively.
4. The control signals CLK, WE, EN, and SSR on both ports have the option of inverted polarity.

Figure 8: Block RAM Primitives

Table 9: Block RAM Port Signals

| Signal Description | Port A Signal Name | Port B Signal Name | Direction | Function |
|----------------------|--------------------|--------------------|-----------|---|
| Address Bus | ADDRA | ADDRB | Input | The Address Bus selects a memory location for read or write operations. The width (w) of the port's associated data path determines the number of available address lines (r). |
| Data Input Bus | DIA | DIB | Input | Data at the DI input bus is written to the addressed memory location addressed on an enabled active CLK edge. It is possible to configure a port's total data path width (w) to be 1, 2, 4, 9, 18, or 36 bits. This selection applies to both the DI and DO paths of a given port. Each port is independent. For a port assigned a width (w), the number of addressable locations will be $16,384/(w-p)$ where "p" is the number of parity bits. Each memory location will have a width of "w" (including parity bits). See the DIP signal description for more information of parity. |
| Parity Data Input(s) | DIPA | DIPB | Input | Parity inputs represent additional bits included in the data input path to support error detection. The number of parity bits "p" included in the DI (same as for the DO bus) depends on a port's total data path width (w). See Table 10. |

Table 9: Block RAM Port Signals (Continued)

| Signal Description | Port A Signal Name | Port B Signal Name | Direction | Function |
|-----------------------|--------------------|--------------------|-----------|---|
| Data Output Bus | DOA | DOB | Output | <p>Basic data access occurs whenever WE is inactive. The DO outputs mirror the data stored in the addressed memory location.</p> <p>Data access with WE asserted is also possible if one of the following two attributes is chosen: WRITE_FIRST accesses data before the write takes place. READ_FIRST accesses data after the write occurs.</p> <p>A third attribute, NO_CHANGE, latches the DO outputs upon the assertion of WE.</p> <p>It is possible to configure a port's total data path width (w) to be 1, 2, 4, 9, 18, or 36 bits. This selection applies to both the DI and DO paths. See the DI signal description.</p> |
| Parity Data Output(s) | DOPA | DOPB | Output | <p>Parity inputs represent additional bits included in the data input path to support error detection. The number of parity bits "p" included in the DI (same as for the DO bus) depends on a port's total data path width (w). See Table 10.</p> |
| Write Enable | WEA | WEB | Input | <p>When asserted together with EN, this input enables the writing of data to the RAM. In this case, the data access attributes WRITE_FIRST, READ_FIRST or NO_CHANGE determines if and how data is updated on the DO outputs. See the DO signal description.</p> <p>When WE is inactive with EN asserted, read operations are still possible. In this case, a transparent latch passes data from the addressed memory location to the DO outputs.</p> |
| Clock Enable | ENA | ENB | Input | <p>When asserted, this input enables the CLK signal to synchronize Block RAM functions as follows: the writing of data to the DI inputs (when WE is also asserted), the updating of data at the DO outputs as well as the setting/resetting of the DO output latches.</p> <p>When de-asserted, the above functions are disabled.</p> |
| Set/Reset | SSRA | SSRB | Input | <p>When asserted, this pin forces the DO output latch to the value that the SRVAL attribute is set to. A Set/Reset operation on one port has no effect on the other ports functioning, nor does it disturb the memory's data contents. It is synchronized to the CLK signal.</p> |
| Clock | CLKA | CLKB | Input | <p>This input accepts the clock signal to which read and write operations are synchronized. All associated port inputs are required to meet setup times with respect to the clock signal's active edge. The data output bus responds after a clock-to-out delay referenced to the clock signal's active edge.</p> |

Port Aspect Ratios

On a given port, it is possible to select a number of different possible widths (w – p) for the DI/DO buses as shown in Table 10. These two buses always have the same width. This data bus width selection is independent for each port. If the data bus width of Port A differs from that of Port B, the

Block RAM automatically performs a bus-matching function. When data are written to a port with a narrow bus, then read from a port with a wide bus, the latter port will effectively combine “narrow” words to form “wide” words. Similarly, when data are written into a port with a wide bus, then read from a port with a narrow bus, the latter port will divide

“wide” words to form “narrow” words. When the data bus width is eight bits or greater, extra parity bits become available. The width of the total data path (w) is the sum of the DI/DO bus width and any parity bits (p).

The width selection made for the DI/DO bus determines the number of address lines according to the relationship expressed below:

$$r = 14 - \lceil \log(w-p)/\log(2) \rceil \quad (1)$$

In turn, the number of address lines delimits the total number (n) of addressable locations or depth according to the following equation:

$$n = 2^r \quad (2)$$

The product of w and n yields the total block RAM capacity. Equations (1) and (2) show that as the data bus width increases, the number of address lines along with the number of addressable memory locations decreases. Using the permissible DI/DO bus widths as inputs to these equations provides the bus width and memory capacity measures shown in Table 10.

Table 10: Port Aspect Ratios for Port A or B

| DI/DO Bus Width (w – p bits) | DIP/DOP Bus Width (p bits) | Total Data Path Width (w bits) | ADDR Bus Width (r bits) | No. of Addressable Locations (n) | Block RAM Capacity (bits) |
|---------------------------------|-------------------------------|-----------------------------------|----------------------------|--|---------------------------------|
| 1 | 0 | 1 | 14 | 16,384 | 16,384 |
| 2 | 0 | 2 | 13 | 8,192 | 16,384 |
| 4 | 0 | 4 | 12 | 4,096 | 16,384 |
| 8 | 1 | 9 | 11 | 2,048 | 18,432 |
| 16 | 2 | 18 | 10 | 1,024 | 18,432 |
| 32 | 4 | 36 | 9 | 512 | 18,432 |

Block RAM Data Operations

Writing data to and accessing data from the block RAM are synchronous operations that take place independently on each of the two ports.

The waveforms for the write operation are shown in the top half of the Figure 9, Figure 10, and Figure 11. When the WE and EN signals enable the active edge of CLK, data at the DI input bus is written to the block RAM location addressed by the ADDR lines.

There are a number of different conditions under which data can be accessed at the DO outputs. Basic data access always occurs when the WE input is inactive. Under this

condition, data stored in the memory location addressed by the ADDR lines passes through a transparent output latch to the DO outputs. The timing for basic data access is shown in the portions of Figure 9, Figure 10, and Figure 11 during which WE is Low.

Data can also be accessed on the DO outputs when asserting the WE input. This is accomplished using two different attributes:

Choosing the WRITE_FIRST attribute, data is written to the addressed memory location on an enabled active CLK edge and is also passed to the DO outputs. WRITE_FIRST timing is shown in the portion of Figure 9 during which WE is High.

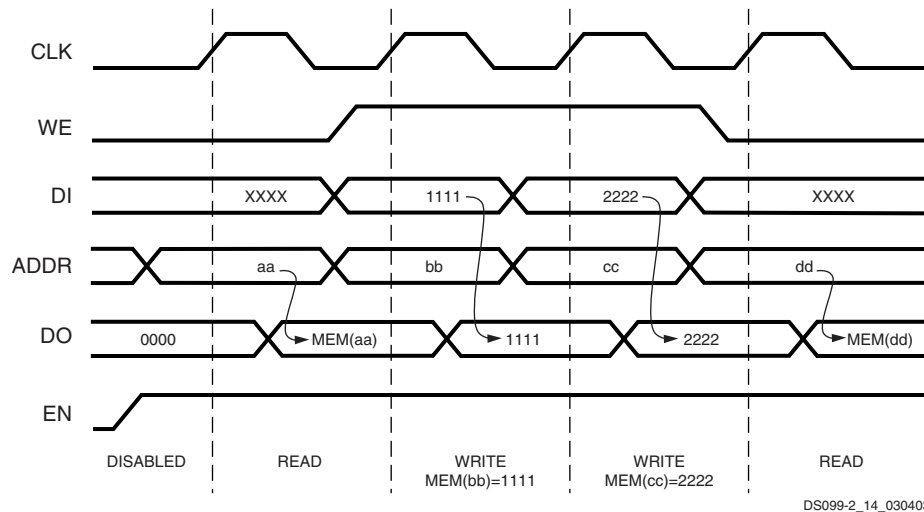


Figure 9: Waveforms of Block RAM Data Operations with WRITE_FIRST Selected

Choosing the READ_FIRST attribute, data already stored in the addressed location pass to the DO outputs before that location is over-written with new data from the DI inputs on

an enabled active CLK edge. READ_FIRST timing is shown in the portion of Figure 10 during which WE is High.

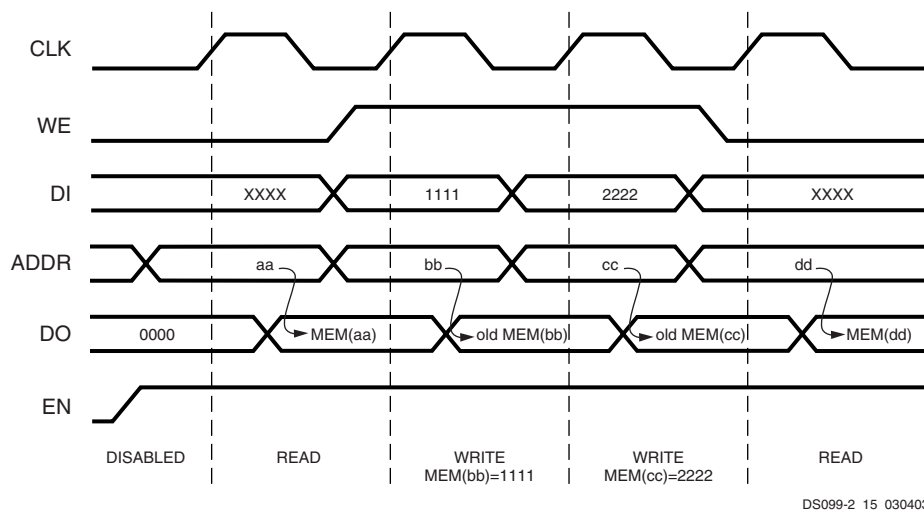


Figure 10: Waveforms of Block RAM Data Operations with READ_FIRST Selected

Choosing a third attribute called NO_CHANGE puts the DO outputs in a latched state when asserting WE. Under this condition, the DO outputs will retain the data driven just

before WE was asserted. NO_CHANGE timing is shown in the portion of Figure 11 during which WE is High.

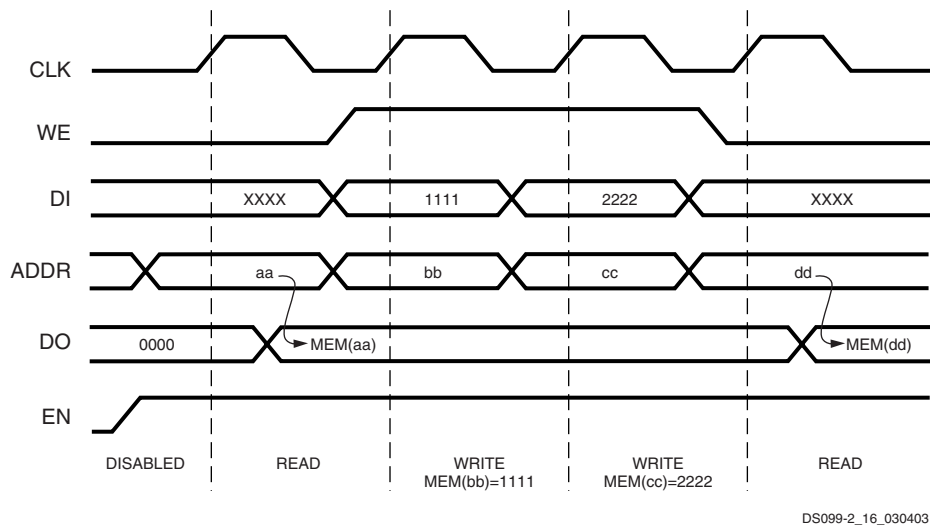


Figure 11: Waveforms of Block RAM Data Operations with NO_CHANGE Selected

Dedicated Multipliers

All Spartan-3 devices provide embedded multipliers that accept two 18-bit words as inputs to produce a 36-bit product. This section provides an introduction to multipliers. For further details, see [XAPP467: Using Embedded Multipliers in Spartan-3 FPGAs](#).

The input buses to the multiplier accept data in two's-complement form (either 18-bit signed or 17-bit unsigned). One such multiplier is matched to each block RAM on the die. The close physical proximity of the two ensures efficient

data handling. Cascading multipliers permits multiplicands more than three in number as well as wider than 18-bits. The multiplier is placed in a design using one of two primitives: an asynchronous version called MULT18X18 and a version with a register at the outputs called MULT18X18S, as shown in [Figure 12a](#) and [Figure 12b](#), respectively. The signals for these primitives are defined in [Table 11](#).

The CORE Generator system produces multipliers based on these primitives that can be configured to suit a wide range of requirements.

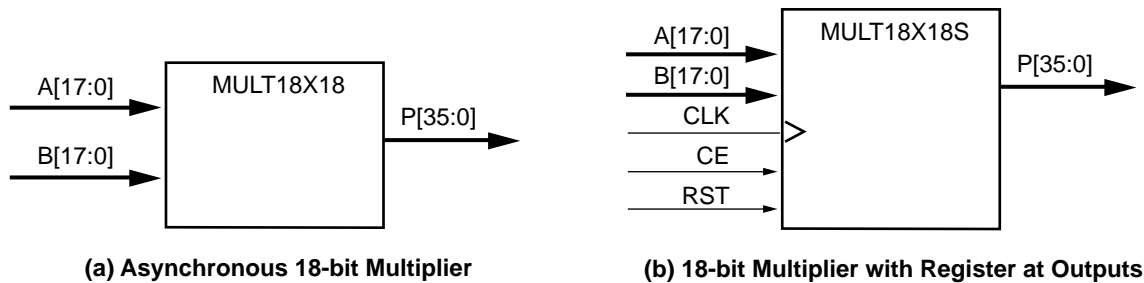


Figure 12: Embedded Multiplier Primitives

Table 11: Embedded Multiplier Primitives Descriptions

| Signal Name | Direction | Function |
|-------------|-----------|--|
| A[17:0] | Input | Apply one 18-bit multiplicand to these inputs. The MULT18X18S primitive requires a setup time before the enabled rising edge of CLK. |
| B[17:0] | Input | Apply the other 18-bit multiplicand to these inputs. The MULT18X18S primitive requires a setup time before the enabled rising edge of CLK. |
| P[35:0] | Output | The output on the P bus is a 36-bit product of the multiplicands A and B. In the case of the MULT18X18S primitive, an enabled rising CLK edge updates the P bus. |
| CLK | Input | CLK is only an input to the MULT18X18S primitive. The clock signal applied to this input when enabled by CE, updates the output register that drives the P bus. |
| CE | Input | CE is only an input to the MULT18X18S primitive. Enable for the CLK signal. Asserting this input enables the CLK signal to update the P bus. |
| RST | Input | RST is only an input to the MULT18X18S primitive. Asserting this input resets the output register on an enabled, rising CLK edge, forcing the P bus to all zeroes. |

Notes:

1. The control signals CLK, CE and RST have the option of inverted polarity.

Digital Clock Manager (DCM)

Spartan-3 devices provide flexible, complete control over clock frequency, phase shift and skew through the use of the DCM feature. To accomplish this, the DCM employs a Delay-Locked Loop (DLL), a fully digital control system that uses feedback to maintain clock signal characteristics with a high degree of precision despite normal variations in operating temperature and voltage. This section provides a fundamental description of the DCM. For further information, see [XAPP462: Using Digital Clock Managers \(DCMs\) in Spartan-3 FPGAs](#).

Each member of the Spartan-3 family has four DCMs, except the smallest, the XC3S50, which has two DCMs. The DCMs are located at the ends of the outermost Block RAM column(s). See [Figure 1](#) in Module 1: **Introduction and Ordering Information**. The Digital Clock Manager is placed in a design as the “DCM” primitive.

The DCM supports three major functions:

- **Clock-skew Elimination:** Clock skew describes the extent to which clock signals may, under normal circumstances, deviate from zero-phase alignment. It occurs when slight differences in path delays cause the

clock signal to arrive at different points on the die at different times. This clock skew can increase set-up and hold time requirements as well as clock-to-out time, which may be undesirable in applications operating at a high frequency, when timing is critical. The DCM eliminates clock skew by aligning the output clock signal it generates with another version of the clock signal that is fed back. As a result, the two clock signals establish a zero-phase relationship. This effectively cancels out clock distribution delays that may lie in the signal path leading from the clock output of the DCM to its feedback input.

- **Frequency Synthesis:** Provided with an input clock signal, the DCM can generate a wide range of different output clock frequencies. This is accomplished by either multiplying and/or dividing the frequency of the input clock signal by any of several different factors.
- **Phase Shifting:** The DCM provides the ability to shift the phase of all its output clock signals with respect to its input clock signal.

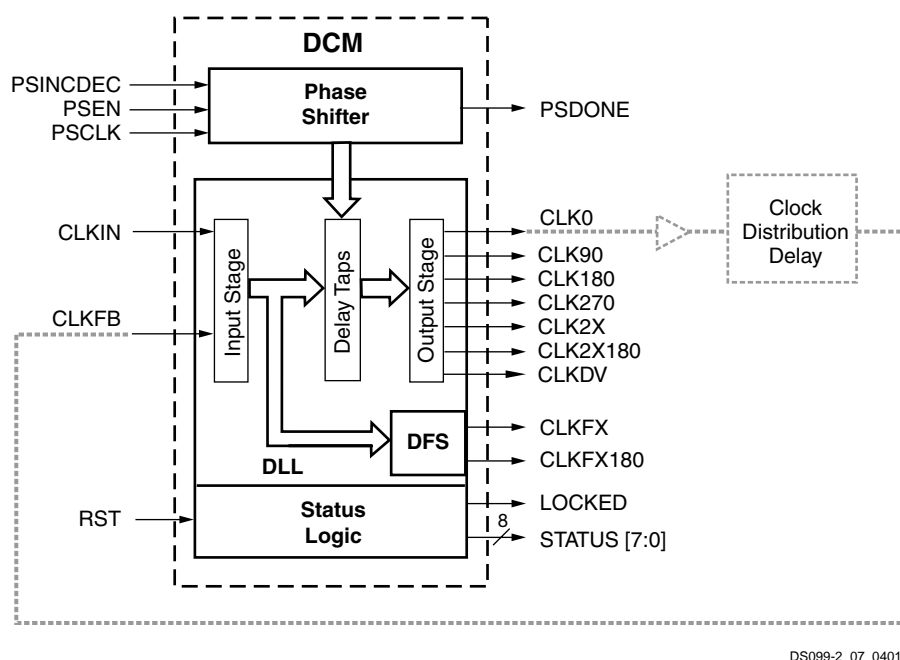


Figure 13: DCM Functional Blocks and Associated Signals

The DCM has four functional components: the Delay-Locked Loop (DLL), the Digital Frequency Synthesizer (DFS), the Phase Shifter (PS), and the Status Logic.

Each component has its associated signals, as shown in Figure 13.

Delay-Locked Loop (DLL)

The most basic function of the DLL component is to eliminate clock skew. The main signal path of the DLL consists of an input stage, followed by a series of discrete delay elements or *taps*, which in turn leads to an output stage. This

path together with logic for phase detection and control forms a system complete with feedback as shown in Figure 14.

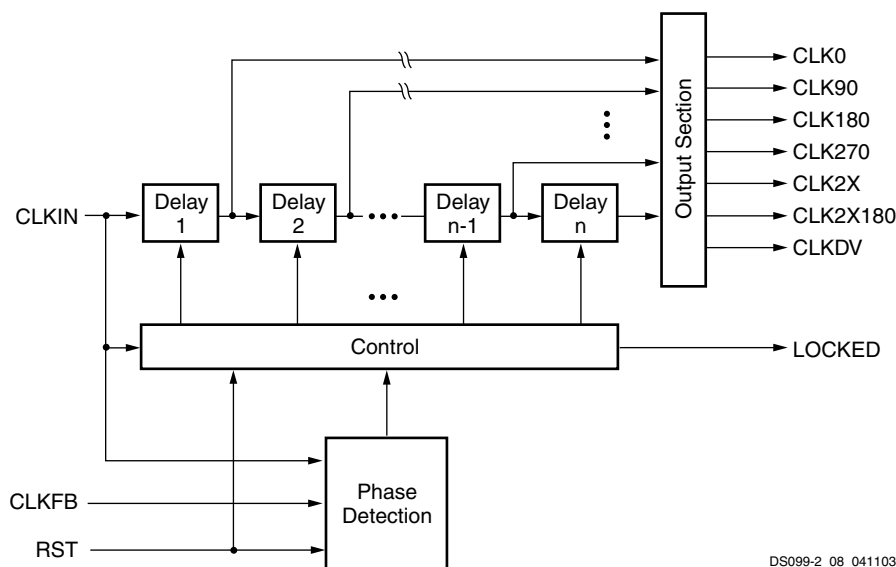


Figure 14: Simplified Functional Diagram of DLL

The DLL component has two clock inputs, CLKIN and CLKFB, as well as seven clock outputs, CLK0, CLK90, CLK180, CLK270, CLK2X, CLK2X180, and CLKDV as described in [Table 12](#). The clock outputs drive simultaneously; however, the High Frequency mode only supports

a subset of the outputs available in the Low Frequency mode. See [DLL Frequency Modes, page 23](#). Signals that initialize and report the state of the DLL are discussed in [The Status Logic Component, page 28](#).

Table 12: DLL Signals

| Signal | Direction | Description | Mode Support | |
|----------|-----------|--|---------------|----------------|
| | | | Low Frequency | High Frequency |
| CLKIN | Input | Accepts original clock signal. | Yes | Yes |
| CLKFB | Input | Accepts either CLK0 or CLK2X as feed back signal. (Set CLK_FEEDBACK attribute accordingly). | Yes | Yes |
| CLK0 | Output | Generates clock signal with same frequency and phase as CLKIN. | Yes | Yes |
| CLK90 | Output | Generates clock signal with same frequency as CLKIN, only phase-shifted 90°. | Yes | No |
| CLK180 | Output | Generates clock signal with same frequency as CLKIN, only phase-shifted 180°. | Yes | Yes |
| CLK270 | Output | Generates clock signal with same frequency as CLKIN, only phase-shifted 270°. | Yes | No |
| CLK2X | Output | Generates clock signal with same phase as CLKIN, only twice the frequency. | Yes | No |
| CLK2X180 | Output | Generates clock signal with twice the frequency of CLKIN, phase-shifted 180° with respect to CLKIN. | Yes | No |
| CLKDV | Output | Divides the CLKIN frequency by CLKDV_DIVIDE value to generate lower frequency clock signal that is phase-aligned to CLKIN. | Yes | Yes |

The clock signal supplied to the CLKIN input serves as a reference waveform, with which the DLL seeks to align the feedback signal at the CLKFB input. When eliminating clock skew, the common approach to using the DLL is as follows: The CLK0 signal is passed through the clock distribution network to all the registers it synchronizes. These registers are either internal or external to the FPGA. After passing through the clock distribution network, the clock signal returns to the DLL via a feedback line called CLKFB. The control block inside the DLL measures the phase error between CLKFB and CLKIN. This phase error is a measure of the clock skew that the clock distribution network intro-

duces. The control block activates the appropriate number of delay elements to cancel out the clock skew. Once the DLL has brought the CLK0 signal in phase with the CLKIN signal, it asserts the LOCKED output, indicating a “lock” on to the CLKIN signal.

DLL Attributes and Related Functions

A number of different functional options can be set for the DLL component through the use of the attributes described in [Table 13](#). Each attribute is described in detail in the sections that follow:

Table 13: DLL Attributes

| Attribute | Description | Values |
|-----------------------|--|--|
| CLK_FEEDBACK | Chooses either the CLK0 or CLK2X output to drive the CLKFB input | NONE, 1X, 2X |
| DLL_FREQUENCY_MODE | Chooses between High Frequency and Low Frequency modes | LOW, HIGH |
| CLKIN_DIVIDE_BY_2 | Halves the frequency of the CLKIN signal just as it enters the DCM | TRUE, FALSE |
| CLKDV_DIVIDE | Selects constant used to divide the CLKIN input frequency to generate the CLKDV output frequency | 1.5, 2, 2.5, 3, 3.5, 4, 4.5, 5, 5.5, 6.0, 6.5, 7.0, 7.5, 8, 9, 10, 11, 12, 13, 14, 15, and 16. |
| DUTY_CYCLE_CORRECTION | Enables 50% duty cycle correction for the CLK0, CLK90, CLK180, and CLK270 outputs | TRUE, FALSE |

DLL Clock Input Connections

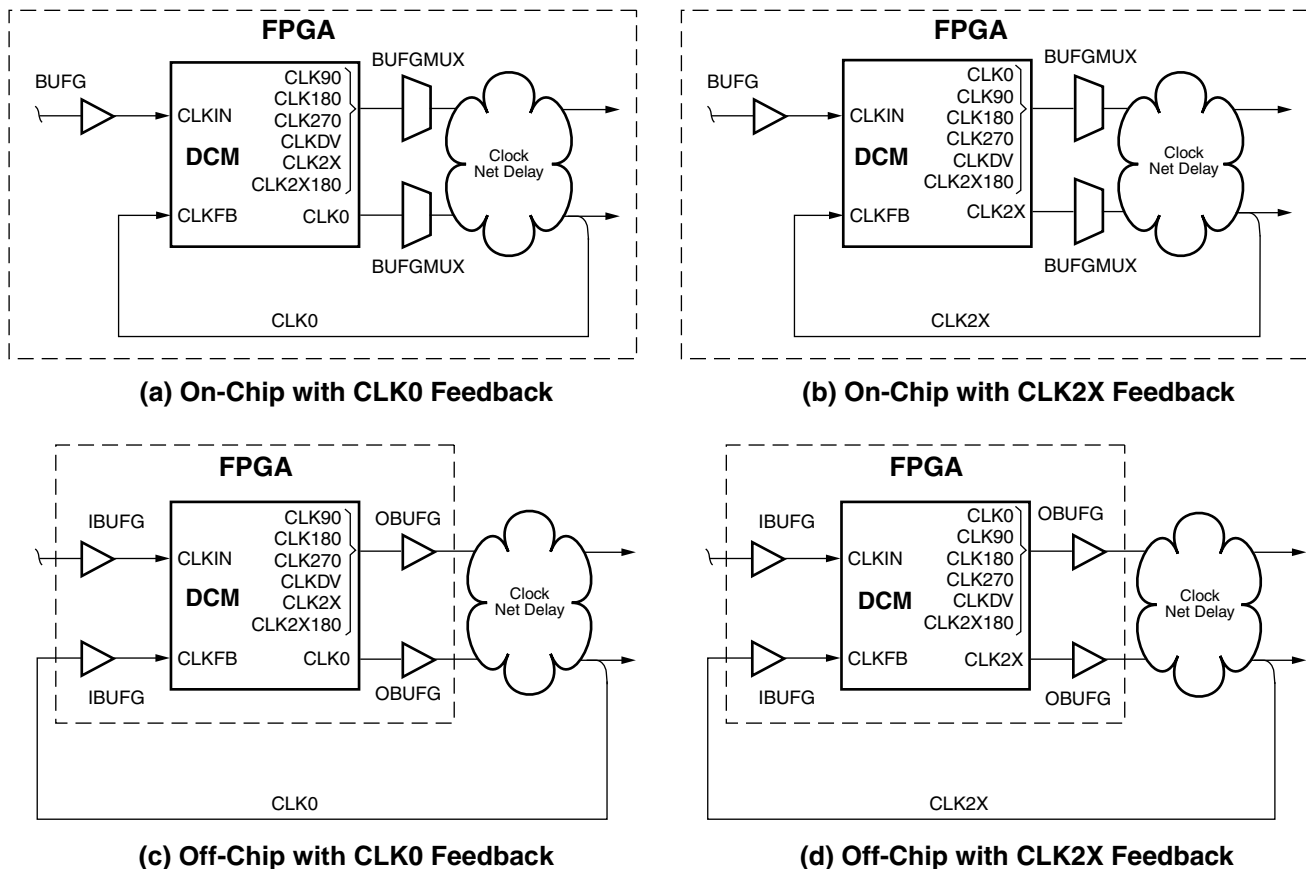
An external clock source enters the FPGA using a Global Clock Input Buffer (IBUFG), which directly accesses the global clock network or an Input Buffer (IBUF). Clock signals within the FPGA drive a global clock net using a Global Clock Multiplexer Buffer (BUFGMUX). The global clock net connects directly to the CLKIN input. The internal and external connections are shown in [Figure 15a](#) and [Figure 15c](#), respectively. A differential clock (e.g., LVDS) can serve as an input to CLKIN.

DLL Clock Output and Feedback Connections

As many as four of the nine DCM clock outputs can simultaneously drive the four BUFGMUX buffers on the same die edge (top or bottom). All DCM clock outputs can simultaneously drive general routing resources, including interconnect leading to OBUF buffers.

The feedback loop is essential for DLL operation and is established by driving the CLKFB input with either the CLK0 or the CLK2X signal so that any undesirable clock distribution delay is included in the loop. It is possible to use either of these two signals for synchronizing any of the seven DLL outputs: CLK0, CLK90, CLK180, CLK270, CLKDV, CLK2X, or CLK2X180. The value assigned to the CLK_FEEDBACK attribute must agree with the physical feedback connection: a value of 1X for the CLK0 case, 2X for the CLK2X case. If the DCM is used in an application that does not require the DLL — i.e., only the DFS is used — then there is no feedback loop so CLK_FEEDBACK is set to NONE.

There are two basic cases that determine how to connect the DLL clock outputs and feedback connections: on-chip synchronization and off-chip synchronization, which are illustrated in [Figure 15a](#) through [Figure 15d](#).



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Notes:

1. In the Low Frequency mode, all seven DLL outputs are available. In the High Frequency mode, only the CLK0, CLK180, and CLKDV outputs are available.

Figure 15: Input Clock, Output Clock, and Feedback Connections for the DLL

In the on-chip synchronization case (Figure 15a and Figure 15b), it is possible to connect any of the DLL's seven output clock signals through general routing resources to the FPGA's internal registers. Either a Global Clock Buffer (BUFG) or a BUFGMUX affords access to the global clock network. As shown in Figure 15a, the feedback loop is created by routing CLK0 (or CLK2X, in Figure 15b) to a global clock net, which in turn drives the CLKFB input.

In the off-chip synchronization case (Figure 15c and Figure 15d), CLK0 (or CLK2X) plus any of the DLL's other output clock signals exit the FPGA using output buffers (OBUF) to drive an external clock network plus registers on the board. As shown in Figure 15c, the feedback loop is formed by feeding CLK0 (or CLK2X, in Figure 15d) back into the FPGA using an IBUFG, which directly accesses the global clock network, or an IBUF. Then, the global clock net is connected directly to the CLKFB input.

DLL Frequency Modes

The DLL supports two distinct operating modes, High Frequency and Low Frequency, with each specified over a different clock frequency range. The DLL_FREQUENCY_MODE

attribute chooses between the two modes. When the attribute is set to LOW, the Low Frequency mode permits all seven DLL clock outputs to operate over a low-to-moderate frequency range. When the attribute is set to HIGH, the High Frequency mode allows the CLK0, CLK180 and CLKDV outputs to operate at the highest possible frequencies. The remaining DLL clock outputs are not available for use in High Frequency mode.

Accommodating High Input Frequencies

If the frequency of the CLKIN signal is high such that it exceeds the maximum permitted, divide it down to an acceptable value using the CLKIN_DIVIDE_BY_2 attribute. When this attribute is set to TRUE, the CLKIN frequency is divided by a factor of two just as it enters the DCM.

Coarse Phase Shift Outputs of the DLL Component

In addition to CLK0 for zero-phase alignment to the CLKIN signal, the DLL also provides the CLK90, CLK180 and CLK270 outputs for 90°, 180° and 270° phase-shifted signals, respectively. These signals are described in Table 12.

Their relative timing in the Low Frequency Mode is shown in **Figure 16**. The CLK90, CLK180 and CLK270 outputs are not available when operating in the High Frequency mode. (See the description of the DLL_FREQUENCY_MODE attribute in **Table 13**.) For control in finer increments than 90°, see the **Phase Shifter (PS)**, page 26 section.

Basic Frequency Synthesis Outputs of the DLL Component

The DLL component provides basic options for frequency multiplication and division in addition to the more flexible synthesis capability of the DFS component, described in a later section. These operations result in output clock signals with frequencies that are either a fraction (for division) or a multiple (for multiplication) of the incoming clock frequency. The CLK2X output produces an in-phase signal that is twice the frequency of CLKIN. The CLK2X180 output also doubles the frequency, but is 180° out-of-phase with respect to CLKIN. The CLKDIV output generates a clock frequency that is a predetermined fraction of the CLKIN frequency. The CLKDV_DIVIDE attribute determines the factor used to divide the CLKIN frequency. The attribute can be set to various values as described in **Table 13**. The basic frequency synthesis outputs are described in **Table 12**. Their relative timing in the Low Frequency Mode is shown in **Figure 16**.

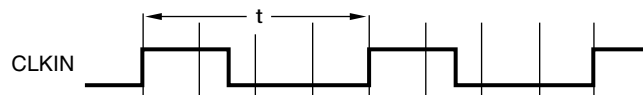
The CLK2X and CLK2X180 outputs are not available when operating in the High Frequency mode. (See the description of the DLL_FREQUENCY_MODE attribute in **Table 14**.)

Duty Cycle Correction of DLL Clock Outputs

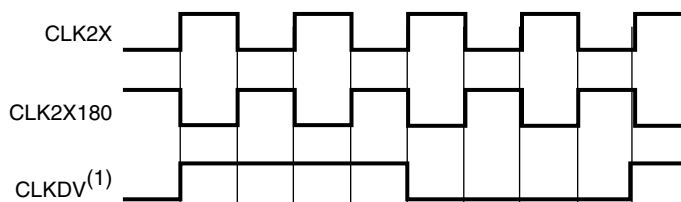
The CLK2X⁽¹⁾, CLK2X180, and CLKDV⁽²⁾ output signals ordinarily exhibit a 50% duty cycle – even if the incoming CLKIN signal has a different duty cycle. Fifty-percent duty cycle means that the High and Low times of each clock cycle are equal. The DUTY_CYCLE_CORRECTION attribute determines whether or not duty cycle correction is applied to the CLK0, CLK90, CLK180 and CLK270 outputs. If DUTY_CYCLE_CORRECTION is set to TRUE, then the duty cycle of these four outputs is corrected to 50%. If DUTY_CYCLE_CORRECTION is set to FALSE, then these outputs exhibit the same duty cycle as the CLKIN signal. **Figure 16** compares the characteristics of the DLL's output signals to those of the CLKIN signal.

Phase: 0° 90° 180° 270° 0° 90° 180° 270° 0°

Input Signal (30% Duty Cycle)

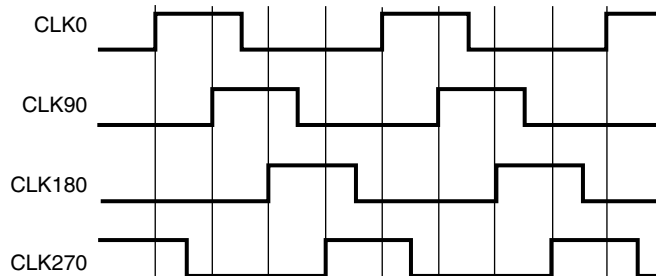


Output Signal - Duty Cycle is Always Corrected

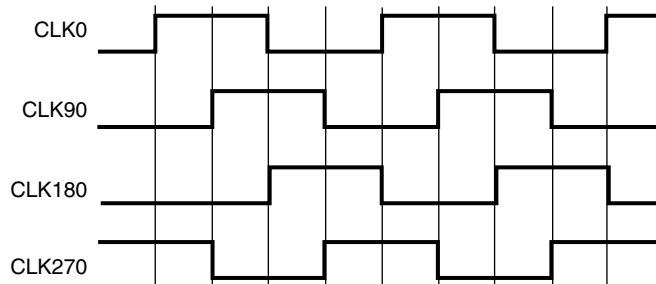


Output Signal - Attribute Corrects Duty Cycle

DUTY_CYCLE_CORRECTION = FALSE



DUTY_CYCLE_CORRECTION = TRUE



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Notes:

1. The DLL attribute CLKDV_DIVIDE is set to 2.

Figure 16: Characteristics of the DLL Clock Outputs

1. The CLK2X output generates a 25% duty cycle clock at the same frequency as the CLKIN signal until the DLL has achieved lock.
2. The duty cycle of the CLKDV outputs may differ somewhat from 50% (i.e., the signal will be High for less than 50% of the period) when the CLKDV_DIVIDE attribute is set to a non-integer value and the DLL is operating in the High Frequency mode.

Digital Frequency Synthesizer (DFS)

The DFS component generates clock signals the frequency of which is a product of the clock frequency at the CLKIN input and a ratio of two user-determined integers. Because of the wide range of possible output frequencies such a ratio permits, the DFS feature provides still further flexibility than the DLL's basic synthesis options as described in the preceding section. The DFS component's two dedicated outputs, CLKFX and CLKFX180, are defined in Table 15.

The signal at the CLKFX180 output is essentially an inversion of the CLKFX signal. These two outputs always exhibit a 50% duty cycle. This is true even when the CLKIN signal does not. These DFS clock outputs are driven at the same time as the DLL's seven clock outputs.

The numerator of the ratio is the integer value assigned to the attribute CLKFX_MULTIPLY and the denominator is the integer value assigned to the attribute CLKFX_DIVIDE. These attributes are described in Table 14.

The output frequency (f_{CLKFX}) can be expressed as a function of the incoming clock frequency (f_{CLKIN}) as follows:

$$f_{CLKFX} = f_{CLKIN} * (CLKFX_MULTIPLY / CLKFX_DIVIDE) \quad (3)$$

Regarding the two attributes, it is possible to assign any combination of integer values, provided that two conditions are met:

1. The two values fall within their corresponding ranges, as specified in Table 14.
2. The f_{CLKFX} frequency calculated from the above expression accords with the DCM's operating frequency specifications.

For example, if CLKFX_MULTIPLY = 5 and CLKFX_DIVIDE = 3, then the frequency of the output clock signal would be 5/3 that of the input clock signal.

DFS Frequency Modes

The DFS supports two operating modes, High Frequency and Low Frequency, with each specified over a different clock frequency range. The DFS_FREQUENCY_MODE attribute chooses between the two modes. When the attribute is set to LOW, the Low Frequency mode permits

the two DFS outputs to operate over a low-to-moderate frequency range. When the attribute is set to HIGH, the High Frequency mode allows both these outputs to operate at the highest possible frequencies.

DFS With or Without the DLL

The DFS component can be used with or without the DLL component:

Without the DLL, the DFS component multiplies or divides the CLKIN signal frequency according to the respective CLKFX_MULTIPLY and CLKFX_DIVIDE values, generating a clock with the new target frequency on the CLKFX and CLKFX180 outputs. Though classified as belonging to the DLL component, the CLKIN input is shared with the DFS component. This case does not employ feedback loop; therefore, it cannot correct for clock distribution delay.

With the DLL, the DFS operates as described in the preceding case, only with the additional benefit of eliminating the clock distribution delay. In this case, a feedback loop from the CLK0 output to the CLKFB input must be present.

The DLL and DFS components work together to achieve this phase correction as follows: Given values for the CLKFX_MULTIPLY and CLKFX_DIVIDE attributes, the DLL selects the delay element for which the output clock edge coincides with the input clock edge whenever mathematically possible. For example, when CLKFX_MULTIPLY = 5 and CLKFX_DIVIDE = 3, the input and output clock edges will coincide every three input periods, which is equivalent in time to five output periods.

Smaller CLKFX_MULTIPLY and CLKFX_DIVIDE values achieve faster lock times. With no factors common to the two attributes, alignment will occur once with every number of cycles equal to the CLKFX_DIVIDE value. Therefore, it is recommended that the user reduce these values by factoring wherever possible. For example, given CLKFX_MULTIPLY = 9 and CLKFX_DIVIDE = 6, removing a factor of three yields CLKFX_MULTIPLY = 3 and CLKFX_DIVIDE = 2. While both value-pairs will result in the multiplication of clock frequency by 3/2, the latter value-pair will enable the DLL to lock more quickly.

Table 14: DFS Attributes

| Attribute | Description | Values |
|--------------------|--|----------------------|
| DFS_FREQUENCY_MODE | Chooses between High Frequency and Low Frequency modes | Low, High |
| CLKFX_MULTIPLY | Frequency multiplier constant | Integer from 2 to 32 |
| CLKFX_DIVIDE | Frequency divisor constant | Integer from 1 to 32 |

Table 15: DFS Signals

| Signal | Direction | Description |
|----------|-----------|---|
| CLKFX | Output | Multiplies the CLKIN frequency by the attribute-value ratio (CLKFX_MULTIPLY/CLKFX_DIVIDE) to generate a clock signal with a new target frequency. |
| CLKFX180 | Output | Generates a clock signal with same frequency as CLKFX, only shifted 180° out-of-phase. |

DFS Clock Output Connections

There are two basic cases that determine how to connect the DFS clock outputs: on-chip and off-chip, which are illustrated in [Figure 15a](#) and [Figure 15c](#), respectively. This is similar to what has already been described for the DLL component. See the [DLL Clock Output and Feedback Connections](#), page 22 section.

In the on-chip case, it is possible to connect either of the DFS's two output clock signals through general routing resources to the FPGA's internal registers. Either a Global Clock Buffer (BUFG) or a BUFGMUX affords access to the global clock network. The optional feedback loop is formed in this way, routing CLK0 to a global clock net, which in turn drives the CLKFB input.

In the off-chip case, the DFS's two output clock signals, plus CLK0 for an optional feedback loop, can exit the FPGA using output buffers (OBUF) to drive a clock network plus registers on the board. The feedback loop is formed by feeding the CLK0 signal back into the FPGA using an IBUFG, which directly accesses the global clock network, or an IBUF. Then, the global clock net is connected directly to the CLKFB input.

Phase Shifter (PS)

The DCM provides two approaches to controlling the phase of a DCM clock output signal relative to the CLKIN signal: First, there are nine clock outputs that employ the DLL to achieve a desired phase relationship: CLK0, CLK90, CLK180, CLK270, CLK2X, CLK2X180, CLKDV CLKFX, and CLKFX180. These outputs afford "coarse" phase control.

The second approach uses the PS component described in this section to provide a still finer degree of control. The PS component accomplishes this by introducing a "fine phase shift" (T_{PS}) between the CLKFB and CLKIN signals inside the DLL component. The user can control this fine phase shift down to a resolution of 1/256 of a CLKIN cycle or one tap delay (DCM_TAP), whichever is greater. When in use, the PS component shifts the phase of all nine DCM clock output signals together. If the PS component is used together with a DCM clock output such as the CLK90, CLK180, CLK270, CLK2X180 and CLKFX180, then the fine phase shift of the former gets added to the coarse phase shift of the latter.

Table 16: PS Attributes

| Attribute | Description | Values |
|--------------------|--|---|
| CLKOUT_PHASE_SHIFT | Disables PS component or chooses between Fixed Phase and Variable Phase modes. | NONE, FIXED, VARIABLE |
| PHASE_SHIFT | Determines size and direction of initial fine phase shift. | Integers from -255 to +255 ⁽¹⁾ |

Notes:

1. The practical range of values will be less when $T_{CLKIN} > FINE_SHIFT_RANGE$ in the Fixed Phase mode, also when $T_{CLKIN} > (FINE_SHIFT_RANGE)/2$ in the Variable Phase mode. the FINE_SHIFT_RANGE represents the sum total delay of all taps.

PS Component Enabling and Mode Selection

The CLKOUT_PHASE_SHIFT attribute enables the PS component for use in addition to selecting between two operating modes. As described in [Table 16](#), this attribute has three possible values: NONE, FIXED and VARIABLE. When CLKOUT_PHASE_SHIFT is set to NONE, the PS component is disabled and its inputs, PSEN, PSCLK, and PSINCDEC, must be tied to GND. The set of waveforms in [Figure 17a](#) shows the disabled case, where the DLL maintains a zero-phase alignment of signals CLKFB and CLKIN upon which the PS component has no effect. The PS component is enabled by setting the attribute to either the FIXED or VARIABLE values, which select the Fixed Phase mode and the Variable Phase mode, respectively. These two modes are described in the sections that follow

Determining the Fine Phase Shift

The user controls the phase shift of CLKFB relative to CLKIN by setting and/or adjusting the value of the PHASE_SHIFT attribute. This value must be an integer ranging from -255 to +255. The PS component uses this value to calculate the desired fine phase shift (T_{PS}) as a fraction of the CLKIN period (T_{CLKIN}). Given values for PHASE_SHIFT and T_{CLKIN} , it is possible to calculate T_{PS} as follows:

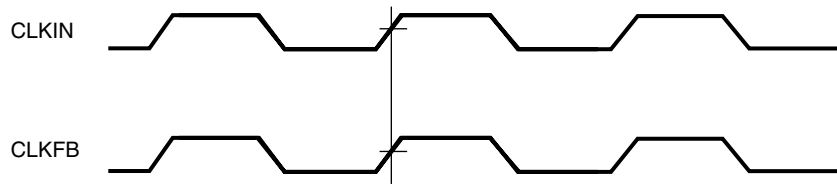
$$T_{PS} = (PHASE_SHIFT/256) * T_{CLKIN} \quad (4)$$

Both the Fixed Phase and Variable Phase operating modes employ this calculation. If the PHASE_SHIFT value is zero, then CLKFB and CLKIN will be in phase, the same as when the PS component is disabled. When the PHASE_SHIFT value is positive, the CLKFB signal will be shifted later in time with respect to CLKIN. If the attribute value is negative, the CLKFB signal will be shifted earlier in time with respect to CLKIN.

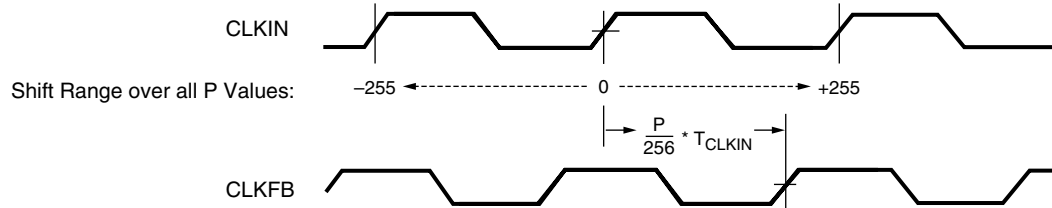
The Fixed Phase Mode

This mode fixes the desired fine phase shift to a fraction of the T_{CLKIN} , as determined by Equation (4) and its user-selected PHASE_SHIFT value P. The set of waveforms in [Figure 17b](#) illustrates the relationship between CLKFB and CLKIN in the Fixed Phase mode. In the Fixed Phase mode, the PSEN, PSCLK and PSINCDEC inputs are not used and must be tied to GND.

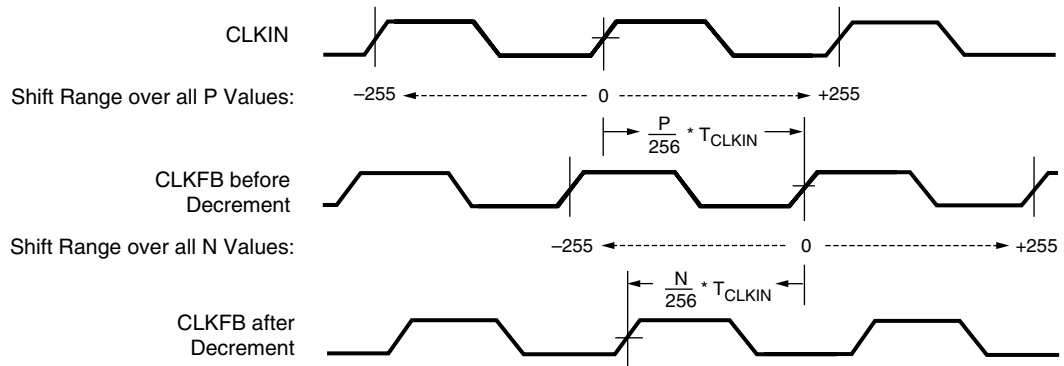
a. CLKOUT_PHASE_SHIFT = NONE



b. CLKOUT_PHASE_SHIFT = FIXED



c. CLKOUT_PHASE_SHIFT = VARIABLE



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Notes:

1. P represents the integer value ranging from -255 to +255 to which the PHASE_SHIFT attribute is assigned.
2. N is an integer value ranging from -255 to +255 that represents the net phase shift effect from a series of increment and/or decrement operations.

$$N = \{\text{Total number of increments}\} - \{\text{Total number of decrements}\}$$

A positive value for N indicates a net increment; a negative value indicates a net decrement.

Figure 17: Phase Shifter Waveforms

Table 17: Signals for Variable Phase Mode

| Signal | Direction | Description |
|-------------------------|-----------|--|
| PSEN ⁽¹⁾ | Input | Enables PSCLK for variable phase adjustment. |
| PSCLK ⁽¹⁾ | Input | Clock to synchronize phase shift adjustment. |
| PSINCDEC ⁽¹⁾ | Input | Chooses between increment and decrement for phase adjustment. It is synchronized to the PSCLK signal. |
| PSDONE | Output | Goes High to indicate that present phase adjustment is complete and PS component is ready for next phase adjustment request. It is synchronized to the PSCLK signal. |

Notes:

1. It is possible to program this input for either a true or inverted polarity

The Variable Phase Mode

The “Variable Phase” mode dynamically adjusts the fine phase shift over time using three inputs to the PS component, namely PSEN, PSCLK and PSINCDEC, as defined in [Table 17](#).

Just following device configuration, the PS component initially determines T_{PS} by evaluating Equation (4) for the value assigned to the PHASE_SHIFT attribute. Then to dynamically adjust that phase shift, use the three PS inputs to increase or decrease the fine phase shift.

PSINCDEC is synchronized to the PSCLK clock signal, which is enabled by asserting PSEN. It is possible to drive the PSCLK input with the CLKIN signal or any other clock signal. A request for phase adjustment is entered as follows: For each PSCLK cycle that PSINCDEC is High, the PS component adds 1/256 of a CLKIN cycle to T_{PS} . Similarly, for each enabled PSCLK cycle that PSINCDEC is Low, the PS component subtracts 1/256 of a CLKIN cycle from T_{PS} . The phase adjustment may require as many as 100 CLKIN cycles plus three PSCLK cycles to take effect, at which

point the output PSDONE goes High for one PSCLK cycle. This pulse indicates that the PS component has finished the present adjustment and is now ready for the next request. Asserting the Reset (RST) input, returns T_{PS} to its original shift time, as determined by the PHASE_SHIFT attribute value. The set of waveforms in [Figure 17c](#) illustrates the relationship between CLKFB and CLKIN in the Variable Phase mode.

The Status Logic Component

The Status Logic component not only reports on the state of the DCM but also provides a means of resetting the DCM to an initial known state. The signals associated with the Status Logic component are described in [Table 18](#).

As a rule, the Reset (RST) input is asserted only upon configuring the device or changing the CLKIN frequency. A DCM reset does not affect attribute values (e.g., CLKFX_MULTIPLY and CLKFX_DIVIDE). If not used, RST must be tied to GND.

The eight bits of the STATUS bus are defined in [Table 19](#).

Table 18: Status Logic Signals

| Signal | Direction | Description |
|-------------|-----------|---|
| RST | Input | A High resets the entire DCM to its initial power-on state. Initializes the DLL taps for a delay of zero. Sets the LOCKED output Low. This input is asynchronous. |
| STATUS[7:0] | Output | The bit values on the STATUS bus provide information regarding the state of DLL and PS operation |
| LOCKED | Output | Indicates that the CLKIN and CLKFB signals are in phase by going High. The two signals are out-of-phase when Low. |

Table 19: DCM STATUS Bus

| Bit | Name | Description |
|-----|----------------------|---|
| 0 | Phase Shift Overflow | A value of 1 indicates a phase shift overflow when one of two conditions occur: <ul style="list-style-type: none"> Incrementing (or decrementing) TPS beyond 255/256 of a CLKIN cycle. The DLL is producing its maximum possible phase shift (i.e., all delay taps are active).⁽¹⁾ |
| 1 | CLKIN Activity | A value of 1 indicates that the CLKIN signal is not toggling. A value of 0 indicates toggling. This bit functions only when the CLKFB input is connected. ⁽²⁾ |
| 2 | Reserved | - |
| 3 | Reserved | - |
| 4 | Reserved | - |
| 5 | Reserved | - |
| 6 | Reserved | - |
| 7 | Reserved | - |

Notes:

- The DLL phase shift with all delay taps active is specified as the parameter FINE_SHIFT_RANGE.
- If only the DFS clock outputs are used, but none of the DLL clock outputs, this bit will not go High when the CLKIN signal stops.

Table 20: Status Attributes

| Attribute | Description | Values |
|--------------|---|-------------|
| STARTUP_WAIT | Delays transition from configuration to user mode until lock condition is achieved. | TRUE, FALSE |

Stabilizing DCM Clocks Before User Mode

It is possible to delay the completion of device configuration until after the DLL has achieved a lock condition using the STARTUP_WAIT attribute described in Table 20. This option ensures that the FPGA does not enter user mode — i.e., begin functional operation — until all system clocks generated by the DCM are stable. In order to achieve the delay, it is necessary to set the attribute to TRUE as well as set the BitGen option LCK_cycle to one of the six cycles making up the Startup phase of configuration. The selected cycle defines the point at which configuration will halt until the LOCKED output goes High.

Global Clock Network

Spartan-3 devices have eight Global Clock inputs called GCLK0 - GCLK7. These inputs provide access to a low-capacitance, low-skew network that is well-suited to carrying high-frequency signals. The Spartan-3 clock network is shown in Figure 18. GCLK0 through GCLK3 are placed at the center of the die's bottom edge. GCLK4 through GCLK7 are placed at the center of the die's top edge. It is possible to route each of the eight Global Clock inputs to any CLB on the die.

Eight Global Clock Multiplexers (also called BUFGMUX elements) are provided that accept signals from Global Clock inputs and route them to the internal clock network as well

as DCMs. Four BUFGMUX elements are placed at the center of the die's bottom edge, just above the GCLK0 - GCLK4 inputs. The remaining four BUFGMUX elements are placed at the center of the die's top edge, just below the GCLK4 - GCLK7 inputs.

Each BUFGMUX element is a 2-to-1 multiplexer that can receive signals from any of the four following sources:

- One of the four Global Clock inputs on the same side of the die — top or bottom — as the BUFGMUX element in use.
- Any of four nearby horizontal Double lines.
- Any of four outputs from the DCM in the right-hand quadrant that is on the same side of the die as the BUFGMUX element in use.
- Any of four outputs from the DCM in the left-hand quadrant that is on the same side of the die as the BUFGMUX element in use.

Sources 3 and 4 are not available on the XC3S50 die that lacks DCMs.

Each BUFGMUX can switch incoming clock signals to two possible destinations:

- The vertical spine belonging to the same side of the die — top or bottom — as the BUFGMUX element in use. The two spines — top and bottom — each comprise four vertical clock lines, each running from one of the

BUFGMUX elements on the same side towards the center of the die. At the center of the die, clock signals reach the eight-line horizontal spine, which spans the width of the die. In turn, the horizontal spine branches out into a subsidiary clock interconnect that accesses the CLBs.

2. The clock input of either DCM on the same side of the die — top or bottom — as the BUFGMUX element in use.

A Global clock input is placed in a design using either a BUFGMUX element or the BUFG (Global Clock Buffer) element. For the purpose of minimizing the dynamic power dissipation of the clock network, the Xilinx development software automatically disables all clock line segments that a design does not use.

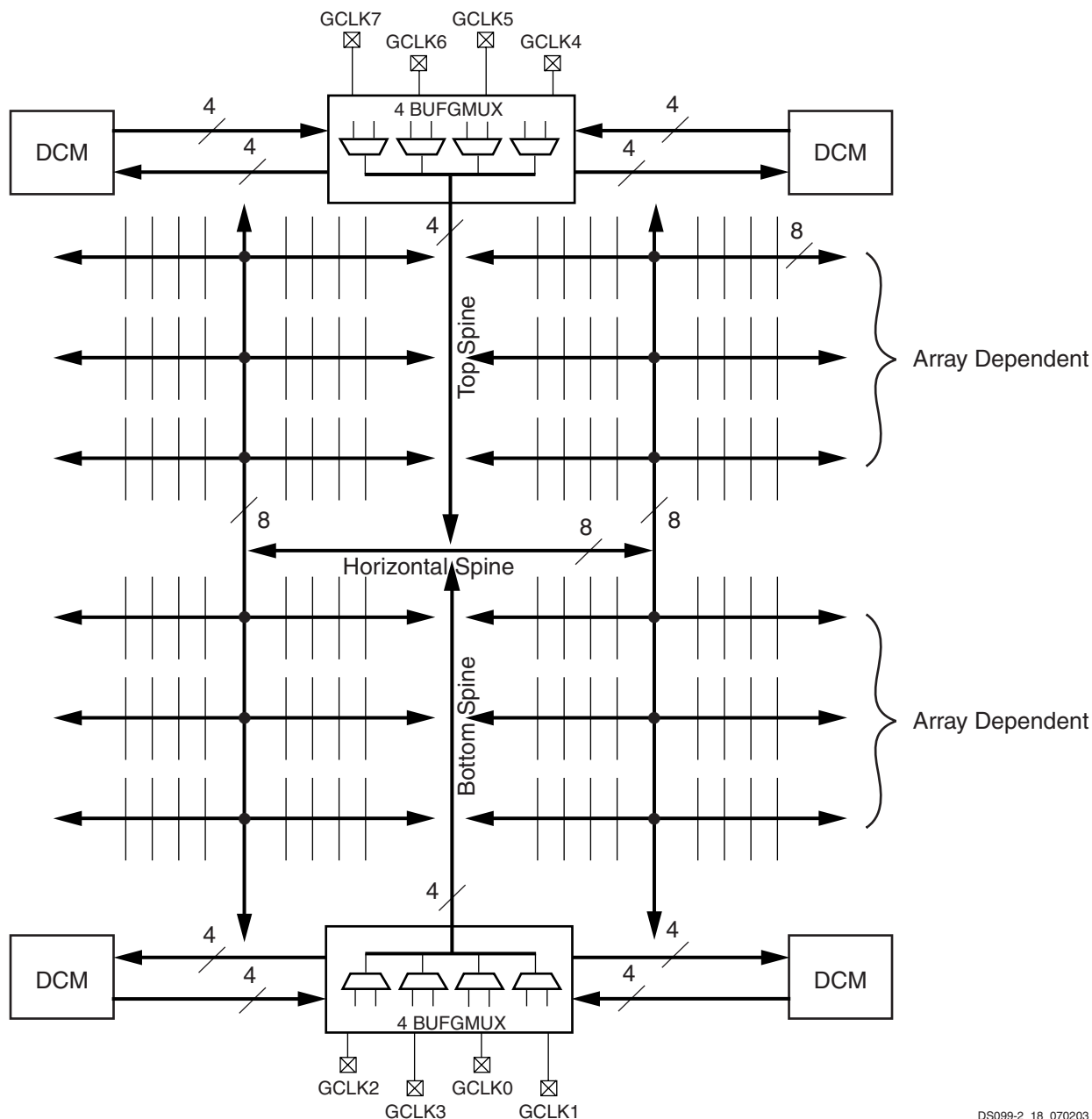


Figure 18: Spartan-3 Clock Network (Top View)

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Interconnect

Interconnect (or routing) passes signals among the various functional elements of Spartan-3 devices. There are four kinds of interconnect: Long lines, Hex lines, Double lines, and Direct lines.

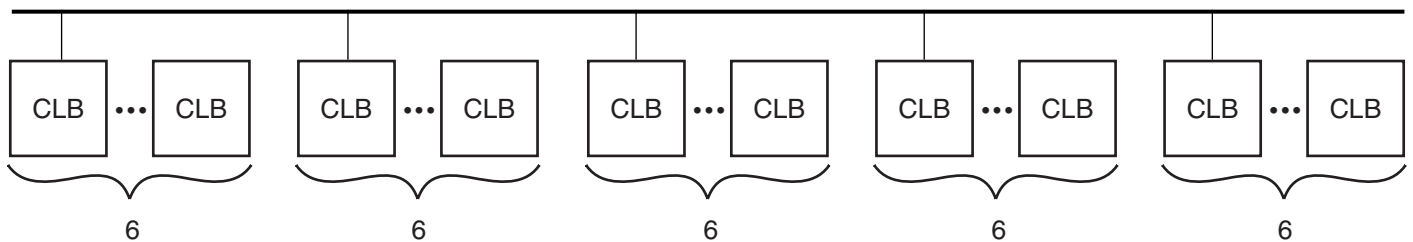
Long lines connect to one out of every six CLBs (see Figure 19a). Because of their low capacitance, these lines are well-suited for carrying high-frequency signals with minimal loading effects (e.g. skew). If all eight Global Clock Inputs are already committed and there remain additional clock signals to be assigned, Long lines serve as a good alternative.

Hex lines connect one out of every three CLBs (see Figure 19b). These lines fall between Long lines and Dou-

ble lines in terms of capability: Hex lines approach the high-frequency characteristics of Long lines at the same time, offering greater connectivity.

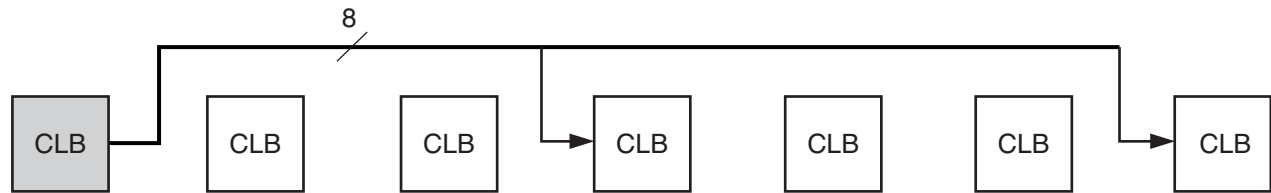
Double lines connect to every other CLB (see Figure 19c). Compared to the types of lines already discussed, Double lines provide a higher degree of flexibility when making connections.

Direct lines afford any CLB direct access to neighboring CLBs (see Figure 19d). These lines are most often used to conduct a signal from a "source" CLB to a Double, Hex, or Long line and then from the longer interconnect back to a Direct line accessing a "destination" CLB.



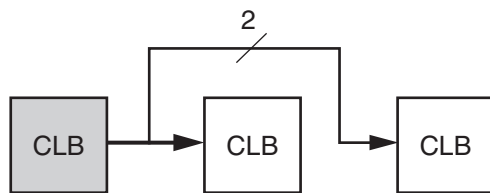
DS099-2_19_040103

(a) Long Line



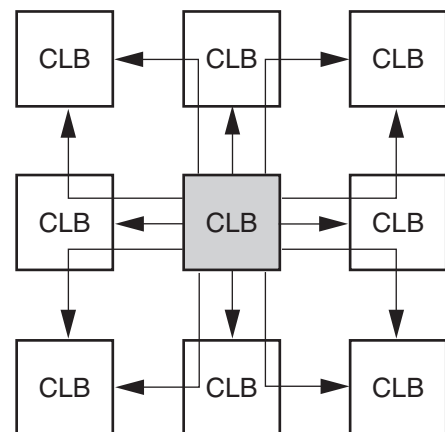
DS099-2_20_040103

(b) Hex Line



DS099-2_21_040103

(c) Double Line



DS099-2_22_040103

(d) Direct Lines

Figure 19: Types of Interconnect

Configuration

Spartan-3 devices are configured by loading application specific configuration data into the internal configuration memory. Configuration is carried out using a subset of the device pins, some of which are "Dedicated" to one function only, while others, indicated by the term "Dual-Purpose",

can be re-used as general-purpose User I/Os once configuration is complete.

Depending on the system design, several configuration modes are supported, selectable via mode pins. The mode pins M0, M1, and M2 are Dedicated pins. The mode pin settings are shown in [Table 21](#).

Table 21: Spartan-3 Configuration Mode Pin Settings

| Configuration Mode ⁽¹⁾ | M0 | M1 | M2 | Synchronizing Clock | Data Width | Serial DOUT ⁽²⁾ |
|-----------------------------------|----|----|----|---------------------|------------|----------------------------|
| Master Serial | 0 | 0 | 0 | CCLK Output | 1 | Yes |
| Slave Serial | 1 | 1 | 1 | CCLK Input | 1 | Yes |
| Master Parallel | 1 | 1 | 0 | CCLK Output | 8 | No |
| Slave Parallel | 0 | 1 | 1 | CCLK Input | 8 | No |
| JTAG | 1 | 0 | 1 | TCK Input | 1 | No |

Notes:

1. The voltage levels on the M0, M1, and M2 pins select the configuration mode.
2. The daisy chain is possible only in the Serial modes when DOUT is used.

An additional pin, HSWAP_EN, is used in conjunction with the mode pins to select whether user I/O pins have pull-ups during configuration. By default, HSWAP_EN is tied High (internal pull-up) which shuts off the pull-ups on the user I/O pins during configuration. When HSWAP_EN is tied Low, user I/Os have pull-ups during configuration. Other Dedicated pins are CCLK (the configuration clock pin), DONE, PROG_B, and the boundary-scan pins: TDI, TDO, TMS, and TCK. Depending on the configuration mode chosen, CCLK can be an output generated by the FPGA, or an input accepting an externally generated clock.

A persist option is available which can be used to force the configuration pins to retain their configuration function even after device configuration is complete. If the persist option is not selected then the configuration pins with the exception of CCLK, PROG_B, and DONE can be used as user I/O in normal operation. The persist option does not apply to the boundary-scan related pins. The persist feature is valuable in applications that readback configuration data after entering the User mode.

[Table 22](#) lists the total number of bits required to configure each FPGA as well as the PROMs suitable for storing those bits. See [DS123: Platform Flash In-System Programmable Configuration PROMs](#) data sheet for more information.

The Standard Configuration Interface

Configuration signals belong to one of two different categories: Dedicated or Dual-Purpose. Which category determines which of the FPGA's power rails supplies the signal's driver and, thus, helps describe the electrical at the pin.

The Dedicated configuration pins include PROG_B, HSWAP_EN, TDI, TMS, TCK, TDO, CCLK, DONE, and M0-M2. These pins use the V_{CCAUX} lines for power.

Table 22: Spartan-3 Configuration Data

| Device | File Sizes | Xilinx Platform Flash PROM | |
|----------|------------|----------------------------|------------------------|
| | | Serial Configuration | Parallel Configuration |
| XC3S50 | 439,264 | XCF01S | XCF08P |
| XC3S200 | 1,047,616 | XCF01S | XCF08P |
| XC3S400 | 1,699,136 | XCF02S | XCF08P |
| XC3S1000 | 3,223,488 | XCF04S | XCF08P |
| XC3S1500 | 5,214,784 | XCF08P | XCF08P |
| XC3S2000 | 7,673,024 | XCF08P | XCF08P |
| XC3S4000 | 11,316,864 | XCF16P | XCF16P |
| XC3S5000 | 13,271,936 | XCF16P | XCF16P |

The Dual-Purpose configuration pins comprise INIT_B, DOUT, BUSY, RDWR_B, CS_B, and DIN/D0-D7. Each of these pins, according to its bank placement, uses the V_{CCO} lines for either Bank 4 (V_{CCO_4}) or Bank 5 (V_{CCO_5}). All the signals used in the serial configuration modes rely on V_{CCO_4} power. Signals used in the parallel configuration modes and Readback require from V_{CCO_5} as well as from V_{CCO_4}.

Both the Dedicated and Dual-Purpose signals described above constitute the configuration interface. In the standard case, this interface is 2.5V-LVCMOS-compatible. This means that 2.5V is applied to the V_{CCAUX}, V_{CCO_4}, and V_{CCO_5} lines (this last in the parallel or Readback case only). One need only apply 2.5 Volts to these V_{CCO} lines from power-on to the end of configuration. Upon entering the User mode, it is possible to switch to supply voltage permitting signal swings other than 2.5V.

3.3V-Tolerant Configuration Interface

It is possible to achieve 3.3V-tolerance at the configuration interface simply by adding a few external resistors. This approach may prove useful when it is undesirable to switch the VCCO_4 and VCCO_5 voltages from 2.5V to 3.3V after configuration.

The 3.3V-tolerance is implemented as follows (a similar approach can be used for other supply voltage levels):

First, to power the Dual-Purpose configuration pins, apply 3.3V to the VCCO_4 and (as needed) the VCCO_5 lines. This scales the output voltages and input thresholds associated with these pins so that they become 3.3V-compatible.

Second, to power the Dedicated configuration pins, apply 2.5V to the V_{CCAUX} lines (the same as for the standard interface). In order to achieve 3.3V-tolerance, the Dedicated inputs will require series resistors that limit the incoming current to 10mA or less. The Dedicated outputs will need pull-up resistors to ensure adequate noise margin when the FPGA is driving a High logic level into another device's 3.3V receiver. Choose a power regulator or supply that can tolerate reverse current on the V_{CCAUX} lines.

Configuration Modes

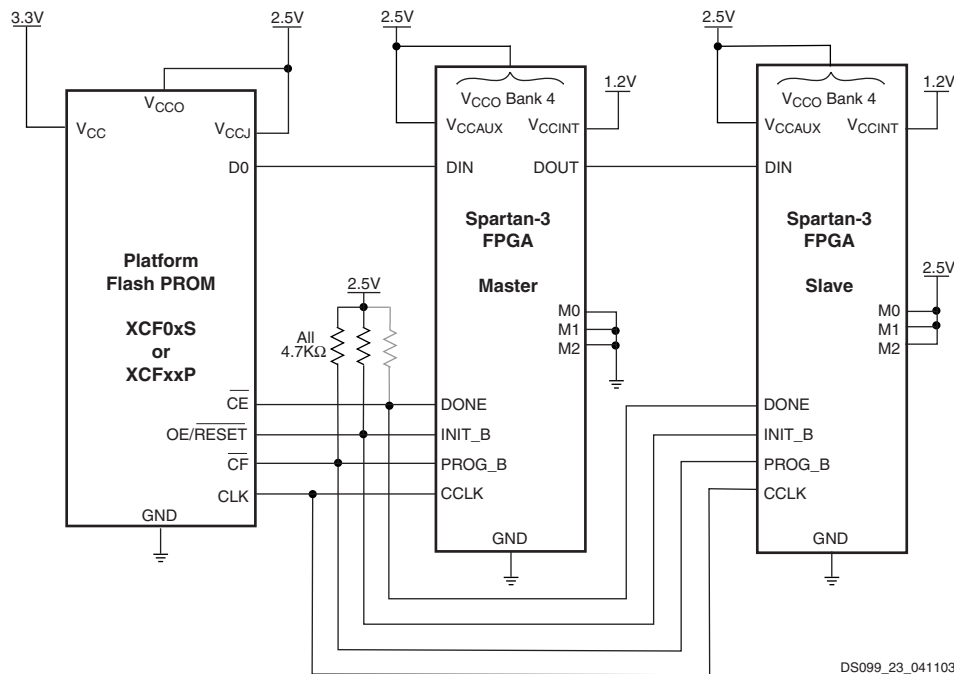
Spartan-3 supports the following five configuration modes:

- Slave Serial mode
- Master Serial mode
- Slave Parallel mode
- Master Parallel mode
- Boundary-Scan (JTAG) mode (IEEE 1532/IEEE 1149.1)

Slave Serial Mode

In Slave Serial mode, the FPGA receives configuration data in bit-serial form from a serial PROM or other serial source of configuration data. The FPGA on the far right of [Figure 20](#) is set for the Slave Serial mode. The CCLK pin on the FPGA is an input in this mode. The serial bitstream must be setup at the DIN input pin a short time before each rising edge of the externally generated CCLK.

Multiple FPGAs can be daisy-chained for configuration from a single source. After a particular FPGA has been configured, the data for the next device is routed internally to the DOUT pin. The data on the DOUT pin changes on the rising edge of CCLK.



Notes:

1. There are two ways to use the DONE line. First, one may set the BitGen option DriveDone to "Yes" only for the last FPGA to be configured in the chain shown above (or for the single FPGA as may be the case). This enables the DONE pin to drive High; thus, no pull-up resistor is necessary. DriveDone is set to "No" for the remaining FPGAs in the chain. Second, DriveDone can be set to "No" for all FPGAs. Then all DONE lines are open-drain and require the pull-up resistor shown in grey. In most cases, a value between 3.3KΩ to 4.7KΩ is sufficient. However, when using DONE synchronously with a long chain of FPGAs, cumulative capacitance may necessitate lower resistor values (e.g. down to 330Ω) in order to ensure a rise time within one clock cycle.
2. For information on how to program the FPGA using 3.3V signals and power, see [3.3V-Tolerant Configuration Interface](#).

Figure 20: Connection Diagram for Master and Slave Serial Configuration

Slave Serial mode is selected by applying <111> to the mode pins (M0, M1, and M2). A weak pull-up on the mode pins makes slave serial the default mode if the pins are left unconnected.

Master Serial Mode

In Master Serial mode, the CCLK pin is an output pin. The FPGA just to the right of the PROM in [Figure 20](#) is set for Master Serial mode. It is the FPGA that drives the configuration clock on the CCLK pin to a Xilinx Serial PROM which in turn feeds bit-serial data to the DIN input. The FPGA accepts this data on each rising CCLK edge. After the FPGA has been loaded, the data for the next device in a daisy-chain is presented on the DOUT pin after the rising CCLK edge.

The interface is identical to slave serial except that an internal oscillator is used to generate the configuration clock (CCLK). A wide range of frequencies can be selected for CCLK which always starts at a default frequency of 6 MHz. Configuration bits then switch CCLK to a higher frequency for the remainder of the configuration.

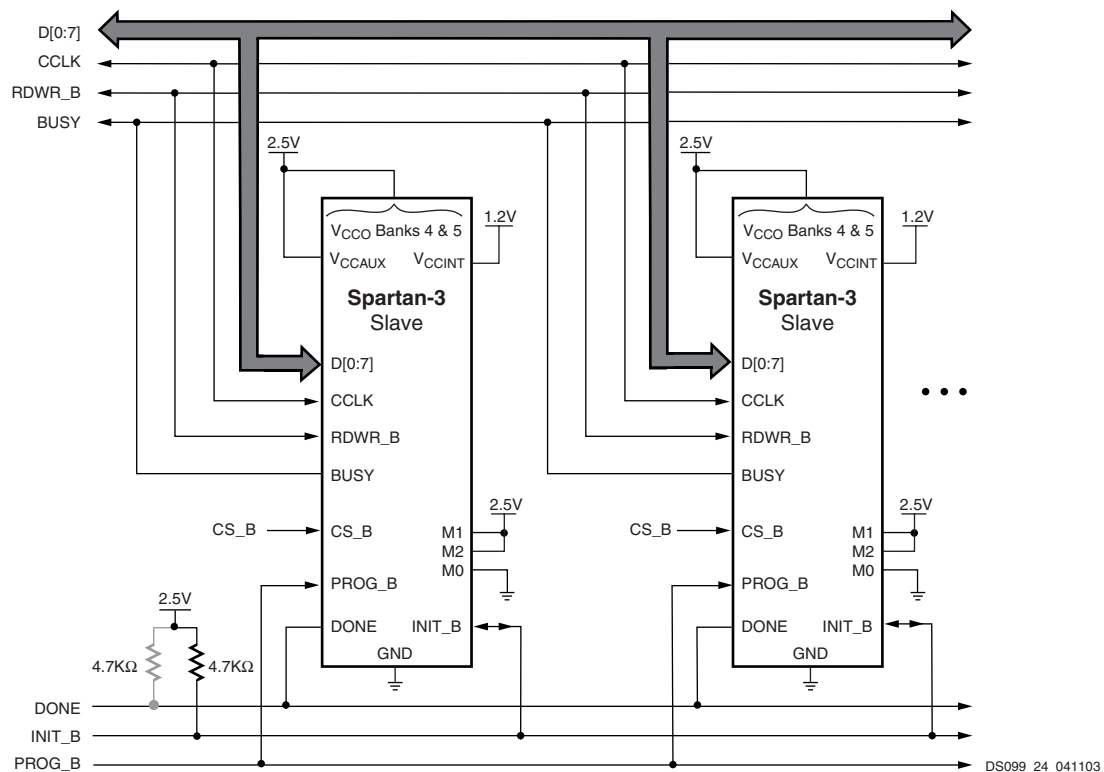
Slave Parallel Mode

The Parallel modes support the fastest configuration. Byte-wide data is written into the FPGA with a BUSY flag

controlling the flow of data. An external source provides 8-bit-wide data, CCLK, an active-Low Chip Select (CS_B) signal and an active-Low Write signal (RDWR_B). If BUSY is asserted (High) by the FPGA, the data must be held until BUSY goes Low. Data can also be read using the Slave Parallel mode. If RDWR_B is asserted, configuration data is read out of the FPGA as part of a readback operation.

After configuration, it is possible to use any of the Multipurpose pins (DIN/D0-D7, DOUT/BUSY, INITB, CS_B, and RDWR_B) as User I/Os. To do this, simply set the BitGen option *Persist* to *No* and assign the desired signals to multipurpose configuration pins using the Xilinx development software. Alternatively, it is possible to continue using the configuration port (e.g. all configuration pins taken together) when operating in the User mode. This is accomplished by setting the *Persist* option to *Yes*.

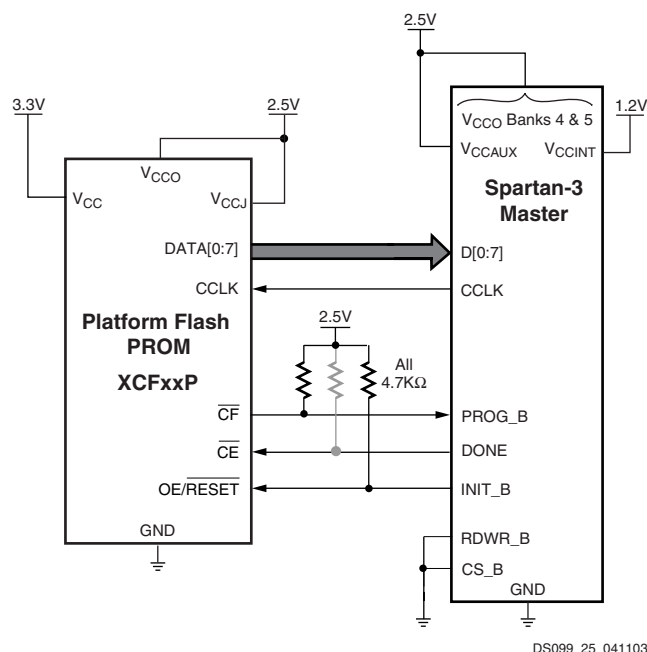
Multiple FPGAs can be configured using the Slave Parallel mode and can be made to start-up simultaneously. [Figure 21](#) shows the device connections. To configure multiple devices in this way, wire the individual CCLK, Data, RDWR_B, and BUSY pins of all the devices in parallel. The individual devices are loaded separately by deasserting the CS_B pin of each device in turn and writing the appropriate data.



Notes:

1. There are two ways to use the DONE line. First, one may set the BitGen option DriveDone to "Yes" only for the last FPGA to be configured in the chain shown above (or for the single FPGA as may be the case). This enables the DONE pin to drive High; thus, no pull-up resistor is necessary. DriveDone is set to "No" for the remaining FPGAs in the chain. Second, DriveDone can be set to "No" for all FPGAs. Then all DONE lines are open-drain and require the pull-up resistor shown in grey. In most cases, a value between 3.3K Ω to 4.7K Ω is sufficient. However, when using DONE synchronously with a long chain of FPGAs, cumulative capacitance may necessitate lower resistor values (e.g. down to 330 Ω) in order to ensure a rise time within one clock cycle.
2. If the FPGAs use different configuration data files, configure them in sequence by first asserting the CS_B of one FPGA then asserting the CS_B of the other FPGA.
3. For information on how to program the FPGA using 3.3V signals and power, see **3.3V-Tolerant Configuration Interface**.

Figure 21: Connection Diagram for Slave Parallel Configuration



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Notes:

1. There are two ways to use the DONE line. First, one may set the BitGen option DriveDone to "Yes" only for the last FPGA to be configured in the chain shown above (or for the single FPGA as may be the case). This enables the DONE pin to drive High; thus, no pull-up resistor is necessary. DriveDone is set to "No" for the remaining FPGAs in the chain. Second, DriveDone can be set to "No" for all FPGAs. Then all DONE lines are open-drain and require the pull-up resistor shown in grey. In most cases, a value between 3.3KΩ to 4.7KΩ is sufficient. However, when using DONE synchronously with a long chain of FPGAs, cumulative capacitance may necessitate lower resistor values (e.g. down to 330Ω) in order to ensure a rise time within one clock cycle.

Figure 22: Connection Diagram for Master Parallel Configuration

Master Parallel Mode

In this mode, the device is configured byte-wide on a CCLK supplied by the FPGA. Timing is similar to the Slave Parallel mode except that CCLK is supplied by the FPGA. The device connections are shown in Figure 22.

Boundary-Scan (JTAG) Mode

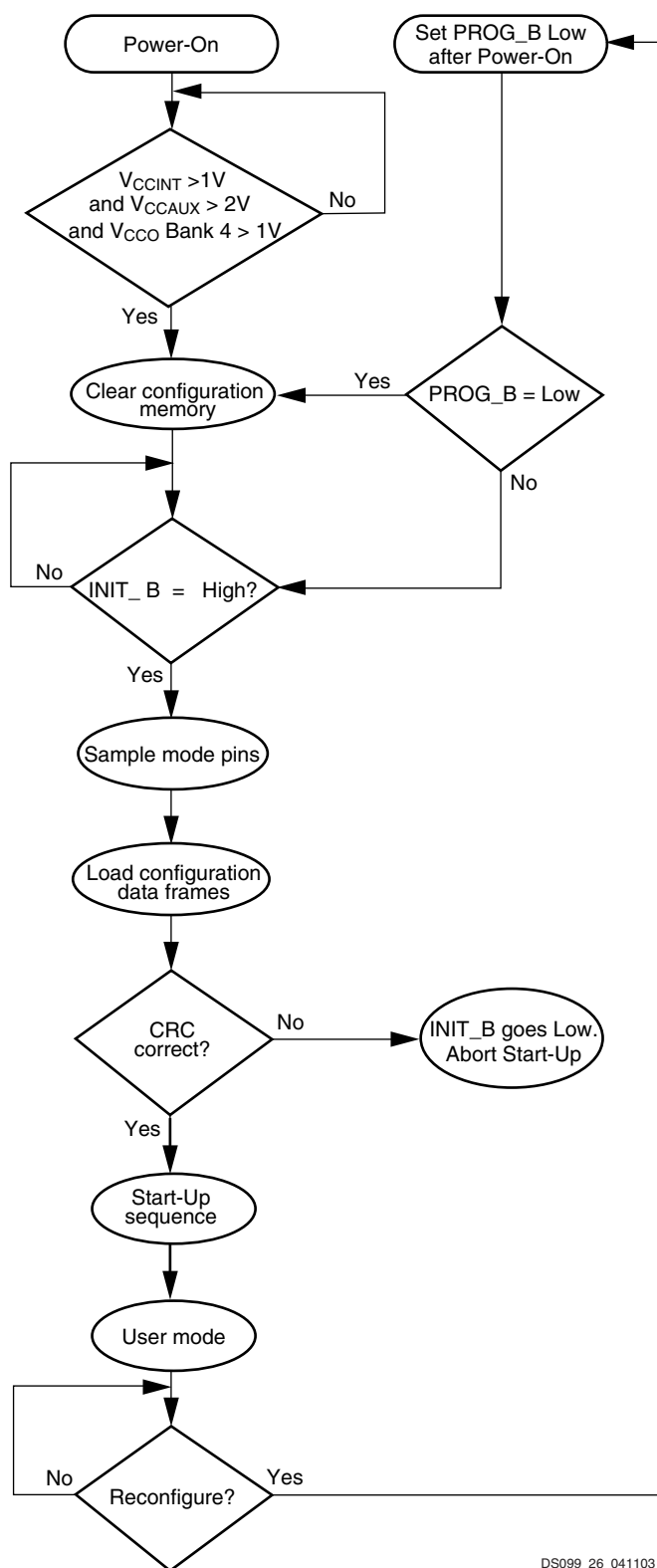
In Boundary-Scan mode, dedicated pins are used for configuring the FPGA. The configuration is done entirely through the IEEE 1149.1 Test Access Port (TAP). FPGA configuration using the Boundary-Scan mode is compliant with the IEEE 1149.1-1993 standard and the new IEEE 1532 standard for In-System Configurable (ISC) devices.

Configuration through the boundary-scan port is always available, independent of the mode selection. Selecting the Boundary-Scan mode simply turns off the other modes.

Configuration Sequence

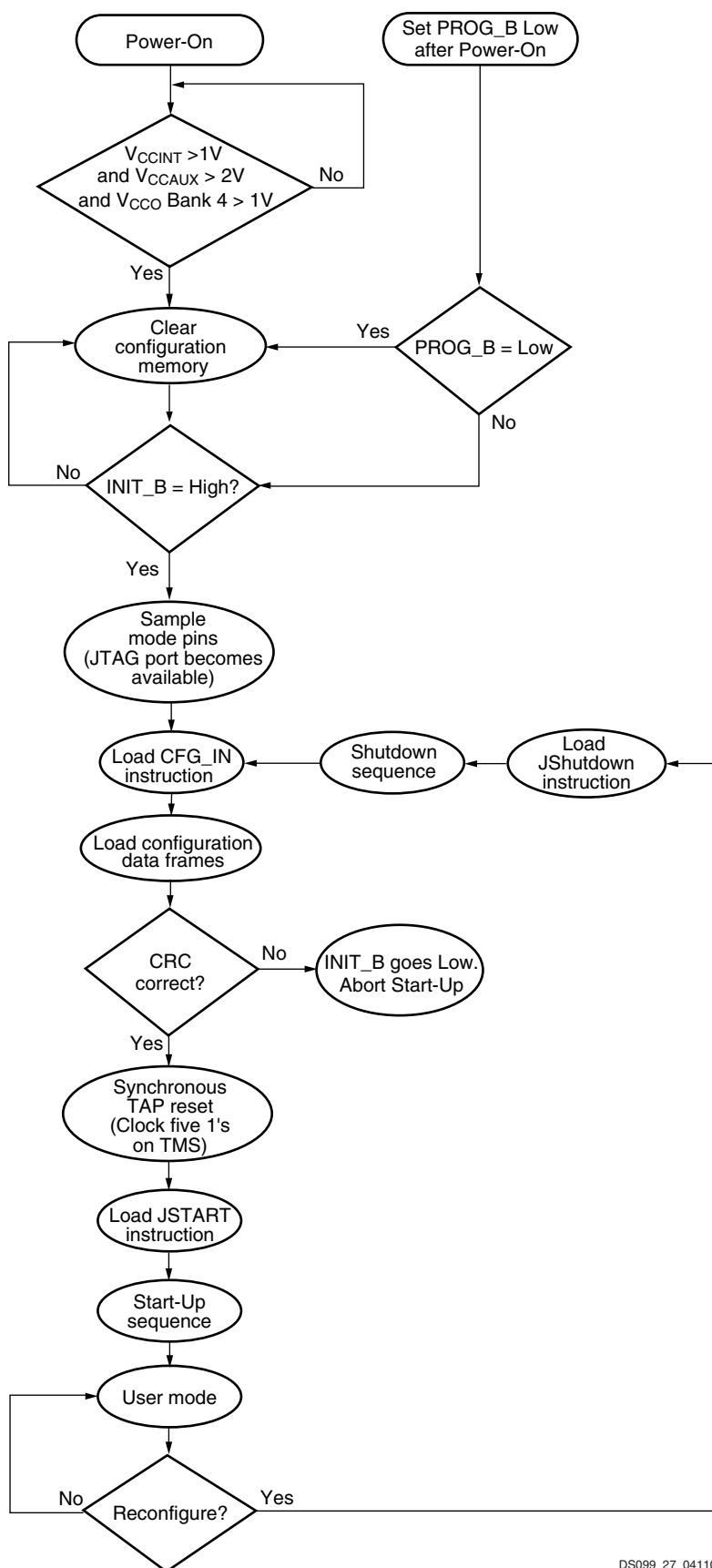
The configuration of Spartan-3 devices is a three-stage process that occurs after Power-On Reset or the assertion of PROG_B. POR occurs after the VCCINT, VCCAUX, and VCCO Bank 4 supplies have reached their respective maximum input threshold levels (see Table 6 in Module 3: **DC and Switching Characteristics**). After POR, the three-stage process begins.

First, the configuration memory is cleared. Next, configuration data is loaded into the memory, and finally, the logic is activated by a start-up process. A flow diagram for the configuration sequence of the Serial and Parallel modes is shown in Figure 23. The flow diagram for the Boundary-Scan configuration sequence appears in Figure 24.



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Figure 23: Configuration Flow Diagram for the Serial and Parallel Modes



DS099_27_041103

Figure 24: Boundary-Scan Configuration Flow Diagram

Configuration is automatically initiated after power-on unless it is delayed by the user. INIT_B is an open-drain line that the FPGA holds Low during the clearing of the configuration memory. Extending the time that the pin is Low causes the configuration sequencer to wait. Thus, configuration is delayed by preventing entry into the phase where data is loaded.

The configuration process can also be initiated by asserting the PROG_B pin. The end of the memory-clearing phase is signaled by the INIT_B pin going High. At this point, the configuration data is written to the FPGA. The FPGA holds the Global Set/Reset (GSR) signal active throughout configuration, keeping all flip-flops on the device in a reset state. The completion of the entire process is signaled by the DONE pin going High.

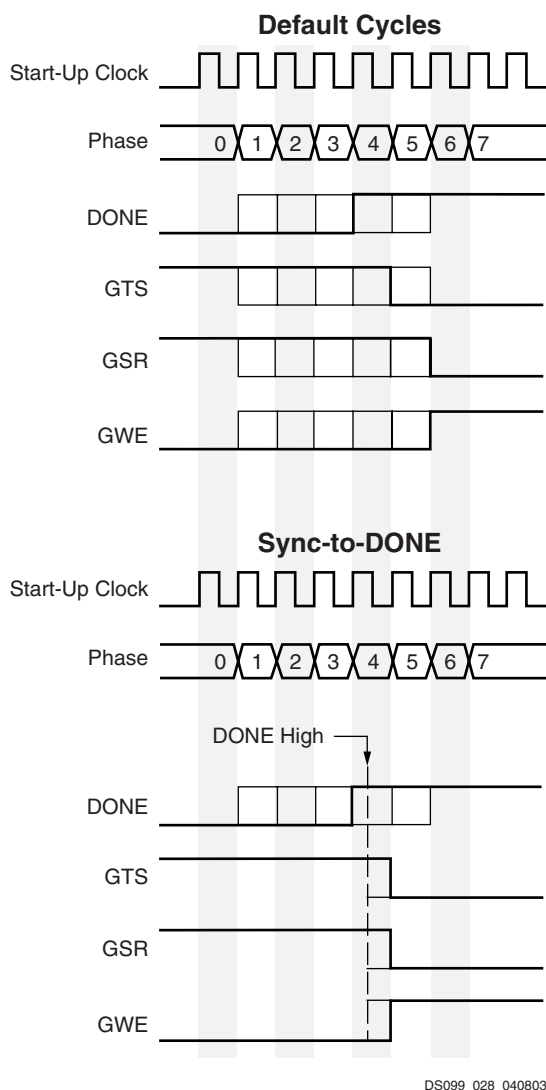
The default start-up sequence, shown in Figure 25, serves as a transition to the User mode. The default start-up sequence is that one CCLK cycle after DONE goes High, the Global Three-State signal (GTS) is released. This permits device outputs to which signals have been assigned to become active. One CCLK cycle later, the Global Write Enable (GWE) signal is released. This permits the internal storage elements to begin changing state in response to the design logic and the user clock.

The relative timing of configuration events can be changed via the BitGen options in the Xilinx development software. In addition, the GTS and GWE events can be made dependent on the DONE pins of multiple devices all going High, forcing the devices to start synchronously. The sequence can also be paused at any stage, until lock has been achieved on any DCM.

Readback

Using Slave Parallel mode, configuration data from the FPGA can be read back. Readback is supported only in the Slave Parallel and Boundary-Scan modes.

Along with the configuration data, it is possible to read back the contents of all registers, distributed SelectRAM, and block RAM resources. This capability is used for real-time debugging.



Notes:

1. The BitGen option StartupClk in the Xilinx development software selects the CCLK input, TCK input, or a user-designated global clock input (the GCLK0 - GCLK7 pins) for receiving the clock signal that synchronizes Start-Up.

Figure 25: Default Start-Up Sequence

Revision History

| Date | Version No. | Description |
|----------|-------------|--|
| 04/11/03 | 1.0 | Initial Xilinx release |
| 05/19/03 | 1.1 | Added Block RAM column, DCMs, and multipliers to XC3S50 descriptions. |
| 07/11/03 | 1.2 | Explained the configuration port <i>Persist</i> option in Slave Parallel Mode section. Updated Figure 2 and Double-Data-Rate Transmission section to indicate that DDR clocking for the XCS350 is the same as that for all other Spartan-3 devices. Updated description of I/O voltage tolerance in ESD Protection section. In Table 6 , changed input termination type for DCI version of the LVCMOS standard to <i>None</i> . Added additional flexibility for making DLL connections in Figure 15 and accompanying text. In the Configuration section, inserted an explanation of how to choose power supplies for the configuration interface, including guidelines for achieving 3.3V-tolerance. |

The Spartan-3 Family Data Sheet

DS099-1, *Spartan-3 1.2V FPGA Family: **Introduction and Ordering Information*** (Module 1)

DS099-2, *Spartan-3 1.2V FPGA Family: **Functional Description*** (Module 2)

DS099-3, *Spartan-3 1.2V FPGA Family: **DC and Switching Characteristics*** (Module 3)

DS099-4, *Spartan-3 1.2V FPGA Family: **Pinout Descriptions*** (Module 4)

DC Electrical Characteristics

In this section, some specifications may be designated as Advance or Preliminary. These terms are defined as follows:

Advance: Initial estimates based on simulation and/or extrapolation from the characteristics of other families. Values are subject to change. Use as estimates, not for production.

Preliminary: Based on characterization. Further changes are not expected.

All specifications are representative of worst-case supply voltage and junction temperature conditions. All specifications are subject to change without notice.

DC and AC characteristics are specified using the same numbers for both commercial and industrial grades unless otherwise noted.

Table 1: Absolute Maximum Ratings^(1, 2)

| Symbol | Description | | Min | Max | Units |
|---------------------------------|--|--|------|------------------------|-------|
| V _{CCINT} | Internal supply voltage | | −0.5 | 1.32 | V |
| V _{CCAUX} | Auxiliary supply voltage | | −0.5 | 3.00 | V |
| V _{CCO} | Output driver supply voltage | | −0.5 | 3.75 | V |
| V _{REF} | Input reference voltage | | −0.5 | V _{CCO} + 0.5 | V |
| V _{IN} | Voltage applied to bidirectional I/O pins as well as unidirectional input and output pins. ⁽³⁾ If present, driver is put in a high-impedance state. | V _{CCO} ≤ 3.0V ⁽⁴⁾ | −0.5 | V _{CCO} + 0.5 | V |
| | | V _{CCO} > 3.0V | −0.3 | 3.75 | V |
| T _J | Operating junction temperature | V _{CCO} ≤ 3.0V ⁽⁴⁾ | - | 125 | °C |
| | | V _{CCO} > 3.0V | - | 105 | °C |
| T _{SOL} ⁽⁵⁾ | Soldering temperature | | - | 220 | °C |
| T _{STG} | Storage temperature | | −65 | 150 | °C |

Notes:

- Stresses beyond those listed under Absolute Maximum Ratings will cause permanent damage to the device. These are stress ratings only; functional operation of the device at these or any other conditions beyond those listed under the Recommended Operating Conditions is not implied. Exposure to Absolute Maximum Ratings conditions for extended periods of time adversely affects device reliability.
- All parameters representing voltages are measured with respect to GND unless otherwise specified.
- This specification applies to all User I/O, Multi-Function, and Dedicated pins.
- When V_{CCO} is 3.0 V or less, V_{IN} overshoot may go as high as $V_{CCO} + 1.0$ V for up to 11 ns provided that the current entering the I/O pin is limited to 10 mA. Also, when V_{CCO} is 3.0 V or less, V_{IN} undershoot may go as low as -1.0 V for up to 11 ns provided that the current entering the I/O pin is limited to 10 mA.
- For soldering guidelines, see the information on "Packaging and Thermal Characteristics" at www.xilinx.com.

Table 2: Supply Voltage Thresholds for Power-On Reset

| Symbol | Description | Min | Max | Units |
|--------------|---|-----|-----|-------|
| V_{CCINTT} | Threshold for the V_{CCINT} supply | 0.4 | 1.0 | V |
| V_{CCAUXT} | Threshold for the V_{CCAUX} supply | 0.8 | 2.0 | V |
| V_{CCO4T} | Threshold for the V_{CCO} Bank 4 supply | 0.4 | 1.0 | V |

Notes:

- V_{CCINT} , V_{CCAUX} , and V_{CCO} supplies may be applied in any order.
- During power-on, when the V_{CCINT} , V_{CCO} Bank 4, and V_{CCAUX} voltages are rising, none may dip at any point within their respective threshold-voltage ranges.
- All parameters representing voltages are measured with respect to GND unless otherwise specified.

Table 3: Power Voltage Levels Necessary for Preserving RAM Contents⁽¹⁾

| Symbol | Description | Min | Units |
|-------------|---|-----|-------|
| V_{DRINT} | V_{CCINT} level required to retain RAM data | 1.0 | V |
| V_{DRAUX} | V_{CCAUX} level required to retain RAM data | 2.0 | V |

Notes:

- RAM contents include configuration data.
- All parameters representing voltages are measured with respect to GND unless otherwise specified.
- The level of the V_{CCO} supply has no effect on data retention.

Table 4: General Recommended Operating Conditions

| Symbol | Description | | Min | Nom | Max | Units |
|---------------------------------|------------------------------|------------|-------|-------|-------|-------|
| T _J | Junction temperature | Commercial | 0 | - | 85 | °C |
| | | Industrial | −40 | - | 100 | °C |
| V _{CCINT} | Internal supply voltage | | 1.140 | 1.200 | 1.260 | V |
| V _{CCO} ⁽¹⁾ | Output driver supply voltage | | 1.140 | - | 3.450 | V |
| V _{CCAUX} | Auxiliary supply voltage | | 2.375 | 2.500 | 2.625 | V |

Notes:

- The V_{CCO} range given here spans the lowest and highest operating voltages of all supported I/O standards. The recommended V_{CCO} range specific to each of the single-ended I/O standards is given in [Table 7](#), and that specific to the differential standards is given in [Table 9](#).
- All parameters representing voltages are measured with respect to GND unless otherwise specified.

Table 5: General DC Characteristics of User I/O, Multi-Function, and Dedicated Pins

| Symbol | Description | Test Conditions | | Min | Nom | Max | Units |
|-----------|--|-------------------------------------|------------------|-----|------|------|---------|
| I_L | Leakage current at User I/O, Multi-Function, and Dedicated pins | Driver is in a high-impedance state | | -10 | - | +10 | μA |
| I_{RPU} | Current through pull-up resistor at User I/O, Multi-Function, and Dedicated pins | $V_{IN} = 0V$ | $V_{CCO} = 3.3V$ | 500 | 1000 | 2000 | μA |
| | | | $V_{CCO} = 3.0V$ | 400 | 800 | 1600 | μA |
| | | | $V_{CCO} = 2.5V$ | 250 | 530 | 1100 | μA |
| | | | $V_{CCO} = 1.8V$ | 120 | 270 | 770 | μA |
| | | | $V_{CCO} = 1.5V$ | 70 | 180 | 440 | μA |
| | | | $V_{CCO} = 1.2V$ | 40 | 100 | 300 | μA |
| I_{RPD} | Current through pull-down resistor at User I/O, Multi-Function, and Dedicated pins | $V_{IN} = V_{CCO} = 3.3V$ | | 250 | 520 | 1100 | μA |
| | | $V_{IN} = V_{CCO} = 3.0V$ | | 250 | 520 | 1100 | μA |
| | | $V_{IN} = V_{CCO} = 2.5V$ | | 250 | 520 | 1100 | μA |
| | | $V_{IN} = V_{CCO} = 1.8V$ | | 250 | 520 | 1100 | μA |
| | | $V_{IN} = V_{CCO} = 1.5V$ | | 240 | 510 | 1100 | μA |
| | | $V_{IN} = V_{CCO} = 1.2V$ | | 230 | 480 | 1000 | μA |
| I_{REF} | V_{REF} current per pin | | | -10 | - | +10 | μA |
| C_{IN} | Input capacitance | | | 5 | - | 11 | pF |

Notes:

- The numbers in this table are guaranteed over the conditions set forth in Table 4.

Table 6: Quiescent Supply Current Characteristics

| Symbol | Description | Device | Commercial | | Industrial | | Units |
|---------------------|---|----------|------------|-----|------------|-----|-------|
| | | | Typ | Max | Typ | Max | |
| I _{CCINTQ} | Quiescent V _{CCINT} supply current | XC3S50 | 10 | | | | mA |
| | | XC3S200 | | | | | mA |
| | | XC3S400 | | | | | mA |
| | | XC3S1000 | 40 | | | | mA |
| | | XC3S1500 | | | | | mA |
| | | XC3S2000 | | | | | mA |
| | | XC3S4000 | | | | | mA |
| | | XC3S5000 | | | | | mA |
| I _{CCOQ} | Quiescent V _{CCO} supply current | XC3S50 | 1.5 | | | | mA |
| | | XC3S200 | | | | | mA |
| | | XC3S400 | | | | | mA |
| | | XC3S1000 | 1.5 | | | | mA |
| | | XC3S1500 | | | | | mA |
| | | XC3S2000 | | | | | mA |
| | | XC3S4000 | | | | | mA |
| | | XC3S5000 | | | | | mA |
| I _{CCAUXQ} | Quiescent V _{CCAUX} supply current | XC3S50 | 7.0 | | | | mA |
| | | XC3S200 | | | | | mA |
| | | XC3S400 | | | | | mA |
| | | XC3S1000 | 25.0 | | | | mA |
| | | XC3S1500 | | | | | mA |
| | | XC3S2000 | | | | | mA |
| | | XC3S4000 | | | | | mA |
| | | XC3S5000 | | | | | mA |

Notes:

1. Quiescent supply current is measured with all I/O drivers in a high-impedance state and with all pull-up/pull-down resistors at the I/O pads disabled. For typical values, the ambient temperature (T_A) is 85 °C with V_{CCINT} = 1.2V, V_{CCO} = 2.5V, and V_{CCAUX} = 2.5V.
2. The numbers in this table are guaranteed over the conditions set forth in Table 4.

Table 7: Recommended Operating Conditions for User I/Os Using Single-Ended Standards

| Signal Standard | V _{CCO} | | | V _{REF} | | | V _{IL} | V _{IH} |
|---|------------------|---------|---------|------------------|---------|---------|--------------------------|--------------------------|
| | Min (V) | Nom (V) | Max (V) | Min (V) | Nom (V) | Max (V) | Max (V) | Min (V) |
| GTL | - | - | - | 0.74 | 0.8 | 0.86 | V _{REF} - 0.05 | V _{REF} + 0.05 |
| GTL_DCI ⁽²⁾ | - | 1.2 | - | 0.74 | 0.8 | 0.86 | V _{REF} - 0.05 | V _{REF} + 0.05 |
| GTLP | - | - | - | 0.88 | 1 | 1.12 | V _{REF} - 0.1 | V _{REF} + 0.1 |
| GTLP_DCI ⁽²⁾ | - | 1.5 | - | 0.88 | 1 | 1.12 | V _{REF} - 0.1 | V _{REF} + 0.1 |
| HSTL_I, HSTL_I_DCI | 1.4 | 1.5 | 1.6 | 0.68 | 0.75 | 0.9 | V _{REF} - 0.1 | V _{REF} + 0.1 |
| HSTL_III, HSTL_III_DCI | 1.4 | 1.5 | 1.6 | 0.68 | 0.9 | 0.9 | V _{REF} - 0.1 | V _{REF} + 0.1 |
| HSTL_I_18, HSTL_I_DCI_18 | 1.7 | 1.8 | 1.9 | - | 0.9 | - | V _{REF} - 0.1 | V _{REF} + 0.1 |
| HSTL_II_18, HSTL_II_DCI_18 | 1.7 | 1.8 | 1.9 | - | 0.9 | - | V _{REF} - 0.1 | V _{REF} + 0.1 |
| HSTL_III_18, HSTL_III_DCI_18 | 1.7 | 1.8 | 1.9 | - | 1.1 | - | V _{REF} - 0.1 | V _{REF} + 0.1 |
| LVC MOS12 ⁽³⁾ | 1.14 | 1.2 | 1.3 | - | - | - | 0.20V _{CCO} | 0.70V _{CCO} |
| LVC MOS15, LVDCI_15 ⁽³⁾ | 1.4 | 1.5 | 1.6 | - | - | - | 0.20V _{CCO} | 0.70V _{CCO} |
| LVC MOS18, LVDCI_18 ⁽³⁾ | 1.7 | 1.8 | 1.9 | - | - | - | 0.20V _{CCO} | 0.70V _{CCO} |
| LVC MOS25 ⁽⁴⁾ , LVDCI_25 ⁽³⁾ | 2.3 | 2.5 | 2.7 | - | - | - | 0.7 | 1.7 |
| LVC MOS33, LVDCI_33 ⁽³⁾ | 3.0 | 3.3 | 3.45 | - | - | - | 0.8 | 2.0 |
| LV TTL | 3.0 | 3.3 | 3.45 | - | - | - | 0.8 | 2.0 |
| PCI33_3 | 3.0 | 3.0 | 3.0 | - | - | - | 0.30V _{CCO} | 0.50V _{CCO} |
| SSTL18_I | 1.65 | 1.8 | 1.95 | 0.825 | 0.9 | 0.975 | V _{REF} - 0.125 | V _{REF} + 0.125 |
| SSTL2_I, SSTL2_I_DCI | 2.3 | 2.5 | 2.7 | 1.15 | 1.25 | 1.35 | V _{REF} - 0.15 | V _{REF} + 0.15 |
| SSTL2_II, SSTL2_II_DCI | 2.3 | 2.5 | 2.7 | 1.15 | 1.25 | 1.35 | V _{REF} - 0.15 | V _{REF} + 0.15 |

Notes:

- Descriptions of the symbols used in this table are as follows:
V_{CCO} -- the supply voltage for the output drivers.
V_{REF} -- the reference voltage for setting the input switching threshold.
V_{IL} -- the input voltage that indicates a Low logic level
V_{IH} -- the input voltage that indicates a High logic level
- Because the GTL and GTLP standards employ open-drain output buffers, the V_{CCO} supply does not provide drive current. Nevertheless, the V_{CCO} level must always be at or above the termination voltage (V_{TT}) and I/O pad voltages.
- There is approximately 100 mV of hysteresis on inputs using any LVC MOS standard.
- In the standard case, all Dedicated pins (M0-M2, CCLK, PROG_B, DONE, HSWAP_EN, TCK, TDI, TDO, TMS) use the LVC MOS25 standard and are powered entirely by V_{CCAUX}. The Dual-Purpose configuration pins (DIN/D0, D1-D7, CS_B, RDWR_B, BUSY/DOUT, and INIT_B) use the LVC MOS25 standard during configuration. For information on how to program the FPGA using 3.3V signals and power, see the **3.3V-Tolerant Configuration Interface** section in Module 2: **Functional Description**. The recommended V_{CCO} or V_{CCAUX} levels must be applied to the Global Clock Inputs (GCLK0 - GCLK7) according to the signal standards assigned to them—the same as for User Inputs.
- All parameters representing voltages are measured with respect to GND unless otherwise specified.

Table 8: DC Characteristics of User I/Os Using Single-Ended Standards

| Signal Standard | Test Conditions | | Logic Level Characteristics | |
|---|-------------------------|-------------------------|-----------------------------|----------------------------|
| | I _{OL} (mA) | I _{OH} (mA) | V _{OL} Max (V) | V _{OH} Min (V) |
| GTL, GTL_DCI | 32 | - | 0.4 | - |
| GTLP, GTLP_DCI | 36 | - | 0.6 | - |
| HSTL_I, HSTL_I_DCI | 8 | -8 | 0.4 | V _{CCO} - 0.4 |
| HSTL_III, HSTL_III_DCI | 24 | -8 | 0.4 | V _{CCO} - 0.4 |
| HSTL_I_18, HSTL_I_DCI_18 | 8 | -8 | 0.4 | V _{CCO} - 0.4 |
| HSTL_II_18, HSTL_II_DCI_18 | 16 | -16 | 0.4 | V _{CCO} - 0.4 |
| HSTL_III_18, HSTL_III_DCI_18 | 24 | -8 | 0.4 | V _{CCO} - 0.4 |
| LVC MOS12 | 6 | -6 | 0.4 | V _{CCO} - 0.4 |
| LVC MOS15, LVDCI_15 | 12 | -12 | 0.4 | V _{CCO} - 0.4 |
| LVC MOS18, LVDCI_18 | 16 | -16 | 0.4 | V _{CCO} - 0.4 |
| LVC MOS25 ⁽²⁾ , LVDCI_25 ⁽³⁾ | 24 | -24 | 0.4 | V _{CCO} - 0.4 |
| LVC MOS33, LVDCI_33 | 24 | -24 | 0.4 | V _{CCO} - 0.4 |
| LVTTL | 24 | -24 | 0.4 | 2.4 |
| PCI33_3 | Note 5 | Note 5 | 0.10V _{CCO} | 0.90V _{CCO} |
| SSTL18_I | 6.7 | -6.7 | V _{TT} - 0.475 | V _{TT} + 0.475 |
| SSTL2_I, SSTL2_I_DCI | 7.5 | -7.5 | V _{TT} - 0.61 | V _{TT} + 0.61 |
| SSTL2_II, SSTL2_II_DCI | 15 | -15 | V _{TT} - 0.80 | V _{TT} + 0.80 |

Notes:

- Descriptions of the symbols used in this table are as follows:
I_{OL} -- the output current condition under which V_{OL} is tested
I_{OH} -- the output current condition under which V_{OH} is tested
V_{OL} -- the output voltage that indicates a Low logic level
V_{OH} -- the output voltage that indicates a High logic level
V_{IL} -- the input voltage that indicates a Low logic level
V_{IH} -- the input voltage that indicates a High logic level
V_{CCO} -- the supply voltage for the output drivers
V_{REF} -- the reference voltage for setting the input switching threshold
V_{TT} -- the termination voltage
- In the standard case, all Dedicated pins (M0-M2, CCLK, PROG_B, DONE, HSWAP_EN, TCK, TDI, TDO, TMS) as well as the Dual-Purpose configuration pins (DIN/D0, D1-D7, CS_B, RDWR_B, BUSY/DOUT, and INIT_B) exhibit LVC MOS25 output characteristics. For information on how to program the FPGA using 3.3V signals and power, see the **3.3V-Tolerant Configuration Interface** section in Module 2: **Functional Description**.
- All parameters representing voltages are measured with respect to GND unless otherwise specified.
- The numbers in this table are guaranteed over the conditions set forth in Table 4 and Table 7.
- Tested according to relevant PCI specifications.

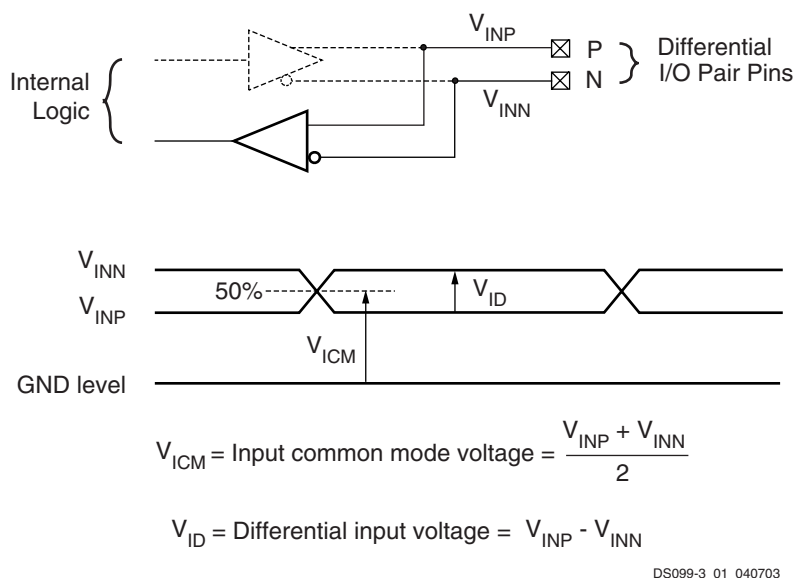


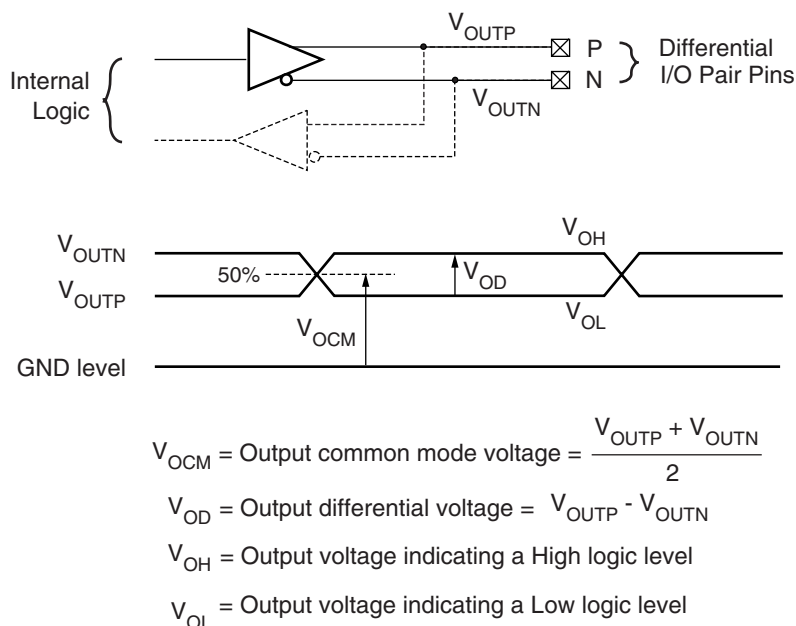
Figure 1: Differential Input Voltages

Table 9: Recommended Operating Conditions for User I/Os Using Differential Signal Standards

| Signal Standard | V_{CCO} | | | V_{ID} | | | V_{ICM} | | |
|-------------------------------|-----------|---------|---------|----------|----------|----------|-----------|---------|---------|
| | Min (V) | Nom (V) | Max (V) | Min (mV) | Nom (mV) | Max (mV) | Min (V) | Nom (V) | Max (V) |
| LDT_25 | 2.38 | 2.50 | 2.63 | 200 | 600 | 1000 | 0.44 | 0.60 | 0.78 |
| LVDS_25, LVDS_25_DCI | 2.38 | 2.50 | 2.63 | 100 | 350 | 600 | 0.30 | 1.25 | 2.20 |
| BLVDS_25 | 2.38 | 2.50 | 2.63 | - | 350 | - | - | 1.25 | - |
| LVDSEXT_25, LVDSEXT_25_DCI | 2.38 | 2.50 | 2.63 | 100 | 540 | 1000 | 0.30 | 1.20 | 2.20 |
| ULVDS_25 | 2.38 | 2.50 | 2.63 | 200 | 600 | 1000 | 0.44 | 0.60 | 0.78 |
| RSDS_25 | 2.38 | 2.50 | 2.63 | 100 | 200 | - | - | 1.30 | - |

Notes:

1. The V_{REF} input is not used for any of the differential I/O standards.
2. Of the parameters shown, only V_{CCO} represents a voltage measured with respect to GND. The remaining parameters are differential measurements. See Figure 1 for parameter definitions.



DS099-3_02_033103

Figure 2: Differential Output Voltages

Table 10: DC Characteristics of User I/Os Using Differential Signal Standards

| Signal Standard | V_{OD} | | | ΔV_{OD} | | V_{OCM} | | | ΔV_{OCM} | | V_{OH} | | V_{OL} | |
|----------------------|----------|----------|----------|-----------------|----------|-----------|---------|---------|------------------|----------|----------|---------|----------|---------|
| | Min (mV) | Typ (mV) | Max (mV) | Min (mV) | Max (mV) | Min (V) | Typ (V) | Max (V) | Min (mV) | Max (mV) | Typ (V) | Max (V) | Min (V) | Typ (V) |
| LDT_25 | 430 | 600 | 670 | -15 | 15 | 0.495 | 0.600 | 0.715 | -15 | 15 | - | - | - | - |
| LVDS_25, LVDS_25_DCI | 250 | 325 | 400 | - | - | 1.125 | 1.20 | 1.375 | - | - | - | 1.475 | 0.925 | - |
| BLVDS_25 | 250 | 350 | 450 | - | - | - | 1.20 | - | - | - | - | - | - | - |
| LVDS_25, LVDS_25_DCI | 330 | 540 | 700 | - | - | 1.125 | 1.20 | 1.375 | - | - | - | 1.700 | 0.705 | - |
| ULVDS_25 | 430 | 600 | 670 | - | - | 0.495 | 0.600 | 0.715 | - | - | - | - | - | - |
| RS_25 | 100 | 325 | 400 | - | - | 1.1 | 1.2 | 1.5 | - | - | - | - | - | - |

Notes:

1. Of the parameters shown, only V_{OH} , V_{OL} , and V_{OCM} represent voltages measured with respect to GND. The remaining parameters are differential measurements. See Figure 2 for parameter definitions.
2. Output voltage measurements for all differential standards are made with a termination resistor (R_T) of 100 Ω across the N and P pins of the differential signal pair.
3. The numbers in this table are guaranteed over the conditions set forth in Table 4 and Table 9.

Switching Characteristics

All Spartan-3 devices are available in two speed grades: –4 and –5. Switching characteristics in this document may be designated as Advance, Preliminary, or Production. Each category is defined as follows:

Advance: These speed files are based on simulations only and are typically available soon after establishing FPGA specifications. Although speed grades with this designation are considered relatively stable and conservative, some under-reporting might still occur.

Preliminary: These speed files are based on complete ES (engineering sample) silicon characterization. Devices and speed grades with this designation are intended to give a better indication of the expected performance of production silicon. The probability of under-reporting preliminary delays is greatly reduced compared to Advance data.

Production: These speed files are released once enough production silicon of a particular device family member has been characterized to provide full correlation between

speed files and devices over numerous production lots. There is no under-reporting of delays, and customers receive formal notification of any subsequent changes. Typically, the slowest speed grades transition to Production before faster speed grades.

All specifications are representative of worst-case supply voltage and junction temperature conditions. Unless otherwise noted, values apply to all Spartan-3 devices.

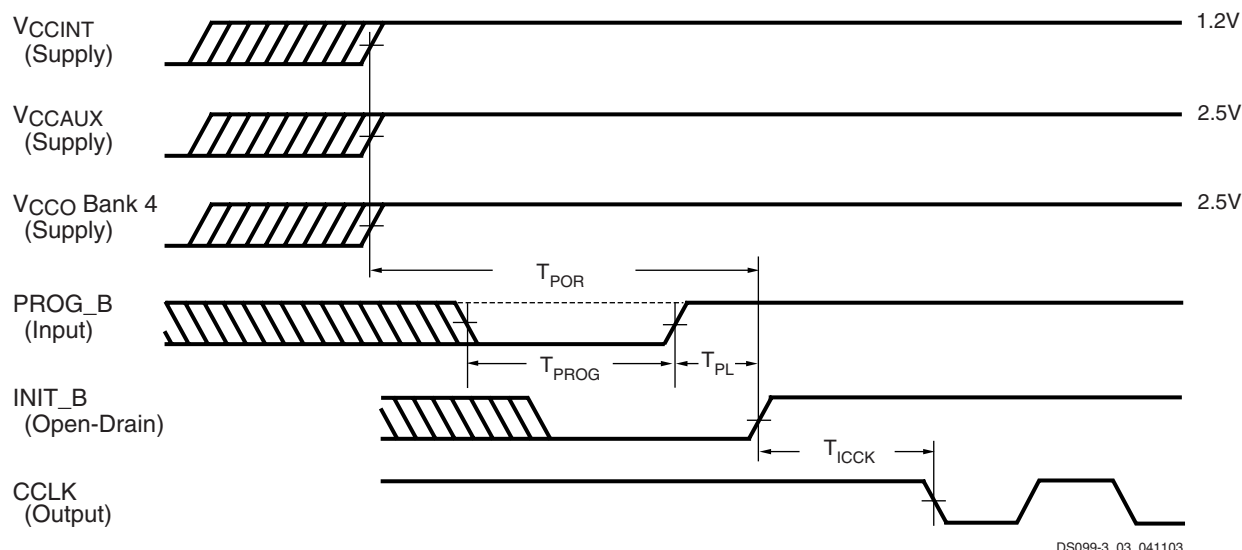
Internal timing parameters are derived from measuring internal test patterns. Timing parameters and their representative values are selected for inclusion below either because they are important as general design requirements or they indicate fundamental device performance characteristics. For more complete, more precise, and worst-case guaranteed data, use the values reported by the Xilinx static timing analyzer (TRACE in the Xilinx development software) and back-annotate to the simulation net list.

Table 11: DLL Timing

| Symbol | Description | Frequency Mode | Speed Grade | | | | Units |
|---------------------|--|----------------|-------------|-----|------|------|-------|
| | | | -5 | | -4 | | |
| | | | Min | Max | Min | Max | |
| Clock Outputs | | | | | | | |
| F _{1XCO} | Frequency at the CLK0 and CLK180 pins | High | | | 48 | 326 | MHZ |
| | | Low | | | 25 | 180 | MHz |
| Clock Inputs | | | | | | | |
| F _{CLKIN} | Frequency at the CLKIN pin | High | | | 48 | 326 | MHz |
| | | Low | | | 25 | 180 | MHz |
| T _{CLKINJ} | Allowable cycle-to-cycle jitter at the CLKIN pin | High | | | −100 | +100 | ps |
| | | Low | | | | | ps |

Notes:

- For up-to-date information on DCM timing, see <http://www.xilinx.com/bvdocs/publications/ds099-3.pdf>.

**Notes:**

1. The V_{CCINT} , V_{CCAUX} , and V_{CCO} supplies may be applied in any order.
2. The Low-going pulse on PROG_B is optional after power-on but necessary for reconfiguration without a power cycle.
3. The rising edge of INIT_B samples the voltage levels applied to the mode pins (M0 - M2).

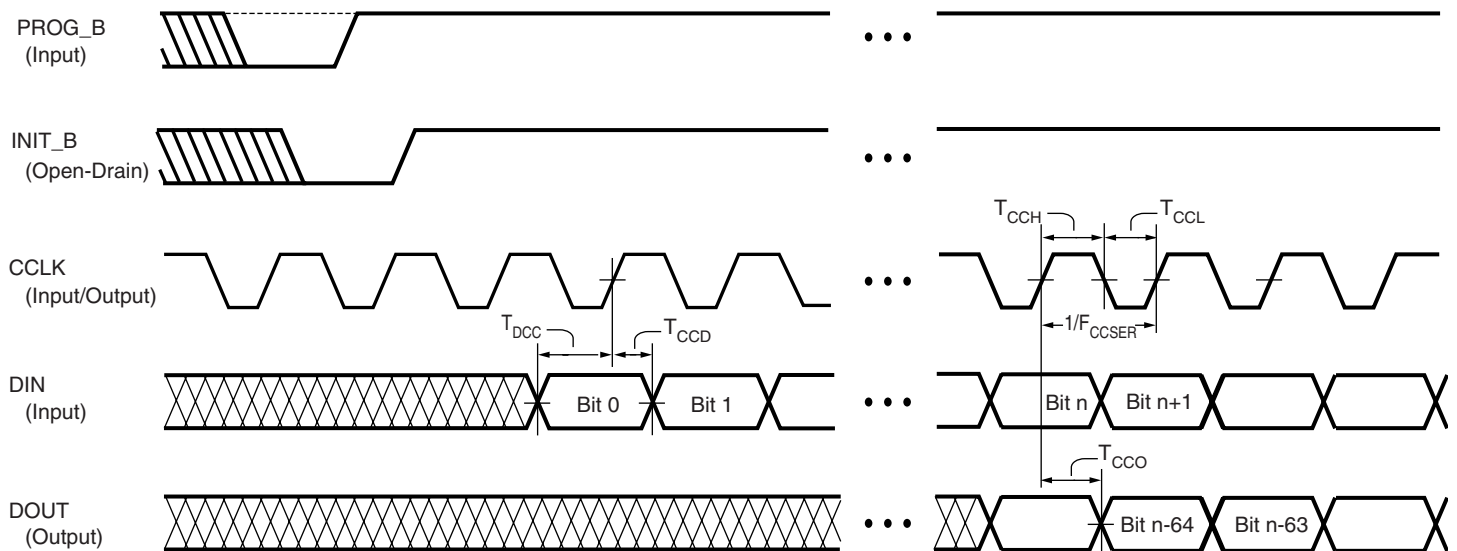
Figure 3: Waveforms for Power-On and the Beginning of Configuration

Table 12: Power-On Timing and the Beginning of Configuration

| Symbol | Description | Device | All Speed Grades | | Units |
|------------|---|----------|------------------|-----|---------|
| | | | Min | Max | |
| T_{POR} | The time from the application of V_{CCINT} , V_{CCAUX} , and V_{CCO} Bank 4 supply voltages (whichever occurs last) to the rising transition of the INIT_B pin ⁽¹⁾ | XC3S50 | - | 5 | ms |
| | | XC3S200 | - | 5 | ms |
| | | XC3S400 | - | 5 | ms |
| | | XC3S1000 | - | 5 | ms |
| | | XC3S1500 | - | 7 | ms |
| | | XC3S2000 | - | 7 | ms |
| | | XC3S4000 | - | 7 | ms |
| | | XC3S5000 | - | 7 | ms |
| T_{PROG} | The width of the low-going pulse on the PROG_B pin | All | 0.3 | - | μ s |
| T_{PL} | The time from the rising edge of the PROG_B pin to the rising transition on the INIT_B pin ⁽¹⁾ | XC3S50 | - | 2 | ms |
| | | XC3S200 | - | 2 | ms |
| | | XC3S400 | - | 2 | ms |
| | | XC3S1000 | - | 2 | ms |
| | | XC3S1500 | - | 3 | ms |
| | | XC3S2000 | - | 3 | ms |
| | | XC3S4000 | - | 3 | ms |
| | | XC3S5000 | - | 3 | ms |
| T_{ICCK} | The time from the rising edge of the INIT_B pin to the generation of the configuration clock signal at the CCLK output pin ⁽²⁾ | All | 0.5 | 4.0 | μ s |

Notes:

1. Power-on reset and the clearing of configuration memory occurs during this period.
2. This specification applies only for the Master Serial and Master Parallel modes.



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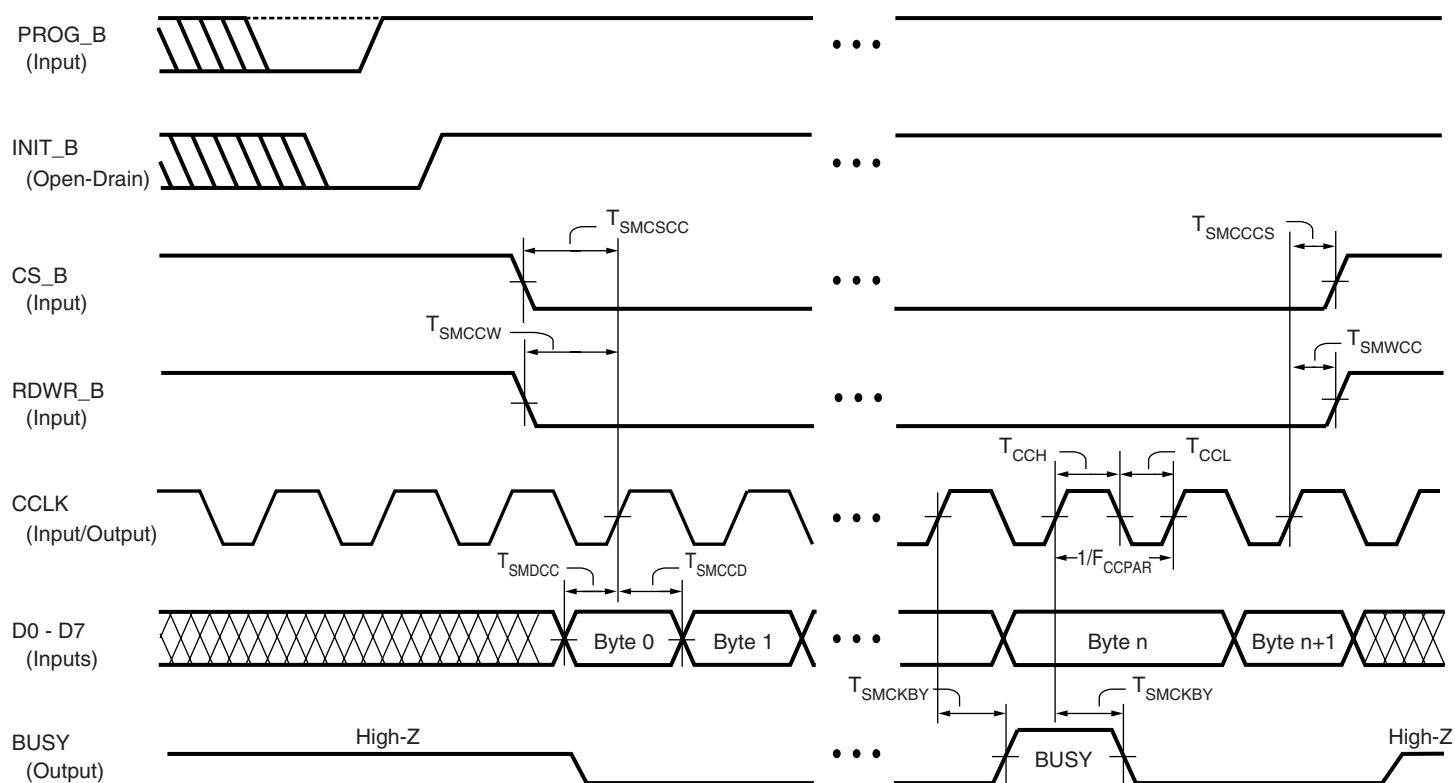
Notes:

1. The CS_B, WRITE_B, and BUSY signals are not used in the serial modes. Keep the CS_B and WRITE_B inputs inactive (i.e., both pins High).

Figure 4: Waveforms for Master and Slave Serial Configuration

Table 13: Timing for the Master and Slave Serial Configuration Modes

| Symbol | Description | Slave/Master | All Speed Grades | | Units |
|-----------------------|--|--------------|------------------|------|-------|
| | | | Min | Max | |
| Setup Times | | | | | |
| T _{DCC} | The time from the setup of data at the DIN pin to the rising transition at the CCLK pin | Both | - | 5.0 | ns |
| Hold Times | | | | | |
| T _{CCD} | The time from the rising transition at the CCLK pin to the point when data is last held at the DIN pin | Both | - | 0 | ns |
| Clock-to-Output Times | | | | | |
| T _{CCO} | The time from the rising transition on the CCLK pin to data appearing at the DOUT pin | Both | - | 12.0 | ns |
| Clock Timing | | | | | |
| T _{CCH} | The High pulse width at the CCLK input pin | Slave | 5.0 | - | ns |
| T _{CCL} | The Low pulse width at the CCLK input pin | | 5.0 | - | ns |
| F _{CCSER} | Frequency of the clock signal at the CCLK input pin | | - | 66 | MHz |
| ΔF _{CCSER} | Variation from the generated CCLK frequency set using the ConfigRate BitGen option | Master | −50% | +50% | - |



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Notes:

1. In a given CCLK cycle, when RDWR_B transitions High or Low while holding CS_B Low, the next rising edge on the CCLK pin will abort configuration.

Figure 5: Waveforms for Master and Slave Parallel Configuration

Table 14: Timing for the Master and Slave Parallel Configuration Modes

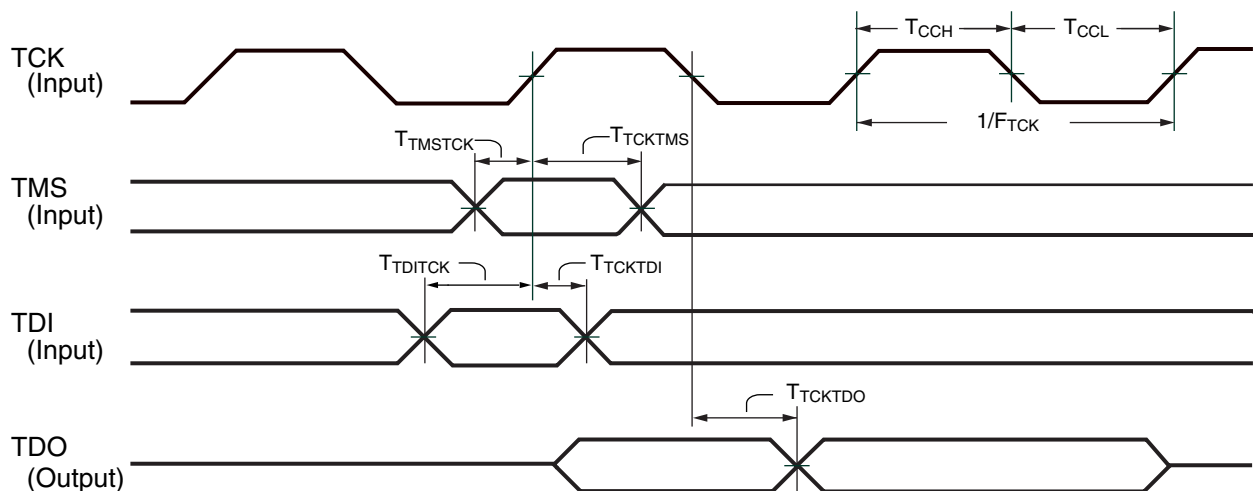
| Symbol | Description | Slave/Master | All Speed Grades | | Units |
|---------------------|--|--------------|------------------|-----|-------|
| | | | Min | Max | |
| Setup Times | | | | | |
| T _{SMDCC} | The time from the setup of data at the D0-D7 pins to the rising transition at the CCLK pin | Both | 5.0 | - | ns |
| T _{SMCSCC} | The time from the setup of a logic level at the CS_B pin to the rising transition at the CCLK pin | | 7.0 | - | ns |
| T _{SMCCW} | The time from the setup of a logic level at the RDWR_B pin to the rising transition at the CCLK pin ⁽¹⁾ | | 7.0 | - | ns |
| Hold Times | | | | | |
| T _{SMCCD} | The time from the rising transition at the CCLK pin to the point when data is last held at the D0-D7 pins | Both | 0 | - | ns |
| T _{SMCCCS} | The time from the rising transition at the CCLK pin to the point when a logic level is last held at the CS_B pin | | 0 | - | ns |
| T _{SMWCC} | The time from the rising transition at the CCLK pin ⁽¹⁾ to the point when a logic level is last held at the RDWR_B pin ⁽¹⁾ | | 0 | - | ns |

Table 14: Timing for the Master and Slave Parallel Configuration Modes (Continued)

| Symbol | Description | Slave/Master | All Speed Grades | | Units | |
|-----------------------|--|---------------------------------------|------------------|------|-------|-----|
| | | | Min | Max | | |
| Clock-to-Output Times | | | | | | |
| T _{SMCKBY} | The time from the rising transition on the CCLK pin to a signal transition at the BUSY pin | Slave | - | 12.0 | ns | |
| Clock Timing | | | | | | |
| T _{CCH} | The High pulse width at the CCLK input pin | | Slave | 5 | - | ns |
| T _{CCL} | The Low pulse width at the CCLK input pin | | | 5 | - | ns |
| F _{CCPAR} | Frequency of the clock signal at the CCLK input pin | Not using the BUSY pin ⁽²⁾ | | - | 66 | MHz |
| | | Using the BUSY pin | | - | 100 | MHz |
| ΔF _{CCPAR} | Variation from the generated CCLK frequency set using the BitGen option ConfigRate | | Master | −50% | +50% | - |

Notes:

1. RDWR_B is synchronized to CCLK for the purpose of performing the Abort operation. The same pin asynchronously controls the driver impedance of the D0 - D7 pins. To avoid contention when writing configuration data to the D0 - D7 bus, do not bring RDWR_B High when CS_B is Low.
2. In the Slave Parallel mode, it is necessary to use the BUSY pin when the CCLK frequency exceeds this maximum specification.



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Figure 6: JTAG Waveforms

Table 15: Timing for the JTAG Port

| Symbol | Description | All Speed Grades | | Units |
|---------------------|---|------------------|-----|-------|
| | | Min | Max | |
| Setup Times | | | | |
| T _{TDITCK} | The time from the setup of data at the TDI pin to the rising transition at the TCK pin | 4.0 | - | ns |
| T _{TMSTCK} | The time from the setup of a logic level at the TMS pin to the rising transition at the TCK pin | 4.0 | - | ns |
| Hold Times | | | | |
| T _{TCKTDI} | The time from the rising transition at the TCK pin to the point when data is last held at the TDI pin | 0 | - | ns |

Table 15: Timing for the JTAG Port (Continued)

| Symbol | Description | All Speed Grades | | Units |
|------------------------------|--|------------------|------|-------|
| | | Min | Max | |
| T_{TCKTMS} | The time from the rising transition at the TCK pin to the point when a logic level is last held at the TMS pin | 0 | - | ns |
| Clock-to-Output Times | | | | |
| T_{TCKTDO} | The time from the falling transition on the TCK pin to data appearing at the TDO pin | - | 11.0 | ns |
| Clock Timing | | | | |
| T_{CCH} | The High pulse width at the TCK pin | 5.0 | - | ns |
| T_{CCL} | The Low pulse width at the TCK pin | 5.0 | - | ns |
| F_{TCK} | Frequency of the clock signal at the TCK pin | - | 33 | MHz |

Revision History

| Date | Version No. | Description |
|----------|-------------|---|
| 04/11/03 | 1.0 | Initial Xilinx release. |
| 07/11/03 | 1.1 | Extended Absolute Maximum Rating for junction temperature in Table 1 . Added numbers for typical quiescent supply current (Table 6) and DLL timing (Table 11) . |

The Spartan-3 Family Data Sheet

DS099-1, *Spartan-3 1.2V FPGA Family: **Introduction and Ordering Information*** (Module 1)

DS099-2, *Spartan-3 1.2V FPGA Family: **Functional Description*** (Module 2)

DS099-3, *Spartan-3 1.2V FPGA Family: **DC and Switching Characteristics*** (Module 3)

DS099-4, *Spartan-3 1.2V FPGA Family: **Pinout Descriptions*** (Module 4)

Introduction

This data sheet module describes the various pins on a Spartan™-3 FPGA and how they connect to the supported component packages.

- The **Pin Types** section categorizes all of the FPGA pins by their function type.
- The **Pin Definitions** section provides a top-level description for each pin on the device.
- The **Detailed, Functional Pin Descriptions** section offers significantly more detail about each pin, especially for the dual- or special-function pins used during device configuration.
- Some pins have associated optional behavior, controlled by settings in the configuration bitstream. These options are described in the **Bitstream Options** section.

- The **Package Overview** section describes the various packaging options available for Spartan-3 FPGAs. Detailed pin list tables and footprint diagrams are provided for each package solution.

Pin Descriptions

Pin Types

A majority of the pins on a Spartan-3 FPGA are general-purpose, user-defined I/O pins. There are, however, up to 12 different functional types of pins on Spartan-3 packages, as outlined in **Table 1**. In the package footprint drawings that follow, the individual pins are color-coded according to pin type as in the table.

Table 1: Types of Pins on Spartan-3 FPGAs

| Type/ Color Code | Description | Pin Name(s) in Type |
|------------------------|---|---|
| I/O | Unrestricted, general-purpose user-I/O pin. Most pins can be paired together to form differential I/Os. | IO, IO_Lxxy_# |
| DUAL | Dual-purpose pin used in some configuration modes during the configuration process and then usually available as a user I/O after configuration. If the pin is not used during configuration, this pin behaves as an I/O-type pin. There are 12 dual-purpose configuration pins on every package. | IO_Lxxy_#/DIN/D0, IO_Lxxy_#/D1, IO_Lxxy_#/D2, IO_Lxxy_#/D3, IO_Lxxy_#/D4, IO_Lxxy_#/D5, IO_Lxxy_#/D6, IO_Lxxy_#/D7, IO_Lxxy_#/CS_B, IO_Lxxy_#/RDWR_B, IO_Lxxy_#/BUSY/DOUT, IO_Lxxy_#/INIT_B |
| CONFIG | Dedicated configuration pin. Not available as a user-I/O pin. Every package has seven dedicated configuration pins. These pins are powered by VCCAUX. | CCLK, DONE, M2, M1, M0, PROG_B, HSWAP_EN |
| JTAG | Dedicated JTAG pin. Not available as a user-I/O pin. Every package has four dedicated JTAG pins. These pins are powered by VCCAUX. | TDI, TMS, TCK, TDO |
| DCI | Dual-purpose pin that is either a user-I/O pin or used to calibrate output buffer impedance for a specific bank using Digital Controlled Impedance (DCI). There are two DCI pins per I/O bank. | IO/VRN_# IO_Lxxy_#/VRN_# IO/VRP_# IO_Lxxy_#/VRP_# |
| VREF | Dual-purpose pin that is either a user-I/O pin or, along with all other VREF pins in the same bank, provides a reference voltage input for certain I/O standards. If used for a reference voltage within a bank, all VREF pins within the bank must be connected. | IO/VREF_# IO_Lxxy_#/VREF_# |

Table 1: Types of Pins on Spartan-3 FPGAs (Continued)

| Type/ Color Code | Description | Pin Name(s) in Type |
|------------------------|---|---|
| GND | Dedicated ground pin. The number of GND pins depends on the package used. All must be connected. | GND |
| VCCAUX | Dedicated auxiliary power supply pin. The number of VCCAUX pins depends on the package used. All must be connected to +2.5V. | VCCAUX |
| VCCINT | Dedicated internal core logic power supply pin. The number of VCCINT pins depends on the package used. All must be connected to +1.2V. | VCCINT |
| VCCO | Dedicated I/O bank, output buffer power supply pin. Along with other VCCO pins in the same bank, this pin supplies power to the output buffers within the I/O bank and sets the input threshold voltage for some I/O standards. | VCCO_# TQ144 Package Only: VCCO_LEFT, VCCO_TOP, VCCO_RIGHT, VCCO_BOTTOM |
| GCLK | Dual-purpose pin that is either a user-I/O pin or an input to a specific global buffer input. Every package has eight dedicated GCLK pins. | IO_Lxyy_#/GCLK0, IO_Lxyy_#/GCLK1, IO_Lxyy_#/GCLK2, IO_Lxyy_#/GCLK3, IO_Lxyy_#/GCLK4, IO_Lxyy_#/GCLK5, IO_Lxyy_#/GCLK6, IO_Lxyy_#/GCLK7 |
| N.C. | This package pin is not connected in this specific device/package combination but may be connected in larger devices in the same package. | N.C. |

Notes:

1. # = I/O bank number, an integer between 0 and 7.

I/Os with Lxyy_# are part of a differential output pair. 'L' indicates differential output capability. The "xx" field is a two-digit integer, unique to each bank that identifies a differential pin-pair. The 'y' field is either 'P' for the true signal or 'N' for the inverted signal in the differential pair. The '#' field is the I/O bank number.

Pin Definitions

Table 2 provides a brief description of each pin listed in the Spartan-3 pinout tables and package footprint diagrams. Pins are categorized by their pin type, as listed in Table 1. See **Detailed, Functional Pin Descriptions** for more information.

Table 2: Spartan-3 Pin Definitions

| Pin Name | Direction | Description |
|--|--|--|
| I/O: General-purpose I/O pins | | |
| I/O | User-defined as input, output, bidirectional, three-state output, open-drain output, open-source output | User I/O: Unrestricted single-ended user-I/O pin. Supports all I/O standards except the differential standards. |
| I/O_Lxxy_# | User-defined as input, output, bidirectional, three-state output, open-drain output, open-source output | User I/O, Half of Differential Pair: Unrestricted single-ended user-I/O pin or half of a differential pair. Supports all I/O standards including the differential standards. |
| DUAL: Dual-purpose configuration pins | | |
| IO_Lxxy_#/DIN/D0, IO_Lxxy_#/D1, IO_Lxxy_#/D2, IO_Lxxy_#/D3, IO_Lxxy_#/D4, IO_Lxxy_#/D5, IO_Lxxy_#/D6, IO_Lxxy_#/D7 | Input during configuration Possible bidirectional I/O after configuration if SelectMap port is retained. Otherwise, user I/O after configuration | Configuration Data Port: In Parallel (SelectMAP) modes, D0-D7 are byte-wide configuration data pins. These pins become user I/Os after configuration unless the SelectMAP port is retained via the Persist bitstream option. In Serial modes, DIN (D0) serves as the single configuration data input. This pin becomes a user I/O after configuration unless retained by the Persist bitstream option. |
| IO_Lxxy_#/CS_B | Input during Parallel mode configuration Possible input after configuration if SelectMap port is retained. Otherwise, user I/O after configuration | Chip Select for Parallel Mode Configuration: In Parallel (SelectMAP) modes, this is the active-Low Chip Select signal. This pin becomes a user I/O after configuration unless the SelectMAP port is retained via the Persist bitstream option. |
| IO_Lxxy_#/RDWR_B | Input during Parallel mode configuration Possible input after configuration if SelectMap port is retained. Otherwise, user I/O after configuration | Read/Write Control for Parallel Mode Configuration: In Parallel (SelectMAP) modes, this is the active-Low Write Enable, active-High Read Enable signal. This pin becomes a user I/O after configuration unless the SelectMAP port is retained via the Persist bitstream option. |
| IO_Lxxy_#/BUSY/DOUT | Output during configuration Possible output after configuration if SelectMap port is retained. Otherwise, user I/O after configuration | Configuration Data Rate Control for Parallel Mode, Serial Data Output for Serial Mode: In Parallel (SelectMAP) modes, BUSY throttles the rate at which configuration data is loaded. This pin becomes a user I/O after configuration unless the SelectMAP port is retained via the Persist bitstream option. In Serial modes, DOUT provides preamble and configuration data to downstream devices in a multi-FPGA daisy-chain. This pin becomes a user I/O after configuration. |

Table 2: Spartan-3 Pin Definitions (Continued)

| Pin Name | Direction | Description |
|---|---|---|
| IO_Lxxy_#/INIT_B | Bidirectional (open-drain) during configuration User I/O after configuration | Initializing Configuration Memory/Detected Configuration Error: When Low, this pin indicates that configuration memory is being cleared. When held Low, this pin delays the start of configuration. After this pin is released or configuration memory is cleared, the pin goes High. During configuration, a Low on this output indicates that a configuration data error occurred. This pin becomes a user I/O after configuration. |
| DCI: Digitally Controlled Impedance reference resistor input pins | | |
| IO_Lxxy_#/VRN_# or IO/VRN_# | Input when using DCI Otherwise, same as I/O | DCI Reference Resistor for NMOS I/O Transistor (per bank): If using DCI, a 1% precision impedance-matching resistor is connected between this pin and the VCCO supply for this bank. Otherwise, this pin is a user I/O. |
| IO_Lxxy_#/VRP_# or IO/VRP_# | Input when using DCI Otherwise, same as I/O | DCI Reference Resistor for PMOS I/O Transistor (per bank): If using DCI, a 1% precision impedance-matching resistor is connected between this pin and the ground supply. Otherwise, this pin is a user I/O. |
| GCLK: Global clock buffer inputs | | |
| IO_Lxxy_#/GCLK0, IO_Lxxy_#/GCLK1, IO_Lxxy_#/GCLK2, IO_Lxxy_#/GCLK3, IO_Lxxy_#/GCLK4, IO_Lxxy_#/GCLK5, IO_Lxxy_#/GCLK6, IO_Lxxy_#/GCLK7 | Input if connected to global clock buffers Otherwise, same as I/O | Global Buffer Input: Direct input to a low-skew global clock buffer. If not connected to a global clock buffer, this pin is a user I/O. |
| VREF: I/O bank input reference voltage pins | | |
| IO_Lxxy_#/VREF_# or IO/VREF_# | Voltage supply input when VREF pins are used within a bank. Otherwise, same as I/O | Input Buffer Reference Voltage for Special I/O Standards (per bank): If required to support special I/O standards, all the VREF pins within a bank connect to a input threshold voltage source. If not used as input reference voltage pins, these pins are available as individual user-I/O pins. |
| CONFIG: Dedicated configuration pins | | |
| CCLK | Input in Slave configuration modes Output in Master configuration modes | Configuration Clock: The configuration clock signal synchronizes configuration data. |
| PROG_B | Input | Program/Configure Device: Active Low asynchronous reset to configuration logic. Asserting PROG_B Low for an extended period delays the configuration process. This pin has an internal weak pull-up resistor during configuration. |

Table 2: Spartan-3 Pin Definitions (Continued)

| Pin Name | Direction | Description |
|--|--|--|
| DONE | Bidirectional with open-drain or totem-pole Output | <p>Configuration Done, Delay Start-up Sequence:</p> <p>A Low-to-High output transition on this bidirectional pin signals the end of the configuration process.</p> <p>The FPGA produces a Low-to-High transition on this pin to indicate that the configuration process is complete. The DriveDone bitstream generation option defines whether this pin functions as a totem-pole output that actively drives High or as an open-drain output. An open-drain output requires a pull-up resistor to produce a High logic level. The open-drain option permits the DONE lines of multiple FPGAs to be tied together, so that the common node transitions High only after all of the FPGAs have completed configuration. Externally holding the open-drain output Low delays the start-up sequence, which marks the transition to user mode.</p> |
| M0, M1, M2 | Input | <p>Configuration Mode Selection:</p> <p>These inputs select the configuration mode. The logic levels applied to the mode pins are sampled on the rising edge of INIT_B. See Table 7.</p> |
| HSWAP_EN | Input | <p>Disable Weak Pull-up Resistors During Configuration:</p> <p>A Low on this pin enables weak pull-up resistors on all pins that are not actively involved in the configuration process. A High value disables all pull-ups, allowing the non-configuration pins to float.</p> |
| JTAG: JTAG interface pins | | |
| TCK | Input | <p>JTAG Test Clock:</p> <p>The TCK clock signal synchronizes all JTAG port operations.</p> |
| TDI | Input | <p>JTAG Test Data Input:</p> <p>TDI is the serial data input for all JTAG instruction and data registers.</p> |
| TMS | Input | <p>JTAG Test Mode Select:</p> <p>The serial TMS input controls the operation of the JTAG port.</p> |
| TDO | Output | <p>JTAG Test Data Output:</p> <p>TDO is the serial data output for all JTAG instruction and data registers.</p> |
| VCCO: I/O bank output voltage supply pins | | |
| VCCO_# | Supply | <p>Power Supply for Output Buffer Drivers (per bank):</p> <p>These pins power the output drivers within a specific I/O bank.</p> |
| VCCAUX: Auxiliary voltage supply pins | | |
| VCCAUX | Supply | <p>Power Supply for Auxiliary Circuits:</p> <p>+2.5V power pins for auxiliary circuits, including the Digital Clock Managers (DCMs), the dedicated configuration pins (CONFIG), and the dedicated JTAG pins. All VCCAUX pins must be connected.</p> |
| VCCINT: Internal core voltage supply pins | | |
| VCCINT | Supply | <p>Power Supply for Internal Core Logic:</p> <p>+1.2V power pins for the internal logic. All pins must be connected.</p> |

Table 2: Spartan-3 Pin Definitions (Continued)

| Pin Name | Direction | Description |
|---------------------------------------|-----------|---|
| GND: Ground supply pins | | |
| GND | Supply | Ground: Ground pins, which are connected to the power supply's return path. All pins must be connected. |
| N.C.: Unconnected package pins | | |
| N.C. | | Unconnected Package Pin: These package pins are unconnected. |

Notes:

1. All unused inputs and bidirectional pins must be tied either High or Low. For unused enable inputs, apply the level that disables the associated function. One common approach is to activate internal pull-up or pull-down resistors. An alternative approach is to externally connect the pin to either VCCO or GND.
2. All outputs are of the totem-pole type — i.e., they can drive High as well as Low logic levels — except for the cases where “Open Drain” is indicated. The latter can only drive a Low logic level and require a pull-up resistor to produce a High logic level.

Detailed, Functional Pin Descriptions

I/O Type: Unrestricted, General-purpose I/O Pins

After configuration, I/O-type pins are inputs, outputs, bidirectional I/O, three-state outputs, open-drain outputs, or open-source outputs, as defined in the application

Pins labeled "IO" support all SelectIO™ signal standards except differential standards. A given device at most only has a few of these pins.

A majority of the general-purpose I/O pins are labeled in the format "IO_Lxxy_#". These pins support all SelectIO signal standards, including the differential standards such as LVDS, ULVDS, BLVDS, RSDS, or LDT.

For additional information, see the "IOBs" section in Module 2: **Functional Description**.

Differential Pair Labeling

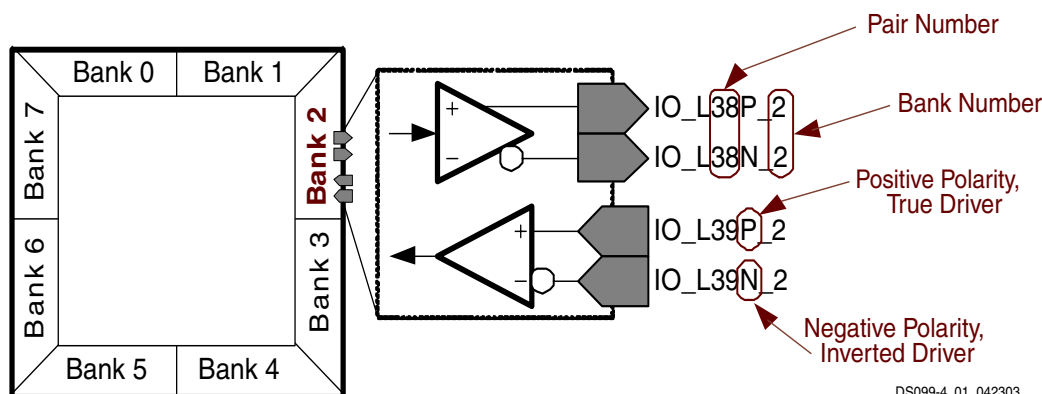
A pin supports differential standards if the pin is labeled in the format "Lxxy_#". The pin name suffix has the following significance. **Figure 1** provides a specific example showing a differential input to and a differential output from Bank 2.

- 'L' indicates differential capability.
- "xx" is a two-digit integer, unique for each bank, that identifies a differential pin-pair.
- 'y' is replaced by 'P' for the true signal or 'N' for the inverted. These two pins form one differential pin-pair.
- '#' is an integer, 0 through 7, indicating the associated I/O bank.

If unused, these pins are in a high impedance state. The Bit-stream generator option UnusedPin enables a weak pull-up or pull-down resistor on all unused I/O pins.

Behavior from Power-On through End of Configuration

During the configuration process, all pins that are not actively involved in the configuration process are in a high-impedance state. The HSWAP_EN input determines whether or not weak pull-up resistors are enabled during configuration. HSWAP_EN = 0 enables the weak pull-up resistors. HSWAP_EN = 1 disables the pull-up resistors allowing the pins to float, which is the desired state for hot-swap applications.



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Figure 1: Differential Pair Labelling

DUAL Type: Dual-Purpose Configuration and I/O Pins

These pins serve dual purposes. The user-I/O pins are temporarily borrowed during the configuration process to load configuration data into the FPGA. After configuration, these pins are then usually available as a user I/O in the application. If a pin is not applicable to the specific configuration mode—controlled by the mode select pins M2, M1, and M0—then the pin behaves as an I/O-type pin.

There are 12 dual-purpose configuration pins on every package, six of which are part of I/O Bank 4, the other six part of I/O Bank 5. Only a few of the pins in Bank 4 are used in the Serial configuration modes.

See "**Configuration**" in Module 2: **Functional Description**.

See "**Pin Behavior During Configuration**, page 15".

Serial Configuration Modes

This section describes the dual-purpose pins used during either Master or Slave Serial mode. See [Table 7](#) for Mode Select pin settings required for Serial modes. All such pins are in Bank 4 and powered by VCCO_4.

In both the Master and Slave Serial modes, DIN is the serial configuration data input. The D1-D7 inputs are unused in serial mode and behave like general-purpose I/O pins.

In all the cases, the configuration data is synchronized to the rising edge of the CCLK clock signal.

The DIN, DOUT, and INIT_B pins can be retained in the application to support reconfiguration by setting the Persist bitstream generation option. However, the serial modes do not support device readback.

Table 3: Dual-Purpose Pins Used in Master or Slave Serial Mode

| Pin Name | Direction | Description |
|----------|----------------------------|--|
| DIN | Input | <p>Serial Data Input:</p> <p>During the Master or Slave Serial configuration modes, DIN is the serial configuration data input, and all data is synchronized to the rising CCLK edge. After configuration, this pin is available as a user I/O.</p> <p>This signal is located in Bank 4 and its output voltage determined by VCCO_4.</p> <p>The BitGen option Persist permits this pin to retain its configuration function in the User mode.</p> |
| DOUT | Output | <p>Serial Data Output:</p> <p>In a multi-FPGA design where all the FPGAs use serial mode, connect the DOUT output of one FPGA—in either Master or Slave Serial mode—to the DIN input of the next FPGA—in Slave Serial mode—so that configuration data passes from one to the next, in daisy-chain fashion. This “daisy chain” permits sequential configuration of multiple FPGAs.</p> <p>This signal is located in Bank 4 and its output voltage determined by VCCO_4.</p> <p>The BitGen option Persist permits this pin to retain its configuration function in the User mode.</p> |
| INIT_B | Bidirectional (open-drain) | <p>Initializing Configuration Memory/Configuration Error:</p> <p>Just after power is applied, the FPGA produces a Low-to-High transition on this pin indicating that initialization (<i>i.e.</i>, clearing) of the configuration memory has finished. Before entering the User mode, this pin functions as an open-drain output, which requires a pull-up resistor in order to produce a High logic level. In a multi-FPGA design, tie (wire AND) the INIT_B pins from all FPGAs together so that the common node transitions High only after all of the FPGAs have been successfully initialized.</p> <p>Externally holding this pin Low beyond the initialization phase delays the start of configuration. This action stalls the FPGA at the configuration step just before the mode select pins are sampled.</p> <p>During configuration, the FPGA indicates the occurrence of a data (<i>i.e.</i>, CRC) error by asserting INIT_B Low.</p> <p>This signal is located in Bank 4 and its output voltage determined by VCCO_4.</p> <p>The BitGen option Persist permits this pin to retain its configuration function in the User mode.</p> |

| Configuration Data Byte | I/O Bank 4 (VCCO_4) | | | | I/O Bank 5 (VCCO_5) | | | |
|-------------------------|---------------------|----|----|----|---------------------|----|----|----|
| | High Nibble | | | | Low Nibble | | | |
| | D0 | D1 | D2 | D3 | D4 | D5 | D6 | D7 |
| 0xA5 = | 1 | 0 | 1 | 0 | 0 | 1 | 0 | 1 |

Figure 2: Configuration Data Byte Mapping to D0-D7 Bits

Parallel Configuration Modes (SelectMAP)

This section describes the dual-purpose configuration pins used during the Master and Slave Parallel configuration modes, sometimes also called the SelectMAP modes. In both Master and Slave Parallel configuration modes, D0-D7 form the byte-wide configuration data input. See Table 7 for Mode Select pin settings required for Parallel modes.

As shown in Figure 2, D0 is the most-significant bit while D7 is the least-significant bit. Bits D0-D3 form the high nibble of the byte and bits D4-D7 form the low nibble.

In the Parallel configuration modes, both the VCCO_4 and VCCO_5 voltage supplies are required and must both equal the voltage of the attached configuration device, typically either 2.5V or 3.3V.

Assert Low both the chip-select pin, CS_B, and the read/write control pin, RDWR_B, to write the configuration data byte presented on the D0-D7 pins to the FPGA on a rising-edge of the configuration clock, CCLK. The order of

CS_B and RDWR_B does not matter, although RDWR_B must be asserted throughout the configuration process. If RDWR_B is de-asserted during configuration, the FPGA aborts the configuration operation.

After configuration, these pins are available as general-purpose user I/O. However, the SelectMAP configuration interface is optionally available for debugging and dynamic reconfiguration. To use these SelectMAP pins after configuration, set the Persist bitstream generation option.

The Readback debugging option, for example, requires the Persist bitstream generation option. During Readback mode, assert CS_B Low, along with RDWR_B High, to read a configuration data byte from the FPGA to the D0-D7 bus on a rising CCLK edge. During Readback mode, D0-D7 are output pins.

In all the cases, the configuration data and control signals are synchronized to the rising edge of the CCLK clock signal.

Table 4: Dual-Purpose Configuration Pins for Parallel (SelectMAP) Configuration Modes

| Pin Name | Direction | Description | | | | | | |
|----------------|--|---|------|----------|---|--|---|--|
| D0, D1, D2, D3 | Input during configuration Output during readback | Configuration Data Port (high nibble): Collectively, the D0-D7 pins are the byte-wide configuration data port for the Parallel (SelectMAP) configuration modes. Configuration data is synchronized to the rising edge of CCLK clock signal. The D0-D3 pins are the high nibble of the configuration data byte and located in Bank 4 and powered by VCCO_4. The BitGen option Persist permits this pin to retain its configuration function in the User mode. | | | | | | |
| D4, D5, D6, D7 | Input during configuration Output during readback | Configuration Data Port (low nibble): The D4-D7 pins are the low nibble of the configuration data byte. However, these signals are located in Bank 5 and powered by VCCO_5. The BitGen option Persist permits this pin to retain its configuration function in the User mode. | | | | | | |
| CS_B | Input | Chip Select for Parallel Mode Configuration: Assert this pin Low, together with RDWR_B to write a configuration data byte from the D0-D7 bus to the FPGA on a rising CCLK edge. During Readback, assert this pin Low, along with RDWR_B High, to read a configuration data byte from the FPGA to the D0-D7 bus on a rising CCLK edge. This signal is located in Bank 5 and powered by VCCO_5. The BitGen option Persist permits this pin to retain its configuration function in the User mode. <table><tr><th>CS_B</th><th>Function</th></tr><tr><td>0</td><td>FPGA selected. SelectMAP inputs are valid on the next rising edge of CCLK.</td></tr><tr><td>1</td><td>FPGA deselected. All SelectMAP inputs are ignored.</td></tr></table> | CS_B | Function | 0 | FPGA selected. SelectMAP inputs are valid on the next rising edge of CCLK. | 1 | FPGA deselected. All SelectMAP inputs are ignored. |
| CS_B | Function | | | | | | | |
| 0 | FPGA selected. SelectMAP inputs are valid on the next rising edge of CCLK. | | | | | | | |
| 1 | FPGA deselected. All SelectMAP inputs are ignored. | | | | | | | |

Table 4: Dual-Purpose Configuration Pins for Parallel (SelectMAP) Configuration Modes (Continued)

| Pin Name | Direction | Description | | | | | | | | |
|----------|--|--|--------|----------|---|---|---|--|------|---|
| RDWR_B | Input | <p>Read/Write Control for Parallel Mode Configuration:</p> <p>In Master and Slave Parallel modes, assert this pin Low together with CS_B to write a configuration data byte from the D0-D7 bus to the FPGA on a rising CCLK edge. Once asserted during configuration, RDWR_B must remain asserted until configuration is complete.</p> <p>During Readback, assert this pin High with CS_B Low to read a configuration data byte from the FPGA to the D0-D7 bus on a rising CCLK edge.</p> <p>This signal is located in Bank 5 and powered by VCCO_5.</p> <p>The BitGen option Persist permits this pin to retain its configuration function in the User mode.</p> <table><tr><th>RDWR_B</th><th>Function</th></tr><tr><td>0</td><td>If CS_B is Low, then load (write) configuration data to the FPGA.</td></tr><tr><td>1</td><td>This option is valid only if the Persist bitstream option is set to Yes. If CS_B is Low, then read configuration data from the FPGA.</td></tr></table> | RDWR_B | Function | 0 | If CS_B is Low, then load (write) configuration data to the FPGA. | 1 | This option is valid only if the Persist bitstream option is set to Yes. If CS_B is Low, then read configuration data from the FPGA. | | |
| RDWR_B | Function | | | | | | | | | |
| 0 | If CS_B is Low, then load (write) configuration data to the FPGA. | | | | | | | | | |
| 1 | This option is valid only if the Persist bitstream option is set to Yes. If CS_B is Low, then read configuration data from the FPGA. | | | | | | | | | |
| BUSY | Output | <p>Configuration Data Rate Control for Parallel Mode:</p> <p>In the Slave and Master Parallel modes, BUSY throttles the rate at which configuration data is loaded. BUSY is only necessary if CCLK operates at greater than 50 MHz. Ignore BUSY for frequencies of 50 MHz and below.</p> <p>When BUSY is Low, the FPGA accepts the next configuration data byte on the next rising CCLK edge for which CS_B and RDWR_B are Low. When BUSY is High, the FPGA ignores the next configuration data byte. The next configuration data value must be held or reloaded until the next rising CCLK edge when BUSY is Low. When CS_B is High, BUSY is in a high impedance state.</p> <table><tr><th>BUSY</th><th>Function</th></tr><tr><td>0</td><td>The FPGA is ready to accept the next configuration data byte.</td></tr><tr><td>1</td><td>The FPGA is busy processing the current configuration data byte and is not ready to accept the next byte.</td></tr><tr><td>Hi-Z</td><td>If CS_B is High, then BUSY is high impedance.</td></tr></table> <p>This signal is located in Bank 4 and its output voltage is determined by VCCO_4. The BitGen option Persist permits this pin to retain its configuration function in the User mode.</p> | BUSY | Function | 0 | The FPGA is ready to accept the next configuration data byte. | 1 | The FPGA is busy processing the current configuration data byte and is not ready to accept the next byte. | Hi-Z | If CS_B is High, then BUSY is high impedance. |
| BUSY | Function | | | | | | | | | |
| 0 | The FPGA is ready to accept the next configuration data byte. | | | | | | | | | |
| 1 | The FPGA is busy processing the current configuration data byte and is not ready to accept the next byte. | | | | | | | | | |
| Hi-Z | If CS_B is High, then BUSY is high impedance. | | | | | | | | | |
| INIT_B | Bidirectional (open-drain) | <p>Initializing Configuration Memory/Configuration Error (active-Low):</p> <p>See description under Serial Configuration Modes, page 7.</p> | | | | | | | | |

JTAG Configuration Mode

In the JTAG configuration mode all dual-purpose configuration pins are unused and behave exactly like user-I/O pins, as shown in Table 10. See Table 7 for Mode Select pin settings required for JTAG mode.

Dual-Purpose Pin I/O Standard During Configuration

During configuration, the dual-purpose pins default to CMOS input and output levels for the associated VCCO voltage supply pins. For example, in the Parallel configuration modes, both VCCO_4 and VCCO_5 are required. If connected to +2.5V, then the associated pins conform to the

LVC MOS25 I/O standard. If connected to +3.3V, then the pins drive LVC MOS output levels and accept either LV TTL or LVC MOS input levels.

Dual-Purpose Pin Behavior After Configuration

After the configuration process completes, these pins, if they were borrowed during configuration, become user-I/O pins available to the application. If a dual-purpose configuration pin is not used during the configuration process—i.e., the parallel configuration pins when using serial mode—then the pin behaves exactly like a general-purpose I/O. See **I/O Type: Unrestricted, General-purpose I/O Pins** section above.

DCI: User I/O or Digitally Controlled Impedance Resistor Reference Input

These pins are individual user-I/O pins unless one of the I/O standards used in the bank requires the Digitally Controlled Impedance (DCI) feature. If DCI is used, then 1% precision resistors connected to the VRP_# and VRN_# pins match the impedance on the input or output buffers of the I/O standards that use DCI within the bank.

The '#' character in the pin name indicates the associated I/O bank and is an integer, 0 through 7.

There are two DCI pins per I/O bank, except in the TQ144 package, which does not have any DCI inputs for Bank 5.

VRP and VRN Impedance Resistor Reference Inputs

The 1% precision impedance-matching resistor attached to the VRP_# pin controls the pull-up impedance of PMOS transistor in the input or output buffer. Consequently, the VRP_# pin must connect to ground. The 'P' character in "VRP" indicates that this pin controls the I/O buffer's PMOS transistor impedance. The VRP_# pin is used for both single and split termination.

The 1% precision impedance-matching resistor attached to the VRN_# pin controls the pull-down impedance of NMOS transistor in the input or output buffer. Consequently, the VRN_# pin must connect to VCCO. The 'N' character in "VRN" indicates that this pin controls the I/O buffer's NMOS transistor impedance. The VRN_# pin is only used for split termination.

Each VRN or VRP reference input requires its own resistor. A single resistor cannot be shared between VRN or VRP pins associated with different banks.

During configuration, these pins behave exactly like user-I/O pins. The associated DCI behavior is not active or valid until after configuration completes.

See "**Digitally Controlled Impedance (DCI)**" in Module 2: **Functional Description**.

DCI Termination Types

If the I/O in an I/O bank do not use the DCI feature, then no external resistors are required and both the VRP_# and VRN_# pins are available for user I/O, as shown in **Figure 3a**.

If the I/O standards within the associated I/O bank require single termination—such as GTL_DCI, GTLP_DCI, or HSTL_III_DCI—then only the VRP_# signal connects to a 1% precision impedance-matching resistor, as shown in **Figure 3b**. The VRN_# pin is available for user I/O.

Finally, if the I/O standards with the associated I/O bank require split termination—such as HSTL_I_DCI,

SSTL2_I_DCI, SSTL2_II_DCI, or LVDS_25_DCI and LVDSEXT_25_DCI receivers—then both the VRP_# and VRN_# pins connect to separate 1% precision impedance-matching resistors, as shown in **Figure 3c**. Neither pin is available for user I/O.

GCLK: Global Clock Buffer Inputs or General-Purpose I/O Pins

These pins are user-I/O pins unless they specifically connect to one of the eight low-skew global clock buffers on the device, specified using the IBUFG primitive.

There are eight GCLK pins per device and two each appear in the top-edge banks, Bank 0 and 1, and the bottom-edge banks, Banks 4 and 5. See **Figure 1** for a picture of bank labeling.

During configuration, these pins behave exactly like user-I/O pins.

CONFIG: Dedicated Configuration Pins

The dedicated configuration pins control the configuration process and are not available as user-I/O pins. Every package has seven dedicated configuration pins. All CONFIG-type pins are powered by the +2.5V VCCAUX supply.

See "**Configuration**" in Module 2: **Functional Description**.

CCLK: Configuration Clock

The configuration clock signal on this pin synchronizes the reading or writing of configuration data. This pin is an input for the Slave configuration modes, both parallel and serial.

After configuration, the CCLK pin is in a high-impedance, floating state. By default, CCLK optionally is pulled High to VCCAUX as defined by the CclkPin bitstream selection. Any clocks applied to CCLK after configuration are ignored unless the bitstream option Persist is set to Yes, which retains the configuration interface. Persist is set to No by default. However, if Persist is set to Yes, then all clock edges are potentially active events, depending on the other configuration control signals.

The bitstream generator option ConfigRate determines the frequency of the internally-generated CCLK oscillator required for the Master configuration modes. The actual frequency is approximate due to the characteristics of the silicon oscillator and varies by up to 30% over the temperature and voltage range. By default, CCLK operates at approximately 6 MHz. Via the ConfigRate option, the oscillator frequency is set at approximately 3, 6, 12, 25, or 50 MHz. At power-on, CCLK always starts operation at its lowest frequency. The device does not start operating at the higher frequency until the ConfigRate control bits are loaded during the configuration process.

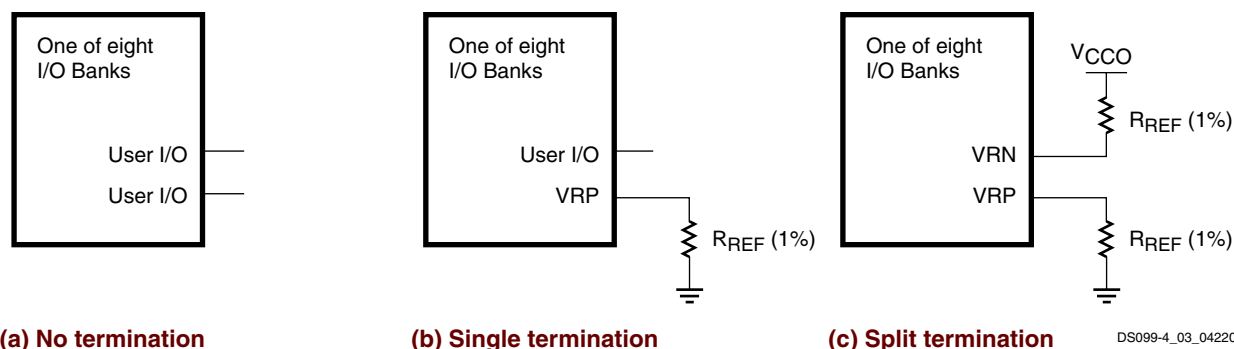


Figure 3: DCI Termination Types

PROG_B: Program/Configure Device

This asynchronous pin initiates the configuration or re-configuration processes. A Low-going pulse resets the configuration logic, initializing the configuration memory. This initialization process cannot finish until PROG_B returns High. Asserting PROG_B Low for an extended period delays the configuration process. At power-up, there is always a weak pull-up resistor to VCCAUX on this pin. After configuration, the bitstream generator option ProgPin determines whether or not the weak pull-up resistor is present. By default, the ProgPin option retains the weak pull-up resistor.

After configuration, hold the PROG_B input High. Any Low-going pulse on PROG_B restarts the configuration process.

Table 5: PROG_B Operation

| PROG_B Input | Response |
|----------------------------|--|
| Power-up | Automatically initiates configuration process. |
| Low-going pulse | Initiate (re-)configuration process and continue to completion. |
| Extended Low | Initiate (re-)configuration process and stall process at step where configuration memory is cleared. Process is stalled until PROG_B returns High. |
| 1 | If the configuration process is started, continue to completion. If configuration process is complete, stay in User mode. |

DONE: Configuration Done, Delay Start-Up Sequence

The FPGA produces a Low-to-High transition on this pin indicating that the configuration process is complete. The bitstream generator option DriveDone determines whether this pin functions as a totem-pole output that can drive High or as an open-drain output. If configured as an open-drain output—which is the default behavior—then a pull-up resistor is required to produce a High logic level. There is a bitstream option that provides an internal weak pull-up resistor, otherwise an external pull-up resistor is required.

The open-drain option permits the DONE lines of multiple FPGAs to be tied together, so that the common node transitions High only after all of the FPGAs have completed configuration. Externally holding the open-drain DONE pin Low delays the start-up sequence, which marks the transition to user mode.

Once the FPGA enters User mode after completing configuration, the DONE pin no longer drives the DONE pin Low. The bitstream generator option DonePin determines whether or not a weak pull-up resistor is present on the DONE pin to pull the pin to VCCAUX. If the weak pull-up resistor is eliminated, then the DONE pin must be pulled High using an external pull-up resistor or one of the FPGAs in the design must actively drive the DONE pin High via the DriveDone bitstream generator option.

The bitstream generator option DriveDone causes the FPGA to actively drive the DONE output High after configuration. This option should only be used in single-FPGA designs or on the last FPGA in a multi-FPGA daisy-chain.

By default, the bitstream generator software retains the weak pull-up resistor and does not actively drive the DONE pin as highlighted in Table 6. Table 6 shows the interaction of these bitstream options in single- and multi-FPGA designs.

Table 6: DonePin and DriveDone Bitstream Option Interaction

| DonePin | DriveDone | Single- or Multi-FPGA Design | Comments |
|----------|-----------|------------------------------|--|
| Pullnone | No | Single | External pull-up resistor, with value between 330Ω to 3.3kΩ required on DONE. |
| Pullnone | No | Multi | External pull-up resistor, with value between 330Ω to 3.3kΩ required on common node connecting to all DONE pins. |
| Pullnone | Yes | Single | OK, no external requirements. |
| Pullnone | Yes | Multi | DriveDone on last device in daisy-chain only. No external requirements. |
| Pullup | No | Single | OK, but weak pull-up on DONE pin has slow rise time. May require 330 Ω pull-up resistor for high CCLK frequencies. |
| Pullup | No | Multi | External pull-up resistor, with value between 330Ω to 3.3kΩ required on common node connecting to all DONE pins. |
| Pullup | Yes | Single | OK, no external requirements. |
| Pullup | Yes | Multi | DriveDone on last device in daisy-chain only. No external requirements. |

M2, M1, M0: Configuration Mode Selection

These inputs select the mode to configure the FPGA. The logic levels applied to the mode pins are sampled on the rising edge of INIT_B.

Table 7: Spartan-3 Configuration Mode Select Settings

| Configuration Mode | M2 | M1 | M0 |
|---------------------|----|----|----|
| Master Serial | 0 | 0 | 0 |
| Slave Serial | 1 | 1 | 1 |
| Master Parallel | 0 | 1 | 1 |
| Slave Parallel | 1 | 1 | 0 |
| JTAG | 1 | 0 | 1 |
| Reserved | 0 | 0 | 1 |
| Reserved | 0 | 1 | 0 |
| Reserved | 1 | 0 | 0 |
| After Configuration | X | X | X |

Notes:

1. X = don't care, either 0 or 1.

In user mode, after configuration successfully completes, any levels applied to these input are ignored. Each of the bitstream generator options M0Pin, M1Pin, and M2Pin determines whether a weak pull-up resistor, weak pull-down resistor, or no resistor is present on its respective mode pin, M0, M1, or M2.

HSWAP_EN: Disable Weak Pull-up Resistors During Configuration

A Low on this asynchronous pin enables weak pull-up resistors on all user I/Os, although only until device configuration

completes. A High disables the weak pull-up resistors (during configuration, which is the desired state for some applications).

Table 8: HSWAP_EN Encoding

| HSWAP_EN | Function |
|---------------------------------------|---|
| During Configuration | |
| 0 | Enable weak pull-up resistors on all pins not actively involved in the configuration process. Pull-ups are only active until configuration completes. See Table 10. |
| 1 | No pull-up resistors during configuration. |
| After Configuration, User Mode | |
| X | This pin has no function except during device configuration. |

Notes:

1. X = don't care, either 0 or 1.

After configuration, HSWAP_EN essentially becomes a "don't care" input and any pull-up resistors previously enabled by HSWAP_EN are disabled. If a user I/O in the application requires a weak pull-up resistor after configuration, place a PULLUP primitive on the associated I/O pin.

The Bitstream generator option HswapenPin determines whether a weak pull-up resistor to VCCAUX, a weak pull-down resistor, or no resistor is present on HSWAP_EN after configuration.

JTAG: Dedicated JTAG Port Pins

These pins are dedicated connections to the four-wire IEEE 1532/IEEE 1149.1 JTAG port, shown in Figure 4 and

described in Table 9. The JTAG port is used for boundary-scan testing, device configuration, application debugging, and possibly an additional serial port for the application. These pins are dedicated and are not available as user-I/O pins. Every package has four dedicated JTAG pins and these pins are powered by the +2.5V VCCAUX supply.

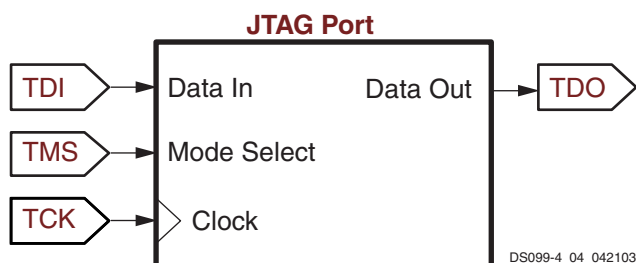


Figure 4: JTAG Port

Using JTAG Port After Configuration

By default, the JTAG port is disabled after the configuration process completes. To continue using the JTAG port, after configuration, place a BSCAN_SPARTAN3 primitive in the design.

Furthermore, the contents of the User ID register within the JTAG port can be specified as a Bitstream Generation option. By default, the 32-bit User ID register contains 0xFFFFFFFF.

Precautions When Using the JTAG Port in 3.3V Environments

The JTAG port is powered by the +2.5V VCCAUX power supply. The JTAG pins can tolerate 3.3V interface signals

but inputs will be clamped by the electro-static discharge (ESD) protection diodes to VCCAUX. Similarly, the TDO pin is a CMOS output powered from +2.5V. Driving a 3.3V input from TDO may require a pull-up resistor to +3.3V.

The following interface precautions are recommended when connecting the JTAG port to a 3.3V interface.

1. Set any inactive JTAG signals, including TCK, Low when not actively used.
2. Drive the JTAG input pins with no more than 10 mA drivers.

VREF: User I/O or Input Buffer Reference Voltage for Special Interface Standards

These pins are individual user-I/O pins unless collectively they supply an input reference voltage, VREF_#, for any SSTL, HSTL, GTL, or GTLP I/Os implemented in the associated I/O bank.

The '#' character in the pin name represents an integer, 0 through 7, that indicates the associated I/O bank.

The VREF function becomes active for this pin whenever a signal standard requiring a reference voltage is used in the associated bank.

If used as a user I/O, then each pin behaves as an independent I/O described in the I/O type section. If used for a reference voltage within a bank, then all VREF pins within the bank must be connected to the same reference voltage.

Spartan-3 devices are designed and characterized to support certain I/O standards when VREF is connected to +1.25V, +1.10V, +1.00V, +0.90V, +0.80V, and +0.75V.

During configuration, these pins behave exactly like user-I/O pins.

Table 9: JTAG Pin Descriptions

| Pin Name | Direction | Description | Bitstream Generation Option |
|----------|-----------|--|--|
| TCK | Input | Test Clock: The TCK clock signal synchronizes all boundary scan operations on its rising edge. | The BitGen option TckPin determines whether a weak pull-up resistor, weak pull-down resistor or no resistor is present. |
| TDI | Input | Test Data Input: TDI is the serial data input for all JTAG instruction and data registers. This input is sampled on the rising edge of TCK. | The BitGen option TdiPin determines whether a weak pull-up resistor, weak pull-down resistor or no resistor is present. |
| TMS | Input | Test Mode Select: The TMS input controls the sequence of states through which the JTAG TAP state machine passes. This input is sampled on the rising edge of TCK. | The BitGen option TmsPin determines whether a weak pull-up resistor, weak pull-down resistor or no resistor is present. |
| TDO | Output | Test Data Output: The TDO pin is the data output for all JTAG instruction and data registers. This output is sampled on the rising edge of TCK. The TDO output is an active totem-pole driver and is not like the open-collector TDO output on Virtex-II Pro FPGAs. | The BitGen option TdoPin determines whether a weak pull-up resistor, weak pull-down resistor or no resistor is present. |

If designing for footprint compatibility across the range of devices in a specific package, and if the VREF_# pins within a bank connect to an input reference voltage, then also connect any N.C. (not connected) pins on the smaller devices in that package to the input reference voltage. More details are provided later for each package type.

N.C. Type: Unconnected Package Pins

Pins marked as “N.C.” are unconnected for the specific device/package combination. For other devices in this same package, this pin may be used as an I/O or VREF connection. In both the pinout tables and the footprint diagrams, unconnected pins are noted with either a black diamond symbol (◆) or a black square symbol (■).

If designing for footprint compatibility across multiple device densities, check the pin types of the other Spartan-3 devices available in the same footprint. If the N.C. pin matches to VREF pins in other devices, and the VREF pins are used in the associated I/O bank, then connect the N.C. to the VREF voltage source.

VCCO Type: Output Voltage Supply for I/O Bank

Each I/O bank has its own set of voltage supply pins that determines the output voltage for the output buffers in the I/O bank. Furthermore, for some I/O standards such as LVCMOS, LVCMOS25, LVTTTL, etc., VCCO sets the input threshold voltage on the associated input buffers.

Spartan-3 devices are designed and characterized to support various I/O standards for VCCO values of +1.2V, +1.5V, +1.8V, +2.5V, and +3.3V.

Most VCCO pins are labeled as VCCO_# where the ‘#’ symbol represents the associated I/O bank number, an integer ranging from 0 to 7. In the 144-pin TQFP package (TQ144) however, the VCCO pins along an edge of the device are combined into a single VCCO input. For example, the VCCO inputs for Bank 0 and Bank 1 along the top edge of the package are combined and relabeled VCCO_TOP. The bottom, left, and right edges are similarly combined.

In Serial configuration mode, VCCO_4 must be at a level compatible with the attached configuration memory or data source. In Parallel configuration mode, both VCCO_4 and VCCO_5 must be at the same compatible voltage level.

All VCCO inputs to a bank must be connected together and to the voltage supply. Furthermore, there must be sufficient supply decoupling to guarantee problem-free operation, as described in [XAPP623: Power Distribution System \(PDS\) Design: Using Bypass/Decoupling Capacitors](#).

VCCINT Type: Voltage Supply for Internal Core Logic

Internal core logic circuits such as the configurable logic blocks (CLBs) and programmable interconnect operate

from the VCCINT voltage supply inputs. VCCINT must be +1.2V.

All VCCINT inputs must be connected together and to the +1.2V voltage supply. Furthermore, there must be sufficient supply decoupling to guarantee problem-free operation, as described in [XAPP623: Power Distribution System \(PDS\) Design: Using Bypass/Decoupling Capacitors](#).

VCCAUX Type: Voltage Supply for Auxiliary Logic

The VCCAUX pins supply power to various auxiliary circuits, such as to the Digital Clock Managers (DCMs), the JTAG pins, and to the dedicated configuration pins (CONFIG type). VCCAUX must be +2.5V.

All VCCAUX inputs must be connected together and to the +2.5V voltage supply. Furthermore, there must be sufficient supply decoupling to guarantee problem-free operation, as described in [XAPP623: Power Distribution System \(PDS\) Design: Using Bypass/Decoupling Capacitors](#).

Because VCCAUX connects to the DCMs and the DCMs are sensitive to voltage changes, be sure that the VCCAUX supply and the ground return paths are designed for low noise and low voltage drop, especially that caused by a large number of simultaneous switching I/Os.

GND Type: Ground

All GND pins must be connected and have a low resistance path back to the various VCCO, VCCINT, and VCCAUX supplies.

Pin Behavior During Configuration

Table 10 shows how various pins behave during the FPGA configuration process. The actual behavior depends on the values applied to the M2, M1, and M0 mode select pins and the HSWAP_EN pin. The mode select pins determine which of the DUAL type pins are active during configuration. In JTAG configuration mode, none of the DUAL-type pins are used for configuration and all behave as user-I/O pins.

All DUAL-type pins not actively used during configuration and all I/O-type, DCI-type, VREF-type, GCLK-type pins are high impedance (floating, three-stated, Hi-Z) during the configuration process. These pins are indicated in **Table 10** as shaded table entries or cells. These pins have a weak pull-up resistor to their associated VCCO if the HSWAP_EN pin is Low.

After configuration completes, some pins have optional behavior controlled by the configuration bitstream loaded into the part. For example, via the bitstream, all unused I/O pins can collectively be configured to have a weak pull-up resistor, a weak pull-down resistor, or be left in a high-impedance state.

Table 10: Pin Behavior After Power-Up, During Configuration

| Pin Name | Configuration Mode Settings <M2:M1:M0> | | | | | Bitstream Configuration Option |
|---|--|---------------|--------------------------|---------------|-------------------|--------------------------------|
| | Serial Modes | | SelectMap Parallel Modes | | JTAG Mode <1:0:1> | |
| | Master <0:0:0> | Slave <1:1:1> | Master <0:1:1> | Slave <1:1:0> | | |
| I/O: General-purpose I/O pins | | | | | | |
| IO | | | | | | UnusedPin |
| IO_Lxxy_# | | | | | | UnusedPin |
| DUAL: Dual-purpose configuration pins | | | | | | |
| IO_Lxxy_#/DIN/D0 | DIN (I) | DIN (I) | D0 (I/O) | D0 (I/O) | | Persist UnusedPin |
| IO_Lxxy_#/D1 | | | D1 (I/O) | D1 (I/O) | | Persist UnusedPin |
| IO_Lxxy_#/D2 | | | D2 (I/O) | D2 (I/O) | | Persist UnusedPin |
| IO_Lxxy_#/D3 | | | D3 (I/O) | D3 (I/O) | | Persist UnusedPin |
| IO_Lxxy_#/D4 | | | D4 (I/O) | D4 (I/O) | | Persist UnusedPin |
| IO_Lxxy_#/D5 | | | D5 (I/O) | D5 (I/O) | | Persist UnusedPin |
| IO_Lxxy_#/D6 | | | D6 (I/O) | D6 (I/O) | | Persist UnusedPin |
| IO_Lxxy_#/D7 | | | D7 (I/O) | D7 (I/O) | | Persist UnusedPin |
| IO_Lxxy_#/CS_B | | | CS_B (I) | CS_B (I) | | Persist UnusedPin |
| IO_Lxxy_#/RDWR_B | | | RDWR_B (I) | RDWR_B (I) | | Persist UnusedPin |
| IO_Lxxy_#/BUSY/DOUT | DOUT (O) | DOUT (O) | BUSY (O) | BUSY (O) | | Persist UnusedPin |
| IO_Lxxy_#/INIT_B | INIT_B (I/OD) | INIT_B (I/OD) | INIT_B (I/OD) | INIT_B (I/OD) | | UnusedPin |
| DCI: Digitally Controlled Impedance reference resistor input pins | | | | | | |
| IO_Lxxy_#/VRN_# | | | | | | UnusedPin |
| IO/VRN_# | | | | | | UnusedPin |
| IO_Lxxy_#/VRP_# | | | | | | UnusedPin |
| IO/VRP_# | | | | | | UnusedPin |


Table 10: Pin Behavior After Power-Up, During Configuration (Continued)

| Pin Name | Configuration Mode Settings <M2:M1:M0> | | | | | Bitstream Configuration Option |
|---|--|------------------------------------|------------------------------------|------------------------------------|-------------------------------------|--------------------------------|
| | Serial Modes | | SelectMap Parallel Modes | | JTAG Mode <1:0:1> | |
| | Master <0:0:0> | Slave <1:1:1> | Master <0:1:1> | Slave <1:1:0> | | |
| GCLK: Global clock buffer inputs | | | | | | |
| IO_Lxxy_#/GCLK0throughGCLK7 | | | | | | UnusedPin |
| VREF: I/O bank input reference voltage pins | | | | | | |
| IO_Lxxy_#/VREF_# | | | | | | UnusedPin |
| IO/VREF_# | | | | | | UnusedPin |
| CONFIG: Dedicated configuration pins | | | | | | |
| CCLK | CCLK (O) | CCLK (I) | CCLK (O) | CCLK (I) | | CclkPin ConfigRate |
| PROG_B | PROG_B (I) (pull-up) | PROG_B (I) (pull-up) | PROG_B (I) (pull-up) | PROG_B (I) (pull-up) | PROG_B (I), Via JPROG_B instruction | ProgPin |
| DONE | DONE (I/OD) | DONE (I/OD) | DONE (I/OD) | DONE (I/OD) | DONE (I/OD) | DriveDone DonePin DonePipe |
| M2 | M2=0 (I) | M2=1 (I) | M2=0 (I) | M2=1 (I) | M2=1 (I) | M2Pin |
| M1 | M1=0 (I) | M1=1 (I) | M1=1 (I) | M1=1 (I) | M1=0 (I) | M1Pin |
| M0 | M0=0 (I) | M0=1 (I) | M0=1 (I) | M0=0 (I) | M0=1 (I) | M0Pin |
| HSWAP_EN | HSWAP_EN (I) | HSWAP_EN (I) | HSWAP_EN (I) | HSWAP_EN (I) | HSWAP_EN (I) | HswapenPin |
| JTAG: JTAG interface pins | | | | | | |
| TDI | TDI (I) | TDI (I) | TDI (I) | TDI (I) | TDI (I) | TdiPin |
| TMS | TMS (I) | TMS (I) | TMS (I) | TMS (I) | TMS (I) | TmsPin |
| TCK | TCK (I) | TCK (I) | TCK (I) | TCK (I) | TCK (I) | TckPin |
| TDO | TDO (O) | TDO (O) | TDO (O) | TDO (O) | TDO (O) | TdoPin |
| VCCO: I/O bank output voltage supply pins | | | | | | |
| VCCO_4 (for DUAL pins) | Same voltage as external interface | Same voltage as external interface | Same voltage as external interface | Same voltage as external interface | VCCO_4 | |
| VCCO_5 (for DUAL pins) | VCCO_5 | VCCO_5 | Same voltage as external interface | Same voltage as external interface | VCCO_5 | |
| VCCO_# | VCCO_# | VCCO_# | VCCO_# | VCCO_# | VCCO_# | |
| VCCAUX: Auxiliary voltage supply pins | | | | | | |
| VCCAUX | +2.5V | +2.5V | +2.5V | +2.5V | +2.5V | |

Table 10: Pin Behavior After Power-Up, During Configuration (Continued)

| Pin Name | Configuration Mode Settings <M2:M1:M0> | | | | | Bitstream Configuration Option |
|---|--|---------------|--------------------------|---------------|-------------------|--------------------------------|
| | Serial Modes | | SelectMap Parallel Modes | | JTAG Mode <1:0:1> | |
| | Master <0:0:0> | Slave <1:1:1> | Master <0:1:1> | Slave <1:1:0> | | |
| VCCINT: Internal core voltage supply pins | | | | | | |
| VCCINT | +1.2V | +1.2V | +1.2V | +1.2V | +1.2V | |
| GND: Ground supply pins | | | | | | |
| GND | GND | GND | GND | GND | GND | |

Notes:

1. # = I/O bank number, an integer from 0 to 7.
2. (I) = input, (O) = output, (OD) = open-drain output, (I/O) = bidirectional, (I/OD) = bidirectional with open-drain output. Open-drain output requires pull-up to create logic High level.
3.  Shaded cell indicates that the pin is high-impedance during configuration. To enable a soft pull-up resistor during configuration, drive or tie HSWAP_EN Low.

Bitstream Options

Table 11 lists the various bitstream options that affect pins on a Spartan-3 FPGA. The table shows the names of the affected pins, describes the function of the bitstream option,

the name of the bitstream generator option variable, and the legal values for each variable. The default option setting for each variable is indicated with bold, underlined text.

Table 11: Bitstream Options Affecting Spartan-3 Pins

| Affected Pin Name(s) | Bitstream Generation Function | Option Variable Name | Values (default value) |
|--|---|----------------------|--|
| All unused I/O pins of type I/O, DUAL, GCLK, DCI, VREF | For all I/O pins that are unused after configuration, this option defines whether the I/Os are individually tied to VCCO via a weak pull-up resistor, tied ground via a weak pull-down resistor, or left floating. If left floating, the unused pins should be connected to a defined logic level, either from a source internal to the FPGA or external. | UnusedPin | <ul style="list-style-type: none"> • <u>Pulldown</u> • Pullup • Pullnone |
| IO_Lxxy_#/DIN, IO_Lxxy_#/DOUT, IO_Lxxy_#/INIT_B | Serial configuration mode: If set to Yes, then these pins retain their functionality after configuration completes, allowing for device (re-)configuration. Readback is not supported in with serial mode. | Persist | <ul style="list-style-type: none"> • <u>No</u> • Yes |
| IO_Lxxy_#/D0, IO_Lxxy_#/D1, IO_Lxxy_#/D2, IO_Lxxy_#/D3, IO_Lxxy_#/D4, IO_Lxxy_#/D5, IO_Lxxy_#/D6, IO_Lxxy_#/D7, IO_Lxxy_#/CS_B, IO_Lxxy_#/RDWR_B, IO_Lxxy_#/BUSY, IO_Lxxy_#/INIT_B | Parallel configuration mode (also called SelectMAP): If set to Yes, then these pins retain their SelectMAP functionality after configuration completes, allowing for device readback and for partial or complete (re-)configuration. | Persist | <ul style="list-style-type: none"> • <u>No</u> • Yes |
| CCLK | After configuration, this bitstream option either pulls CCLK to VCCAUX via a weak pull-up resistor, or allows CCLK to float. | CclkPin | <ul style="list-style-type: none"> • <u>Pullup</u> • Pullnone |
| CCLK | For Master configuration modes, this option sets the approximate frequency, in MHz, for the internal silicon oscillator. | ConfigRate | 3, <u>6</u> , 12, 25, 50 |

Table 11: Bitstream Options Affecting Spartan-3 Pins (Continued)

| Affected Pin Name(s) | Bitstream Generation Function | Option Variable Name | Values (default value) |
|----------------------|--|----------------------|---|
| PROG_B | A weak pull-up resistor to VCCAUX exists on PROG_B during configuration. After configuration, this bitstream option either pulls DONE to VCCAUX via a weak pull-up resistor, or allows DONE to float. | ProgPin | <ul style="list-style-type: none"> Pullup Pullnone |
| DONE | After configuration, this bitstream option either pulls DONE to VCCAUX via a weak pull-up resistor, or allows DONE to float. See also DriveDone option. | DonePin | <ul style="list-style-type: none"> Pullup Pullnone |
| DONE | If set to Yes, this option allows the FPGA's DONE pin to drive High when configuration completes. By default, the DONE is an open-drain output and can only drive Low. Only single FPGAs and the last FPGA in a multi-FPGA daisy-chain should use this option. | DriveDone | <ul style="list-style-type: none"> No Yes |
| M2 | After configuration, this bitstream option either pulls M2 to VCCAUX via a weak pull-up resistor, to ground via a weak pull-down resistor, or allows M2 to float. | M2Pin | <ul style="list-style-type: none"> Pullup Pulldown Pullnone |
| M1 | After configuration, this bitstream option either pulls M1 to VCCAUX via a weak pull-up resistor, to ground via a weak pull-down resistor, or allows M1 to float. | M1Pin | <ul style="list-style-type: none"> Pullup Pulldown Pullnone |
| M0 | After configuration, this bitstream option either pulls M0 to VCCAUX via a weak pull-up resistor, to ground via a weak pull-down resistor, or allows M0 to float. | M0Pin | <ul style="list-style-type: none"> Pullup Pulldown Pullnone |
| HSWAP_EN | After configuration, this bitstream option either pulls HSWAP_EN to VCCAUX via a weak pull-up resistor, to ground via a weak pull-down resistor, or allows HSWAP_EN to float. | HswapenPin | <ul style="list-style-type: none"> Pullup Pulldown Pullnone |
| TDI | After configuration, this bitstream option either pulls TDI to VCCAUX via a weak pull-up resistor, to ground via a weak pull-down resistor, or allows TDI to float. | TdiPin | <ul style="list-style-type: none"> Pullup Pulldown Pullnone |
| TMS | After configuration, this bitstream option either pulls TMS to VCCAUX via a weak pull-up resistor, to ground via a weak pull-down resistor, or allows TMS to float. | TmsPin | <ul style="list-style-type: none"> Pullup Pulldown Pullnone |
| TCK | After configuration, this bitstream option either pulls TCK to VCCAUX via a weak pull-up resistor, to ground via a weak pull-down resistor, or allows TCK to float. | TckPin | <ul style="list-style-type: none"> Pullup Pulldown Pullnone |
| TDO | After configuration, this bitstream option either pulls TDO to VCCAUX via a weak pull-up resistor, to ground via a weak pull-down resistor, or allows TDO to float. | TdoPin | <ul style="list-style-type: none"> Pullup Pulldown Pullnone |

Setting Options via BitGen Command-Line Program

To set one or more bitstream generator options using the BitGen command-line program, enter

```
bitgen -g <variable_name>:<value>
[<variable_name>:<value> ...]
```

where **<variable_name>** is one of the entries from Table 11 and **<value>** is one of the possible values for the specified variable. Multiple bitstream options may be entered in this manner.

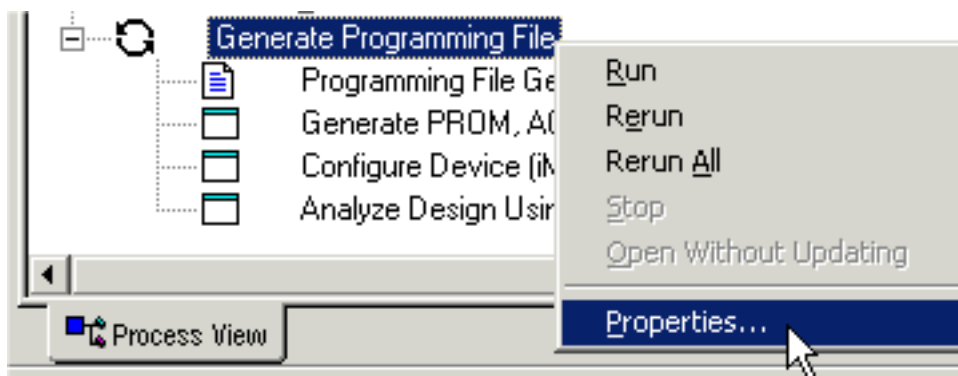
For a complete listing of all BitGen options, their possible settings, and their default settings, enter the following command.

```
bitgen -help spartan3
```

Setting Options in Project Navigator

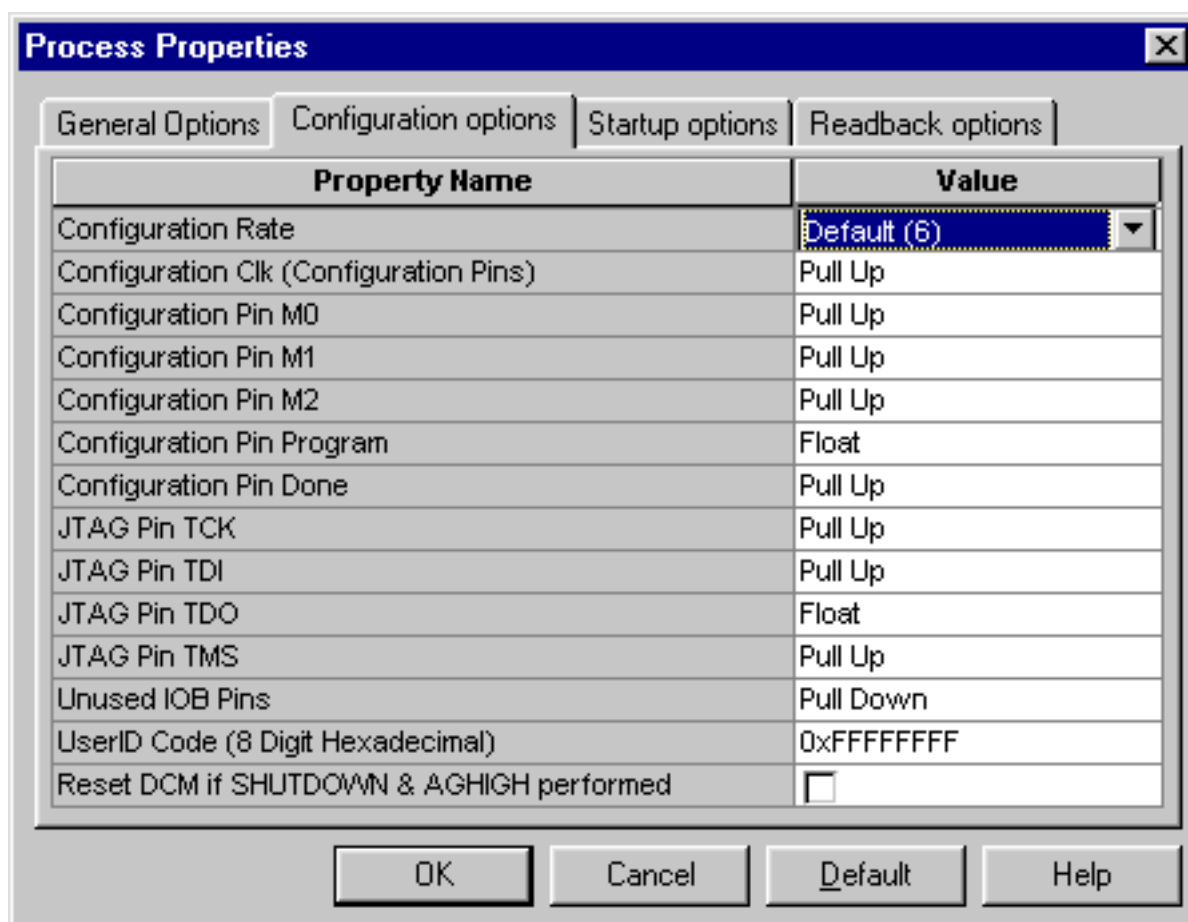
To set the bitstream generation options in Xilinx ISE Project Navigator, right-click on the **Generate Programming File** step in the Process View and click **Properties**, as shown in Figure 5.

Click the **Configuration options** tab and modify the available options as required by the application, as shown in Figure 6.



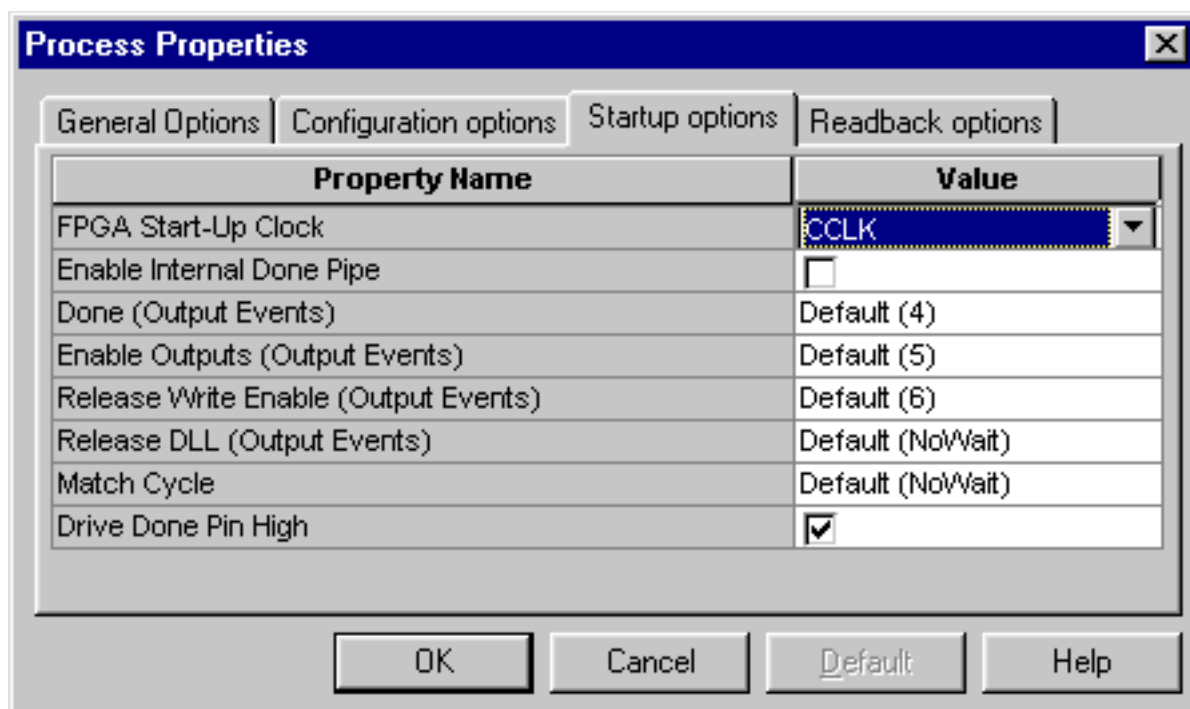
DS099-4_05_030103

Figure 5: Setting Properties for Generate Programming File Step



DS099-4_06_030103

Figure 6: Configuration Option Settings



DS099-4_07_030103

Figure 7: Setting to Drive DONE Pin High after Configuration

To have the DONE pin drive High after successful configuration, click the **Startup options** tab and check the **Drive Done Pin High** box, as shown in Figure 7.

Click **OK** when finished.

Again, right-click on the **Generate Programming File** step in the Process View. This time, choose **Run** or **Rerun** to execute the changes.

Package Overview

Table 12 shows the eight, low-cost, space-saving production packages for the Spartan-3 family. Not all Spartan-3 densities are available in all packages. However, for a specific package there is a common footprint for that supports the various devices available in that package. See the footprint diagrams that follow.

Table 12: Spartan-3 Family Package Options

| Package | Leads | Type | Maximum I/O | Pitch (mm) | Area (mm) | Height (mm) |
|---------|-------|----------------------------------|-------------|------------|-------------|-------------|
| VQ100 | 100 | Very-thin Quad Flat Pack | 63 | 0.5 | 16 x 16 | 1.20 |
| TQ144 | 144 | Thin Quad Flat Pack | 97 | 0.5 | 22 x 22 | 1.60 |
| PQ208 | 208 | Quad Flat Pack | 141 | 0.5 | 30.6 x 30.6 | 4.10 |
| FT256 | 256 | Fine-pitch, Thin Ball Grid Array | 173 | 1.0 | 17 x 17 | 1.55 |
| FG456 | 456 | Fine-pitch Ball Grid Array | 333 | 1.0 | 23 x 23 | 2.60 |
| FG676 | 676 | Fine-pitch Ball Grid Array | 405 | 1.0 | 27 x 27 | 2.60 |
| FG900 | 900 | Fine-pitch Ball Grid Array | 549 | 1.0 | 31 x 31 | 2.60 |
| FG1156 | 1156 | Fine-pitch Ball Grid Array | 692 | 1.0 | 35 x 35 | 2.60 |

Detailed mechanical drawings for each package type are available from the Xilinx web site at the specified location in [Table 13](#).

Table 13: Xilinx Package Mechanical Drawings

| Package | Web Link (URL) |
|---------|---|
| VQ100 | http://www.xilinx.com/bvdocs/packages/vq100.pdf |
| TQ144 | http://www.xilinx.com/bvdocs/packages/tq144.pdf |
| PQ208 | http://www.xilinx.com/bvdocs/packages/pq208.pdf |
| FT256 | http://www.xilinx.com/bvdocs/packages/ft256.pdf |
| FG456 | http://www.xilinx.com/bvdocs/packages/fg456.pdf |
| FG676 | http://www.xilinx.com/bvdocs/packages/fg676.pdf |
| FG900 | http://www.xilinx.com/bvdocs/packages/fg900.pdf |
| FG1156 | http://www.xilinx.com/bvdocs/packages/fg1156.pdf |

Each package has three separate voltage supply inputs—VCCINT, VCCAUX, and VCCO—and a common ground return, GND. The numbers of pins dedicated to these functions varies by package, as shown in [Table 14](#).

Table 14: Power and Ground Supply Pins by Package

| Package | VCCINT | VCCAUX | VCCO | GND |
|---------|--------|--------|------|-----|
| VQ100 | 4 | 4 | 8 | 10 |
| TQ144 | 4 | 4 | 12 | 16 |
| PQ208 | 4 | 8 | 12 | 28 |
| FT256 | 8 | 8 | 24 | 32 |
| FG456 | 12 | 8 | 40 | 52 |
| FG676 | 20 | 16 | 64 | 76 |
| FG900 | 32 | 24 | 80 | 120 |
| FG1156 | 40 | 32 | 104 | 184 |

A majority of package pins are user-defined I/O pins. However, the numbers and characteristics of these I/O depends on the device type and the package in which it is available, as shown in [Table 15](#). The table shows the maximum number of single-ended I/O pins available, assuming that all I/O-, DUAL-, DCI-, VREF-, and GCLK-type pins are used as general-purpose I/O. Likewise, the table shows the maximum number of differential pin-pairs available on the package. Finally, the table shows how the total maximum user I/Os are distributed by pin type, including the number of unconnected—i.e., N.C.—pins on the device.

Table 15: Maximum User I/Os by Package

| Device | Package | Maximum User I/Os | Maximum Differential Pairs | All Possible I/O Pins by Type | | | | | N.C. |
|---------|---------|-------------------|----------------------------|-------------------------------|------|-----|------|------|------|
| | | | | I/O | DUAL | DCI | VREF | GCLK | |
| XC3S50 | VQ100 | 63 | 29 | 22 | 12 | 14 | 7 | 8 | 0 |
| XC3S200 | VQ100 | 63 | 29 | 22 | 12 | 14 | 7 | 8 | 0 |
| XC3S50 | TQ144 | 97 | 46 | 51 | 12 | 14 | 12 | 8 | 0 |
| XC3S200 | TQ144 | 97 | 46 | 51 | 12 | 14 | 12 | 8 | 0 |
| XC3S400 | TQ144 | 97 | 46 | 51 | 12 | 14 | 12 | 8 | 0 |
| XC3S50 | PQ208 | 124 | 56 | 72 | 12 | 16 | 16 | 8 | 17 |
| XC3S200 | PQ208 | 141 | 62 | 83 | 12 | 16 | 22 | 8 | 0 |
| XC3S400 | PQ208 | 141 | 62 | 83 | 12 | 16 | 22 | 8 | 0 |

Table 15: Maximum User I/Os by Package (Continued)

| Device | Package | Maximum User I/Os | Maximum Differential Pairs | All Possible I/O Pins by Type | | | | | N.C. |
|----------|---------|-------------------|----------------------------|-------------------------------|------|-----|------|------|------|
| | | | | I/O | DUAL | DCI | VREF | GCLK | |
| XC3S200 | FT256 | 173 | 76 | 113 | 12 | 16 | 24 | 8 | 0 |
| XC3S400 | FT256 | 173 | 76 | 113 | 12 | 16 | 24 | 8 | 0 |
| XC3S1000 | FT256 | 173 | 76 | 113 | 12 | 16 | 24 | 8 | 0 |
| XC3S400 | FG456 | 264 | 116 | 196 | 12 | 16 | 32 | 8 | 69 |
| XC3S1000 | FG456 | 333 | 149 | 261 | 12 | 16 | 36 | 8 | 0 |
| XC3S1500 | FG456 | 333 | 149 | 261 | 12 | 16 | 36 | 8 | 0 |
| XC3S1000 | FG676 | 391 | 175 | 315 | 12 | 16 | 40 | 8 | 98 |
| XC3S1500 | FG676 | 487 | 221 | 403 | 12 | 16 | 48 | 8 | 2 |
| XC3S2000 | FG676 | 489 | 221 | 405 | 12 | 16 | 48 | 8 | 0 |
| XC3S2000 | FG900 | 565 | 270 | 481 | 12 | 16 | 48 | 8 | 68 |
| XC3S4000 | FG900 | 633 | 300 | 549 | 12 | 16 | 48 | 8 | 0 |
| XC3S5000 | FG900 | 633 | 300 | 549 | 12 | 16 | 48 | 8 | 0 |
| XC3S4000 | FG1156 | 712 | 312 | 621 | 12 | 16 | 55 | 8 | 73 |
| XC3S5000 | FG1156 | 784 | 344 | 692 | 12 | 16 | 56 | 8 | 1 |

Electronic versions of the package pinout tables and footprints are available for download from the Xilinx web site. Using a spreadsheet program, the data can be sorted and reformatted according to any specific needs. Similarly, the

ASCII-text file is easily parsed by most scripting programs. Download the files from the following location:

http://www.xilinx.com/bvdocs/publications/s3_pin.zip

VQ100: 100-lead Very-thin Quad Flat Package

The XC3S50 and the XC3S200 devices are available in the 100-lead very-thin quad flat package, VQ100. Both devices share a common footprint for this package as shown in [Table 16](#) and [Figure 8](#).

All the package pins appear in [Table 16](#) and are sorted by bank number, then by pin name. Pairs of pins that form a differential I/O pair appear together in the table. The table also shows the pin number for each pin and the pin type, as defined earlier.

Pinout Table

Table 16: VQ100 Package Pinout

| Bank | XC3S50 XC3S200 Pin Name | VQ100 Pin Number | Type |
|------|-------------------------------|---------------------|------|
| 0 | IO_L01N_0/VRP_0 | P97 | DCI |
| 0 | IO_L01P_0/VRN_0 | P96 | DCI |
| 0 | IO_L31N_0 | P92 | I/O |
| 0 | IO_L31P_0/VREF_0 | P91 | VREF |
| 0 | IO_L32N_0/GCLK7 | P90 | GCLK |
| 0 | IO_L32P_0/GCLK6 | P89 | GCLK |
| 0 | VCCO_0 | P94 | VCCO |
| 1 | IO | P81 | I/O |
| 1 | IO_L01N_1/VRP_1 | P80 | DCI |
| 1 | IO_L01P_1/VRN_1 | P79 | DCI |
| 1 | IO_L31N_1/VREF_1 | P86 | VREF |
| 1 | IO_L31P_1 | P85 | I/O |
| 1 | IO_L32N_1/GCLK5 | P88 | GCLK |
| 1 | IO_L32P_1/GCLK4 | P87 | GCLK |
| 1 | VCCO_1 | P83 | VCCO |
| 2 | IO_L01N_2/VRP_2 | P75 | DCI |
| 2 | IO_L01P_2/VRN_2 | P74 | DCI |
| 2 | IO_L21N_2 | P72 | I/O |
| 2 | IO_L21P_2 | P71 | I/O |
| 2 | IO_L24N_2 | P68 | I/O |
| 2 | IO_L24P_2 | P67 | I/O |
| 2 | IO_L40N_2 | P65 | I/O |
| 2 | IO_L40P_2/VREF_2 | P64 | VREF |
| 2 | VCCO_2 | P70 | VCCO |
| 3 | IO | P55 | I/O |
| 3 | IO | P59 | I/O |
| 3 | IO_L01N_3/VRP_3 | P54 | DCI |
| 3 | IO_L01P_3/VRN_3 | P53 | DCI |
| 3 | IO_L24N_3 | P61 | I/O |

Table 16: VQ100 Package Pinout

| Bank | XC3S50 XC3S200 Pin Name | VQ100 Pin Number | Type |
|------|-------------------------------|---------------------|------|
| 3 | IO_L24P_3 | P60 | I/O |
| 3 | IO_L40N_3/VREF_3 | P63 | VREF |
| 3 | IO_L40P_3 | P62 | I/O |
| 3 | VCCO_3 | P57 | VCCO |
| 4 | IO_L01N_4/VRP_4 | P50 | DCI |
| 4 | IO_L01P_4/VRN_4 | P49 | DCI |
| 4 | IO_L27N_4/DIN/D0 | P48 | DUAL |
| 4 | IO_L27P_4/D1 | P47 | DUAL |
| 4 | IO_L30N_4/D2 | P44 | DUAL |
| 4 | IO_L30P_4/D3 | P43 | DUAL |
| 4 | IO_L31N_4/INIT_B | P42 | DUAL |
| 4 | IO_L31P_4/DOOUT/BUSY | P40 | DUAL |
| 4 | IO_L32N_4/GCLK1 | P39 | GCLK |
| 4 | IO_L32P_4/GCLK0 | P38 | GCLK |
| 4 | VCCO_4 | P46 | VCCO |
| 5 | IO_L01N_5/RDWR_B | P28 | DUAL |
| 5 | IO_L01P_5/CS_B | P27 | DUAL |
| 5 | IO_L28N_5/D6 | P32 | DUAL |
| 5 | IO_L28P_5/D7 | P30 | DUAL |
| 5 | IO_L31N_5/D4 | P35 | DUAL |
| 5 | IO_L31P_5/D5 | P34 | DUAL |
| 5 | IO_L32N_5/GCLK3 | P37 | GCLK |
| 5 | IO_L32P_5/GCLK2 | P36 | GCLK |
| 5 | VCCO_5 | P31 | VCCO |
| 6 | IO | P17 | I/O |
| 6 | IO | P21 | I/O |
| 6 | IO_L01N_6/VRP_6 | P23 | DCI |
| 6 | IO_L01P_6/VRN_6 | P22 | DCI |
| 6 | IO_L24N_6/VREF_6 | P16 | VREF |
| 6 | IO_L24P_6 | P15 | I/O |
| 6 | IO_L40N_6 | P14 | I/O |
| 6 | IO_L40P_6/VREF_6 | P13 | VREF |
| 6 | VCCO_6 | P19 | VCCO |
| 7 | IO_L01N_7/VRP_7 | P2 | DCI |
| 7 | IO_L01P_7/VRN_7 | P1 | DCI |
| 7 | IO_L21N_7 | P5 | I/O |
| 7 | IO_L21P_7 | P4 | I/O |
| 7 | IO_L23N_7 | P9 | I/O |
| 7 | IO_L23P_7 | P8 | I/O |
| 7 | IO_L40N_7/VREF_7 | P12 | VREF |
| 7 | IO_L40P_7 | P11 | I/O |

Table 16: VQ100 Package Pinout

| Bank | XC3S50 XC3S200 Pin Name | VQ100 Pin Number | Type |
|------|-------------------------------|---------------------|--------|
| 7 | VCCO_7 | P6 | VCCO |
| N/A | GND | P3 | GND |
| N/A | GND | P10 | GND |
| N/A | GND | P20 | GND |
| N/A | GND | P29 | GND |
| N/A | GND | P41 | GND |
| N/A | GND | P56 | GND |
| N/A | GND | P66 | GND |
| N/A | GND | P73 | GND |
| N/A | GND | P82 | GND |
| N/A | GND | P95 | GND |
| N/A | VCCAUX | P7 | VCCAUX |
| N/A | VCCAUX | P33 | VCCAUX |
| N/A | VCCAUX | P58 | VCCAUX |
| N/A | VCCAUX | P84 | VCCAUX |
| N/A | VCCINT | P18 | VCCINT |
| N/A | VCCINT | P45 | VCCINT |
| N/A | VCCINT | P69 | VCCINT |

Table 16: VQ100 Package Pinout

| Bank | XC3S50 XC3S200 Pin Name | VQ100 Pin Number | Type |
|--------|-------------------------------|---------------------|--------|
| N/A | VCCINT | P93 | VCCINT |
| VCCAUX | CCLK | P52 | CONFIG |
| VCCAUX | DONE | P51 | CONFIG |
| VCCAUX | HSWAP_EN | P98 | CONFIG |
| VCCAUX | M0 | P25 | CONFIG |
| VCCAUX | M1 | P24 | CONFIG |
| VCCAUX | M2 | P26 | CONFIG |
| VCCAUX | PROG_B | P99 | CONFIG |
| VCCAUX | TCK | P77 | JTAG |
| VCCAUX | TDI | P100 | JTAG |
| VCCAUX | TDO | P76 | JTAG |
| VCCAUX | TMS | P78 | JTAG |

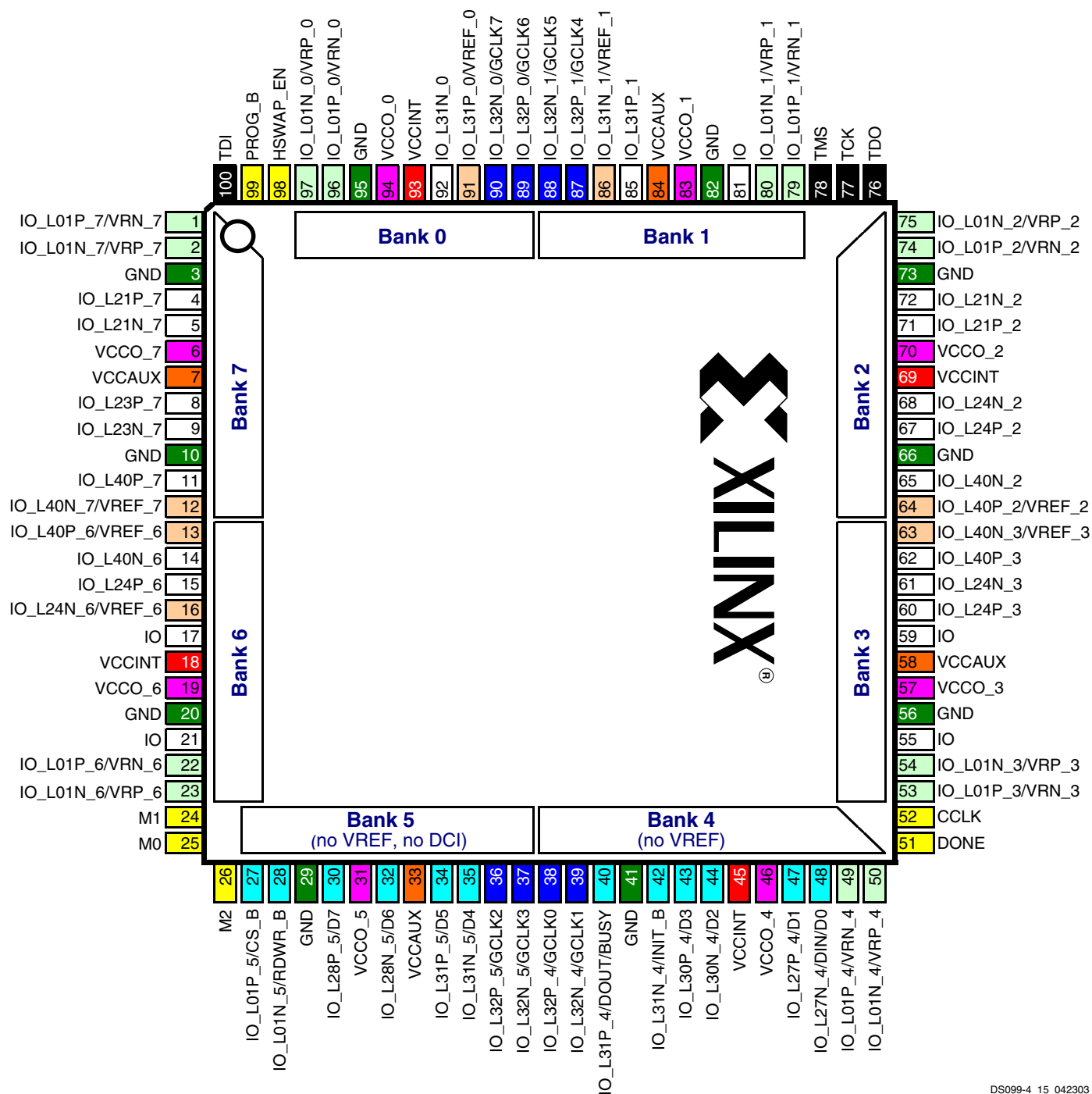
User I/Os by Bank

Table 17 indicates how the available user-I/O pins are distributed between the eight I/O banks on the VQ100 package.

Table 17: User I/Os Per Bank in VQ100 Package

| Package Edge | I/O Bank | Maximum I/O | All Possible I/O Pins by Type | | | | |
|--------------|----------|----------------|-------------------------------|------|-----|------|------|
| | | | I/O | DUAL | DCI | VREF | GCLK |
| Top | 0 | 6 | 1 | 0 | 2 | 1 | 2 |
| | 1 | 7 | 2 | 0 | 2 | 1 | 2 |
| Right | 2 | 8 | 5 | 0 | 2 | 1 | 0 |
| | 3 | 8 | 5 | 0 | 2 | 1 | 0 |
| Bottom | 4 | 10 | 0 | 6 | 2 | 0 | 2 |
| | 5 | 8 | 0 | 6 | 0 | 0 | 2 |
| Left | 6 | 8 | 4 | 0 | 2 | 2 | 0 |
| | 7 | 8 | 5 | 0 | 2 | 1 | 0 |

VQ100 Footprint



DS099-4_15_042303

Figure 8: VQ100 Package Footprint (top view). Note pin 1 indicator in top-left corner and logo orientation.

| | | | | | |
|----|---|----|--|---|---|
| 22 | I/O: Unrestricted, general-purpose user I/O | 12 | DUAL: Configuration pin, then possible user I/O | 7 | VREF: User I/O or input voltage reference for bank |
| 14 | DCI: User I/O or reference resistor input for bank | 8 | GCLK: User I/O or global clock buffer input | 8 | VCCO: Output voltage supply for bank |
| 7 | CONFIG: Dedicated configuration pins | 4 | JTAG: Dedicated JTAG port pins | 4 | VCCINT: Internal core voltage supply (+1.2V) |
| 0 | N.C.: No unconnected pins in this package | 10 | GND: Ground | 4 | VCCAUX: Auxiliary voltage supply (+2.5V) |

TQ144: 144-lead Thin Quad Flat Package

The XC3S50, the XC3S200, and the XC3S400 are available in the 144-lead thin quad flat package, TQ144. Consequently, there is only one footprint for this package as shown in [Table 18](#) and [Figure 9](#).

The TQ144 package only has four separate VCCO inputs, unlike the other packages, which have eight separate VCCO inputs. The TQ144 package has a separate VCCO input for the top, bottom, left, and right. However, there are still eight separate I/O banks, as shown in [Table 18](#) and [Figure 9](#). Banks 0 and 1 share the VCCO_TOP input, Banks 2 and 3 share the VCCO_RIGHT input, Banks 4 and 5 share the VCCO_BOTTOM input, and Banks 6 and 7 share the VCCO_LEFT input.

All the package pins appear in [Table 18](#) and are sorted by bank number, then by pin name. Pairs of pins that form a differential I/O pair appear together in the table. The table also shows the pin number for each pin and the pin type, as defined earlier.

Pinout Table

Table 18: TQ144 Package Pinout

| Bank | XC3S50 XC3S200 XC3S400 Pin Name | TQ144 Pin Number | Type |
|------|--|---------------------|------|
| 0 | IO_L01N_0/VRP_0 | P141 | DCI |
| 0 | IO_L01P_0/VRN_0 | P140 | DCI |
| 0 | IO_L27N_0 | P137 | I/O |
| 0 | IO_L27P_0 | P135 | I/O |
| 0 | IO_L30N_0 | P132 | I/O |
| 0 | IO_L30P_0 | P131 | I/O |
| 0 | IO_L31N_0 | P130 | I/O |
| 0 | IO_L31P_0/VREF_0 | P129 | VREF |
| 0 | IO_L32N_0/GCLK7 | P128 | GCLK |
| 0 | IO_L32P_0/GCLK6 | P127 | GCLK |
| 1 | IO | P116 | I/O |
| 1 | IO_L01N_1/VRP_1 | P113 | DCI |
| 1 | IO_L01P_1/VRN_1 | P112 | DCI |
| 1 | IO_L28N_1 | P119 | I/O |
| 1 | IO_L28P_1 | P118 | I/O |
| 1 | IO_L31N_1/VREF_1 | P123 | VREF |
| 1 | IO_L31P_1 | P122 | I/O |
| 1 | IO_L32N_1/GCLK5 | P125 | GCLK |
| 1 | IO_L32P_1/GCLK4 | P124 | GCLK |
| 2 | IO_L01N_2/VRP_2 | P108 | DCI |
| 2 | IO_L01P_2/VRN_2 | P107 | DCI |
| 2 | IO_L20N_2 | P105 | I/O |

Table 18: TQ144 Package Pinout (Continued)

| Bank | XC3S50 XC3S200 XC3S400 Pin Name | TQ144 Pin Number | Type |
|------|--|---------------------|------|
| 2 | IO_L20P_2 | P104 | I/O |
| 2 | IO_L21N_2 | P103 | I/O |
| 2 | IO_L21P_2 | P102 | I/O |
| 2 | IO_L22N_2 | P100 | I/O |
| 2 | IO_L22P_2 | P99 | I/O |
| 2 | IO_L23N_2/VREF_2 | P98 | VREF |
| 2 | IO_L23P_2 | P97 | I/O |
| 2 | IO_L24N_2 | P96 | I/O |
| 2 | IO_L24P_2 | P95 | I/O |
| 2 | IO_L40N_2 | P93 | I/O |
| 2 | IO_L40P_2/VREF_2 | P92 | VREF |
| 3 | IO | P76 | I/O |
| 3 | IO_L01N_3/VRP_3 | P74 | DCI |
| 3 | IO_L01P_3/VRN_3 | P73 | DCI |
| 3 | IO_L20N_3 | P78 | I/O |
| 3 | IO_L20P_3 | P77 | I/O |
| 3 | IO_L21N_3 | P80 | I/O |
| 3 | IO_L21P_3 | P79 | I/O |
| 3 | IO_L22N_3 | P83 | I/O |
| 3 | IO_L22P_3 | P82 | I/O |
| 3 | IO_L23N_3 | P85 | I/O |
| 3 | IO_L23P_3/VREF_3 | P84 | VREF |
| 3 | IO_L24N_3 | P87 | I/O |
| 3 | IO_L24P_3 | P86 | I/O |
| 3 | IO_L40N_3/VREF_3 | P90 | VREF |
| 3 | IO_L40P_3 | P89 | I/O |
| 4 | IO/VREF_4 | P70 | VREF |
| 4 | IO_L01N_4/VRP_4 | P69 | DCI |
| 4 | IO_L01P_4/VRN_4 | P68 | DCI |
| 4 | IO_L27N_4/DIN/D0 | P65 | DUAL |
| 4 | IO_L27P_4/D1 | P63 | DUAL |
| 4 | IO_L30N_4/D2 | P60 | DUAL |
| 4 | IO_L30P_4/D3 | P59 | DUAL |
| 4 | IO_L31N_4/INIT_B | P58 | DUAL |
| 4 | IO_L31P_4/DOU/BUSY | P57 | DUAL |
| 4 | IO_L32N_4/GCLK1 | P56 | GCLK |
| 4 | IO_L32P_4/GCLK0 | P55 | GCLK |
| 5 | IO/VREF_5 | P44 | VREF |
| 5 | IO_L01N_5/RDWR_B | P41 | DUAL |
| 5 | IO_L01P_5/CS_B | P40 | DUAL |
| 5 | IO_L28N_5/D6 | P47 | DUAL |

Table 18: TQ144 Package Pinout (Continued)

| Bank | XC3S50 XC3S200 XC3S400 Pin Name | TQ144 Pin Number | Type |
|------|--|---------------------|------|
| 5 | IO_L28P_5/D7 | P46 | DUAL |
| 5 | IO_L31N_5/D4 | P51 | DUAL |
| 5 | IO_L31P_5/D5 | P50 | DUAL |
| 5 | IO_L32N_5/GCLK3 | P53 | GCLK |
| 5 | IO_L32P_5/GCLK2 | P52 | GCLK |
| 6 | IO_L01N_6/VRP_6 | P36 | DCI |
| 6 | IO_L01P_6/VRN_6 | P35 | DCI |
| 6 | IO_L20N_6 | P33 | I/O |
| 6 | IO_L20P_6 | P32 | I/O |
| 6 | IO_L21N_6 | P31 | I/O |
| 6 | IO_L21P_6 | P30 | I/O |
| 6 | IO_L22N_6 | P28 | I/O |
| 6 | IO_L22P_6 | P27 | I/O |
| 6 | IO_L23N_6 | P26 | I/O |
| 6 | IO_L23P_6 | P25 | I/O |
| 6 | IO_L24N_6/VREF_6 | P24 | VREF |
| 6 | IO_L24P_6 | P23 | I/O |
| 6 | IO_L40N_6 | P21 | I/O |
| 6 | IO_L40P_6/VREF_6 | P20 | VREF |
| 7 | IO/VREF_7 | P4 | VREF |
| 7 | IO_L01N_7/VRP_7 | P2 | DCI |
| 7 | IO_L01P_7/VRN_7 | P1 | DCI |
| 7 | IO_L20N_7 | P6 | I/O |
| 7 | IO_L20P_7 | P5 | I/O |
| 7 | IO_L21N_7 | P8 | I/O |
| 7 | IO_L21P_7 | P7 | I/O |
| 7 | IO_L22N_7 | P11 | I/O |
| 7 | IO_L22P_7 | P10 | I/O |
| 7 | IO_L23N_7 | P13 | I/O |
| 7 | IO_L23P_7 | P12 | I/O |
| 7 | IO_L24N_7 | P15 | I/O |
| 7 | IO_L24P_7 | P14 | I/O |
| 7 | IO_L40N_7/VREF_7 | P18 | VREF |
| 7 | IO_L40P_7 | P17 | I/O |
| 0,1 | VCCO_TOP | P126 | VCCO |
| 0,1 | VCCO_TOP | P138 | VCCO |
| 0,1 | VCCO_TOP | P115 | VCCO |
| 2,3 | VCCO_RIGHT | P106 | VCCO |
| 2,3 | VCCO_RIGHT | P75 | VCCO |
| 2,3 | VCCO_RIGHT | P91 | VCCO |
| 4,5 | VCCO_BOTTOM | P54 | VCCO |

Table 18: TQ144 Package Pinout (Continued)

| Bank | XC3S50 XC3S200 XC3S400 Pin Name | TQ144 Pin Number | Type |
|--------|--|---------------------|--------|
| 4,5 | VCCO_BOTTOM | P43 | VCCO |
| 4,5 | VCCO_BOTTOM | P66 | VCCO |
| 6,7 | VCCO_LEFT | P19 | VCCO |
| 6,7 | VCCO_LEFT | P34 | VCCO |
| 6,7 | VCCO_LEFT | P3 | VCCO |
| N/A | GND | P136 | GND |
| N/A | GND | P139 | GND |
| N/A | GND | P114 | GND |
| N/A | GND | P117 | GND |
| N/A | GND | P94 | GND |
| N/A | GND | P101 | GND |
| N/A | GND | P81 | GND |
| N/A | GND | P88 | GND |
| N/A | GND | P64 | GND |
| N/A | GND | P67 | GND |
| N/A | GND | P42 | GND |
| N/A | GND | P45 | GND |
| N/A | GND | P22 | GND |
| N/A | GND | P29 | GND |
| N/A | GND | P9 | GND |
| N/A | GND | P16 | GND |
| N/A | VCCAUX | P134 | VCCAUX |
| N/A | VCCAUX | P120 | VCCAUX |
| N/A | VCCAUX | P62 | VCCAUX |
| N/A | VCCAUX | P48 | VCCAUX |
| N/A | VCCINT | P133 | VCCINT |
| N/A | VCCINT | P121 | VCCINT |
| N/A | VCCINT | P61 | VCCINT |
| N/A | VCCINT | P49 | VCCINT |
| VCCAUX | CCLK | P72 | CONFIG |
| VCCAUX | DONE | P71 | CONFIG |
| VCCAUX | HSWAP_EN | P142 | CONFIG |
| VCCAUX | M0 | P38 | CONFIG |
| VCCAUX | M1 | P37 | CONFIG |
| VCCAUX | M2 | P39 | CONFIG |
| VCCAUX | PROG_B | P143 | CONFIG |
| VCCAUX | TCK | P110 | JTAG |
| VCCAUX | TDI | P144 | JTAG |
| VCCAUX | TDO | P109 | JTAG |
| VCCAUX | TMS | P111 | JTAG |

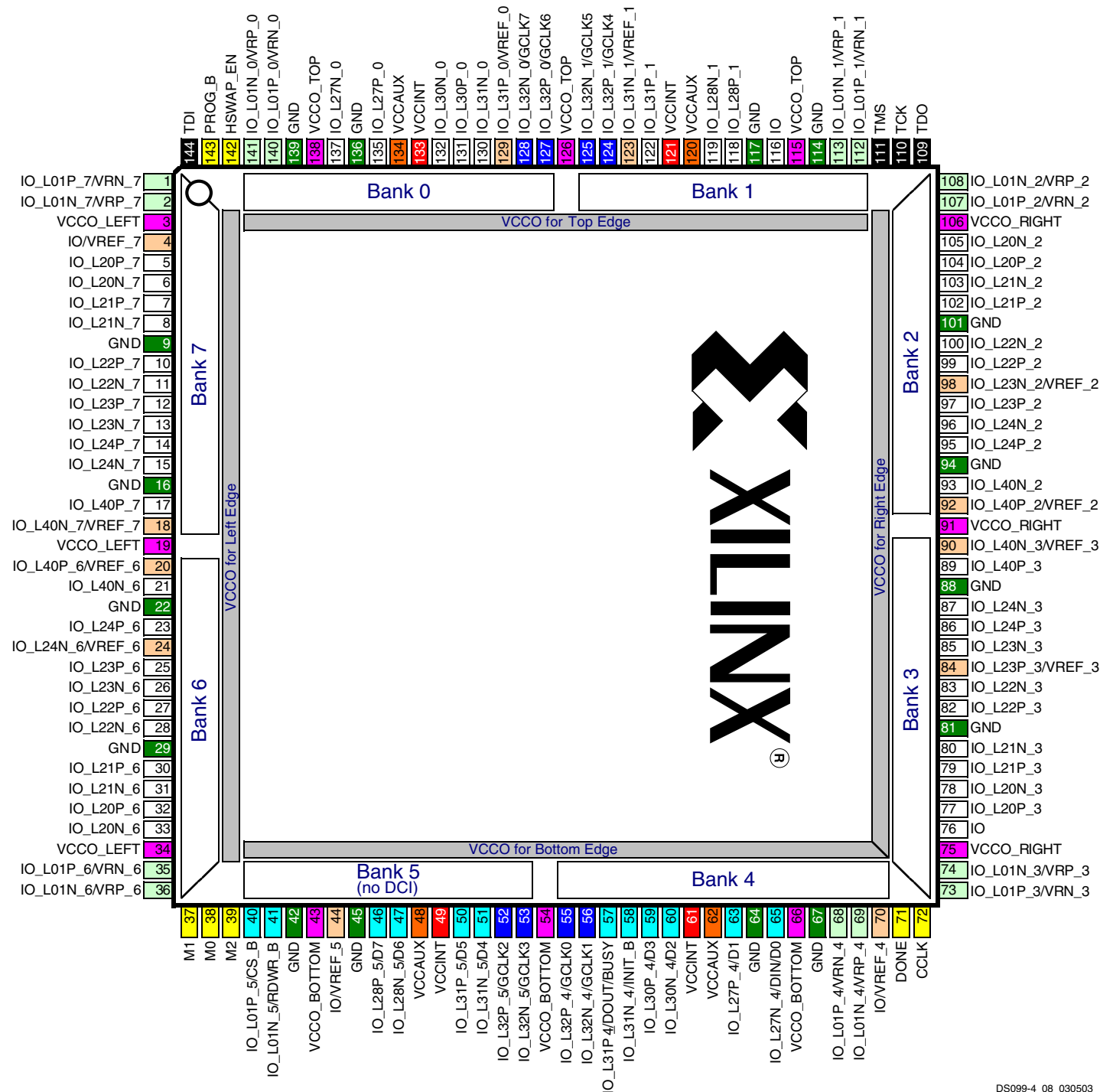
User I/Os by Bank

Table 19 indicates how the available user-I/O pins are distributed between the eight I/O banks on the TQ144 package.

Table 19: User I/Os Per Bank in TQ144 Package

| Package Edge | I/O Bank | Maximum I/O | All Possible I/O Pins by Type | | | | |
|--------------|----------|-------------|-------------------------------|------|-----|------|------|
| | | | I/O | DUAL | DCI | VREF | GCLK |
| Top | 0 | 10 | 5 | 0 | 2 | 1 | 2 |
| | 1 | 9 | 4 | 0 | 2 | 1 | 2 |
| Right | 2 | 14 | 10 | 0 | 2 | 2 | 0 |
| | 3 | 15 | 11 | 0 | 2 | 2 | 0 |
| Bottom | 4 | 11 | 0 | 6 | 2 | 1 | 2 |
| | 5 | 9 | 0 | 6 | 0 | 1 | 2 |
| Left | 6 | 14 | 10 | 0 | 2 | 2 | 0 |
| | 7 | 15 | 11 | 0 | 2 | 2 | 0 |

TQ144 Footprint



DS099-4_08_030503

Figure 9: TQ144 Package Footprint (top view). Note pin 1 indicator in top-left corner and logo orientation.

| | | | | | |
|----|--|----|---|----|--|
| 51 | I/O: Unrestricted, general-purpose user I/O | 12 | DUAL: Configuration pin, then possible user I/O | 12 | VREF: User I/O or input voltage reference for bank |
| 14 | DCI: User I/O or reference resistor input for bank | 8 | GCLK: User I/O or global clock buffer input | 12 | VCCO: Output voltage supply for bank |
| 7 | CONFIG: Dedicated configuration pins | 4 | JTAG: Dedicated JTAG port pins | 4 | VCCINT: Internal core voltage supply (+1.2V) |
| 0 | N.C.: No unconnected pins in this package | 16 | GND: Ground | 4 | VCCAUX: Auxiliary voltage supply (+2.5V) |

PQ208: 208-lead Plastic Quad Flat Pack

The 208-lead plastic quad flat package, PQ208, supports three different Spartan-3 devices, including the XC3S50, the XC3S200, and the XC3S400. The footprints for the XC3S200 and XC3S400 are identical, as shown in [Table 20](#) and [Figure 10](#). The XC3S50, however, has fewer I/O pins resulting in 17 unconnected pins on the PQ208 package, labeled as “N.C.” In [Table 20](#) and [Figure 10](#), these unconnected pins are indicated with a black diamond symbol (◆).

All the package pins appear in [Table 20](#) and are sorted by bank number, then by pin name. Pairs of pins that form a differential I/O pair appear together in the table. The table also shows the pin number for each pin and the pin type, as defined earlier.

If there is a difference between the XC3S50 pinout and the pinout for the XC3S200 and XC3S400, then that difference is highlighted in [Table 20](#). If the table entry is shaded grey, then there is an unconnected pin on the XC3S50 that maps to a user-I/O pin on the XC3S200 and XC3S400. If the table entry is shaded tan, then the unconnected pin on the XC3S50 maps to a VREF-type pin on the XC3S200 and XC3S400. If the other VREF pins in the bank all connect to a voltage reference to support a special I/O standard, then also connect the N.C. pin on the XC3S50 to the same VREF voltage. This provides maximum flexibility as you could potentially migrate a design from the XC3S50 device to an XC3S200 or XC3S400 FPGA without changing the printed circuit board.

Pinout Table

Table 20: PQ208 Package Pinout

| Bank | XC3S50 Pin Name | XC3S200 XC3S400 Pin Name | PQ208 Pin Number | Type |
|------|----------------------|--------------------------------|------------------------|------|
| 0 | IO | IO | P189 | I/O |
| 0 | IO | IO | P197 | I/O |
| 0 | N.C. (◆) | IO/VREF_0 | P200 | VREF |
| 0 | IO/VREF_0 | IO/VREF_0 | P205 | VREF |
| 0 | IO_L01N_0/ VRP_0 | IO_L01N_0/ VRP_0 | P204 | DCI |
| 0 | IO_L01P_0/ VRN_0 | IO_L01P_0/ VRN_0 | P203 | DCI |
| 0 | IO_L25N_0 | IO_L25N_0 | P199 | I/O |
| 0 | IO_L25P_0 | IO_L25P_0 | P198 | I/O |
| 0 | IO_L27N_0 | IO_L27N_0 | P196 | I/O |
| 0 | IO_L27P_0 | IO_L27P_0 | P194 | I/O |
| 0 | IO_L30N_0 | IO_L30N_0 | P191 | I/O |
| 0 | IO_L30P_0 | IO_L30P_0 | P190 | I/O |
| 0 | IO_L31N_0 | IO_L31N_0 | P187 | I/O |
| 0 | IO_L31P_0/ VREF_0 | IO_L31P_0/ VREF_0 | P185 | VREF |

Table 20: PQ208 Package Pinout (Continued)

| Bank | XC3S50 Pin Name | XC3S200 XC3S400 Pin Name | PQ208 Pin Number | Type |
|------|----------------------|--------------------------------|------------------------|------|
| 0 | IO_L32N_0/ GCLK7 | IO_L32N_0/ GCLK7 | P184 | GCLK |
| 0 | IO_L32P_0/ GCLK6 | IO_L32P_0/ GCLK6 | P183 | GCLK |
| 0 | VCCO_0 | VCCO_0 | P188 | VCCO |
| 0 | VCCO_0 | VCCO_0 | P201 | VCCO |
| 1 | IO | IO | P167 | I/O |
| 1 | IO | IO | P175 | I/O |
| 1 | IO | IO | P182 | I/O |
| 1 | IO_L01N_1/ VRP_1 | IO_L01N_1/ VRP_1 | P162 | DCI |
| 1 | IO_L01P_1/ VRN_1 | IO_L01P_1/ VRN_1 | P161 | DCI |
| 1 | IO_L10N_1/ VREF_1 | IO_L10N_1/ VREF_1 | P166 | VREF |
| 1 | IO_L10P_1 | IO_L10P_1 | P165 | I/O |
| 1 | IO_L27N_1 | IO_L27N_1 | P169 | I/O |
| 1 | IO_L27P_1 | IO_L27P_1 | P168 | I/O |
| 1 | IO_L28N_1 | IO_L28N_1 | P172 | I/O |
| 1 | IO_L28P_1 | IO_L28P_1 | P171 | I/O |
| 1 | IO_L31N_1/ VREF_1 | IO_L31N_1/ VREF_1 | P178 | VREF |
| 1 | IO_L31P_1 | IO_L31P_1 | P176 | I/O |
| 1 | IO_L32N_1/ GCLK5 | IO_L32N_1/ GCLK5 | P181 | GCLK |
| 1 | IO_L32P_1/ GCLK4 | IO_L32P_1/ GCLK4 | P180 | GCLK |
| 1 | VCCO_1 | VCCO_1 | P164 | VCCO |
| 1 | VCCO_1 | VCCO_1 | P177 | VCCO |
| 2 | N.C. (◆) | IO/VREF_2 | P154 | VREF |
| 2 | IO_L01N_2/ VRP_2 | IO_L01N_2/ VRP_2 | P156 | DCI |
| 2 | IO_L01P_2/ VRN_2 | IO_L01P_2/ VRN_2 | P155 | DCI |
| 2 | IO_L19N_2 | IO_L19N_2 | P152 | I/O |
| 2 | IO_L19P_2 | IO_L19P_2 | P150 | I/O |
| 2 | IO_L20N_2 | IO_L20N_2 | P149 | I/O |
| 2 | IO_L20P_2 | IO_L20P_2 | P148 | I/O |
| 2 | IO_L21N_2 | IO_L21N_2 | P147 | I/O |
| 2 | IO_L21P_2 | IO_L21P_2 | P146 | I/O |
| 2 | IO_L22N_2 | IO_L22N_2 | P144 | I/O |
| 2 | IO_L22P_2 | IO_L22P_2 | P143 | I/O |
| 2 | IO_L23N_2/ VREF_2 | IO_L23N_2/ VREF_2 | P141 | VREF |
| 2 | IO_L23P_2 | IO_L23P_2 | P140 | I/O |

Table 20: PQ208 Package Pinout (Continued)

| Bank | XC3S50 Pin Name | XC3S200 XC3S400 Pin Name | PQ208 Pin Number | Type |
|------|----------------------|--------------------------------|------------------------|------|
| 2 | IO_L24N_2 | IO_L24N_2 | P139 | I/O |
| 2 | IO_L24P_2 | IO_L24P_2 | P138 | I/O |
| 2 | N.C. (◆) | IO_L39N_2 | P137 | I/O |
| 2 | N.C. (◆) | IO_L39P_2 | P135 | I/O |
| 2 | IO_L40N_2 | IO_L40N_2 | P133 | I/O |
| 2 | IO_L40P_2/ VREF_2 | IO_L40P_2/ VREF_2 | P132 | VREF |
| 2 | VCCO_2 | VCCO_2 | P136 | VCCO |
| 2 | VCCO_2 | VCCO_2 | P153 | VCCO |
| 3 | IO_L01N_3/ VRP_3 | IO_L01N_3/ VRP_3 | P107 | DCI |
| 3 | IO_L01P_3/ VRN_3 | IO_L01P_3/ VRN_3 | P106 | DCI |
| 3 | N.C. (◆) | IO_L17N_3 | P109 | I/O |
| 3 | N.C. (◆) | IO_L17P_3/ VREF_3 | P108 | VREF |
| 3 | IO_L19N_3 | IO_L19N_3 | P113 | I/O |
| 3 | IO_L19P_3 | IO_L19P_3 | P111 | I/O |
| 3 | IO_L20N_3 | IO_L20N_3 | P115 | I/O |
| 3 | IO_L20P_3 | IO_L20P_3 | P114 | I/O |
| 3 | IO_L21N_3 | IO_L21N_3 | P117 | I/O |
| 3 | IO_L21P_3 | IO_L21P_3 | P116 | I/O |
| 3 | IO_L22N_3 | IO_L22N_3 | P120 | I/O |
| 3 | IO_L22P_3 | IO_L22P_3 | P119 | I/O |
| 3 | IO_L23N_3 | IO_L23N_3 | P123 | I/O |
| 3 | IO_L23P_3/ VREF_3 | IO_L23P_3/ VREF_3 | P122 | VREF |
| 3 | IO_L24N_3 | IO_L24N_3 | P125 | I/O |
| 3 | IO_L24P_3 | IO_L24P_3 | P124 | I/O |
| 3 | N.C. (◆) | IO_L39N_3 | P128 | I/O |
| 3 | N.C. (◆) | IO_L39P_3 | P126 | I/O |
| 3 | IO_L40N_3/ VREF_3 | IO_L40N_3/ VREF_3 | P131 | VREF |
| 3 | IO_L40P_3 | IO_L40P_3 | P130 | I/O |
| 3 | VCCO_3 | VCCO_3 | P110 | VCCO |
| 3 | VCCO_3 | VCCO_3 | P127 | VCCO |
| 4 | IO | IO | P93 | I/O |
| 4 | N.C. (◆) | IO | P97 | I/O |
| 4 | IO/VREF_4 | IO/VREF_4 | P85 | VREF |
| 4 | N.C. (◆) | IO/VREF_4 | P96 | VREF |
| 4 | IO/VREF_4 | IO/VREF_4 | P102 | VREF |
| 4 | IO_L01N_4/ VRP_4 | IO_L01N_4/ VRP_4 | P101 | DCI |

Table 20: PQ208 Package Pinout (Continued)

| Bank | XC3S50 Pin Name | XC3S200 XC3S400 Pin Name | PQ208 Pin Number | Type |
|------|-------------------------|--------------------------------|------------------------|------|
| 4 | IO_L01P_4/ VRN_4 | IO_L01P_4/ VRN_4 | P100 | DCI |
| 4 | IO_L25N_4 | IO_L25N_4 | P95 | I/O |
| 4 | IO_L25P_4 | IO_L25P_4 | P94 | I/O |
| 4 | IO_L27N_4/ DIN/D0 | IO_L27N_4/ DIN/D0 | P92 | DUAL |
| 4 | IO_L27P_4/ D1 | IO_L27P_4/ D1 | P90 | DUAL |
| 4 | IO_L30N_4/ D2 | IO_L30N_4/ D2 | P87 | DUAL |
| 4 | IO_L30P_4/ D3 | IO_L30P_4/ D3 | P86 | DUAL |
| 4 | IO_L31N_4/ INIT_B | IO_L31N_4/ INIT_B | P83 | DUAL |
| 4 | IO_L31P_4/ DOUT/BUSY | IO_L31P_4/ DOUT/BUSY | P81 | DUAL |
| 4 | IO_L32N_4/ GCLK1 | IO_L32N_4/ GCLK1 | P80 | GCLK |
| 4 | IO_L32P_4/ GCLK0 | IO_L32P_4/ GCLK0 | P79 | GCLK |
| 4 | VCCO_4 | VCCO_4 | P84 | VCCO |
| 4 | VCCO_4 | VCCO_4 | P98 | VCCO |
| 5 | IO | IO | P63 | I/O |
| 5 | IO | IO | P71 | I/O |
| 5 | IO/VREF_5 | IO/VREF_5 | P78 | VREF |
| 5 | IO_L01N_5/ RDWR_B | IO_L01N_5/ RDWR_B | P58 | DUAL |
| 5 | IO_L01P_5/ CS_B | IO_L01P_5/ CS_B | P57 | DUAL |
| 5 | IO_L10N_5/ VRP_5 | IO_L10N_5/ VRP_5 | P62 | DCI |
| 5 | IO_L10P_5/ VRN_5 | IO_L10P_5/ VRN_5 | P61 | DCI |
| 5 | IO_L27N_5/ VREF_5 | IO_L27N_5/ VREF_5 | P65 | VREF |
| 5 | IO_L27P_5 | IO_L27P_5 | P64 | I/O |
| 5 | IO_L28N_5/ D6 | IO_L28N_5/ D6 | P68 | DUAL |
| 5 | IO_L28P_5/ D7 | IO_L28P_5/ D7 | P67 | DUAL |
| 5 | IO_L31N_5/ D4 | IO_L31N_5/ D4 | P74 | DUAL |
| 5 | IO_L31P_5/ D5 | IO_L31P_5/ D5 | P72 | DUAL |
| 5 | IO_L32N_5/ GCLK3 | IO_L32N_5/ GCLK3 | P77 | GCLK |

Table 20: PQ208 Package Pinout (Continued)

| Bank | XC3S50 Pin Name | XC3S200 XC3S400 Pin Name | PQ208 Pin Number | Type |
|------|----------------------|--------------------------------|------------------------|------|
| 5 | IO_L32P_5/ GCLK2 | IO_L32P_5/ GCLK2 | P76 | GCLK |
| 5 | VCCO_5 | VCCO_5 | P60 | VCCO |
| 5 | VCCO_5 | VCCO_5 | P73 | VCCO |
| 6 | N.C. (◆) | IO/VREF_6 | P50 | VREF |
| 6 | IO_L01N_6/ VRP_6 | IO_L01N_6/ VRP_6 | P52 | DCI |
| 6 | IO_L01P_6/ VRN_6 | IO_L01P_6/ VRN_6 | P51 | DCI |
| 6 | IO_L19N_6 | IO_L19N_6 | P48 | I/O |
| 6 | IO_L19P_6 | IO_L19P_6 | P46 | I/O |
| 6 | IO_L20N_6 | IO_L20N_6 | P45 | I/O |
| 6 | IO_L20P_6 | IO_L20P_6 | P44 | I/O |
| 6 | IO_L21N_6 | IO_L21N_6 | P43 | I/O |
| 6 | IO_L21P_6 | IO_L21P_6 | P42 | I/O |
| 6 | IO_L22N_6 | IO_L22N_6 | P40 | I/O |
| 6 | IO_L22P_6 | IO_L22P_6 | P39 | I/O |
| 6 | IO_L23N_6 | IO_L23N_6 | P37 | I/O |
| 6 | IO_L23P_6 | IO_L23P_6 | P36 | I/O |
| 6 | IO_L24N_6/ VREF_6 | IO_L24N_6/ VREF_6 | P35 | VREF |
| 6 | IO_L24P_6 | IO_L24P_6 | P34 | I/O |
| 6 | N.C. (◆) | IO_L39N_6 | P33 | I/O |
| 6 | N.C. (◆) | IO_L39P_6 | P31 | I/O |
| 6 | IO_L40N_6 | IO_L40N_6 | P29 | I/O |
| 6 | IO_L40P_6/ VREF_6 | IO_L40P_6/ VREF_6 | P28 | VREF |
| 6 | VCCO_6 | VCCO_6 | P32 | VCCO |
| 6 | VCCO_6 | VCCO_6 | P49 | VCCO |
| 7 | IO_L01N_7/ VRP_7 | IO_L01N_7/ VRP_7 | P3 | DCI |
| 7 | IO_L01P_7/ VRN_7 | IO_L01P_7/ VRN_7 | P2 | DCI |
| 7 | N.C. (◆) | IO_L16N_7 | P5 | I/O |
| 7 | N.C. (◆) | IO_L16P_7/ VREF_7 | P4 | VREF |
| 7 | IO_L19N_7/ VREF_7 | IO_L19N_7/ VREF_7 | P9 | VREF |
| 7 | IO_L19P_7 | IO_L19P_7 | P7 | I/O |
| 7 | IO_L20N_7 | IO_L20N_7 | P11 | I/O |
| 7 | IO_L20P_7 | IO_L20P_7 | P10 | I/O |
| 7 | IO_L21N_7 | IO_L21N_7 | P13 | I/O |
| 7 | IO_L21P_7 | IO_L21P_7 | P12 | I/O |
| 7 | IO_L22N_7 | IO_L22N_7 | P16 | I/O |

Table 20: PQ208 Package Pinout (Continued)

| Bank | XC3S50 Pin Name | XC3S200 XC3S400 Pin Name | PQ208 Pin Number | Type |
|------|----------------------|--------------------------------|------------------------|--------|
| 7 | IO_L22P_7 | IO_L22P_7 | P15 | I/O |
| 7 | IO_L23N_7 | IO_L23N_7 | P19 | I/O |
| 7 | IO_L23P_7 | IO_L23P_7 | P18 | I/O |
| 7 | IO_L24N_7 | IO_L24N_7 | P21 | I/O |
| 7 | IO_L24P_7 | IO_L24P_7 | P20 | I/O |
| 7 | N.C. (◆) | IO_L39N_7 | P24 | I/O |
| 7 | N.C. (◆) | IO_L39P_7 | P22 | I/O |
| 7 | IO_L40N_7/ VREF_7 | IO_L40N_7/ VREF_7 | P27 | VREF |
| 7 | IO_L40P_7 | IO_L40P_7 | P26 | I/O |
| 7 | VCCO_7 | VCCO_7 | P6 | VCCO |
| 7 | VCCO_7 | VCCO_7 | P23 | VCCO |
| N/A | GND | GND | P1 | GND |
| N/A | GND | GND | P186 | GND |
| N/A | GND | GND | P195 | GND |
| N/A | GND | GND | P202 | GND |
| N/A | GND | GND | P163 | GND |
| N/A | GND | GND | P170 | GND |
| N/A | GND | GND | P179 | GND |
| N/A | GND | GND | P134 | GND |
| N/A | GND | GND | P145 | GND |
| N/A | GND | GND | P151 | GND |
| N/A | GND | GND | P157 | GND |
| N/A | GND | GND | P112 | GND |
| N/A | GND | GND | P118 | GND |
| N/A | GND | GND | P129 | GND |
| N/A | GND | GND | P82 | GND |
| N/A | GND | GND | P91 | GND |
| N/A | GND | GND | P99 | GND |
| N/A | GND | GND | P105 | GND |
| N/A | GND | GND | P53 | GND |
| N/A | GND | GND | P59 | GND |
| N/A | GND | GND | P66 | GND |
| N/A | GND | GND | P75 | GND |
| N/A | GND | GND | P30 | GND |
| N/A | GND | GND | P41 | GND |
| N/A | GND | GND | P47 | GND |
| N/A | GND | GND | P8 | GND |
| N/A | GND | GND | P14 | GND |
| N/A | GND | GND | P25 | GND |
| N/A | VCCAUX | VCCAUX | P193 | VCCAUX |
| N/A | VCCAUX | VCCAUX | P173 | VCCAUX |

Table 20: PQ208 Package Pinout (Continued)

| Bank | XC3S50 Pin Name | XC3S200 XC3S400 Pin Name | PQ208 Pin Number | Type |
|--------|--------------------|--------------------------------|------------------------|--------|
| N/A | VCCAUX | VCCAUX | P142 | VCCAUX |
| N/A | VCCAUX | VCCAUX | P121 | VCCAUX |
| N/A | VCCAUX | VCCAUX | P89 | VCCAUX |
| N/A | VCCAUX | VCCAUX | P69 | VCCAUX |
| N/A | VCCAUX | VCCAUX | P38 | VCCAUX |
| N/A | VCCAUX | VCCAUX | P17 | VCCAUX |
| N/A | VCCINT | VCCINT | P192 | VCCINT |
| N/A | VCCINT | VCCINT | P174 | VCCINT |
| N/A | VCCINT | VCCINT | P88 | VCCINT |
| N/A | VCCINT | VCCINT | P70 | VCCINT |
| VCCAUX | CCLK | CCLK | P104 | CONFIG |
| VCCAUX | DONE | DONE | P103 | CONFIG |
| VCCAUX | HSWAP_EN | HSWAP_EN | P206 | CONFIG |
| VCCAUX | M0 | M0 | P55 | CONFIG |

Table 20: PQ208 Package Pinout (Continued)

| Bank | XC3S50 Pin Name | XC3S200 XC3S400 Pin Name | PQ208 Pin Number | Type |
|--------|--------------------|--------------------------------|------------------------|--------|
| VCCAUX | M1 | M1 | P54 | CONFIG |
| VCCAUX | M2 | M2 | P56 | CONFIG |
| VCCAUX | PROG_B | PROG_B | P207 | CONFIG |
| VCCAUX | TCK | TCK | P159 | JTAG |
| VCCAUX | TDI | TDI | P208 | JTAG |
| VCCAUX | TDO | TDO | P158 | JTAG |
| VCCAUX | TMS | TMS | P160 | JTAG |

User I/Os by Bank

Table 21 indicates how the available user-I/O pins are distributed between the eight I/O banks for the XC3S50 in the PQ208 package. Similarly, Table 22 shows how the available user-I/O pins are distributed between the eight I/O banks for the XC3S200 and XC3S400 in the PQ208 package.

Table 21: User I/Os Per Bank for XC3S50 in PQ208 Package

| Package Edge | I/O Bank | Maximum I/O | All Possible I/O Pins by Type | | | | |
|--------------|----------|----------------|-------------------------------|------|-----|------|------|
| | | | I/O | DUAL | DCI | VREF | GCLK |
| Top | 0 | 15 | 9 | 0 | 2 | 2 | 2 |
| | 1 | 15 | 9 | 0 | 2 | 2 | 2 |
| Right | 2 | 16 | 13 | 0 | 2 | 2 | 0 |
| | 3 | 16 | 12 | 0 | 2 | 2 | 0 |
| Bottom | 4 | 15 | 3 | 6 | 2 | 2 | 2 |
| | 5 | 15 | 3 | 6 | 2 | 2 | 2 |
| Left | 6 | 16 | 12 | 0 | 2 | 2 | 0 |
| | 7 | 16 | 12 | 0 | 2 | 2 | 0 |

Table 22: User I/Os Per Bank for XC3S200 and XC3S400 in PQ208 Package

| Package Edge | I/O Bank | Maximum I/O | All Possible I/O Pins by Type | | | | |
|--------------|----------|-------------|-------------------------------|------|-----|------|------|
| | | | I/O | DUAL | DCI | VREF | GCLK |
| Top | 0 | 16 | 9 | 0 | 2 | 3 | 2 |
| | 1 | 15 | 9 | 0 | 2 | 2 | 2 |
| Right | 2 | 19 | 14 | 0 | 2 | 3 | 0 |
| | 3 | 20 | 15 | 0 | 2 | 3 | 0 |
| Bottom | 4 | 17 | 4 | 6 | 2 | 3 | 2 |
| | 5 | 15 | 3 | 6 | 2 | 2 | 2 |
| Left | 6 | 19 | 14 | 0 | 2 | 3 | 0 |
| | 7 | 20 | 15 | 0 | 2 | 3 | 0 |

PQ208 Footprint

Left Half of Package (top view)

XC3S50

(124 max. user I/O)

72 I/O: Unrestricted,
general-purpose user I/O

16 VREF: User I/O or input
voltage reference for bank

17 N.C.: Unconnected pins for
XC3S50 (◆)

XC3S200, XC3S400

(141 max user I/O)

83 I/O: Unrestricted,
general-purpose user I/O

22 VREF: User I/O or input
voltage reference for bank

0 N.C.: No unconnected pins
in this package

All devices

12 DUAL: Configuration pin,
then possible user I/O

8 GCLK: User I/O or global
clock buffer input

16 DCI: User I/O or reference
resistor input for bank

7 CONFIG: Dedicated
configuration pins

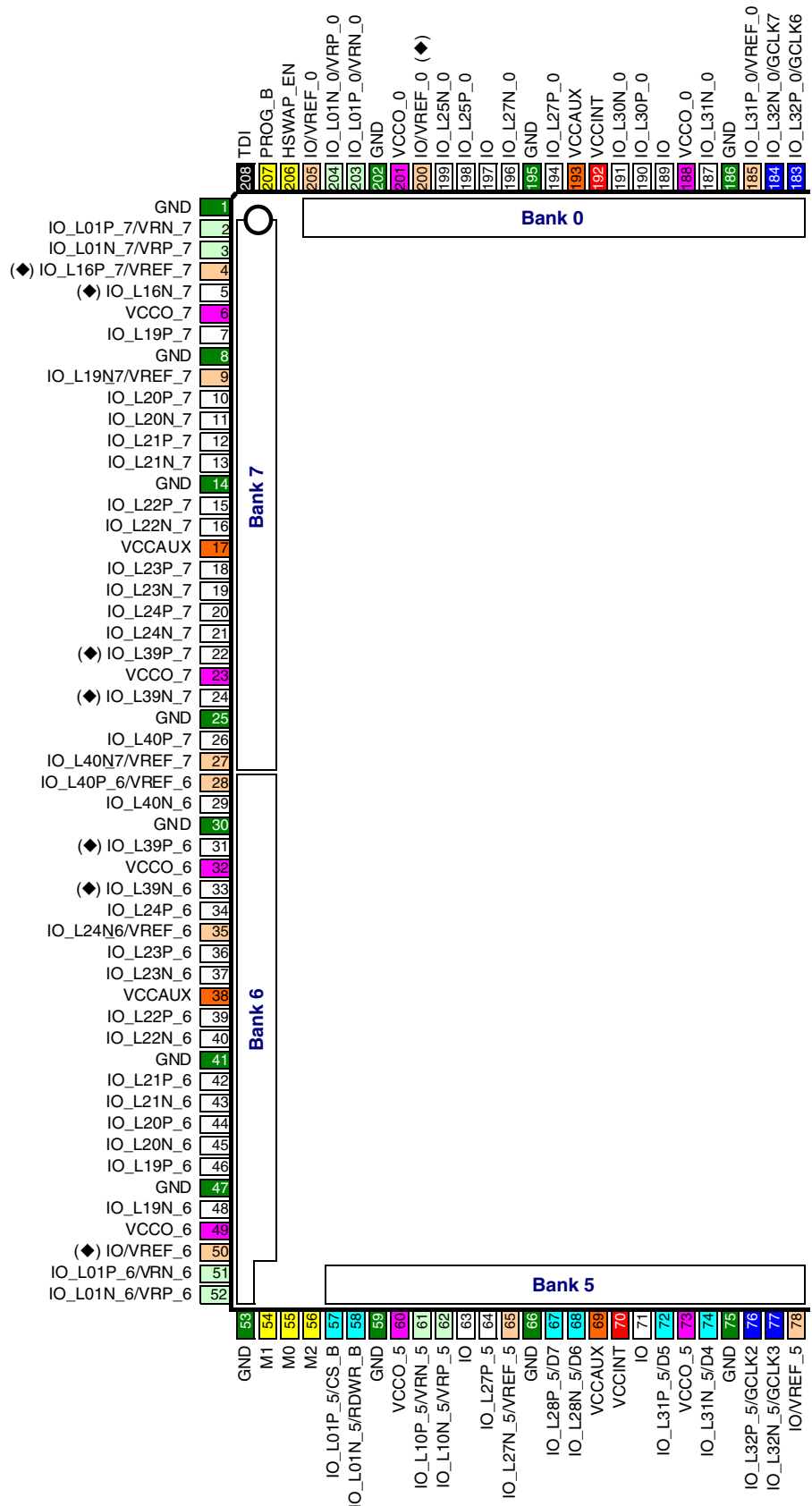
4 JTAG: Dedicated JTAG
port pins

4 VCCINT: Internal core
voltage supply (+1.2V)

12 VCCO: Output voltage
supply for bank

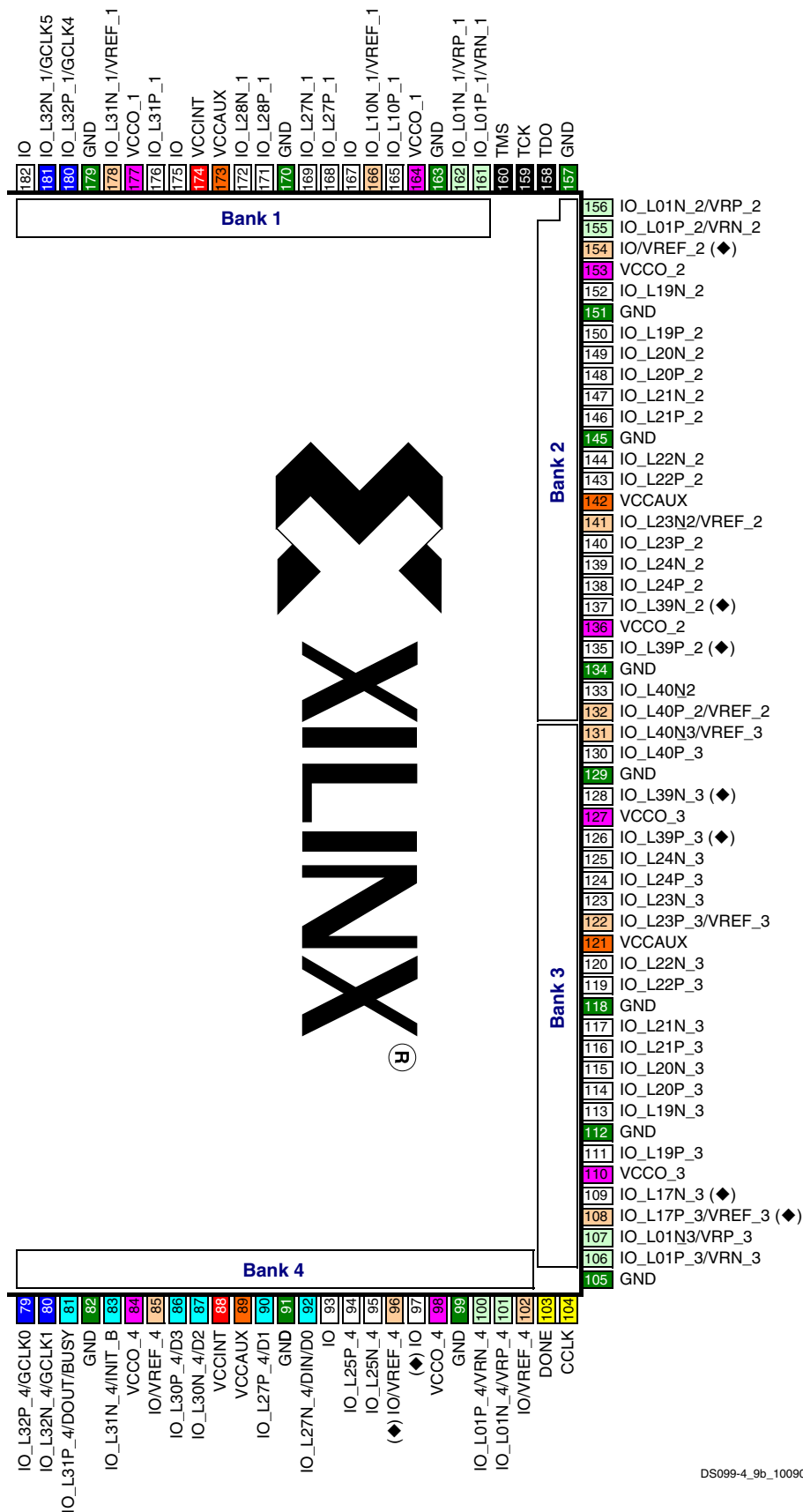
8 VCCAUX: Auxiliary voltage
supply (+2.5V)

28 GND: Ground



DS099-4_09a_1009

Figure 10: PQ208 Package Footprint (top view). Note pin 1 indicator in top-left corner and logo orientation.



DS099-4_9b_100903

FT256: 256-lead Fine-pitch Thin Ball Grid Array

The 256-lead fine-pitch thin ball grid array package, FT256, supports three different Spartan-3 devices, including the XC3S200, the XC3S400, and the XC3S1000. The footprints for all three devices are identical, as shown in [Table 23](#) and [Figure 11](#).

All the package pins appear in [Table 23](#) and are sorted by bank number, then by pin name. Pairs of pins that form a differential I/O pair appear together in the table. The table also shows the pin number for each pin and the pin type, as defined earlier.

Pinout Table

Table 23: FT256 Package Pinout

| Bank | XC3S200 XC3S400 XC3S1000 Pin Name | FT256 Pin Number | Type |
|------|--|------------------------|------|
| 0 | IO | A5 | I/O |
| 0 | IO | A7 | I/O |
| 0 | IO/VREF_0 | A3 | VREF |
| 0 | IO/VREF_0 | D5 | VREF |
| 0 | IO_L01N_0/VRP_0 | B4 | DCI |
| 0 | IO_L01P_0/VRN_0 | A4 | DCI |
| 0 | IO_L25N_0 | C5 | I/O |
| 0 | IO_L25P_0 | B5 | I/O |
| 0 | IO_L27N_0 | E6 | I/O |
| 0 | IO_L27P_0 | D6 | I/O |
| 0 | IO_L28N_0 | C6 | I/O |
| 0 | IO_L28P_0 | B6 | I/O |
| 0 | IO_L29N_0 | E7 | I/O |
| 0 | IO_L29P_0 | D7 | I/O |
| 0 | IO_L30N_0 | C7 | I/O |
| 0 | IO_L30P_0 | B7 | I/O |
| 0 | IO_L31N_0 | D8 | I/O |
| 0 | IO_L31P_0/VREF_0 | C8 | VREF |
| 0 | IO_L32N_0/GCLK7 | B8 | GCLK |
| 0 | IO_L32P_0/GCLK6 | A8 | GCLK |
| 0 | VCCO_0 | E8 | VCCO |
| 0 | VCCO_0 | F7 | VCCO |
| 0 | VCCO_0 | F8 | VCCO |
| 1 | IO | A9 | I/O |
| 1 | IO | A12 | I/O |
| 1 | IO | C10 | I/O |
| 1 | IO/VREF_1 | D12 | VREF |
| 1 | IO_L01N_1/VRP_1 | A14 | DCI |

Table 23: FT256 Package Pinout (Continued)

| Bank | XC3S200 XC3S400 XC3S1000 Pin Name | FT256 Pin Number | Type |
|------|--|------------------------|------|
| 1 | IO_L01P_1/VRN_1 | B14 | DCI |
| 1 | IO_L10N_1/VREF_1 | A13 | VREF |
| 1 | IO_L10P_1 | B13 | I/O |
| 1 | IO_L27N_1 | B12 | I/O |
| 1 | IO_L27P_1 | C12 | I/O |
| 1 | IO_L28N_1 | D11 | I/O |
| 1 | IO_L28P_1 | E11 | I/O |
| 1 | IO_L29N_1 | B11 | I/O |
| 1 | IO_L29P_1 | C11 | I/O |
| 1 | IO_L30N_1 | D10 | I/O |
| 1 | IO_L30P_1 | E10 | I/O |
| 1 | IO_L31N_1/VREF_1 | A10 | VREF |
| 1 | IO_L31P_1 | B10 | I/O |
| 1 | IO_L32N_1/GCLK5 | C9 | GCLK |
| 1 | IO_L32P_1/GCLK4 | D9 | GCLK |
| 1 | VCCO_1 | E9 | VCCO |
| 1 | VCCO_1 | F9 | VCCO |
| 1 | VCCO_1 | F10 | VCCO |
| 2 | IO | G16 | I/O |
| 2 | IO_L01N_2/VRP_2 | B16 | DCI |
| 2 | IO_L01P_2/VRN_2 | C16 | DCI |
| 2 | IO_L16N_2 | C15 | I/O |
| 2 | IO_L16P_2 | D14 | I/O |
| 2 | IO_L17N_2 | D15 | I/O |
| 2 | IO_L17P_2/VREF_2 | D16 | VREF |
| 2 | IO_L19N_2 | E13 | I/O |
| 2 | IO_L19P_2 | E14 | I/O |
| 2 | IO_L20N_2 | E15 | I/O |
| 2 | IO_L20P_2 | E16 | I/O |
| 2 | IO_L21N_2 | F12 | I/O |
| 2 | IO_L21P_2 | F13 | I/O |
| 2 | IO_L22N_2 | F14 | I/O |
| 2 | IO_L22P_2 | F15 | I/O |
| 2 | IO_L23N_2/VREF_2 | G12 | VREF |
| 2 | IO_L23P_2 | G13 | I/O |
| 2 | IO_L24N_2 | G14 | I/O |
| 2 | IO_L24P_2 | G15 | I/O |
| 2 | IO_L39N_2 | H13 | I/O |
| 2 | IO_L39P_2 | H14 | I/O |
| 2 | IO_L40N_2 | H15 | I/O |

Table 23: FT256 Package Pinout (Continued)

| Bank | XC3S200 XC3S400 XC3S1000 Pin Name | FT256 Pin Number | Type |
|------|--|------------------------|------|
| 2 | IO_L40P_2/VREF_2 | H16 | VREF |
| 2 | VCCO_2 | G11 | VCCO |
| 2 | VCCO_2 | H11 | VCCO |
| 2 | VCCO_2 | H12 | VCCO |
| 3 | IO | K15 | I/O |
| 3 | IO_L01N_3/VRP_3 | P16 | DCI |
| 3 | IO_L01P_3/VRN_3 | R16 | DCI |
| 3 | IO_L16N_3 | P15 | I/O |
| 3 | IO_L16P_3 | P14 | I/O |
| 3 | IO_L17N_3 | N16 | I/O |
| 3 | IO_L17P_3/VREF_3 | N15 | VREF |
| 3 | IO_L19N_3 | M14 | I/O |
| 3 | IO_L19P_3 | N14 | I/O |
| 3 | IO_L20N_3 | M16 | I/O |
| 3 | IO_L20P_3 | M15 | I/O |
| 3 | IO_L21N_3 | L13 | I/O |
| 3 | IO_L21P_3 | M13 | I/O |
| 3 | IO_L22N_3 | L15 | I/O |
| 3 | IO_L22P_3 | L14 | I/O |
| 3 | IO_L23N_3 | K12 | I/O |
| 3 | IO_L23P_3/VREF_3 | L12 | VREF |
| 3 | IO_L24N_3 | K14 | I/O |
| 3 | IO_L24P_3 | K13 | I/O |
| 3 | IO_L39N_3 | J14 | I/O |
| 3 | IO_L39P_3 | J13 | I/O |
| 3 | IO_L40N_3/VREF_3 | J16 | VREF |
| 3 | IO_L40P_3 | K16 | I/O |
| 3 | VCCO_3 | J11 | VCCO |
| 3 | VCCO_3 | J12 | VCCO |
| 3 | VCCO_3 | K11 | VCCO |
| 4 | IO | T12 | I/O |
| 4 | IO | T14 | I/O |
| 4 | IO/VREF_4 | N12 | VREF |
| 4 | IO/VREF_4 | P13 | VREF |
| 4 | IO/VREF_4 | T10 | VREF |
| 4 | IO_L01N_4/VRP_4 | R13 | DCI |
| 4 | IO_L01P_4/VRN_4 | T13 | DCI |
| 4 | IO_L25N_4 | P12 | I/O |
| 4 | IO_L25P_4 | R12 | I/O |
| 4 | IO_L27N_4/DIN/D0 | M11 | DUAL |

Table 23: FT256 Package Pinout (Continued)

| Bank | XC3S200 XC3S400 XC3S1000 Pin Name | FT256 Pin Number | Type |
|------|--|------------------------|------|
| 4 | IO_L27P_4/D1 | N11 | DUAL |
| 4 | IO_L28N_4 | P11 | I/O |
| 4 | IO_L28P_4 | R11 | I/O |
| 4 | IO_L29N_4 | M10 | I/O |
| 4 | IO_L29P_4 | N10 | I/O |
| 4 | IO_L30N_4/D2 | P10 | DUAL |
| 4 | IO_L30P_4/D3 | R10 | DUAL |
| 4 | IO_L31N_4/INIT_B | N9 | DUAL |
| 4 | IO_L31P_4/DOUT/BUSY | P9 | DUAL |
| 4 | IO_L32N_4/GCLK1 | R9 | GCLK |
| 4 | IO_L32P_4/GCLK0 | T9 | GCLK |
| 4 | VCCO_4 | L9 | VCCO |
| 4 | VCCO_4 | L10 | VCCO |
| 4 | VCCO_4 | M9 | VCCO |
| 5 | IO | N5 | I/O |
| 5 | IO | P7 | I/O |
| 5 | IO | T5 | I/O |
| 5 | IO/VREF_5 | T8 | VREF |
| 5 | IO_L01N_5/RDWR_B | T3 | DUAL |
| 5 | IO_L01P_5/CS_B | R3 | DUAL |
| 5 | IO_L10N_5/VRP_5 | T4 | DCI |
| 5 | IO_L10P_5/VRN_5 | R4 | DCI |
| 5 | IO_L27N_5/VREF_5 | R5 | VREF |
| 5 | IO_L27P_5 | P5 | I/O |
| 5 | IO_L28N_5/D6 | N6 | DUAL |
| 5 | IO_L28P_5/D7 | M6 | DUAL |
| 5 | IO_L29N_5 | R6 | I/O |
| 5 | IO_L29P_5/VREF_5 | P6 | VREF |
| 5 | IO_L30N_5 | N7 | I/O |
| 5 | IO_L30P_5 | M7 | I/O |
| 5 | IO_L31N_5/D4 | T7 | DUAL |
| 5 | IO_L31P_5/D5 | R7 | DUAL |
| 5 | IO_L32N_5/GCLK3 | P8 | GCLK |
| 5 | IO_L32P_5/GCLK2 | N8 | GCLK |
| 5 | VCCO_5 | L7 | VCCO |
| 5 | VCCO_5 | L8 | VCCO |
| 5 | VCCO_5 | M8 | VCCO |
| 6 | IO | K1 | I/O |
| 6 | IO_L01N_6/VRP_6 | R1 | DCI |
| 6 | IO_L01P_6/VRN_6 | P1 | DCI |

Table 23: FT256 Package Pinout (Continued)

| Bank | XC3S200 XC3S400 XC3S1000 Pin Name | FT256 Pin Number | Type |
|------|--|------------------------|------|
| 6 | IO_L16N_6 | P2 | I/O |
| 6 | IO_L16P_6 | N3 | I/O |
| 6 | IO_L17N_6 | N2 | I/O |
| 6 | IO_L17P_6/VREF_6 | N1 | VREF |
| 6 | IO_L19N_6 | M4 | I/O |
| 6 | IO_L19P_6 | M3 | I/O |
| 6 | IO_L20N_6 | M2 | I/O |
| 6 | IO_L20P_6 | M1 | I/O |
| 6 | IO_L21N_6 | L5 | I/O |
| 6 | IO_L21P_6 | L4 | I/O |
| 6 | IO_L22N_6 | L3 | I/O |
| 6 | IO_L22P_6 | L2 | I/O |
| 6 | IO_L23N_6 | K5 | I/O |
| 6 | IO_L23P_6 | K4 | I/O |
| 6 | IO_L24N_6/VREF_6 | K3 | VREF |
| 6 | IO_L24P_6 | K2 | I/O |
| 6 | IO_L39N_6 | J4 | I/O |
| 6 | IO_L39P_6 | J3 | I/O |
| 6 | IO_L40N_6 | J2 | I/O |
| 6 | IO_L40P_6/VREF_6 | J1 | VREF |
| 6 | VCCO_6 | J5 | VCCO |
| 6 | VCCO_6 | J6 | VCCO |
| 6 | VCCO_6 | K6 | VCCO |
| 7 | IO | G2 | I/O |
| 7 | IO_L01N_7/VRP_7 | C1 | DCI |
| 7 | IO_L01P_7/VRN_7 | B1 | DCI |
| 7 | IO_L16N_7 | C2 | I/O |
| 7 | IO_L16P_7/VREF_7 | C3 | VREF |
| 7 | IO_L17N_7 | D1 | I/O |
| 7 | IO_L17P_7 | D2 | I/O |
| 7 | IO_L19N_7/VREF_7 | E3 | VREF |
| 7 | IO_L19P_7 | D3 | I/O |
| 7 | IO_L20N_7 | E1 | I/O |
| 7 | IO_L20P_7 | E2 | I/O |
| 7 | IO_L21N_7 | F4 | I/O |
| 7 | IO_L21P_7 | E4 | I/O |
| 7 | IO_L22N_7 | F2 | I/O |
| 7 | IO_L22P_7 | F3 | I/O |
| 7 | IO_L23N_7 | G5 | I/O |
| 7 | IO_L23P_7 | F5 | I/O |

Table 23: FT256 Package Pinout (Continued)

| Bank | XC3S200 XC3S400 XC3S1000 Pin Name | FT256 Pin Number | Type |
|------|--|------------------------|------|
| 7 | IO_L24N_7 | G3 | I/O |
| 7 | IO_L24P_7 | G4 | I/O |
| 7 | IO_L39N_7 | H3 | I/O |
| 7 | IO_L39P_7 | H4 | I/O |
| 7 | IO_L40N_7/VREF_7 | H1 | VREF |
| 7 | IO_L40P_7 | G1 | I/O |
| 7 | VCCO_7 | G6 | VCCO |
| 7 | VCCO_7 | H5 | VCCO |
| 7 | VCCO_7 | H6 | VCCO |
| N/A | GND | A1 | GND |
| N/A | GND | A16 | GND |
| N/A | GND | B2 | GND |
| N/A | GND | B9 | GND |
| N/A | GND | B15 | GND |
| N/A | GND | F6 | GND |
| N/A | GND | F11 | GND |
| N/A | GND | G7 | GND |
| N/A | GND | G8 | GND |
| N/A | GND | G9 | GND |
| N/A | GND | G10 | GND |
| N/A | GND | H2 | GND |
| N/A | GND | H7 | GND |
| N/A | GND | H8 | GND |
| N/A | GND | H9 | GND |
| N/A | GND | H10 | GND |
| N/A | GND | J7 | GND |
| N/A | GND | J8 | GND |
| N/A | GND | J9 | GND |
| N/A | GND | J10 | GND |
| N/A | GND | J15 | GND |
| N/A | GND | K7 | GND |
| N/A | GND | K8 | GND |
| N/A | GND | K9 | GND |
| N/A | GND | K10 | GND |
| N/A | GND | L6 | GND |
| N/A | GND | L11 | GND |
| N/A | GND | R2 | GND |
| N/A | GND | R8 | GND |
| N/A | GND | R15 | GND |
| N/A | GND | T1 | GND |

Table 23: FT256 Package Pinout (Continued)

| Bank | XC3S200 XC3S400 XC3S1000 Pin Name | FT256 Pin Number | Type |
|------|--|------------------------|--------|
| N/A | GND | T16 | GND |
| N/A | VCCAUX | A6 | VCCAUX |
| N/A | VCCAUX | A11 | VCCAUX |
| N/A | VCCAUX | F1 | VCCAUX |
| N/A | VCCAUX | F16 | VCCAUX |
| N/A | VCCAUX | L1 | VCCAUX |
| N/A | VCCAUX | L16 | VCCAUX |
| N/A | VCCAUX | T6 | VCCAUX |
| N/A | VCCAUX | T11 | VCCAUX |
| N/A | VCCINT | D4 | VCCINT |
| N/A | VCCINT | D13 | VCCINT |
| N/A | VCCINT | E5 | VCCINT |
| N/A | VCCINT | E12 | VCCINT |
| N/A | VCCINT | M5 | VCCINT |
| N/A | VCCINT | M12 | VCCINT |
| N/A | VCCINT | N4 | VCCINT |

Table 23: FT256 Package Pinout (Continued)

| Bank | XC3S200 XC3S400 XC3S1000 Pin Name | FT256 Pin Number | Type |
|--------|--|------------------------|--------|
| N/A | VCCINT | N13 | VCCINT |
| VCCAUX | CCLK | T15 | CONFIG |
| VCCAUX | DONE | R14 | CONFIG |
| VCCAUX | HSWAP_EN | C4 | CONFIG |
| VCCAUX | M0 | P3 | CONFIG |
| VCCAUX | M1 | T2 | CONFIG |
| VCCAUX | M2 | P4 | CONFIG |
| VCCAUX | PROG_B | B3 | CONFIG |
| VCCAUX | TCK | C14 | JTAG |
| VCCAUX | TDI | A2 | JTAG |
| VCCAUX | TDO | A15 | JTAG |
| VCCAUX | TMS | C13 | JTAG |

User I/Os by Bank

Table 24 indicates how the available user-I/O pins are distributed between the eight I/O banks on the FT256 package.

Table 24: User I/Os Per Bank in FT256 Package

| Package Edge | I/O Bank | Maximum I/O | All Possible I/O Pins by Type | | | | |
|--------------|----------|----------------|-------------------------------|------|-----|------|------|
| | | | I/O | DUAL | DCI | VREF | GCLK |
| Top | 0 | 20 | 13 | 0 | 2 | 3 | 2 |
| | 1 | 20 | 13 | 0 | 2 | 3 | 2 |
| Right | 2 | 23 | 18 | 0 | 2 | 3 | 0 |
| | 3 | 23 | 18 | 0 | 2 | 3 | 0 |
| Bottom | 4 | 21 | 8 | 6 | 2 | 3 | 2 |
| | 5 | 20 | 7 | 6 | 2 | 3 | 2 |
| Left | 6 | 23 | 18 | 0 | 2 | 3 | 0 |
| | 7 | 23 | 18 | 0 | 2 | 3 | 0 |

FT256 Footprint

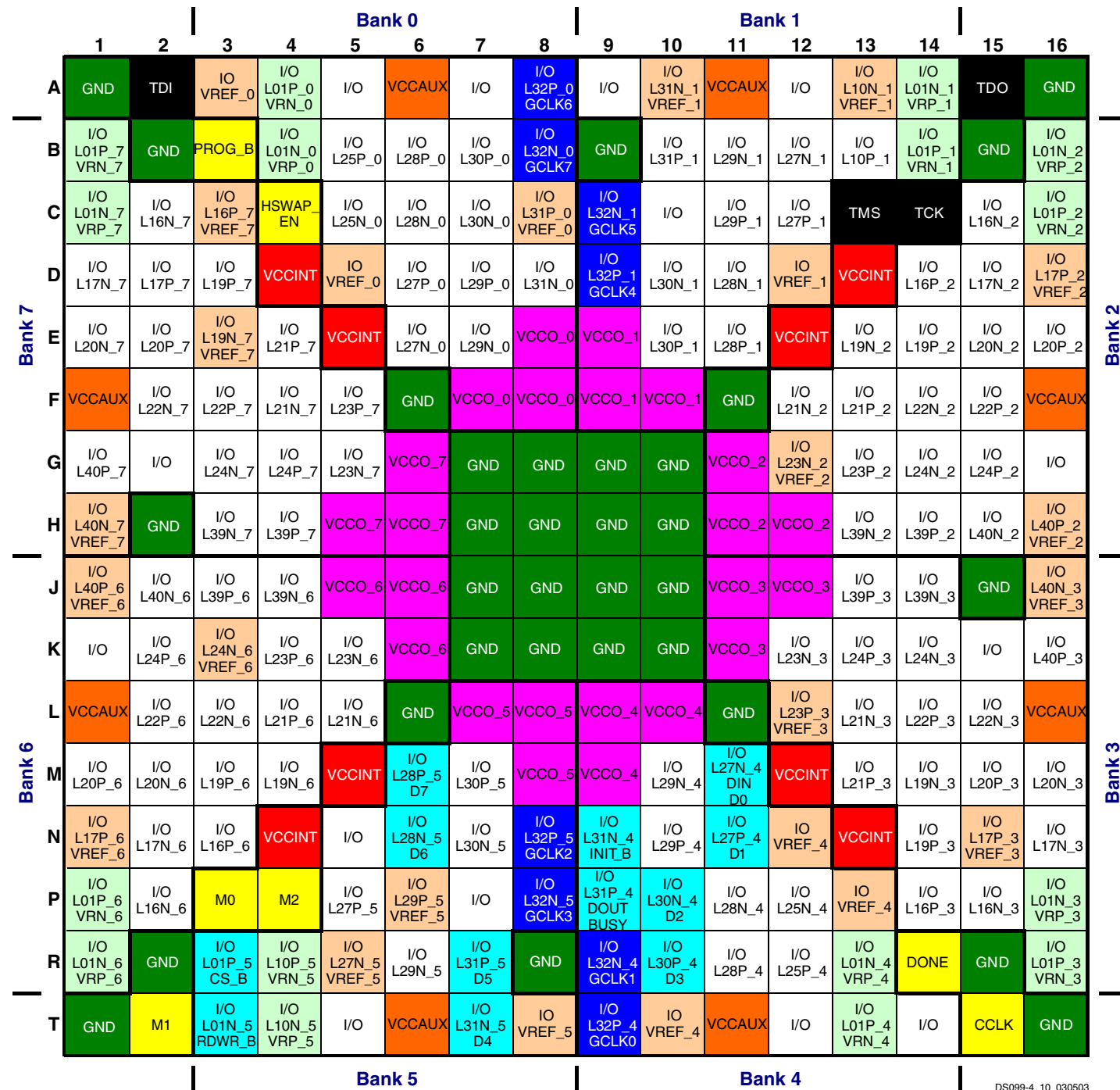


Figure 11: FT256 Package Footprint (top view)

| | | | | | |
|-----|--|----|---|----|--|
| 113 | I/O: Unrestricted, general-purpose user I/O | 12 | DUAL: Configuration pin, then possible user I/O | 24 | VREF: User I/O or input voltage reference for bank |
| 16 | DCI: User I/O or reference resistor input for bank | 8 | GCLK: User I/O or global clock buffer input | 24 | VCCO: Output voltage supply for bank |
| 7 | CONFIG: Dedicated configuration pins | 4 | JTAG: Dedicated JTAG port pins | 8 | VCCINT: Internal core voltage supply (+1.2V) |
| 0 | N.C.: No unconnected pins in this package | 32 | GND: Ground | 8 | VCCAUX: Auxiliary voltage supply (+2.5V) |

FG456: 456-lead Fine-pitch Ball Grid Array

The 456-lead fine-pitch ball grid array package, FG456, supports three different Spartan-3 devices, including the XC3S400, the XC3S1000, and the XC3S1500. The footprints for the XC3S1000 and XC3S1500 are identical, as shown in [Table 25](#) and [Figure 12](#). The XC3S400, however, has fewer I/O pins which consequently results in 69 unconnected pins on the FG456 package, labeled as “N.C.” In [Table 25](#) and [Figure 12](#), these unconnected pins are indicated with a black diamond symbol (◆).

All the package pins appear in [Table 25](#) and are sorted by bank number, then by pin name. Pairs of pins that form a differential I/O pair appear together in the table. The table also shows the pin number for each pin and the pin type, as defined earlier.

If there is a difference between the XC3S400 pinout and the pinout for the XC3S1000 and XC3S1500, then that difference is highlighted in [Table 25](#). If the table entry is shaded grey, then there is an unconnected pin on the XC3S400 that maps to a user-I/O pin on the XC3S1000 and XC3S1500. If the table entry is shaded tan, then the unconnected pin on the XC3S400 maps to a VREF-type pin on the XC3S1000 and XC3S1500. If the other VREF pins in the bank all connect to a voltage reference to support a special I/O standard, then also connect the N.C. pin on the XC3S400 to the same VREF voltage. This provides maximum flexibility as you could potentially migrate a design from the XC3S400 device to an XC3S1000 or XC3S1500 FPGA without changing the printed circuit board.

Pinout Table

Table 25: FG456 Package Pinout

| Bank | 3S400 Pin Name | 3S1000 3S1500 Pin Name | FG456 Pin Number | Type |
|------|---------------------|------------------------------|------------------------|------|
| 0 | IO | IO | A10 | I/O |
| 0 | IO | IO | D9 | I/O |
| 0 | IO | IO | D10 | I/O |
| 0 | IO | IO | F6 | I/O |
| 0 | IO/VREF_0 | IO/VREF_0 | A3 | VREF |
| 0 | IO/VREF_0 | IO/VREF_0 | C7 | VREF |
| 0 | N.C. (◆) | IO/VREF_0 | E5 | VREF |
| 0 | IO/VREF_0 | IO/VREF_0 | F7 | VREF |
| 0 | IO_L01N_0/ VRP_0 | IO_L01N_0/ VRP_0 | B4 | DCI |
| 0 | IO_L01P_0/ VRN_0 | IO_L01P_0/ VRN_0 | A4 | DCI |
| 0 | IO_L06N_0 | IO_L06N_0 | D5 | I/O |
| 0 | IO_L06P_0 | IO_L06P_0 | C5 | I/O |
| 0 | IO_L09N_0 | IO_L09N_0 | B5 | I/O |
| 0 | IO_L09P_0 | IO_L09P_0 | A5 | I/O |

Table 25: FG456 Package Pinout (Continued)

| Bank | 3S400 Pin Name | 3S1000 3S1500 Pin Name | FG456 Pin Number | Type |
|------|----------------------|------------------------------|------------------------|------|
| 0 | IO_L10N_0 | IO_L10N_0 | E6 | I/O |
| 0 | IO_L10P_0 | IO_L10P_0 | D6 | I/O |
| 0 | IO_L15N_0 | IO_L15N_0 | C6 | I/O |
| 0 | IO_L15P_0 | IO_L15P_0 | B6 | I/O |
| 0 | IO_L16N_0 | IO_L16N_0 | E7 | I/O |
| 0 | IO_L16P_0 | IO_L16P_0 | D7 | I/O |
| 0 | N.C. (◆) | IO_L19N_0 | B7 | I/O |
| 0 | N.C. (◆) | IO_L19P_0 | A7 | I/O |
| 0 | N.C. (◆) | IO_L22N_0 | E8 | I/O |
| 0 | N.C. (◆) | IO_L22P_0 | D8 | I/O |
| 0 | IO_L24N_0 | IO_L24N_0 | B8 | I/O |
| 0 | IO_L24P_0 | IO_L24P_0 | A8 | I/O |
| 0 | IO_L25N_0 | IO_L25N_0 | F9 | I/O |
| 0 | IO_L25P_0 | IO_L25P_0 | E9 | I/O |
| 0 | IO_L27N_0 | IO_L27N_0 | B9 | I/O |
| 0 | IO_L27P_0 | IO_L27P_0 | A9 | I/O |
| 0 | IO_L28N_0 | IO_L28N_0 | F10 | I/O |
| 0 | IO_L28P_0 | IO_L28P_0 | E10 | I/O |
| 0 | IO_L29N_0 | IO_L29N_0 | C10 | I/O |
| 0 | IO_L29P_0 | IO_L29P_0 | B10 | I/O |
| 0 | IO_L30N_0 | IO_L30N_0 | F11 | I/O |
| 0 | IO_L30P_0 | IO_L30P_0 | E11 | I/O |
| 0 | IO_L31N_0 | IO_L31N_0 | D11 | I/O |
| 0 | IO_L31P_0/ VREF_0 | IO_L31P_0/ VREF_0 | C11 | VREF |
| 0 | IO_L32N_0/ GCLK7 | IO_L32N_0/ GCLK7 | B11 | GCLK |
| 0 | IO_L32P_0/ GCLK6 | IO_L32P_0/ GCLK6 | A11 | GCLK |
| 0 | VCCO_0 | VCCO_0 | C8 | VCCO |
| 0 | VCCO_0 | VCCO_0 | F8 | VCCO |
| 0 | VCCO_0 | VCCO_0 | G9 | VCCO |
| 0 | VCCO_0 | VCCO_0 | G10 | VCCO |
| 0 | VCCO_0 | VCCO_0 | G11 | VCCO |
| 1 | IO | IO | A12 | I/O |
| 1 | IO | IO | E16 | I/O |
| 1 | IO | IO | F12 | I/O |
| 1 | IO | IO | F13 | I/O |
| 1 | IO | IO | F16 | I/O |
| 1 | IO | IO | F17 | I/O |
| 1 | IO/VREF_1 | IO/VREF_1 | E13 | VREF |
| 1 | N.C. (◆) | IO/VREF_1 | F14 | VREF |
| 1 | IO_L01N_1/ VRP_1 | IO_L01N_1/ VRP_1 | C19 | DCI |
| 1 | IO_L01P_1/ VRN_1 | IO_L01P_1/ VRN_1 | B20 | DCI |

Table 25: FG456 Package Pinout (Continued)

| Bank | 3S400 Pin Name | 3S1000 3S1500 Pin Name | FG456 Pin Number | Type |
|------|----------------------|------------------------------|------------------------|------|
| 1 | IO_L06N_1/ VREF_1 | IO_L06N_1/ VREF_1 | A19 | VREF |
| 1 | IO_L06P_1 | IO_L06P_1 | B19 | I/O |
| 1 | IO_L09N_1 | IO_L09N_1 | C18 | I/O |
| 1 | IO_L09P_1 | IO_L09P_1 | D18 | I/O |
| 1 | IO_L10N_1/ VREF_1 | IO_L10N_1/ VREF_1 | A18 | VREF |
| 1 | IO_L10P_1 | IO_L10P_1 | B18 | I/O |
| 1 | IO_L15N_1 | IO_L15N_1 | D17 | I/O |
| 1 | IO_L15P_1 | IO_L15P_1 | E17 | I/O |
| 1 | IO_L16N_1 | IO_L16N_1 | B17 | I/O |
| 1 | IO_L16P_1 | IO_L16P_1 | C17 | I/O |
| 1 | N.C. (◆) | IO_L19N_1 | C16 | I/O |
| 1 | N.C. (◆) | IO_L19P_1 | D16 | I/O |
| 1 | N.C. (◆) | IO_L22N_1 | A16 | I/O |
| 1 | N.C. (◆) | IO_L22P_1 | B16 | I/O |
| 1 | IO_L24N_1 | IO_L24N_1 | D15 | I/O |
| 1 | IO_L24P_1 | IO_L24P_1 | E15 | I/O |
| 1 | IO_L25N_1 | IO_L25N_1 | B15 | I/O |
| 1 | IO_L25P_1 | IO_L25P_1 | A15 | I/O |
| 1 | IO_L27N_1 | IO_L27N_1 | D14 | I/O |
| 1 | IO_L27P_1 | IO_L27P_1 | E14 | I/O |
| 1 | IO_L28N_1 | IO_L28N_1 | A14 | I/O |
| 1 | IO_L28P_1 | IO_L28P_1 | B14 | I/O |
| 1 | IO_L29N_1 | IO_L29N_1 | C13 | I/O |
| 1 | IO_L29P_1 | IO_L29P_1 | D13 | I/O |
| 1 | IO_L30N_1 | IO_L30N_1 | A13 | I/O |
| 1 | IO_L30P_1 | IO_L30P_1 | B13 | I/O |
| 1 | IO_L31N_1/ VREF_1 | IO_L31N_1/ VREF_1 | D12 | VREF |
| 1 | IO_L31P_1 | IO_L31P_1 | E12 | I/O |
| 1 | IO_L32N_1/ GCLK5 | IO_L32N_1/ GCLK5 | B12 | GCLK |
| 1 | IO_L32P_1/ GCLK4 | IO_L32P_1/ GCLK4 | C12 | GCLK |
| 1 | VCCO_1 | VCCO_1 | C15 | VCCO |
| 1 | VCCO_1 | VCCO_1 | F15 | VCCO |
| 1 | VCCO_1 | VCCO_1 | G12 | VCCO |
| 1 | VCCO_1 | VCCO_1 | G13 | VCCO |
| 1 | VCCO_1 | VCCO_1 | G14 | VCCO |
| 2 | IO | IO | C22 | I/O |
| 2 | IO_L01N_2/ VRP_2 | IO_L01N_2/ VRP_2 | C20 | DCI |
| 2 | IO_L01P_2/ VRN_2 | IO_L01P_2/ VRN_2 | C21 | DCI |
| 2 | IO_L16N_2 | IO_L16N_2 | D20 | I/O |

Table 25: FG456 Package Pinout (Continued)

| Bank | 3S400 Pin Name | 3S1000 3S1500 Pin Name | FG456 Pin Number | Type |
|------|----------------------|------------------------------|------------------------|------|
| 2 | IO_L16P_2 | IO_L16P_2 | D19 | I/O |
| 2 | IO_L17N_2 | IO_L17N_2 | D21 | I/O |
| 2 | IO_L17P_2 /VREF_2 | IO_L17P_2/ VREF_2 | D22 | VREF |
| 2 | IO_L19N_2 | IO_L19N_2 | E18 | I/O |
| 2 | IO_L19P_2 | IO_L19P_2 | F18 | I/O |
| 2 | IO_L20N_2 | IO_L20N_2 | E19 | I/O |
| 2 | IO_L20P_2 | IO_L20P_2 | E20 | I/O |
| 2 | IO_L21N_2 | IO_L21N_2 | E21 | I/O |
| 2 | IO_L21P_2 | IO_L21P_2 | E22 | I/O |
| 2 | IO_L22N_2 | IO_L22N_2 | G17 | I/O |
| 2 | IO_L22P_2 | IO_L22P_2 | G18 | I/O |
| 2 | IO_L23N_2 /VREF_2 | IO_L23N_2/ VREF_2 | F19 | VREF |
| 2 | IO_L23P_2 | IO_L23P_2 | G19 | I/O |
| 2 | IO_L24N_2 | IO_L24N_2 | F20 | I/O |
| 2 | IO_L24P_2 | IO_L24P_2 | F21 | I/O |
| 2 | N.C. (◆) | IO_L26N_2 | G20 | I/O |
| 2 | N.C. (◆) | IO_L26P_2 | H19 | I/O |
| 2 | IO_L27N_2 | IO_L27N_2 | G21 | I/O |
| 2 | IO_L27P_2 | IO_L27P_2 | G22 | I/O |
| 2 | N.C. (◆) | IO_L28N_2 | H18 | I/O |
| 2 | N.C. (◆) | IO_L28P_2 | J17 | I/O |
| 2 | N.C. (◆) | IO_L29N_2 | H21 | I/O |
| 2 | N.C. (◆) | IO_L29P_2 | H22 | I/O |
| 2 | N.C. (◆) | IO_L31N_2 | J18 | I/O |
| 2 | N.C. (◆) | IO_L31P_2 | J19 | I/O |
| 2 | N.C. (◆) | IO_L32N_2 | J21 | I/O |
| 2 | N.C. (◆) | IO_L32P_2 | J22 | I/O |
| 2 | N.C. (◆) | IO_L33N_2 | K17 | I/O |
| 2 | N.C. (◆) | IO_L33P_2 | K18 | I/O |
| 2 | IO_L34N_2/ VREF_2 | IO_L34N_2/ VREF_2 | K19 | VREF |
| 2 | IO_L34P_2 | IO_L34P_2 | K20 | I/O |
| 2 | IO_L35N_2 | IO_L35N_2 | K21 | I/O |
| 2 | IO_L35P_2 | IO_L35P_2 | K22 | I/O |
| 2 | IO_L38N_2 | IO_L38N_2 | L17 | I/O |
| 2 | IO_L38P_2 | IO_L38P_2 | L18 | I/O |
| 2 | IO_L39N_2 | IO_L39N_2 | L19 | I/O |
| 2 | IO_L39P_2 | IO_L39P_2 | L20 | I/O |
| 2 | IO_L40N_2 | IO_L40N_2 | L21 | I/O |
| 2 | IO_L40P_2/ VREF_2 | IO_L40P_2/ VREF_2 | L22 | VREF |
| 2 | VCCO_2 | VCCO_2 | H17 | VCCO |
| 2 | VCCO_2 | VCCO_2 | H20 | VCCO |

Table 25: FG456 Package Pinout (Continued)

| Bank | 3S400 Pin Name | 3S1000 3S1500 Pin Name | FG456 Pin Number | Type |
|------|----------------------|------------------------------|------------------------|------|
| 2 | VCCO_2 | VCCO_2 | J16 | VCCO |
| 2 | VCCO_2 | VCCO_2 | K16 | VCCO |
| 2 | VCCO_2 | VCCO_2 | L16 | VCCO |
| 3 | IO | IO | Y21 | I/O |
| 3 | IO_L01N_3/ VRP_3 | IO_L01N_3/ VRP_3 | Y20 | DCI |
| 3 | IO_L01P_3/ VRN_3 | IO_L01P_3/ VRN_3 | Y19 | DCI |
| 3 | IO_L16N_3 | IO_L16N_3 | W22 | I/O |
| 3 | IO_L16P_3 | IO_L16P_3 | Y22 | I/O |
| 3 | IO_L17N_3 | IO_L17N_3 | V19 | I/O |
| 3 | IO_L17P_3/ VREF_3 | IO_L17P_3/ VREF_3 | W19 | VREF |
| 3 | IO_L19N_3 | IO_L19N_3 | W21 | I/O |
| 3 | IO_L19P_3 | IO_L19P_3 | W20 | I/O |
| 3 | IO_L20N_3 | IO_L20N_3 | U19 | I/O |
| 3 | IO_L20P_3 | IO_L20P_3 | V20 | I/O |
| 3 | IO_L21N_3 | IO_L21N_3 | V22 | I/O |
| 3 | IO_L21P_3 | IO_L21P_3 | V21 | I/O |
| 3 | IO_L22N_3 | IO_L22N_3 | T17 | I/O |
| 3 | IO_L22P_3 | IO_L22P_3 | U18 | I/O |
| 3 | IO_L23N_3 | IO_L23N_3 | U21 | I/O |
| 3 | IO_L23P_3/ VREF_3 | IO_L23P_3/ VREF_3 | U20 | VREF |
| 3 | IO_L24N_3 | IO_L24N_3 | R18 | I/O |
| 3 | IO_L24P_3 | IO_L24P_3 | T18 | I/O |
| 3 | N.C. (◆) | IO_L26N_3 | T20 | I/O |
| 3 | N.C. (◆) | IO_L26P_3 | T19 | I/O |
| 3 | IO_L27N_3 | IO_L27N_3 | T22 | I/O |
| 3 | IO_L27P_3 | IO_L27P_3 | T21 | I/O |
| 3 | N.C. (◆) | IO_L28N_3 | R22 | I/O |
| 3 | N.C. (◆) | IO_L28P_3 | R21 | I/O |
| 3 | N.C. (◆) | IO_L29N_3 | P19 | I/O |
| 3 | N.C. (◆) | IO_L29P_3 | R19 | I/O |
| 3 | N.C. (◆) | IO_L31N_3 | P18 | I/O |
| 3 | N.C. (◆) | IO_L31P_3 | P17 | I/O |
| 3 | N.C. (◆) | IO_L32N_3 | P22 | I/O |
| 3 | N.C. (◆) | IO_L32P_3 | P21 | I/O |
| 3 | N.C. (◆) | IO_L33N_3 | N18 | I/O |
| 3 | N.C. (◆) | IO_L33P_3 | N17 | I/O |
| 3 | IO_L34N_3 | IO_L34N_3 | N20 | I/O |
| 3 | IO_L34P_3/ VREF_3 | IO_L34P_3/ VREF_3 | N19 | VREF |
| 3 | IO_L35N_3 | IO_L35N_3 | N22 | I/O |
| 3 | IO_L35P_3 | IO_L35P_3 | N21 | I/O |
| 3 | IO_L38N_3 | IO_L38N_3 | M18 | I/O |

Table 25: FG456 Package Pinout (Continued)

| Bank | 3S400 Pin Name | 3S1000 3S1500 Pin Name | FG456 Pin Number | Type |
|------|----------------------|------------------------------|------------------------|------|
| 3 | IO_L38P_3 | IO_L38P_3 | M17 | I/O |
| 3 | IO_L39N_3 | IO_L39N_3 | M20 | I/O |
| 3 | IO_L39P_3 | IO_L39P_3 | M19 | I/O |
| 3 | IO_L40N_3/ VREF_3 | IO_L40N_3/ VREF_3 | M22 | VREF |
| 3 | IO_L40P_3 | IO_L40P_3 | M21 | I/O |
| 3 | VCCO_3 | VCCO_3 | M16 | VCCO |
| 3 | VCCO_3 | VCCO_3 | N16 | VCCO |
| 3 | VCCO_3 | VCCO_3 | P16 | VCCO |
| 3 | VCCO_3 | VCCO_3 | R17 | VCCO |
| 3 | VCCO_3 | VCCO_3 | R20 | VCCO |
| 4 | IO | IO | U16 | I/O |
| 4 | IO | IO | U17 | I/O |
| 4 | IO | IO | W13 | I/O |
| 4 | IO | IO | W14 | I/O |
| 4 | IO/VREF_4 | IO/VREF_4 | AB13 | VREF |
| 4 | IO/VREF_4 | IO/VREF_4 | V18 | VREF |
| 4 | IO/VREF_4 | IO/VREF_4 | Y16 | VREF |
| 4 | IO_L01N_4/ VRP_4 | IO_L01N_4/ VRP_4 | AA20 | DCI |
| 4 | IO_L01P_4/ VRN_4 | IO_L01P_4/ VRN_4 | AB20 | DCI |
| 4 | N.C. (◆) | IO_L05N_4 | AA19 | I/O |
| 4 | N.C. (◆) | IO_L05P_4 | AB19 | I/O |
| 4 | IO_L06N_4/ VREF_4 | IO_L06N_4/ VREF_4 | W18 | VREF |
| 4 | IO_L06P_4 | IO_L06P_4 | Y18 | I/O |
| 4 | IO_L09N_4 | IO_L09N_4 | AA18 | I/O |
| 4 | IO_L09P_4 | IO_L09P_4 | AB18 | I/O |
| 4 | IO_L10N_4 | IO_L10N_4 | V17 | I/O |
| 4 | IO_L10P_4 | IO_L10P_4 | W17 | I/O |
| 4 | IO_L15N_4 | IO_L15N_4 | Y17 | I/O |
| 4 | IO_L15P_4 | IO_L15P_4 | AA17 | I/O |
| 4 | IO_L16N_4 | IO_L16N_4 | V16 | I/O |
| 4 | IO_L16P_4 | IO_L16P_4 | W16 | I/O |
| 4 | N.C. (◆) | IO_L19N_4 | AA16 | I/O |
| 4 | N.C. (◆) | IO_L19P_4 | AB16 | I/O |
| 4 | N.C. (◆) | IO_L22N_4/ VREF_4 | V15 | VREF |
| 4 | N.C. (◆) | IO_L22P_4 | W15 | I/O |
| 4 | IO_L24N_4 | IO_L24N_4 | AA15 | I/O |
| 4 | IO_L24P_4 | IO_L24P_4 | AB15 | I/O |
| 4 | IO_L25N_4 | IO_L25N_4 | U14 | I/O |
| 4 | IO_L25P_4 | IO_L25P_4 | V14 | I/O |
| 4 | IO_L27N_4/ DIN/D0 | IO_L27N_4/ DIN/D0 | AA14 | DUAL |

Table 25: FG456 Package Pinout (Continued)

| Bank | 3S400 Pin Name | 3S1000 3S1500 Pin Name | FG456 Pin Number | Type |
|------|-------------------------|------------------------------|------------------------|------|
| 4 | IO_L27P_4/ D1 | IO_L27P_4/ D1 | AB14 | DUAL |
| 4 | IO_L28N_4 | IO_L28N_4 | U13 | I/O |
| 4 | IO_L28P_4 | IO_L28P_4 | V13 | I/O |
| 4 | IO_L29N_4 | IO_L29N_4 | Y13 | I/O |
| 4 | IO_L29P_4 | IO_L29P_4 | AA13 | I/O |
| 4 | IO_L30N_4/ D2 | IO_L30N_4/ D2 | U12 | DUAL |
| 4 | IO_L30P_4/ D3 | IO_L30P_4/ D3 | V12 | DUAL |
| 4 | IO_L31N_4/ INIT_B | IO_L31N_4/ INIT_B | W12 | DUAL |
| 4 | IO_L31P_4/ DOUT/BUSY | IO_L31P_4/ DOUT/BUSY | Y12 | DUAL |
| 4 | IO_L32N_4/ GCLK1 | IO_L32N_4/ GCLK1 | AA12 | GCLK |
| 4 | IO_L32P_4/ GCLK0 | IO_L32P_4/ GCLK0 | AB12 | GCLK |
| 4 | VCCO_4 | VCCO_4 | T12 | VCCO |
| 4 | VCCO_4 | VCCO_4 | T13 | VCCO |
| 4 | VCCO_4 | VCCO_4 | T14 | VCCO |
| 4 | VCCO_4 | VCCO_4 | U15 | VCCO |
| 4 | VCCO_4 | VCCO_4 | Y15 | VCCO |
| 5 | IO | IO | U7 | I/O |
| 5 | N.C. (◆) | IO | U9 | I/O |
| 5 | IO | IO | U10 | I/O |
| 5 | IO | IO | U11 | I/O |
| 5 | IO | IO | V7 | I/O |
| 5 | IO | IO | V10 | I/O |
| 5 | IO/VREF_5 | IO/VREF_5 | AB11 | VREF |
| 5 | IO/VREF_5 | IO/VREF_5 | U6 | VREF |
| 5 | IO_L01N_5/ RDWR_B | IO_L01N_5/ RDWR_B | Y4 | DUAL |
| 5 | IO_L01P_5/ CS_B | IO_L01P_5/ CS_B | AA3 | DUAL |
| 5 | IO_L06N_5 | IO_L06N_5 | AB4 | I/O |
| 5 | IO_L06P_5 | IO_L06P_5 | AA4 | I/O |
| 5 | IO_L09N_5 | IO_L09N_5 | Y5 | I/O |
| 5 | IO_L09P_5 | IO_L09P_5 | W5 | I/O |
| 5 | IO_L10N_5/ VRP_5 | IO_L10N_5/ VRP_5 | AB5 | DCI |
| 5 | IO_L10P_5/ VRN_5 | IO_L10P_5/ VRN_5 | AA5 | DCI |
| 5 | IO_L15N_5 | IO_L15N_5 | W6 | I/O |
| 5 | IO_L15P_5 | IO_L15P_5 | V6 | I/O |
| 5 | IO_L16N_5 | IO_L16N_5 | AA6 | I/O |
| 5 | IO_L16P_5 | IO_L16P_5 | Y6 | I/O |

Table 25: FG456 Package Pinout (Continued)

| Bank | 3S400 Pin Name | 3S1000 3S1500 Pin Name | FG456 Pin Number | Type |
|------|----------------------|------------------------------|------------------------|------|
| 5 | N.C. (◆) | IO_L19N_5 | Y7 | I/O |
| 5 | N.C. (◆) | IO_L19P_5/ VREF_5 | W7 | VREF |
| 5 | N.C. (◆) | IO_L22N_5 | AB7 | I/O |
| 5 | N.C. (◆) | IO_L22P_5 | AA7 | I/O |
| 5 | IO_L24N_5 | IO_L24N_5 | W8 | I/O |
| 5 | IO_L24P_5 | IO_L24P_5 | V8 | I/O |
| 5 | IO_L25N_5 | IO_L25N_5 | AB8 | I/O |
| 5 | IO_L25P_5 | IO_L25P_5 | AA8 | I/O |
| 5 | IO_L27N_5/ VREF_5 | IO_L27N_5/ VREF_5 | W9 | VREF |
| 5 | IO_L27P_5 | IO_L27P_5 | V9 | I/O |
| 5 | IO_L28N_5/ D6 | IO_L28N_5/ D6 | AB9 | DUAL |
| 5 | IO_L28P_5/ D7 | IO_L28P_5/ D7 | AA9 | DUAL |
| 5 | IO_L29N_5 | IO_L29N_5 | Y10 | I/O |
| 5 | IO_L29P_5/ VREF_5 | IO_L29P_5/ VREF_5 | W10 | VREF |
| 5 | IO_L30N_5 | IO_L30N_5 | AB10 | I/O |
| 5 | IO_L30P_5 | IO_L30P_5 | AA10 | I/O |
| 5 | IO_L31N_5/ D4 | IO_L31N_5/ D4 | W11 | DUAL |
| 5 | IO_L31P_5/ D5 | IO_L31P_5/ D5 | V11 | DUAL |
| 5 | IO_L32N_5/ GCLK3 | IO_L32N_5/ GCLK3 | AA11 | GCLK |
| 5 | IO_L32P_5/ GCLK2 | IO_L32P_5/ GCLK2 | Y11 | GCLK |
| 5 | VCCO_5 | VCCO_5 | T9 | VCCO |
| 5 | VCCO_5 | VCCO_5 | T10 | VCCO |
| 5 | VCCO_5 | VCCO_5 | T11 | VCCO |
| 5 | VCCO_5 | VCCO_5 | U8 | VCCO |
| 5 | VCCO_5 | VCCO_5 | Y8 | VCCO |
| 6 | IO | IO | Y1 | I/O |
| 6 | IO_L01N_6/ VRP_6 | IO_L01N_6/ VRP_6 | Y3 | DCI |
| 6 | IO_L01P_6/ VRN_6 | IO_L01P_6/ VRN_6 | Y2 | DCI |
| 6 | IO_L16N_6 | IO_L16N_6 | W4 | I/O |
| 6 | IO_L16P_6 | IO_L16P_6 | W3 | I/O |
| 6 | IO_L17N_6 | IO_L17N_6 | W2 | I/O |
| 6 | IO_L17P_6/ VREF_6 | IO_L17P_6/ VREF_6 | W1 | VREF |
| 6 | IO_L19N_6 | IO_L19N_6 | V5 | I/O |
| 6 | IO_L19P_6 | IO_L19P_6 | U5 | I/O |
| 6 | IO_L20N_6 | IO_L20N_6 | V4 | I/O |

Table 25: FG456 Package Pinout (Continued)

| Bank | 3S400 Pin Name | 3S1000 3S1500 Pin Name | FG456 Pin Number | Type |
|------|----------------------|------------------------------|------------------------|------|
| 6 | IO_L20P_6 | IO_L20P_6 | V3 | I/O |
| 6 | IO_L21N_6 | IO_L21N_6 | V2 | I/O |
| 6 | IO_L21P_6 | IO_L21P_6 | V1 | I/O |
| 6 | IO_L22N_6 | IO_L22N_6 | T6 | I/O |
| 6 | IO_L22P_6 | IO_L22P_6 | T5 | I/O |
| 6 | IO_L23N_6 | IO_L23N_6 | U4 | I/O |
| 6 | IO_L23P_6 | IO_L23P_6 | T4 | I/O |
| 6 | IO_L24N_6/ VREF_6 | IO_L24N_6/ VREF_6 | U3 | VREF |
| 6 | IO_L24P_6 | IO_L24P_6 | U2 | I/O |
| 6 | N.C. (◆) | IO_L26N_6 | T3 | I/O |
| 6 | N.C. (◆) | IO_L26P_6 | R4 | I/O |
| 6 | IO_L27N_6 | IO_L27N_6 | T2 | I/O |
| 6 | IO_L27P_6 | IO_L27P_6 | T1 | I/O |
| 6 | N.C. (◆) | IO_L28N_6 | R5 | I/O |
| 6 | N.C. (◆) | IO_L28P_6 | P6 | I/O |
| 6 | N.C. (◆) | IO_L29N_6 | R2 | I/O |
| 6 | N.C. (◆) | IO_L29P_6 | R1 | I/O |
| 6 | N.C. (◆) | IO_L31N_6 | P5 | I/O |
| 6 | N.C. (◆) | IO_L31P_6 | P4 | I/O |
| 6 | N.C. (◆) | IO_L32N_6 | P2 | I/O |
| 6 | N.C. (◆) | IO_L32P_6 | P1 | I/O |
| 6 | N.C. (◆) | IO_L33N_6 | N6 | I/O |
| 6 | N.C. (◆) | IO_L33P_6 | N5 | I/O |
| 6 | IO_L34N_6/ VREF_6 | IO_L34N_6/ VREF_6 | N4 | VREF |
| 6 | IO_L34P_6 | IO_L34P_6 | N3 | I/O |
| 6 | IO_L35N_6 | IO_L35N_6 | N2 | I/O |
| 6 | IO_L35P_6 | IO_L35P_6 | N1 | I/O |
| 6 | IO_L38N_6 | IO_L38N_6 | M6 | I/O |
| 6 | IO_L38P_6 | IO_L38P_6 | M5 | I/O |
| 6 | IO_L39N_6 | IO_L39N_6 | M4 | I/O |
| 6 | IO_L39P_6 | IO_L39P_6 | M3 | I/O |
| 6 | IO_L40N_6 | IO_L40N_6 | M2 | I/O |
| 6 | IO_L40P_6/ VREF_6 | IO_L40P_6/ VREF_6 | M1 | VREF |
| 6 | VCCO_6 | VCCO_6 | M7 | VCCO |
| 6 | VCCO_6 | VCCO_6 | N7 | VCCO |
| 6 | VCCO_6 | VCCO_6 | P7 | VCCO |
| 6 | VCCO_6 | VCCO_6 | R3 | VCCO |
| 6 | VCCO_6 | VCCO_6 | R6 | VCCO |
| 7 | IO | IO | C2 | I/O |
| 7 | IO_L01N_7/ VRP_7 | IO_L01N_7/ VRP_7 | C3 | DCI |
| 7 | IO_L01P_7/ VRN_7 | IO_L01P_7/ VRN_7 | C4 | DCI |

Table 25: FG456 Package Pinout (Continued)

| Bank | 3S400 Pin Name | 3S1000 3S1500 Pin Name | FG456 Pin Number | Type |
|------|----------------------|------------------------------|------------------------|------|
| 7 | IO_L16N_7 | IO_L16N_7 | D1 | I/O |
| 7 | IO_L16P_7/ VREF_7 | IO_L16P_7/ VREF_7 | C1 | VREF |
| 7 | IO_L17N_7 | IO_L17N_7 | E4 | I/O |
| 7 | IO_L17P_7 | IO_L17P_7 | D4 | I/O |
| 7 | IO_L19N_7/ VREF_7 | IO_L19N_7/ VREF_7 | D3 | VREF |
| 7 | IO_L19P_7 | IO_L19P_7 | D2 | I/O |
| 7 | IO_L20N_7 | IO_L20N_7 | F4 | I/O |
| 7 | IO_L20P_7 | IO_L20P_7 | E3 | I/O |
| 7 | IO_L21N_7 | IO_L21N_7 | E1 | I/O |
| 7 | IO_L21P_7 | IO_L21P_7 | E2 | I/O |
| 7 | IO_L22N_7 | IO_L22N_7 | G6 | I/O |
| 7 | IO_L22P_7 | IO_L22P_7 | F5 | I/O |
| 7 | IO_L23N_7 | IO_L23N_7 | F2 | I/O |
| 7 | IO_L23P_7 | IO_L23P_7 | F3 | I/O |
| 7 | IO_L24N_7 | IO_L24N_7 | H5 | I/O |
| 7 | IO_L24P_7 | IO_L24P_7 | G5 | I/O |
| 7 | N.C. (◆) | IO_L26N_7 | G3 | I/O |
| 7 | N.C. (◆) | IO_L26P_7 | G4 | I/O |
| 7 | IO_L27N_7 | IO_L27N_7 | G1 | I/O |
| 7 | IO_L27P_7/ VREF_7 | IO_L27P_7/ VREF_7 | G2 | VREF |
| 7 | N.C. (◆) | IO_L28N_7 | H1 | I/O |
| 7 | N.C. (◆) | IO_L28P_7 | H2 | I/O |
| 7 | N.C. (◆) | IO_L29N_7 | J4 | I/O |
| 7 | N.C. (◆) | IO_L29P_7 | H4 | I/O |
| 7 | N.C. (◆) | IO_L31N_7 | J5 | I/O |
| 7 | N.C. (◆) | IO_L31P_7 | J6 | I/O |
| 7 | N.C. (◆) | IO_L32N_7 | J1 | I/O |
| 7 | N.C. (◆) | IO_L32P_7 | J2 | I/O |
| 7 | N.C. (◆) | IO_L33N_7 | K5 | I/O |
| 7 | N.C. (◆) | IO_L33P_7 | K6 | I/O |
| 7 | IO_L34N_7 | IO_L34N_7 | K3 | I/O |
| 7 | IO_L34P_7 | IO_L34P_7 | K4 | I/O |
| 7 | IO_L35N_7 | IO_L35N_7 | K1 | I/O |
| 7 | IO_L35P_7 | IO_L35P_7 | K2 | I/O |
| 7 | IO_L38N_7 | IO_L38N_7 | L5 | I/O |
| 7 | IO_L38P_7 | IO_L38P_7 | L6 | I/O |
| 7 | IO_L39N_7 | IO_L39N_7 | L3 | I/O |
| 7 | IO_L39P_7 | IO_L39P_7 | L4 | I/O |
| 7 | IO_L40N_7/ VREF_7 | IO_L40N_7/ VREF_7 | L1 | VREF |
| 7 | IO_L40P_7 | IO_L40P_7 | L2 | I/O |
| 7 | VCCO_7 | VCCO_7 | H3 | VCCO |
| 7 | VCCO_7 | VCCO_7 | H6 | VCCO |

Table 25: FG456 Package Pinout (Continued)

| Bank | 3S400 Pin Name | 3S1000 3S1500 Pin Name | FG456 Pin Number | Type |
|------|-------------------|------------------------------|------------------------|------|
| 7 | VCCO_7 | VCCO_7 | J7 | VCCO |
| 7 | VCCO_7 | VCCO_7 | K7 | VCCO |
| 7 | VCCO_7 | VCCO_7 | L7 | VCCO |
| N/A | GND | GND | A1 | GND |
| N/A | GND | GND | A22 | GND |
| N/A | GND | GND | AA2 | GND |
| N/A | GND | GND | AA21 | GND |
| N/A | GND | GND | AB1 | GND |
| N/A | GND | GND | AB22 | GND |
| N/A | GND | GND | B2 | GND |
| N/A | GND | GND | B21 | GND |
| N/A | GND | GND | C9 | GND |
| N/A | GND | GND | C14 | GND |
| N/A | GND | GND | J3 | GND |
| N/A | GND | GND | J9 | GND |
| N/A | GND | GND | J10 | GND |
| N/A | GND | GND | J11 | GND |
| N/A | GND | GND | J12 | GND |
| N/A | GND | GND | J13 | GND |
| N/A | GND | GND | J14 | GND |
| N/A | GND | GND | J20 | GND |
| N/A | GND | GND | K9 | GND |
| N/A | GND | GND | K10 | GND |
| N/A | GND | GND | K11 | GND |
| N/A | GND | GND | K12 | GND |
| N/A | GND | GND | K13 | GND |
| N/A | GND | GND | K14 | GND |
| N/A | GND | GND | L9 | GND |
| N/A | GND | GND | L10 | GND |
| N/A | GND | GND | L11 | GND |
| N/A | GND | GND | L12 | GND |
| N/A | GND | GND | L13 | GND |
| N/A | GND | GND | L14 | GND |
| N/A | GND | GND | M9 | GND |
| N/A | GND | GND | M10 | GND |
| N/A | GND | GND | M11 | GND |
| N/A | GND | GND | M12 | GND |
| N/A | GND | GND | M13 | GND |
| N/A | GND | GND | M14 | GND |
| N/A | GND | GND | N9 | GND |
| N/A | GND | GND | N10 | GND |
| N/A | GND | GND | N11 | GND |
| N/A | GND | GND | N12 | GND |
| N/A | GND | GND | N13 | GND |
| N/A | GND | GND | N14 | GND |

Table 25: FG456 Package Pinout (Continued)

| Bank | 3S400 Pin Name | 3S1000 3S1500 Pin Name | FG456 Pin Number | Type |
|--------|-------------------|------------------------------|------------------------|--------|
| N/A | GND | GND | P3 | GND |
| N/A | GND | GND | P9 | GND |
| N/A | GND | GND | P10 | GND |
| N/A | GND | GND | P11 | GND |
| N/A | GND | GND | P12 | GND |
| N/A | GND | GND | P13 | GND |
| N/A | GND | GND | P14 | GND |
| N/A | GND | GND | P20 | GND |
| N/A | GND | GND | Y9 | GND |
| N/A | GND | GND | Y14 | GND |
| N/A | VCCAUX | VCCAUX | A6 | VCCAUX |
| N/A | VCCAUX | VCCAUX | A17 | VCCAUX |
| N/A | VCCAUX | VCCAUX | AB6 | VCCAUX |
| N/A | VCCAUX | VCCAUX | AB17 | VCCAUX |
| N/A | VCCAUX | VCCAUX | F1 | VCCAUX |
| N/A | VCCAUX | VCCAUX | F22 | VCCAUX |
| N/A | VCCAUX | VCCAUX | U1 | VCCAUX |
| N/A | VCCAUX | VCCAUX | U22 | VCCAUX |
| N/A | VCCINT | VCCINT | G7 | VCCINT |
| N/A | VCCINT | VCCINT | G8 | VCCINT |
| N/A | VCCINT | VCCINT | G15 | VCCINT |
| N/A | VCCINT | VCCINT | G16 | VCCINT |
| N/A | VCCINT | VCCINT | H7 | VCCINT |
| N/A | VCCINT | VCCINT | H16 | VCCINT |
| N/A | VCCINT | VCCINT | R7 | VCCINT |
| N/A | VCCINT | VCCINT | R16 | VCCINT |
| N/A | VCCINT | VCCINT | T7 | VCCINT |
| N/A | VCCINT | VCCINT | T8 | VCCINT |
| N/A | VCCINT | VCCINT | T15 | VCCINT |
| N/A | VCCINT | VCCINT | T16 | VCCINT |
| VCCAUX | CCLK | CCLK | AA22 | CONFIG |
| VCCAUX | DONE | DONE | AB21 | CONFIG |
| VCCAUX | HSWAP_EN | HSWAP_EN | B3 | CONFIG |
| VCCAUX | M0 | M0 | AB2 | CONFIG |
| VCCAUX | M1 | M1 | AA1 | CONFIG |
| VCCAUX | M2 | M2 | AB3 | CONFIG |
| VCCAUX | PROG_B | PROG_B | A2 | CONFIG |
| VCCAUX | TCK | TCK | A21 | JTAG |
| VCCAUX | TDI | TDI | B1 | JTAG |
| VCCAUX | TDO | TDO | B22 | JTAG |
| VCCAUX | TMS | TMS | A20 | JTAG |

User I/Os by Bank

Table 26 indicates how the available user-I/O pins are distributed between the eight I/O banks for the XC3S400 in the FG456 package. Similarly, Table 27 shows how the avail-

able user-I/O pins are distributed between the eight I/O banks for the XC3S1000 and XC3S1500 in the FG456 package.

Table 26: User I/Os Per Bank for XC3S400 in FG456 Package

| Edge | I/O Bank | Maximum I/O | All Possible I/O Pins by Type | | | | |
|--------|----------|-------------|-------------------------------|------|-----|------|------|
| | | | I/O | DUAL | DCI | VREF | GCLK |
| Top | 0 | 35 | 27 | 0 | 2 | 4 | 2 |
| | 1 | 35 | 27 | 0 | 2 | 4 | 2 |
| Right | 2 | 31 | 25 | 0 | 2 | 4 | 0 |
| | 3 | 31 | 25 | 0 | 2 | 4 | 0 |
| Bottom | 4 | 35 | 21 | 6 | 2 | 4 | 2 |
| | 5 | 35 | 21 | 6 | 2 | 4 | 2 |
| Left | 6 | 31 | 25 | 0 | 2 | 4 | 0 |
| | 7 | 31 | 25 | 0 | 2 | 4 | 0 |

Table 27: User I/Os Per Bank for XC3S1000 and XC3S1500 in FG456 Package

| Edge | I/O Bank | Maximum I/O | All Possible I/O Pins by Type | | | | |
|--------|----------|-------------|-------------------------------|------|-----|------|------|
| | | | I/O | DUAL | DCI | VREF | GCLK |
| Top | 0 | 40 | 31 | 0 | 2 | 5 | 2 |
| | 1 | 40 | 31 | 0 | 2 | 5 | 2 |
| Right | 2 | 43 | 37 | 0 | 2 | 4 | 0 |
| | 3 | 43 | 37 | 0 | 2 | 4 | 0 |
| Bottom | 4 | 41 | 26 | 6 | 2 | 5 | 2 |
| | 5 | 40 | 25 | 6 | 2 | 5 | 2 |
| Left | 6 | 43 | 37 | 0 | 2 | 4 | 0 |
| | 7 | 43 | 37 | 0 | 2 | 4 | 0 |

FG456 Footprint

Left Half of Package (top view)

XC3S400

(264 max. user I/O)

196 I/O: Unrestricted,
general-purpose user I/O

32 VREF: User I/O or input
voltage reference for bank

69 N.C.: Unconnected pins for
XC3S400 (◆)

XC3S1000, XC3S1500

(333 max user I/O)

261 I/O: Unrestricted,
general-purpose user I/O

36 VREF: User I/O or input
voltage reference for bank

0 N.C.: No unconnected pins
in this package

All devices

12 DUAL: Configuration pin,
then possible user I/O

8 GCLK: User I/O or global
clock buffer input

16 DCI: User I/O or reference
resistor input for bank

7 CONFIG: Dedicated
configuration pins

4 JTAG: Dedicated JTAG
port pins

12 VCCINT: Internal core
voltage supply (+1.2V)

40 VCCO: Output voltage
supply for bank

8 VCCAUX: Auxiliary voltage
supply (+2.5V)

52 GND: Ground

| | 1 | 2 | 3 | 4 | 5 | 6 | Bank 0 | 7 | 8 | 9 | 10 | 11 |
|---|-------------------|-------------------|-------------------|-------------------|------------------|------------|-------------------|------------|-------------------|------------|-------------------|------------------|
| A | GND | PROG_B | I/O VREF_0 | I/O L01P_0 VRN_0 | I/O L09P_0 | VCCAUX | I/O L19P_0 | I/O L24P_0 | I/O L27P_0 | I/O | I/O | I/O L32P_0 GCLK6 |
| B | TDI | GND | HSWAP_EN | I/O L01N_0 VRP_0 | I/O L09N_0 | I/O L15P_0 | I/O L19N_0 | I/O L24N_0 | I/O L27N_0 | I/O L29P_0 | I/O | I/O L32N_0 GCLK7 |
| C | I/O L16P_7 VREF_7 | I/O | I/O L01N_7 VRP_7 | I/O L01P_7 VRN_7 | I/O L06P_0 | I/O L15N_0 | I/O VREF_0 | VCCO_0 | GND | I/O L29N_0 | I/O L31P_0 VREF_0 | I/O |
| D | I/O L16N_7 | I/O L19P_7 | I/O L19N_7 VREF_7 | I/O L17P_7 | I/O L06N_0 | I/O L10P_0 | I/O L16P_0 | I/O L22P_0 | I/O | I/O | I/O | I/O L31N_0 |
| E | I/O L21N_7 | I/O L21P_7 | I/O L20P_7 | I/O L17N_7 | I/O VREF_0 | I/O L10N_0 | I/O L16N_0 | I/O L22N_0 | I/O | I/O L25P_0 | I/O L28P_0 | I/O L30P_0 |
| F | VCCAUX | I/O L23N_7 | I/O L23P_7 | I/O L20N_7 | I/O L22P_7 | I/O | I/O VREF_0 | VCCO_0 | I/O L25N_0 | I/O L28N_0 | I/O L30N_0 | I/O |
| G | I/O L27N_7 | I/O L27P_7 VREF_7 | I/O L26N_7 | I/O L26P_7 | I/O L24P_7 | I/O L22N_7 | VCCINT | VCCINT | VCCO_0 | VCCO_0 | VCCO_0 | VCCO_0 |
| H | I/O L28N_7 | I/O L28P_7 | VCCO_7 | I/O L29P_7 | I/O L24N_7 | VCCO_7 | VCCINT | | | | | |
| J | I/O L32N_7 | I/O L32P_7 | GND | I/O L29N_7 | I/O L31P_7 | I/O L31P_7 | VCCO_7 | | GND | GND | GND | GND |
| K | I/O L35N_7 | I/O L35P_7 | I/O L34N_7 | I/O L34P_7 | I/O L33N_7 | I/O L33P_7 | VCCO_7 | | GND | GND | GND | GND |
| L | I/O L40N_7 VREF_7 | I/O L40P_7 | I/O L39N_7 | I/O L39P_7 | I/O L38N_7 | I/O L38P_7 | VCCO_7 | | GND | GND | GND | GND |
| M | I/O L40P_6 VREF_6 | I/O L40N_6 | I/O L39P_6 | I/O L39N_6 | I/O L38P_6 | I/O L38N_6 | VCCO_6 | | GND | GND | GND | GND |
| N | I/O L35P_6 | I/O L35N_6 | I/O L34P_6 | I/O L34N_6 VREF_6 | I/O L33P_6 | I/O L33N_6 | VCCO_6 | | GND | GND | GND | GND |
| P | I/O L32P_6 | I/O L32N_6 | GND | I/O L31P_6 | I/O L31N_6 | I/O L28P_6 | VCCO_6 | | GND | GND | GND | GND |
| R | I/O L29P_6 | I/O L29N_6 | VCCO_6 | I/O L26P_6 | I/O L26N_6 | VCCO_6 | VCCINT | | | | | |
| T | I/O L27P_6 | I/O L27N_6 | I/O L26N_6 | I/O L23P_6 | I/O L22P_6 | I/O L22N_6 | VCCINT | VCCINT | VCCO_5 | VCCO_5 | VCCO_5 | VCCO_5 |
| U | VCCAUX | I/O L24P_6 | I/O L24N_6 VREF_6 | I/O L23N_6 | I/O L19P_6 | I/O VREF_5 | I/O | VCCO_5 | I/O | I/O | I/O | I/O |
| V | I/O L21P_6 | I/O L21N_6 | I/O L20P_6 | I/O L20N_6 | I/O L19N_6 | I/O L15P_5 | I/O | I/O L24P_5 | I/O L27P_5 | I/O | I/O L31P_5 D5 | I/O |
| W | I/O L17P_6 VREF_6 | I/O L17N_6 | I/O L16P_6 | I/O L16N_6 | I/O L09P_5 | I/O L15N_5 | I/O L19P_5 VREF_5 | I/O L24N_5 | I/O L27N_5 VREF_5 | I/O L29P_5 | I/O L31N_5 D4 | I/O |
| Y | I/O | I/O L01P_6 VRN_6 | I/O L01N_6 VRP_6 | I/O L01N_5 RDWR_B | I/O L09N_5 | I/O L16P_5 | I/O L19N_5 | VCCO_5 | GND | I/O L29N_5 | I/O L32P_5 GCLK2 | I/O |
| A | M1 | GND | I/O L01P_5 CS_B | I/O L06P_5 | I/O L10P_5 VRN_5 | I/O L16N_5 | I/O L22P_5 | I/O L25P_5 | I/O L28P_5 D7 | I/O L30P_5 | I/O L32N_5 GCLK3 | I/O |
| A | GND | M0 | M2 | I/O L06N_5 | I/O L10N_5 VRP_5 | VCCAUX | I/O L22N_5 | I/O L25N_5 | I/O L28N_5 D6 | I/O L30N_5 | I/O VREF_5 | I/O |
| B | | | | | | | | | | | | |
| | | | | | | | Bank 5 | | | | | |

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Figure 12: FG456 Package Footprint (top view)

| Bank 1 | | | | | | | | | | | | | | | | | | | | | |
|----------------------------|------------|------------------------|---------------------------|-----------------|-----------------|----------------------|----------------------|----------------------|---------------------|----------------------|-----|--|--|--|--|--|--|--|--|--|--|
| 12 | 13 | 14 | 15 | 16 | 17 | 18 | 19 | 20 | 21 | 22 | | | | | | | | | | | |
| I/O | I/O L30N_1 | I/O L28N_1 | I/O L25P_1 | I/O L22N_1 ◆ | VCCAUX | I/O L10N_1 VREF_1 | I/O L06N_1 VREF_1 | TMS | TCK | GND | A | | | | | | | | | | |
| I/O L32N_1 GCLK5 | I/O L30P_1 | I/O L28P_1 | I/O L25N_1 | I/O L22P_1 ◆ | I/O L16N_1 | I/O L10P_1 | I/O L06P_1 | I/O L01P_1 VRN_1 | GND | TDO | B | | | | | | | | | | |
| I/O L32P_1 GCLK4 | I/O L29N_1 | GND | VCCO_1 | I/O L19N_1 ◆ | I/O L16P_1 | I/O L09N_1 | I/O L01N_1 VRP_1 | I/O L01N_2 VRP_2 | I/O L01P_2 VRN_2 | I/O | C | | | | | | | | | | |
| I/O L31N_1 VREF_1 | I/O L29P_1 | I/O L27N_1 | I/O L24N_1 | I/O L19P_1 ◆ | I/O L15N_1 | I/O L09P_1 | I/O L16P_2 | I/O L16N_2 | I/O L17N_2 | I/O L17P_2 VREF_2 | D | | | | | | | | | | |
| I/O L31P_1 | I/O VREF_1 | I/O L27P_1 | I/O L24P_1 | I/O | I/O L15P_1 | I/O L19N_2 | I/O L20N_2 | I/O L20P_2 | I/O L21N_2 | I/O L21P_2 | E | | | | | | | | | | |
| I/O | I/O | I/O VREF_1 ◆ | VCCO_1 | I/O | I/O | I/O L19P_2 | I/O L23N_2 VREF_2 | I/O L24N_2 | I/O L24P_2 | VCCAUX | F | | | | | | | | | | |
| VCCO_1 | VCCO_1 | VCCO_1 | VCCINT | VCCINT | I/O L22N_2 | I/O L22P_2 | I/O L23P_2 | I/O L26N_2 ◆ | I/O L27N_2 | I/O L27P_2 | G | | | | | | | | | | |
| | | | | VCCINT | VCCO_2 | I/O L28N_2 ◆ | I/O L26P_2 ◆ | VCCO_2 | I/O L29N_2 ◆ | I/O L29P_2 ◆ | H | | | | | | | | | | |
| GND | GND | GND | | VCCO_2 | I/O L28P_2 ◆ | I/O L31N_2 ◆ | I/O L31P_2 ◆ | GND | I/O L32N_2 ◆ | I/O L32P_2 ◆ | J | | | | | | | | | | |
| GND | GND | GND | | VCCO_2 | I/O L33N_2 ◆ | I/O L33P_2 ◆ | I/O L34N_2 VREF_2 | I/O L34P_2 | I/O L35N_2 | I/O L35P_2 | K | | | | | | | | | | |
| GND | GND | GND | | VCCO_2 | I/O L38N_2 | I/O L38P_2 | I/O L39N_2 | I/O L39P_2 | I/O L40N_2 | I/O L40P_2 VREF_2 | L | | | | | | | | | | |
| GND | GND | GND | | VCCO_3 | I/O L38P_3 | I/O L38N_3 | I/O L39P_3 | I/O L39N_3 | I/O L40P_3 | I/O L40N_3 VREF_3 | M | | | | | | | | | | |
| GND | GND | GND | | VCCO_3 | I/O L33P_3 ◆ | I/O L33N_3 ◆ | I/O L34P_3 VREF_3 | I/O L34N_3 | I/O L35P_3 | I/O L35N_3 | N | | | | | | | | | | |
| GND | GND | GND | | VCCO_3 | I/O L31P_3 ◆ | I/O L31N_3 ◆ | I/O L29N_3 ◆ | GND | I/O L32P_3 ◆ | I/O L32N_3 ◆ | P | | | | | | | | | | |
| | | | | VCCINT | VCCO_3 | I/O L24N_3 | I/O L29P_3 ◆ | VCCO_3 | I/O L28P_3 ◆ | I/O L28N_3 ◆ | R | | | | | | | | | | |
| VCCO_4 | VCCO_4 | VCCO_4 | VCCINT | VCCINT | I/O L22N_3 | I/O L24P_3 | I/O L26P_3 ◆ | I/O L26N_3 ◆ | I/O L27P_3 | I/O L27N_3 | T | | | | | | | | | | |
| I/O L30N_4 D2 | I/O L28N_4 | I/O L25N_4 | VCCO_4 | I/O | I/O | I/O L22P_3 | I/O L20N_3 | I/O L23P_3 VREF_3 | I/O L23N_3 | VCCAUX | U | | | | | | | | | | |
| I/O L30P_4 D3 | I/O L28P_4 | I/O L25P_4 | I/O L22N_4 VREF_4 ◆ | I/O L16N_4 | I/O L10N_4 | I/O VREF_4 | I/O L17N_3 | I/O L20P_3 | I/O L21P_3 | I/O L21N_3 | V | | | | | | | | | | |
| I/O L31N_4 INIT_B | I/O | I/O | I/O L22P_4 ◆ | I/O L16P_4 | I/O L10P_4 | I/O L06N_4 VREF_4 | I/O L17P_3 VREF_3 | I/O L19P_3 | I/O L19N_3 | I/O L16N_3 | W | | | | | | | | | | |
| I/O L31P_4 DOUT BUSY | I/O L29N_4 | GND | VCCO_4 | I/O VREF_4 | I/O L15N_4 | I/O L06P_4 | I/O L01P_3 VRN_3 | I/O L01N_3 VRP_3 | I/O | I/O L16P_3 | Y | | | | | | | | | | |
| I/O L32N_4 GCLK1 | I/O L29P_4 | I/O L27N_4 DN D0 | I/O L24N_4 | I/O L19N_4 ◆ | I/O L15P_4 | I/O L09N_4 | I/O L05N_4 ◆ | I/O L01N_4 VRP_4 | GND | CCLK | A A | | | | | | | | | | |
| I/O L32P_4 GCLK0 | I/O VREF_4 | I/O L27P_4 D1 | I/O L24P_4 | I/O L19P_4 ◆ | VCCAUX | I/O L09P_4 | I/O L05P_4 ◆ | I/O L01P_4 VRN_4 | DONE | GND | A B | | | | | | | | | | |

Right Half of Package
(top view)

Bank 4

DS099-4_11b_030503

FG676: 676-lead Fine-pitch Ball Grid Array

The 676-lead fine-pitch ball grid array package, FG676, supports three different Spartan-3 devices, including the XC3S1000, the XC3S1500, and the XC3S2000. All three have nearly identical footprints but are slightly different due to unconnected pins on the XC3S1000 and XC3S1500. For example, because the XC3S1000 has fewer I/O pins, this device has 98 unconnected pins on the FG456 package, labeled as “N.C.” In [Table 28](#) and [Figure 13](#), these unconnected pins are indicated with a black diamond symbol (◆). The XC3S1500, however, has only two unconnected pins, also labeled “N.C.” in the pinout table but indicated with a black square symbol (■).

All the package pins appear in [Table 28](#) and are sorted by bank number, then by pin name. Pairs of pins that form a differential I/O pair appear together in the table. The table also shows the pin number for each pin and the pin type, as defined earlier.

If there is a difference between the XC1000, XC3S1500 and XC3S2000 pinouts, then that difference is highlighted in [Table 28](#). If the table entry is shaded grey, then there is an unconnected pin on either the XC3S1000 or XC3S1500 that maps to a user-I/O pin on the XC3S2000. If the table entry is shaded tan, then the unconnected pin on either the XC3S1000 or XC3S1500 maps to a VREF-type pin on the XC3S2000. If the other VREF pins in the bank all connect to a voltage reference to support a special I/O standard, then also connect the N.C. pin on the XC3S1000 or XC3S1500 to the same VREF voltage. This provides maximum flexibility as you could potentially migrate a design from the XC3S1000 through to the XC3S2000 FPGA without changing the printed circuit board.

Pinout Table

Table 28: FG676 Package Pinout

| Bank | XC3S1000 Pin Name | XC3S1500 Pin Name | XC3S2000 Pin Name | FG676 Pin Number | Type |
|------|----------------------|----------------------|----------------------|------------------------|------|
| 0 | IO | IO | IO | A3 | I/O |
| 0 | IO | IO | IO | A5 | I/O |
| 0 | IO | IO | IO | A6 | I/O |
| 0 | IO | IO | IO | C4 | I/O |
| 0 | N.C. (◆) | IO | IO | C8 | I/O |
| 0 | IO | IO | IO | C12 | I/O |
| 0 | IO | IO | IO | E13 | I/O |
| 0 | IO | IO | IO | H11 | I/O |
| 0 | IO | IO | IO | H12 | I/O |
| 0 | IO/VREF_0 | IO/VREF_0 | IO/VREF_0 | B3 | VREF |
| 0 | IO/VREF_0 | IO/VREF_0 | IO/VREF_0 | F7 | VREF |
| 0 | IO/VREF_0 | IO/VREF_0 | IO/VREF_0 | G10 | VREF |
| 0 | IO_L01N_0/ VRP_0 | IO_L01N_0/ VRP_0 | IO_L01N_0/ VRP_0 | E5 | DCI |

Table 28: FG676 Package Pinout (Continued)

| Bank | XC3S1000 Pin Name | XC3S1500 Pin Name | XC3S2000 Pin Name | FG676 Pin Number | Type |
|------|----------------------|----------------------|----------------------|------------------------|------|
| 0 | IO_L01P_0/ VRN_0 | IO_L01P_0/ VRN_0 | IO_L01P_0/ VRN_0 | D5 | DCI |
| 0 | IO_L05N_0 | IO_L05N_0 | IO_L05N_0 | B4 | I/O |
| 0 | IO_L05P_0/ VREF_0 | IO_L05P_0/ VREF_0 | IO_L05P_0/ VREF_0 | A4 | VREF |
| 0 | IO_L06N_0 | IO_L06N_0 | IO_L06N_0 | C5 | I/O |
| 0 | IO_L06P_0 | IO_L06P_0 | IO_L06P_0 | B5 | I/O |
| 0 | IO_L07N_0 | IO_L07N_0 | IO_L07N_0 | E6 | I/O |
| 0 | IO_L07P_0 | IO_L07P_0 | IO_L07P_0 | D6 | I/O |
| 0 | IO_L08N_0 | IO_L08N_0 | IO_L08N_0 | C6 | I/O |
| 0 | IO_L08P_0 | IO_L08P_0 | IO_L08P_0 | B6 | I/O |
| 0 | IO_L09N_0 | IO_L09N_0 | IO_L09N_0 | E7 | I/O |
| 0 | IO_L09P_0 | IO_L09P_0 | IO_L09P_0 | D7 | I/O |
| 0 | IO_L10N_0 | IO_L10N_0 | IO_L10N_0 | B7 | I/O |
| 0 | IO_L10P_0 | IO_L10P_0 | IO_L10P_0 | A7 | I/O |
| 0 | N.C. (◆) | IO_L11N_0 | IO_L11N_0 | G8 | I/O |
| 0 | N.C. (◆) | IO_L11P_0 | IO_L11P_0 | F8 | I/O |
| 0 | N.C. (◆) | IO_L12N_0 | IO_L12N_0 | E8 | I/O |
| 0 | N.C. (◆) | IO_L12P_0 | IO_L12P_0 | D8 | I/O |
| 0 | IO_L15N_0 | IO_L15N_0 | IO_L15N_0 | B8 | I/O |
| 0 | IO_L15P_0 | IO_L15P_0 | IO_L15P_0 | A8 | I/O |
| 0 | IO_L16N_0 | IO_L16N_0 | IO_L16N_0 | G9 | I/O |
| 0 | IO_L16P_0 | IO_L16P_0 | IO_L16P_0 | F9 | I/O |
| 0 | N.C. (◆) | IO_L17N_0 | IO_L17N_0 | E9 | I/O |
| 0 | N.C. (◆) | IO_L17P_0 | IO_L17P_0 | D9 | I/O |
| 0 | N.C. (◆) | IO_L18N_0 | IO_L18N_0 | C9 | I/O |
| 0 | N.C. (◆) | IO_L18P_0 | IO_L18P_0 | B9 | I/O |
| 0 | IO_L19N_0 | IO_L19N_0 | IO_L19N_0 | F10 | I/O |
| 0 | IO_L19P_0 | IO_L19P_0 | IO_L19P_0 | E10 | I/O |
| 0 | IO_L22N_0 | IO_L22N_0 | IO_L22N_0 | D10 | I/O |
| 0 | IO_L22P_0 | IO_L22P_0 | IO_L22P_0 | C10 | I/O |
| 0 | N.C. (◆) | IO_L23N_0 | IO_L23N_0 | B10 | I/O |
| 0 | N.C. (◆) | IO_L23P_0 | IO_L23P_0 | A10 | I/O |
| 0 | IO_L24N_0 | IO_L24N_0 | IO_L24N_0 | G11 | I/O |
| 0 | IO_L24P_0 | IO_L24P_0 | IO_L24P_0 | F11 | I/O |
| 0 | IO_L25N_0 | IO_L25N_0 | IO_L25N_0 | E11 | I/O |
| 0 | IO_L25P_0 | IO_L25P_0 | IO_L25P_0 | D11 | I/O |
| 0 | N.C. (◆) | IO_L26N_0 | IO_L26N_0 | B11 | I/O |
| 0 | N.C. (◆) | IO_L26P_0/ VREF_0 | IO_L26P_0/ VREF_0 | A11 | VREF |
| 0 | IO_L27N_0 | IO_L27N_0 | IO_L27N_0 | G12 | I/O |
| 0 | IO_L27P_0 | IO_L27P_0 | IO_L27P_0 | H13 | I/O |
| 0 | IO_L28N_0 | IO_L28N_0 | IO_L28N_0 | F12 | I/O |
| 0 | IO_L28P_0 | IO_L28P_0 | IO_L28P_0 | E12 | I/O |
| 0 | IO_L29N_0 | IO_L29N_0 | IO_L29N_0 | B12 | I/O |
| 0 | IO_L29P_0 | IO_L29P_0 | IO_L29P_0 | A12 | I/O |

Table 28: FG676 Package Pinout (Continued)

| Bank | XC3S1000 Pin Name | XC3S1500 Pin Name | XC3S2000 Pin Name | FG676 Pin Number | Type |
|------|----------------------|----------------------|----------------------|------------------------|------|
| 0 | IO_L30N_0 | IO_L30N_0 | IO_L30N_0 | G13 | I/O |
| 0 | IO_L30P_0 | IO_L30P_0 | IO_L30P_0 | F13 | I/O |
| 0 | IO_L31N_0 | IO_L31N_0 | IO_L31N_0 | D13 | I/O |
| 0 | IO_L31P_0/ VREF_0 | IO_L31P_0/ VREF_0 | IO_L31P_0/ VREF_0 | C13 | VREF |
| 0 | IO_L32N_0/ GCLK7 | IO_L32N_0/ GCLK7 | IO_L32N_0/ GCLK7 | B13 | GCLK |
| 0 | IO_L32P_0/ GCLK6 | IO_L32P_0/ GCLK6 | IO_L32P_0/ GCLK6 | A13 | GCLK |
| 0 | VCCO_0 | VCCO_0 | VCCO_0 | C7 | VCCO |
| 0 | VCCO_0 | VCCO_0 | VCCO_0 | C11 | VCCO |
| 0 | VCCO_0 | VCCO_0 | VCCO_0 | H9 | VCCO |
| 0 | VCCO_0 | VCCO_0 | VCCO_0 | H10 | VCCO |
| 0 | VCCO_0 | VCCO_0 | VCCO_0 | J11 | VCCO |
| 0 | VCCO_0 | VCCO_0 | VCCO_0 | J12 | VCCO |
| 0 | VCCO_0 | VCCO_0 | VCCO_0 | J13 | VCCO |
| 0 | VCCO_0 | VCCO_0 | VCCO_0 | K13 | VCCO |
| 1 | IO | IO | IO | A14 | I/O |
| 1 | IO | IO | IO | A22 | I/O |
| 1 | IO | IO | IO | A23 | I/O |
| 1 | IO | IO | IO | D16 | I/O |
| 1 | IO | IO | IO | E18 | I/O |
| 1 | IO | IO | IO | F14 | I/O |
| 1 | IO | IO | IO | F20 | I/O |
| 1 | IO | IO | IO | G19 | I/O |
| 1 | IO/VREF_1 | IO/VREF_1 | IO/VREF_1 | C15 | VREF |
| 1 | IO/VREF_1 | IO/VREF_1 | IO/VREF_1 | C17 | VREF |
| 1 | N.C. (◆) | IO/VREF_1 | IO/VREF_1 | D18 | VREF |
| 1 | IO_L01N_1/ VRP_1 | IO_L01N_1/ VRP_1 | IO_L01N_1/ VRP_1 | D22 | DCI |
| 1 | IO_L01P_1/ VRN_1 | IO_L01P_1/ VRN_1 | IO_L01P_1/ VRN_1 | E22 | DCI |
| 1 | IO_L04N_1 | IO_L04N_1 | IO_L04N_1 | B23 | I/O |
| 1 | IO_L04P_1 | IO_L04P_1 | IO_L04P_1 | C23 | I/O |
| 1 | IO_L05N_1 | IO_L05N_1 | IO_L05N_1 | E21 | I/O |
| 1 | IO_L05P_1 | IO_L05P_1 | IO_L05P_1 | F21 | I/O |
| 1 | IO_L06N_1/ VREF_1 | IO_L06N_1/ VREF_1 | IO_L06N_1/ VREF_1 | B22 | VREF |
| 1 | IO_L06P_1 | IO_L06P_1 | IO_L06P_1 | C22 | I/O |
| 1 | IO_L07N_1 | IO_L07N_1 | IO_L07N_1 | C21 | I/O |
| 1 | IO_L07P_1 | IO_L07P_1 | IO_L07P_1 | D21 | I/O |
| 1 | IO_L08N_1 | IO_L08N_1 | IO_L08N_1 | A21 | I/O |
| 1 | IO_L08P_1 | IO_L08P_1 | IO_L08P_1 | B21 | I/O |
| 1 | IO_L09N_1 | IO_L09N_1 | IO_L09N_1 | D20 | I/O |
| 1 | IO_L09P_1 | IO_L09P_1 | IO_L09P_1 | E20 | I/O |
| 1 | IO_L10N_1/ VREF_1 | IO_L10N_1/ VREF_1 | IO_L10N_1/ VREF_1 | A20 | VREF |

Table 28: FG676 Package Pinout (Continued)

| Bank | XC3S1000 Pin Name | XC3S1500 Pin Name | XC3S2000 Pin Name | FG676 Pin Number | Type |
|------|----------------------|----------------------|----------------------|------------------------|------|
| 1 | IO_L10P_1 | IO_L10P_1 | IO_L10P_1 | B20 | I/O |
| 1 | N.C. (◆) | IO_L11N_1 | IO_L11N_1 | E19 | I/O |
| 1 | N.C. (◆) | IO_L11P_1 | IO_L11P_1 | F19 | I/O |
| 1 | N.C. (◆) | IO_L12N_1 | IO_L12N_1 | C19 | I/O |
| 1 | N.C. (◆) | IO_L12P_1 | IO_L12P_1 | D19 | I/O |
| 1 | IO_L15N_1 | IO_L15N_1 | IO_L15N_1 | A19 | I/O |
| 1 | IO_L15P_1 | IO_L15P_1 | IO_L15P_1 | B19 | I/O |
| 1 | IO_L16N_1 | IO_L16N_1 | IO_L16N_1 | F18 | I/O |
| 1 | IO_L16P_1 | IO_L16P_1 | IO_L16P_1 | G18 | I/O |
| 1 | N.C. (◆) | IO_L18N_1 | IO_L18N_1 | B18 | I/O |
| 1 | N.C. (◆) | IO_L18P_1 | IO_L18P_1 | C18 | I/O |
| 1 | IO_L19N_1 | IO_L19N_1 | IO_L19N_1 | F17 | I/O |
| 1 | IO_L19P_1 | IO_L19P_1 | IO_L19P_1 | G17 | I/O |
| 1 | IO_L22N_1 | IO_L22N_1 | IO_L22N_1 | D17 | I/O |
| 1 | IO_L22P_1 | IO_L22P_1 | IO_L22P_1 | E17 | I/O |
| 1 | N.C. (◆) | IO_L23N_1 | IO_L23N_1 | A17 | I/O |
| 1 | N.C. (◆) | IO_L23P_1 | IO_L23P_1 | B17 | I/O |
| 1 | IO_L24N_1 | IO_L24N_1 | IO_L24N_1 | G16 | I/O |
| 1 | IO_L24P_1 | IO_L24P_1 | IO_L24P_1 | H16 | I/O |
| 1 | IO_L25N_1 | IO_L25N_1 | IO_L25N_1 | E16 | I/O |
| 1 | IO_L25P_1 | IO_L25P_1 | IO_L25P_1 | F16 | I/O |
| 1 | N.C. (◆) | IO_L26N_1 | IO_L26N_1 | A16 | I/O |
| 1 | N.C. (◆) | IO_L26P_1 | IO_L26P_1 | B16 | I/O |
| 1 | IO_L27N_1 | IO_L27N_1 | IO_L27N_1 | G15 | I/O |
| 1 | IO_L27P_1 | IO_L27P_1 | IO_L27P_1 | H15 | I/O |
| 1 | IO_L28N_1 | IO_L28N_1 | IO_L28N_1 | E15 | I/O |
| 1 | IO_L28P_1 | IO_L28P_1 | IO_L28P_1 | F15 | I/O |
| 1 | IO_L29N_1 | IO_L29N_1 | IO_L29N_1 | A15 | I/O |
| 1 | IO_L29P_1 | IO_L29P_1 | IO_L29P_1 | B15 | I/O |
| 1 | IO_L30N_1 | IO_L30N_1 | IO_L30N_1 | G14 | I/O |
| 1 | IO_L30P_1 | IO_L30P_1 | IO_L30P_1 | H14 | I/O |
| 1 | IO_L31N_1/ VREF_1 | IO_L31N_1/ VREF_1 | IO_L31N_1/ VREF_1 | D14 | VREF |
| 1 | IO_L31P_1 | IO_L31P_1 | IO_L31P_1 | E14 | I/O |
| 1 | IO_L32N_1/ GCLK5 | IO_L32N_1/ GCLK5 | IO_L32N_1/ GCLK5 | B14 | GCLK |
| 1 | IO_L32P_1/ GCLK4 | IO_L32P_1/ GCLK4 | IO_L32P_1/ GCLK4 | C14 | GCLK |
| 1 | VCCO_1 | VCCO_1 | VCCO_1 | C16 | VCCO |
| 1 | VCCO_1 | VCCO_1 | VCCO_1 | C20 | VCCO |
| 1 | VCCO_1 | VCCO_1 | VCCO_1 | H17 | VCCO |
| 1 | VCCO_1 | VCCO_1 | VCCO_1 | H18 | VCCO |
| 1 | VCCO_1 | VCCO_1 | VCCO_1 | J14 | VCCO |
| 1 | VCCO_1 | VCCO_1 | VCCO_1 | J15 | VCCO |
| 1 | VCCO_1 | VCCO_1 | VCCO_1 | J16 | VCCO |

Table 28: FG676 Package Pinout (Continued)

| Bank | XC3S1000 Pin Name | XC3S1500 Pin Name | XC3S2000 Pin Name | FG676 Pin Number | Type |
|------|----------------------|----------------------|----------------------|------------------------|------|
| 1 | VCCO_1 | VCCO_1 | VCCO_1 | K14 | VCCO |
| 2 | N.C. (◆) | N.C. (■) | IO | F22 | I/O |
| 2 | IO_L01N_2/ VRP_2 | IO_L01N_2/ VRP_2 | IO_L01N_2/ VRP_2 | C25 | DCI |
| 2 | IO_L01P_2/ VRN_2 | IO_L01P_2/ VRN_2 | IO_L01P_2/ VRN_2 | C26 | DCI |
| 2 | IO_L02N_2 | IO_L02N_2 | IO_L02N_2 | E23 | I/O |
| 2 | IO_L02P_2 | IO_L02P_2 | IO_L02P_2 | E24 | I/O |
| 2 | IO_L03N_2/ VREF_2 | IO_L03N_2/ VREF_2 | IO_L03N_2/ VREF_2 | D25 | VREF |
| 2 | IO_L03P_2 | IO_L03P_2 | IO_L03P_2 | D26 | I/O |
| 2 | N.C. (◆) | IO_L05N_2 | IO_L05N_2 | E25 | I/O |
| 2 | N.C. (◆) | IO_L05P_2 | IO_L05P_2 | E26 | I/O |
| 2 | N.C. (◆) | IO_L06N_2 | IO_L06N_2 | G20 | I/O |
| 2 | N.C. (◆) | IO_L06P_2 | IO_L06P_2 | G21 | I/O |
| 2 | N.C. (◆) | IO_L07N_2 | IO_L07N_2 | F23 | I/O |
| 2 | N.C. (◆) | IO_L07P_2 | IO_L07P_2 | F24 | I/O |
| 2 | N.C. (◆) | IO_L08N_2 | IO_L08N_2 | G22 | I/O |
| 2 | N.C. (◆) | IO_L08P_2 | IO_L08P_2 | G23 | I/O |
| 2 | N.C. (◆) | IO_L09N_2/ VREF_2 | IO_L09N_2/ VREF_2 | F25 | VREF |
| 2 | N.C. (◆) | IO_L09P_2 | IO_L09P_2 | F26 | I/O |
| 2 | N.C. (◆) | IO_L10N_2 | IO_L10N_2 | G25 | I/O |
| 2 | N.C. (◆) | IO_L10P_2 | IO_L10P_2 | G26 | I/O |
| 2 | IO_L14N_2 | IO_L14N_2 | IO_L14N_2 | H20 | I/O |
| 2 | IO_L14P_2 | IO_L14P_2 | IO_L14P_2 | H21 | I/O |
| 2 | IO_L16N_2 | IO_L16N_2 | IO_L16N_2 | H22 | I/O |
| 2 | IO_L16P_2 | IO_L16P_2 | IO_L16P_2 | J21 | I/O |
| 2 | IO_L17N_2 | IO_L17N_2 | IO_L17N_2 | H23 | I/O |
| 2 | IO_L17P_2/ VREF_2 | IO_L17P_2/ VREF_2 | IO_L17P_2/ VREF_2 | H24 | VREF |
| 2 | IO_L19N_2 | IO_L19N_2 | IO_L19N_2 | H25 | I/O |
| 2 | IO_L19P_2 | IO_L19P_2 | IO_L19P_2 | H26 | I/O |
| 2 | IO_L20N_2 | IO_L20N_2 | IO_L20N_2 | J20 | I/O |
| 2 | IO_L20P_2 | IO_L20P_2 | IO_L20P_2 | K20 | I/O |
| 2 | IO_L21N_2 | IO_L21N_2 | IO_L21N_2 | J22 | I/O |
| 2 | IO_L21P_2 | IO_L21P_2 | IO_L21P_2 | J23 | I/O |
| 2 | IO_L22N_2 | IO_L22N_2 | IO_L22N_2 | J24 | I/O |
| 2 | IO_L22P_2 | IO_L22P_2 | IO_L22P_2 | J25 | I/O |
| 2 | IO_L23N_2/ VREF_2 | IO_L23N_2/ VREF_2 | IO_L23N_2/ VREF_2 | K21 | VREF |
| 2 | IO_L23P_2 | IO_L23P_2 | IO_L23P_2 | K22 | I/O |
| 2 | IO_L24N_2 | IO_L24N_2 | IO_L24N_2 | K23 | I/O |
| 2 | IO_L24P_2 | IO_L24P_2 | IO_L24P_2 | K24 | I/O |
| 2 | IO_L26N_2 | IO_L26N_2 | IO_L26N_2 | K25 | I/O |
| 2 | IO_L26P_2 | IO_L26P_2 | IO_L26P_2 | K26 | I/O |
| 2 | IO_L27N_2 | IO_L27N_2 | IO_L27N_2 | L19 | I/O |

Table 28: FG676 Package Pinout (Continued)

| Bank | XC3S1000 Pin Name | XC3S1500 Pin Name | XC3S2000 Pin Name | FG676 Pin Number | Type |
|------|----------------------|----------------------|----------------------|------------------------|------|
| 2 | IO_L27P_2 | IO_L27P_2 | IO_L27P_2 | L20 | I/O |
| 2 | IO_L28N_2 | IO_L28N_2 | IO_L28N_2 | L21 | I/O |
| 2 | IO_L28P_2 | IO_L28P_2 | IO_L28P_2 | L22 | I/O |
| 2 | IO_L29N_2 | IO_L29N_2 | IO_L29N_2 | L25 | I/O |
| 2 | IO_L29P_2 | IO_L29P_2 | IO_L29P_2 | L26 | I/O |
| 2 | IO_L31N_2 | IO_L31N_2 | IO_L31N_2 | M19 | I/O |
| 2 | IO_L31P_2 | IO_L31P_2 | IO_L31P_2 | M20 | I/O |
| 2 | IO_L32N_2 | IO_L32N_2 | IO_L32N_2 | M21 | I/O |
| 2 | IO_L32P_2 | IO_L32P_2 | IO_L32P_2 | M22 | I/O |
| 2 | IO_L33N_2 | IO_L33N_2 | IO_L33N_2 | L23 | I/O |
| 2 | IO_L33P_2 | IO_L33P_2 | IO_L33P_2 | M24 | I/O |
| 2 | IO_L34N_2/ VREF_2 | IO_L34N_2/ VREF_2 | IO_L34N_2/ VREF_2 | M25 | VREF |
| 2 | IO_L34P_2 | IO_L34P_2 | IO_L34P_2 | M26 | I/O |
| 2 | IO_L35N_2 | IO_L35N_2 | IO_L35N_2 | N19 | I/O |
| 2 | IO_L35P_2 | IO_L35P_2 | IO_L35P_2 | N20 | I/O |
| 2 | IO_L38N_2 | IO_L38N_2 | IO_L38N_2 | N21 | I/O |
| 2 | IO_L38P_2 | IO_L38P_2 | IO_L38P_2 | N22 | I/O |
| 2 | IO_L39N_2 | IO_L39N_2 | IO_L39N_2 | N23 | I/O |
| 2 | IO_L39P_2 | IO_L39P_2 | IO_L39P_2 | N24 | I/O |
| 2 | IO_L40N_2 | IO_L40N_2 | IO_L40N_2 | N25 | I/O |
| 2 | IO_L40P_2/ VREF_2 | IO_L40P_2/ VREF_2 | IO_L40P_2/ VREF_2 | N26 | VREF |
| 2 | VCCO_2 | VCCO_2 | VCCO_2 | G24 | VCCO |
| 2 | VCCO_2 | VCCO_2 | VCCO_2 | J19 | VCCO |
| 2 | VCCO_2 | VCCO_2 | VCCO_2 | K19 | VCCO |
| 2 | VCCO_2 | VCCO_2 | VCCO_2 | L18 | VCCO |
| 2 | VCCO_2 | VCCO_2 | VCCO_2 | L24 | VCCO |
| 2 | VCCO_2 | VCCO_2 | VCCO_2 | M18 | VCCO |
| 2 | VCCO_2 | VCCO_2 | VCCO_2 | N17 | VCCO |
| 2 | VCCO_2 | VCCO_2 | VCCO_2 | N18 | VCCO |
| 3 | IO_L01N_3/ VRP_3 | IO_L01N_3/ VRP_3 | IO_L01N_3/ VRP_3 | AA22 | DCI |
| 3 | IO_L01P_3/ VRN_3 | IO_L01P_3/ VRN_3 | IO_L01P_3/ VRN_3 | AA21 | DCI |
| 3 | IO_L02N_3/ VREF_3 | IO_L02N_3/ VREF_3 | IO_L02N_3/ VREF_3 | AB24 | VREF |
| 3 | IO_L02P_3 | IO_L02P_3 | IO_L02P_3 | AB23 | I/O |
| 3 | IO_L03N_3 | IO_L03N_3 | IO_L03N_3 | AC26 | I/O |
| 3 | IO_L03P_3 | IO_L03P_3 | IO_L03P_3 | AC25 | I/O |
| 3 | N.C. (◆) | IO_L05N_3 | IO_L05N_3 | Y21 | I/O |
| 3 | N.C. (◆) | IO_L05P_3 | IO_L05P_3 | Y20 | I/O |
| 3 | N.C. (◆) | IO_L06N_3 | IO_L06N_3 | AB26 | I/O |
| 3 | N.C. (◆) | IO_L06P_3 | IO_L06P_3 | AB25 | I/O |
| 3 | N.C. (◆) | IO_L07N_3 | IO_L07N_3 | AA24 | I/O |
| 3 | N.C. (◆) | IO_L07P_3 | IO_L07P_3 | AA23 | I/O |
| 3 | N.C. (◆) | IO_L08N_3 | IO_L08N_3 | Y23 | I/O |

Table 28: FG676 Package Pinout (Continued)

| Bank | XC3S1000 Pin Name | XC3S1500 Pin Name | XC3S2000 Pin Name | FG676 Pin Number | Type |
|------|----------------------|----------------------|----------------------|------------------------|------|
| 3 | N.C. (◆) | IO_L08P_3 | IO_L08P_3 | Y22 | I/O |
| 3 | N.C. (◆) | IO_L09N_3 | IO_L09N_3 | AA26 | I/O |
| 3 | N.C. (◆) | IO_L09P_3/ VREF_3 | IO_L09P_3/ VREF_3 | AA25 | VREF |
| 3 | N.C. (◆) | IO_L10N_3 | IO_L10N_3 | W21 | I/O |
| 3 | N.C. (◆) | IO_L10P_3 | IO_L10P_3 | W20 | I/O |
| 3 | IO_L14N_3 | IO_L14N_3 | IO_L14N_3 | Y26 | I/O |
| 3 | IO_L14P_3 | IO_L14P_3 | IO_L14P_3 | Y25 | I/O |
| 3 | IO_L16N_3 | IO_L16N_3 | IO_L16N_3 | V21 | I/O |
| 3 | IO_L16P_3 | IO_L16P_3 | IO_L16P_3 | W22 | I/O |
| 3 | IO_L17N_3 | IO_L17N_3 | IO_L17N_3 | W24 | I/O |
| 3 | IO_L17P_3/ VREF_3 | IO_L17P_3/ VREF_3 | IO_L17P_3/ VREF_3 | W23 | VREF |
| 3 | IO_L19N_3 | IO_L19N_3 | IO_L19N_3 | W26 | I/O |
| 3 | IO_L19P_3 | IO_L19P_3 | IO_L19P_3 | W25 | I/O |
| 3 | IO_L20N_3 | IO_L20N_3 | IO_L20N_3 | U20 | I/O |
| 3 | IO_L20P_3 | IO_L20P_3 | IO_L20P_3 | V20 | I/O |
| 3 | IO_L21N_3 | IO_L21N_3 | IO_L21N_3 | V23 | I/O |
| 3 | IO_L21P_3 | IO_L21P_3 | IO_L21P_3 | V22 | I/O |
| 3 | IO_L22N_3 | IO_L22N_3 | IO_L22N_3 | V25 | I/O |
| 3 | IO_L22P_3 | IO_L22P_3 | IO_L22P_3 | V24 | I/O |
| 3 | IO_L23N_3 | IO_L23N_3 | IO_L23N_3 | U22 | I/O |
| 3 | IO_L23P_3/ VREF_3 | IO_L23P_3/ VREF_3 | IO_L23P_3/ VREF_3 | U21 | VREF |
| 3 | IO_L24N_3 | IO_L24N_3 | IO_L24N_3 | U24 | I/O |
| 3 | IO_L24P_3 | IO_L24P_3 | IO_L24P_3 | U23 | I/O |
| 3 | IO_L26N_3 | IO_L26N_3 | IO_L26N_3 | U26 | I/O |
| 3 | IO_L26P_3 | IO_L26P_3 | IO_L26P_3 | U25 | I/O |
| 3 | IO_L27N_3 | IO_L27N_3 | IO_L27N_3 | T20 | I/O |
| 3 | IO_L27P_3 | IO_L27P_3 | IO_L27P_3 | T19 | I/O |
| 3 | IO_L28N_3 | IO_L28N_3 | IO_L28N_3 | T22 | I/O |
| 3 | IO_L28P_3 | IO_L28P_3 | IO_L28P_3 | T21 | I/O |
| 3 | IO_L29N_3 | IO_L29N_3 | IO_L29N_3 | T26 | I/O |
| 3 | IO_L29P_3 | IO_L29P_3 | IO_L29P_3 | T25 | I/O |
| 3 | IO_L31N_3 | IO_L31N_3 | IO_L31N_3 | R20 | I/O |
| 3 | IO_L31P_3 | IO_L31P_3 | IO_L31P_3 | R19 | I/O |
| 3 | IO_L32N_3 | IO_L32N_3 | IO_L32N_3 | R22 | I/O |
| 3 | IO_L32P_3 | IO_L32P_3 | IO_L32P_3 | R21 | I/O |
| 3 | IO_L33N_3 | IO_L33N_3 | IO_L33N_3 | R24 | I/O |
| 3 | IO_L33P_3 | IO_L33P_3 | IO_L33P_3 | T23 | I/O |
| 3 | IO_L34N_3 | IO_L34N_3 | IO_L34N_3 | R26 | I/O |
| 3 | IO_L34P_3/ VREF_3 | IO_L34P_3/ VREF_3 | IO_L34P_3/ VREF_3 | R25 | VREF |
| 3 | IO_L35N_3 | IO_L35N_3 | IO_L35N_3 | P20 | I/O |
| 3 | IO_L35P_3 | IO_L35P_3 | IO_L35P_3 | P19 | I/O |
| 3 | IO_L38N_3 | IO_L38N_3 | IO_L38N_3 | P22 | I/O |

Table 28: FG676 Package Pinout (Continued)

| Bank | XC3S1000 Pin Name | XC3S1500 Pin Name | XC3S2000 Pin Name | FG676 Pin Number | Type |
|------|----------------------|----------------------|----------------------|------------------------|------|
| 3 | IO_L38P_3 | IO_L38P_3 | IO_L38P_3 | P21 | I/O |
| 3 | IO_L39N_3 | IO_L39N_3 | IO_L39N_3 | P24 | I/O |
| 3 | IO_L39P_3 | IO_L39P_3 | IO_L39P_3 | P23 | I/O |
| 3 | IO_L40N_3/ VREF_3 | IO_L40N_3/ VREF_3 | IO_L40N_3/ VREF_3 | P26 | VREF |
| 3 | IO_L40P_3 | IO_L40P_3 | IO_L40P_3 | P25 | I/O |
| 3 | VCCO_3 | VCCO_3 | VCCO_3 | P17 | VCCO |
| 3 | VCCO_3 | VCCO_3 | VCCO_3 | P18 | VCCO |
| 3 | VCCO_3 | VCCO_3 | VCCO_3 | R18 | VCCO |
| 3 | VCCO_3 | VCCO_3 | VCCO_3 | T18 | VCCO |
| 3 | VCCO_3 | VCCO_3 | VCCO_3 | T24 | VCCO |
| 3 | VCCO_3 | VCCO_3 | VCCO_3 | U19 | VCCO |
| 3 | VCCO_3 | VCCO_3 | VCCO_3 | V19 | VCCO |
| 3 | VCCO_3 | VCCO_3 | VCCO_3 | Y24 | VCCO |
| 4 | IO | IO | IO | AA20 | I/O |
| 4 | IO | IO | IO | AD15 | I/O |
| 4 | N.C. (◆) | IO | IO | AD19 | I/O |
| 4 | IO | IO | IO | AD23 | I/O |
| 4 | IO | IO | IO | AF21 | I/O |
| 4 | IO | IO | IO | AF22 | I/O |
| 4 | IO | IO | IO | W15 | I/O |
| 4 | IO | IO | IO | W16 | I/O |
| 4 | IO/VREF_4 | IO/VREF_4 | IO/VREF_4 | AB14 | VREF |
| 4 | IO/VREF_4 | IO/VREF_4 | IO/VREF_4 | AD25 | VREF |
| 4 | IO/VREF_4 | IO/VREF_4 | IO/VREF_4 | Y17 | VREF |
| 4 | IO_L01N_4/ VRP_4 | IO_L01N_4/ VRP_4 | IO_L01N_4/ VRP_4 | AB22 | DCI |
| 4 | IO_L01P_4/ VRN_4 | IO_L01P_4/ VRN_4 | IO_L01P_4/ VRN_4 | AC22 | DCI |
| 4 | IO_L04N_4 | IO_L04N_4 | IO_L04N_4 | AE24 | I/O |
| 4 | IO_L04P_4 | IO_L04P_4 | IO_L04P_4 | AF24 | I/O |
| 4 | IO_L05N_4 | IO_L05N_4 | IO_L05N_4 | AE23 | I/O |
| 4 | IO_L05P_4 | IO_L05P_4 | IO_L05P_4 | AF23 | I/O |
| 4 | IO_L06N_4/ VREF_4 | IO_L06N_4/ VREF_4 | IO_L06N_4/ VREF_4 | AD22 | VREF |
| 4 | IO_L06P_4 | IO_L06P_4 | IO_L06P_4 | AE22 | I/O |
| 4 | IO_L07N_4 | IO_L07N_4 | IO_L07N_4 | AB21 | I/O |
| 4 | IO_L07P_4 | IO_L07P_4 | IO_L07P_4 | AC21 | I/O |
| 4 | IO_L08N_4 | IO_L08N_4 | IO_L08N_4 | AD21 | I/O |
| 4 | IO_L08P_4 | IO_L08P_4 | IO_L08P_4 | AE21 | I/O |
| 4 | IO_L09N_4 | IO_L09N_4 | IO_L09N_4 | AB20 | I/O |
| 4 | IO_L09P_4 | IO_L09P_4 | IO_L09P_4 | AC20 | I/O |
| 4 | IO_L10N_4 | IO_L10N_4 | IO_L10N_4 | AE20 | I/O |
| 4 | IO_L10P_4 | IO_L10P_4 | IO_L10P_4 | AF20 | I/O |
| 4 | N.C. (◆) | IO_L11N_4 | IO_L11N_4 | Y19 | I/O |
| 4 | N.C. (◆) | IO_L11P_4 | IO_L11P_4 | AA19 | I/O |

Table 28: FG676 Package Pinout (Continued)

| Bank | XC3S1000 Pin Name | XC3S1500 Pin Name | XC3S2000 Pin Name | FG676 Pin Number | Type |
|------|-------------------------|-------------------------|-------------------------|------------------------|------|
| 4 | N.C. (◆) | IO_L12N_4 | IO_L12N_4 | AB19 | I/O |
| 4 | N.C. (◆) | IO_L12P_4 | IO_L12P_4 | AC19 | I/O |
| 4 | IO_L15N_4 | IO_L15N_4 | IO_L15N_4 | AE19 | I/O |
| 4 | IO_L15P_4 | IO_L15P_4 | IO_L15P_4 | AF19 | I/O |
| 4 | IO_L16N_4 | IO_L16N_4 | IO_L16N_4 | Y18 | I/O |
| 4 | IO_L16P_4 | IO_L16P_4 | IO_L16P_4 | AA18 | I/O |
| 4 | N.C. (◆) | IO_L17N_4 | IO_L17N_4 | AB18 | I/O |
| 4 | N.C. (◆) | IO_L17P_4 | IO_L17P_4 | AC18 | I/O |
| 4 | N.C. (◆) | IO_L18N_4 | IO_L18N_4 | AD18 | I/O |
| 4 | N.C. (◆) | IO_L18P_4 | IO_L18P_4 | AE18 | I/O |
| 4 | IO_L19N_4 | IO_L19N_4 | IO_L19N_4 | AC17 | I/O |
| 4 | IO_L19P_4 | IO_L19P_4 | IO_L19P_4 | AA17 | I/O |
| 4 | IO_L22N_4/ VREF_4 | IO_L22N_4/ VREF_4 | IO_L22N_4/ VREF_4 | AD17 | VREF |
| 4 | IO_L22P_4 | IO_L22P_4 | IO_L22P_4 | AB17 | I/O |
| 4 | N.C. (◆) | IO_L23N_4 | IO_L23N_4 | AE17 | I/O |
| 4 | N.C. (◆) | IO_L23P_4 | IO_L23P_4 | AF17 | I/O |
| 4 | IO_L24N_4 | IO_L24N_4 | IO_L24N_4 | Y16 | I/O |
| 4 | IO_L24P_4 | IO_L24P_4 | IO_L24P_4 | AA16 | I/O |
| 4 | IO_L25N_4 | IO_L25N_4 | IO_L25N_4 | AB16 | I/O |
| 4 | IO_L25P_4 | IO_L25P_4 | IO_L25P_4 | AC16 | I/O |
| 4 | N.C. (◆) | IO_L26N_4 | IO_L26N_4 | AE16 | I/O |
| 4 | N.C. (◆) | IO_L26P_4/ VREF_4 | IO_L26P_4/ VREF_4 | AF16 | VREF |
| 4 | IO_L27N_4/ DIN/D0 | IO_L27N_4/ DIN/D0 | IO_L27N_4/ DIN/D0 | Y15 | DUAL |
| 4 | IO_L27P_4/ D1 | IO_L27P_4/ D1 | IO_L27P_4/ D1 | W14 | DUAL |
| 4 | IO_L28N_4 | IO_L28N_4 | IO_L28N_4 | AA15 | I/O |
| 4 | IO_L28P_4 | IO_L28P_4 | IO_L28P_4 | AB15 | I/O |
| 4 | IO_L29N_4 | IO_L29N_4 | IO_L29N_4 | AE15 | I/O |
| 4 | IO_L29P_4 | IO_L29P_4 | IO_L29P_4 | AF15 | I/O |
| 4 | IO_L30N_4/ D2 | IO_L30N_4/ D2 | IO_L30N_4/ D2 | Y14 | DUAL |
| 4 | IO_L30P_4/ D3 | IO_L30P_4/ D3 | IO_L30P_4/ D3 | AA14 | DUAL |
| 4 | IO_L31N_4/ INIT_B | IO_L31N_4/ INIT_B | IO_L31N_4/ INIT_B | AC14 | DUAL |
| 4 | IO_L31P_4/ DOUT/BUSY | IO_L31P_4/ DOUT/BUSY | IO_L31P_4/ DOUT/BUSY | AD14 | DUAL |
| 4 | IO_L32N_4/ GCLK1 | IO_L32N_4/ GCLK1 | IO_L32N_4/ GCLK1 | AE14 | GCLK |
| 4 | IO_L32P_4/ GCLK0 | IO_L32P_4/ GCLK0 | IO_L32P_4/ GCLK0 | AF14 | GCLK |
| 4 | VCCO_4 | VCCO_4 | VCCO_4 | AD16 | VCCO |
| 4 | VCCO_4 | VCCO_4 | VCCO_4 | AD20 | VCCO |
| 4 | VCCO_4 | VCCO_4 | VCCO_4 | U14 | VCCO |
| 4 | VCCO_4 | VCCO_4 | VCCO_4 | V14 | VCCO |

Table 28: FG676 Package Pinout (Continued)

| Bank | XC3S1000 Pin Name | XC3S1500 Pin Name | XC3S2000 Pin Name | FG676 Pin Number | Type |
|------|----------------------|----------------------|----------------------|------------------------|------|
| 4 | VCCO_4 | VCCO_4 | VCCO_4 | V15 | VCCO |
| 4 | VCCO_4 | VCCO_4 | VCCO_4 | V16 | VCCO |
| 4 | VCCO_4 | VCCO_4 | VCCO_4 | W17 | VCCO |
| 4 | VCCO_4 | VCCO_4 | VCCO_4 | W18 | VCCO |
| 5 | IO | IO | IO | AA7 | I/O |
| 5 | IO | IO | IO | AA13 | I/O |
| 5 | IO | IO | IO | AB9 | I/O |
| 5 | N.C. (◆) | IO | IO | AC9 | I/O |
| 5 | IO | IO | IO | AC11 | I/O |
| 5 | IO | IO | IO | AD10 | I/O |
| 5 | IO | IO | IO | AD12 | I/O |
| 5 | IO | IO | IO | AF4 | I/O |
| 5 | IO | IO | IO | Y8 | I/O |
| 5 | IO/VREF_5 | IO/VREF_5 | IO/VREF_5 | AF5 | VREF |
| 5 | IO/VREF_5 | IO/VREF_5 | IO/VREF_5 | AF13 | VREF |
| 5 | IO_L01N_5/ RDWR_B | IO_L01N_5/ RDWR_B | IO_L01N_5/ RDWR_B | AC5 | DUAL |
| 5 | IO_L01P_5/ CS_B | IO_L01P_5/ CS_B | IO_L01P_5/ CS_B | AB5 | DUAL |
| 5 | IO_L04N_5 | IO_L04N_5 | IO_L04N_5 | AE4 | I/O |
| 5 | IO_L04P_5 | IO_L04P_5 | IO_L04P_5 | AD4 | I/O |
| 5 | IO_L05N_5 | IO_L05N_5 | IO_L05N_5 | AB6 | I/O |
| 5 | IO_L05P_5 | IO_L05P_5 | IO_L05P_5 | AA6 | I/O |
| 5 | IO_L06N_5 | IO_L06N_5 | IO_L06N_5 | AE5 | I/O |
| 5 | IO_L06P_5 | IO_L06P_5 | IO_L06P_5 | AD5 | I/O |
| 5 | IO_L07N_5 | IO_L07N_5 | IO_L07N_5 | AD6 | I/O |
| 5 | IO_L07P_5 | IO_L07P_5 | IO_L07P_5 | AC6 | I/O |
| 5 | IO_L08N_5 | IO_L08N_5 | IO_L08N_5 | AF6 | I/O |
| 5 | IO_L08P_5 | IO_L08P_5 | IO_L08P_5 | AE6 | I/O |
| 5 | IO_L09N_5 | IO_L09N_5 | IO_L09N_5 | AC7 | I/O |
| 5 | IO_L09P_5 | IO_L09P_5 | IO_L09P_5 | AB7 | I/O |
| 5 | IO_L10N_5/ VRP_5 | IO_L10N_5/ VRP_5 | IO_L10N_5/ VRP_5 | AF7 | DCI |
| 5 | IO_L10P_5/ VRN_5 | IO_L10P_5/ VRN_5 | IO_L10P_5/ VRN_5 | AE7 | DCI |
| 5 | N.C. (◆) | IO_L11N_5/ VREF_5 | IO_L11N_5/ VREF_5 | AB8 | VREF |
| 5 | N.C. (◆) | IO_L11P_5 | IO_L11P_5 | AA8 | I/O |
| 5 | N.C. (◆) | IO_L12N_5 | IO_L12N_5 | AD8 | I/O |
| 5 | N.C. (◆) | IO_L12P_5 | IO_L12P_5 | AC8 | I/O |
| 5 | IO_L15N_5 | IO_L15N_5 | IO_L15N_5 | AF8 | I/O |
| 5 | IO_L15P_5 | IO_L15P_5 | IO_L15P_5 | AE8 | I/O |
| 5 | IO_L16N_5 | IO_L16N_5 | IO_L16N_5 | AA9 | I/O |
| 5 | IO_L16P_5 | IO_L16P_5 | IO_L16P_5 | Y9 | I/O |
| 5 | N.C. (◆) | IO_L18N_5 | IO_L18N_5 | AE9 | I/O |
| 5 | N.C. (◆) | IO_L18P_5 | IO_L18P_5 | AD9 | I/O |
| 5 | IO_L19N_5 | IO_L19N_5 | IO_L19N_5 | AA10 | I/O |

Table 28: FG676 Package Pinout (Continued)

| Bank | XC3S1000 Pin Name | XC3S1500 Pin Name | XC3S2000 Pin Name | FG676 Pin Number | Type |
|------|----------------------|----------------------|----------------------|------------------------|------|
| 5 | IO_L19P_5/ VREF_5 | IO_L19P_5/ VREF_5 | IO_L19P_5/ VREF_5 | Y10 | VREF |
| 5 | IO_L22N_5 | IO_L22N_5 | IO_L22N_5 | AC10 | I/O |
| 5 | IO_L22P_5 | IO_L22P_5 | IO_L22P_5 | AB10 | I/O |
| 5 | N.C. (◆) | IO_L23N_5 | IO_L23N_5 | AF10 | I/O |
| 5 | N.C. (◆) | IO_L23P_5 | IO_L23P_5 | AE10 | I/O |
| 5 | IO_L24N_5 | IO_L24N_5 | IO_L24N_5 | Y11 | I/O |
| 5 | IO_L24P_5 | IO_L24P_5 | IO_L24P_5 | W11 | I/O |
| 5 | IO_L25N_5 | IO_L25N_5 | IO_L25N_5 | AB11 | I/O |
| 5 | IO_L25P_5 | IO_L25P_5 | IO_L25P_5 | AA11 | I/O |
| 5 | N.C. (◆) | IO_L26N_5 | IO_L26N_5 | AF11 | I/O |
| 5 | N.C. (◆) | IO_L26P_5 | IO_L26P_5 | AE11 | I/O |
| 5 | IO_L27N_5/ VREF_5 | IO_L27N_5/ VREF_5 | IO_L27N_5/ VREF_5 | Y12 | VREF |
| 5 | IO_L27P_5 | IO_L27P_5 | IO_L27P_5 | W12 | I/O |
| 5 | IO_L28N_5/ D6 | IO_L28N_5/ D6 | IO_L28N_5/ D6 | AB12 | DUAL |
| 5 | IO_L28P_5/ D7 | IO_L28P_5/ D7 | IO_L28P_5/ D7 | AA12 | DUAL |
| 5 | IO_L29N_5 | IO_L29N_5 | IO_L29N_5 | AF12 | I/O |
| 5 | IO_L29P_5/ VREF_5 | IO_L29P_5/ VREF_5 | IO_L29P_5/ VREF_5 | AE12 | VREF |
| 5 | IO_L30N_5 | IO_L30N_5 | IO_L30N_5 | Y13 | I/O |
| 5 | IO_L30P_5 | IO_L30P_5 | IO_L30P_5 | W13 | I/O |
| 5 | IO_L31N_5/ D4 | IO_L31N_5/ D4 | IO_L31N_5/ D4 | AC13 | DUAL |
| 5 | IO_L31P_5/ D5 | IO_L31P_5/ D5 | IO_L31P_5/ D5 | AB13 | DUAL |
| 5 | IO_L32N_5/ GCLK3 | IO_L32N_5/ GCLK3 | IO_L32N_5/ GCLK3 | AE13 | GCLK |
| 5 | IO_L32P_5/ GCLK2 | IO_L32P_5/ GCLK2 | IO_L32P_5/ GCLK2 | AD13 | GCLK |
| 5 | VCCO_5 | VCCO_5 | VCCO_5 | AD7 | VCCO |
| 5 | VCCO_5 | VCCO_5 | VCCO_5 | AD11 | VCCO |
| 5 | VCCO_5 | VCCO_5 | VCCO_5 | U13 | VCCO |
| 5 | VCCO_5 | VCCO_5 | VCCO_5 | V11 | VCCO |
| 5 | VCCO_5 | VCCO_5 | VCCO_5 | V12 | VCCO |
| 5 | VCCO_5 | VCCO_5 | VCCO_5 | V13 | VCCO |
| 5 | VCCO_5 | VCCO_5 | VCCO_5 | W9 | VCCO |
| 5 | VCCO_5 | VCCO_5 | VCCO_5 | W10 | VCCO |
| 6 | N.C. (◆) | N.C. (■) | IO | AA5 | I/O |
| 6 | IO_L01N_6/ VRP_6 | IO_L01N_6/ VRP_6 | IO_L01N_6/ VRP_6 | AD2 | DCI |
| 6 | IO_L01P_6/ VRN_6 | IO_L01P_6/ VRN_6 | IO_L01P_6/ VRN_6 | AD1 | DCI |
| 6 | IO_L02N_6 | IO_L02N_6 | IO_L02N_6 | AB4 | I/O |
| 6 | IO_L02P_6 | IO_L02P_6 | IO_L02P_6 | AB3 | I/O |
| 6 | IO_L03N_6/ VREF_6 | IO_L03N_6/ VREF_6 | IO_L03N_6/ VREF_6 | AC2 | VREF |

Table 28: FG676 Package Pinout (Continued)

| Bank | XC3S1000 Pin Name | XC3S1500 Pin Name | XC3S2000 Pin Name | FG676 Pin Number | Type |
|------|----------------------|----------------------|----------------------|------------------------|------|
| 6 | IO_L03P_6 | IO_L03P_6 | IO_L03P_6 | AC1 | I/O |
| 6 | N.C. (◆) | IO_L05N_6 | IO_L05N_6 | AB2 | I/O |
| 6 | N.C. (◆) | IO_L05P_6 | IO_L05P_6 | AB1 | I/O |
| 6 | N.C. (◆) | IO_L06N_6 | IO_L06N_6 | Y7 | I/O |
| 6 | N.C. (◆) | IO_L06P_6 | IO_L06P_6 | Y6 | I/O |
| 6 | N.C. (◆) | IO_L07N_6 | IO_L07N_6 | AA4 | I/O |
| 6 | N.C. (◆) | IO_L07P_6 | IO_L07P_6 | AA3 | I/O |
| 6 | N.C. (◆) | IO_L08N_6 | IO_L08N_6 | Y5 | I/O |
| 6 | N.C. (◆) | IO_L08P_6 | IO_L08P_6 | Y4 | I/O |
| 6 | N.C. (◆) | IO_L09N_6/ VREF_6 | IO_L09N_6/ VREF_6 | AA2 | VREF |
| 6 | N.C. (◆) | IO_L09P_6 | IO_L09P_6 | AA1 | I/O |
| 6 | N.C. (◆) | IO_L10N_6 | IO_L10N_6 | Y2 | I/O |
| 6 | N.C. (◆) | IO_L10P_6 | IO_L10P_6 | Y1 | I/O |
| 6 | IO_L14N_6 | IO_L14N_6 | IO_L14N_6 | W7 | I/O |
| 6 | IO_L14P_6 | IO_L14P_6 | IO_L14P_6 | W6 | I/O |
| 6 | IO_L16N_6 | IO_L16N_6 | IO_L16N_6 | V6 | I/O |
| 6 | IO_L16P_6 | IO_L16P_6 | IO_L16P_6 | W5 | I/O |
| 6 | IO_L17N_6 | IO_L17N_6 | IO_L17N_6 | W4 | I/O |
| 6 | IO_L17P_6/ VREF_6 | IO_L17P_6/ VREF_6 | IO_L17P_6/ VREF_6 | W3 | VREF |
| 6 | IO_L19N_6 | IO_L19N_6 | IO_L19N_6 | W2 | I/O |
| 6 | IO_L19P_6 | IO_L19P_6 | IO_L19P_6 | W1 | I/O |
| 6 | IO_L20N_6 | IO_L20N_6 | IO_L20N_6 | V7 | I/O |
| 6 | IO_L20P_6 | IO_L20P_6 | IO_L20P_6 | U7 | I/O |
| 6 | IO_L21N_6 | IO_L21N_6 | IO_L21N_6 | V5 | I/O |
| 6 | IO_L21P_6 | IO_L21P_6 | IO_L21P_6 | V4 | I/O |
| 6 | IO_L22N_6 | IO_L22N_6 | IO_L22N_6 | V3 | I/O |
| 6 | IO_L22P_6 | IO_L22P_6 | IO_L22P_6 | V2 | I/O |
| 6 | IO_L23N_6 | IO_L23N_6 | IO_L23N_6 | U6 | I/O |
| 6 | IO_L23P_6 | IO_L23P_6 | IO_L23P_6 | U5 | I/O |
| 6 | IO_L24N_6/ VREF_6 | IO_L24N_6/ VREF_6 | IO_L24N_6/ VREF_6 | U4 | VREF |
| 6 | IO_L24P_6 | IO_L24P_6 | IO_L24P_6 | U3 | I/O |
| 6 | IO_L26N_6 | IO_L26N_6 | IO_L26N_6 | U2 | I/O |
| 6 | IO_L26P_6 | IO_L26P_6 | IO_L26P_6 | U1 | I/O |
| 6 | IO_L27N_6 | IO_L27N_6 | IO_L27N_6 | T8 | I/O |
| 6 | IO_L27P_6 | IO_L27P_6 | IO_L27P_6 | T7 | I/O |
| 6 | IO_L28N_6 | IO_L28N_6 | IO_L28N_6 | T6 | I/O |
| 6 | IO_L28P_6 | IO_L28P_6 | IO_L28P_6 | T5 | I/O |
| 6 | IO_L29N_6 | IO_L29N_6 | IO_L29N_6 | T2 | I/O |
| 6 | IO_L29P_6 | IO_L29P_6 | IO_L29P_6 | T1 | I/O |
| 6 | IO_L31N_6 | IO_L31N_6 | IO_L31N_6 | R8 | I/O |
| 6 | IO_L31P_6 | IO_L31P_6 | IO_L31P_6 | R7 | I/O |
| 6 | IO_L32N_6 | IO_L32N_6 | IO_L32N_6 | R6 | I/O |
| 6 | IO_L32P_6 | IO_L32P_6 | IO_L32P_6 | R5 | I/O |

Table 28: FG676 Package Pinout (Continued)

| Bank | XC3S1000 Pin Name | XC3S1500 Pin Name | XC3S2000 Pin Name | FG676 Pin Number | Type |
|------|----------------------|----------------------|----------------------|------------------------|------|
| 6 | IO_L33N_6 | IO_L33N_6 | IO_L33N_6 | T4 | I/O |
| 6 | IO_L33P_6 | IO_L33P_6 | IO_L33P_6 | R3 | I/O |
| 6 | IO_L34N_6/ VREF_6 | IO_L34N_6/ VREF_6 | IO_L34N_6/ VREF_6 | R2 | VREF |
| 6 | IO_L34P_6 | IO_L34P_6 | IO_L34P_6 | R1 | I/O |
| 6 | IO_L35N_6 | IO_L35N_6 | IO_L35N_6 | P8 | I/O |
| 6 | IO_L35P_6 | IO_L35P_6 | IO_L35P_6 | P7 | I/O |
| 6 | IO_L38N_6 | IO_L38N_6 | IO_L38N_6 | P6 | I/O |
| 6 | IO_L38P_6 | IO_L38P_6 | IO_L38P_6 | P5 | I/O |
| 6 | IO_L39N_6 | IO_L39N_6 | IO_L39N_6 | P4 | I/O |
| 6 | IO_L39P_6 | IO_L39P_6 | IO_L39P_6 | P3 | I/O |
| 6 | IO_L40N_6 | IO_L40N_6 | IO_L40N_6 | P2 | I/O |
| 6 | IO_L40P_6/ VREF_6 | IO_L40P_6/ VREF_6 | IO_L40P_6/ VREF_6 | P1 | VREF |
| 6 | VCCO_6 | VCCO_6 | VCCO_6 | P9 | VCCO |
| 6 | VCCO_6 | VCCO_6 | VCCO_6 | P10 | VCCO |
| 6 | VCCO_6 | VCCO_6 | VCCO_6 | R9 | VCCO |
| 6 | VCCO_6 | VCCO_6 | VCCO_6 | T3 | VCCO |
| 6 | VCCO_6 | VCCO_6 | VCCO_6 | T9 | VCCO |
| 6 | VCCO_6 | VCCO_6 | VCCO_6 | U8 | VCCO |
| 6 | VCCO_6 | VCCO_6 | VCCO_6 | V8 | VCCO |
| 6 | VCCO_6 | VCCO_6 | VCCO_6 | Y3 | VCCO |
| 7 | IO_L01N_7/ VRP_7 | IO_L01N_7/ VRP_7 | IO_L01N_7/ VRP_7 | F5 | DCI |
| 7 | IO_L01P_7/ VRN_7 | IO_L01P_7/ VRN_7 | IO_L01P_7/ VRN_7 | F6 | DCI |
| 7 | IO_L02N_7 | IO_L02N_7 | IO_L02N_7 | E3 | I/O |
| 7 | IO_L02P_7 | IO_L02P_7 | IO_L02P_7 | E4 | I/O |
| 7 | IO_L03N_7/ VREF_7 | IO_L03N_7/ VREF_7 | IO_L03N_7/ VREF_7 | D1 | VREF |
| 7 | IO_L03P_7 | IO_L03P_7 | IO_L03P_7 | D2 | I/O |
| 7 | N.C. (◆) | IO_L05N_7 | IO_L05N_7 | G6 | I/O |
| 7 | N.C. (◆) | IO_L05P_7 | IO_L05P_7 | G7 | I/O |
| 7 | N.C. (◆) | IO_L06N_7 | IO_L06N_7 | E1 | I/O |
| 7 | N.C. (◆) | IO_L06P_7 | IO_L06P_7 | E2 | I/O |
| 7 | N.C. (◆) | IO_L07N_7 | IO_L07N_7 | F3 | I/O |
| 7 | N.C. (◆) | IO_L07P_7 | IO_L07P_7 | F4 | I/O |
| 7 | N.C. (◆) | IO_L08N_7 | IO_L08N_7 | G4 | I/O |
| 7 | N.C. (◆) | IO_L08P_7 | IO_L08P_7 | G5 | I/O |
| 7 | N.C. (◆) | IO_L09N_7 | IO_L09N_7 | F1 | I/O |
| 7 | N.C. (◆) | IO_L09P_7 | IO_L09P_7 | F2 | I/O |
| 7 | N.C. (◆) | IO_L10N_7 | IO_L10N_7 | H6 | I/O |
| 7 | N.C. (◆) | IO_L10P_7/ VREF_7 | IO_L10P_7/ VREF_7 | H7 | VREF |
| 7 | IO_L14N_7 | IO_L14N_7 | IO_L14N_7 | G1 | I/O |
| 7 | IO_L14P_7 | IO_L14P_7 | IO_L14P_7 | G2 | I/O |
| 7 | IO_L16N_7 | IO_L16N_7 | IO_L16N_7 | J6 | I/O |

Table 28: FG676 Package Pinout (Continued)

| Bank | XC3S1000 Pin Name | XC3S1500 Pin Name | XC3S2000 Pin Name | FG676 Pin Number | Type |
|------|----------------------|----------------------|----------------------|------------------------|------|
| 7 | IO_L16P_7/ VREF_7 | IO_L16P_7/ VREF_7 | IO_L16P_7/ VREF_7 | H5 | VREF |
| 7 | IO_L17N_7 | IO_L17N_7 | IO_L17N_7 | H3 | I/O |
| 7 | IO_L17P_7 | IO_L17P_7 | IO_L17P_7 | H4 | I/O |
| 7 | IO_L19N_7/ VREF_7 | IO_L19N_7/ VREF_7 | IO_L19N_7/ VREF_7 | H1 | VREF |
| 7 | IO_L19P_7 | IO_L19P_7 | IO_L19P_7 | H2 | I/O |
| 7 | IO_L20N_7 | IO_L20N_7 | IO_L20N_7 | K7 | I/O |
| 7 | IO_L20P_7 | IO_L20P_7 | IO_L20P_7 | J7 | I/O |
| 7 | IO_L21N_7 | IO_L21N_7 | IO_L21N_7 | J4 | I/O |
| 7 | IO_L21P_7 | IO_L21P_7 | IO_L21P_7 | J5 | I/O |
| 7 | IO_L22N_7 | IO_L22N_7 | IO_L22N_7 | J2 | I/O |
| 7 | IO_L22P_7 | IO_L22P_7 | IO_L22P_7 | J3 | I/O |
| 7 | IO_L23N_7 | IO_L23N_7 | IO_L23N_7 | K5 | I/O |
| 7 | IO_L23P_7 | IO_L23P_7 | IO_L23P_7 | K6 | I/O |
| 7 | IO_L24N_7 | IO_L24N_7 | IO_L24N_7 | K3 | I/O |
| 7 | IO_L24P_7 | IO_L24P_7 | IO_L24P_7 | K4 | I/O |
| 7 | IO_L26N_7 | IO_L26N_7 | IO_L26N_7 | K1 | I/O |
| 7 | IO_L26P_7 | IO_L26P_7 | IO_L26P_7 | K2 | I/O |
| 7 | IO_L27N_7 | IO_L27N_7 | IO_L27N_7 | L7 | I/O |
| 7 | IO_L27P_7/ VREF_7 | IO_L27P_7/ VREF_7 | IO_L27P_7/ VREF_7 | L8 | VREF |
| 7 | IO_L28N_7 | IO_L28N_7 | IO_L28N_7 | L5 | I/O |
| 7 | IO_L28P_7 | IO_L28P_7 | IO_L28P_7 | L6 | I/O |
| 7 | IO_L29N_7 | IO_L29N_7 | IO_L29N_7 | L1 | I/O |
| 7 | IO_L29P_7 | IO_L29P_7 | IO_L29P_7 | L2 | I/O |
| 7 | IO_L31N_7 | IO_L31N_7 | IO_L31N_7 | M7 | I/O |
| 7 | IO_L31P_7 | IO_L31P_7 | IO_L31P_7 | M8 | I/O |
| 7 | IO_L32N_7 | IO_L32N_7 | IO_L32N_7 | M6 | I/O |
| 7 | IO_L32P_7 | IO_L32P_7 | IO_L32P_7 | M5 | I/O |
| 7 | IO_L33N_7 | IO_L33N_7 | IO_L33N_7 | M3 | I/O |
| 7 | IO_L33P_7 | IO_L33P_7 | IO_L33P_7 | L4 | I/O |
| 7 | IO_L34N_7 | IO_L34N_7 | IO_L34N_7 | M1 | I/O |
| 7 | IO_L34P_7 | IO_L34P_7 | IO_L34P_7 | M2 | I/O |
| 7 | IO_L35N_7 | IO_L35N_7 | IO_L35N_7 | N7 | I/O |
| 7 | IO_L35P_7 | IO_L35P_7 | IO_L35P_7 | N8 | I/O |
| 7 | IO_L38N_7 | IO_L38N_7 | IO_L38N_7 | N5 | I/O |
| 7 | IO_L38P_7 | IO_L38P_7 | IO_L38P_7 | N6 | I/O |
| 7 | IO_L39N_7 | IO_L39N_7 | IO_L39N_7 | N3 | I/O |
| 7 | IO_L39P_7 | IO_L39P_7 | IO_L39P_7 | N4 | I/O |
| 7 | IO_L40N_7/ VREF_7 | IO_L40N_7/ VREF_7 | IO_L40N_7/ VREF_7 | N1 | VREF |
| 7 | IO_L40P_7 | IO_L40P_7 | IO_L40P_7 | N2 | I/O |
| 7 | VCCO_7 | VCCO_7 | VCCO_7 | G3 | VCCO |
| 7 | VCCO_7 | VCCO_7 | VCCO_7 | J8 | VCCO |
| 7 | VCCO_7 | VCCO_7 | VCCO_7 | K8 | VCCO |

Table 28: FG676 Package Pinout (Continued)

| Bank | XC3S1000 Pin Name | XC3S1500 Pin Name | XC3S2000 Pin Name | FG676 Pin Number | Type |
|------|----------------------|----------------------|----------------------|------------------------|------|
| 7 | VCCO_7 | VCCO_7 | VCCO_7 | L3 | VCCO |
| 7 | VCCO_7 | VCCO_7 | VCCO_7 | L9 | VCCO |
| 7 | VCCO_7 | VCCO_7 | VCCO_7 | M9 | VCCO |
| 7 | VCCO_7 | VCCO_7 | VCCO_7 | N9 | VCCO |
| 7 | VCCO_7 | VCCO_7 | VCCO_7 | N10 | VCCO |
| N/A | GND | GND | GND | A1 | GND |
| N/A | GND | GND | GND | A26 | GND |
| N/A | GND | GND | GND | AC4 | GND |
| N/A | GND | GND | GND | AC12 | GND |
| N/A | GND | GND | GND | AC15 | GND |
| N/A | GND | GND | GND | AC23 | GND |
| N/A | GND | GND | GND | AD3 | GND |
| N/A | GND | GND | GND | AD24 | GND |
| N/A | GND | GND | GND | AE2 | GND |
| N/A | GND | GND | GND | AE25 | GND |
| N/A | GND | GND | GND | AF1 | GND |
| N/A | GND | GND | GND | AF26 | GND |
| N/A | GND | GND | GND | B2 | GND |
| N/A | GND | GND | GND | B25 | GND |
| N/A | GND | GND | GND | C3 | GND |
| N/A | GND | GND | GND | C24 | GND |
| N/A | GND | GND | GND | D4 | GND |
| N/A | GND | GND | GND | D12 | GND |
| N/A | GND | GND | GND | D15 | GND |
| N/A | GND | GND | GND | D23 | GND |
| N/A | GND | GND | GND | K11 | GND |
| N/A | GND | GND | GND | K12 | GND |
| N/A | GND | GND | GND | K15 | GND |
| N/A | GND | GND | GND | K16 | GND |
| N/A | GND | GND | GND | L10 | GND |
| N/A | GND | GND | GND | L11 | GND |
| N/A | GND | GND | GND | L12 | GND |
| N/A | GND | GND | GND | L13 | GND |
| N/A | GND | GND | GND | L14 | GND |
| N/A | GND | GND | GND | L15 | GND |
| N/A | GND | GND | GND | L16 | GND |
| N/A | GND | GND | GND | L17 | GND |
| N/A | GND | GND | GND | M4 | GND |
| N/A | GND | GND | GND | M10 | GND |
| N/A | GND | GND | GND | M11 | GND |
| N/A | GND | GND | GND | M12 | GND |
| N/A | GND | GND | GND | M13 | GND |
| N/A | GND | GND | GND | M14 | GND |
| N/A | GND | GND | GND | M15 | GND |
| N/A | GND | GND | GND | M16 | GND |

Table 28: FG676 Package Pinout (Continued)

| Bank | XC3S1000 Pin Name | XC3S1500 Pin Name | XC3S2000 Pin Name | FG676 Pin Number | Type |
|------|----------------------|----------------------|----------------------|------------------------|--------|
| N/A | GND | GND | GND | M17 | GND |
| N/A | GND | GND | GND | M23 | GND |
| N/A | GND | GND | GND | N11 | GND |
| N/A | GND | GND | GND | N12 | GND |
| N/A | GND | GND | GND | N13 | GND |
| N/A | GND | GND | GND | N14 | GND |
| N/A | GND | GND | GND | N15 | GND |
| N/A | GND | GND | GND | N16 | GND |
| N/A | GND | GND | GND | P11 | GND |
| N/A | GND | GND | GND | P12 | GND |
| N/A | GND | GND | GND | P13 | GND |
| N/A | GND | GND | GND | P14 | GND |
| N/A | GND | GND | GND | P15 | GND |
| N/A | GND | GND | GND | P16 | GND |
| N/A | GND | GND | GND | R4 | GND |
| N/A | GND | GND | GND | R10 | GND |
| N/A | GND | GND | GND | R11 | GND |
| N/A | GND | GND | GND | R12 | GND |
| N/A | GND | GND | GND | R13 | GND |
| N/A | GND | GND | GND | R14 | GND |
| N/A | GND | GND | GND | R15 | GND |
| N/A | GND | GND | GND | R16 | GND |
| N/A | GND | GND | GND | R17 | GND |
| N/A | GND | GND | GND | R23 | GND |
| N/A | GND | GND | GND | T10 | GND |
| N/A | GND | GND | GND | T11 | GND |
| N/A | GND | GND | GND | T12 | GND |
| N/A | GND | GND | GND | T13 | GND |
| N/A | GND | GND | GND | T14 | GND |
| N/A | GND | GND | GND | T15 | GND |
| N/A | GND | GND | GND | T16 | GND |
| N/A | GND | GND | GND | T17 | GND |
| N/A | GND | GND | GND | U11 | GND |
| N/A | GND | GND | GND | U12 | GND |
| N/A | GND | GND | GND | U15 | GND |
| N/A | GND | GND | GND | U16 | GND |
| N/A | VCCAUX | VCCAUX | VCCAUX | A2 | VCCAUX |
| N/A | VCCAUX | VCCAUX | VCCAUX | A9 | VCCAUX |
| N/A | VCCAUX | VCCAUX | VCCAUX | A18 | VCCAUX |
| N/A | VCCAUX | VCCAUX | VCCAUX | A25 | VCCAUX |
| N/A | VCCAUX | VCCAUX | VCCAUX | AE1 | VCCAUX |
| N/A | VCCAUX | VCCAUX | VCCAUX | AE26 | VCCAUX |
| N/A | VCCAUX | VCCAUX | VCCAUX | AF2 | VCCAUX |
| N/A | VCCAUX | VCCAUX | VCCAUX | AF9 | VCCAUX |
| N/A | VCCAUX | VCCAUX | VCCAUX | AF18 | VCCAUX |

Table 28: FG676 Package Pinout (Continued)

| Bank | XC3S1000 Pin Name | XC3S1500 Pin Name | XC3S2000 Pin Name | FG676 Pin Number | Type |
|------------|----------------------|----------------------|----------------------|------------------------|--------|
| N/A | VCCAUX | VCCAUX | VCCAUX | AF25 | VCCAUX |
| N/A | VCCAUX | VCCAUX | VCCAUX | B1 | VCCAUX |
| N/A | VCCAUX | VCCAUX | VCCAUX | B26 | VCCAUX |
| N/A | VCCAUX | VCCAUX | VCCAUX | J1 | VCCAUX |
| N/A | VCCAUX | VCCAUX | VCCAUX | J26 | VCCAUX |
| N/A | VCCAUX | VCCAUX | VCCAUX | V1 | VCCAUX |
| N/A | VCCAUX | VCCAUX | VCCAUX | V26 | VCCAUX |
| N/A | VCCINT | VCCINT | VCCINT | H8 | VCCINT |
| N/A | VCCINT | VCCINT | VCCINT | H19 | VCCINT |
| N/A | VCCINT | VCCINT | VCCINT | J9 | VCCINT |
| N/A | VCCINT | VCCINT | VCCINT | J10 | VCCINT |
| N/A | VCCINT | VCCINT | VCCINT | J17 | VCCINT |
| N/A | VCCINT | VCCINT | VCCINT | J18 | VCCINT |
| N/A | VCCINT | VCCINT | VCCINT | K9 | VCCINT |
| N/A | VCCINT | VCCINT | VCCINT | K10 | VCCINT |
| N/A | VCCINT | VCCINT | VCCINT | K17 | VCCINT |
| N/A | VCCINT | VCCINT | VCCINT | K18 | VCCINT |
| N/A | VCCINT | VCCINT | VCCINT | U9 | VCCINT |
| N/A | VCCINT | VCCINT | VCCINT | U10 | VCCINT |
| N/A | VCCINT | VCCINT | VCCINT | U17 | VCCINT |
| N/A | VCCINT | VCCINT | VCCINT | U18 | VCCINT |
| N/A | VCCINT | VCCINT | VCCINT | V9 | VCCINT |
| N/A | VCCINT | VCCINT | VCCINT | V10 | VCCINT |
| N/A | VCCINT | VCCINT | VCCINT | V17 | VCCINT |
| N/A | VCCINT | VCCINT | VCCINT | V18 | VCCINT |
| N/A | VCCINT | VCCINT | VCCINT | W8 | VCCINT |
| N/A | VCCINT | VCCINT | VCCINT | W19 | VCCINT |
| VCC AUX | CCLK | CCLK | CCLK | AD26 | CONFIG |

Table 28: FG676 Package Pinout (Continued)

| Bank | XC3S1000 Pin Name | XC3S1500 Pin Name | XC3S2000 Pin Name | FG676 Pin Number | Type |
|------------|----------------------|----------------------|----------------------|------------------------|--------|
| VCC AUX | DONE | DONE | DONE | AC24 | CONFIG |
| VCC AUX | HSWAP_EN | HSWAP_EN | HSWAP_EN | C2 | CONFIG |
| VCC AUX | M0 | M0 | M0 | AE3 | CONFIG |
| VCC AUX | M1 | M1 | M1 | AC3 | CONFIG |
| VCC AUX | M2 | M2 | M2 | AF3 | CONFIG |
| VCC AUX | PROG_B | PROG_B | PROG_B | D3 | CONFIG |
| VCC AUX | TCK | TCK | TCK | B24 | JTAG |
| VCC AUX | TDI | TDI | TDI | C1 | JTAG |
| VCC AUX | TDO | TDO | TDO | D24 | JTAG |
| VCC AUX | TMS | TMS | TMS | A24 | JTAG |

User I/Os by Bank

Table 29 indicates how the available user-I/O pins are distributed between the eight I/O banks for the XC3S1000 in the FG676 package. Similarly, Table 30 shows how the available user-I/O pins are distributed between the eight I/O banks for the XC3S1500 in the FG676 package. Finally, Table 31 shows the same information for the XC3S2000 in the FG676 package.

Table 29: User I/Os Per Bank for XC3S1000 in FG676 Package

| Edge | I/O Bank | Maximum I/O | All Possible I/O Pins by Type | | | | |
|--------|-------------|----------------|-------------------------------|------|-----|------|------|
| | | | I/O | DUAL | DCI | VREF | GCLK |
| Top | 0 | 49 | 40 | 0 | 2 | 5 | 2 |
| | 1 | 50 | 41 | 0 | 2 | 5 | 2 |
| Right | 2 | 48 | 41 | 0 | 2 | 5 | 0 |
| | 3 | 48 | 41 | 0 | 2 | 5 | 0 |
| Bottom | 4 | 50 | 35 | 6 | 2 | 5 | 2 |
| | 5 | 50 | 35 | 6 | 2 | 5 | 2 |
| Left | 6 | 48 | 41 | 0 | 2 | 5 | 0 |
| | 7 | 48 | 41 | 0 | 2 | 5 | 0 |

Table 30: User I/Os Per Bank for XC3S1500 in FG676 Package

| Edge | I/O Bank | Maximum I/O | All Possible I/O Pins by Type | | | | |
|--------|----------|-------------|-------------------------------|------|-----|------|------|
| | | | I/O | DUAL | DCI | VREF | GCLK |
| Top | 0 | 62 | 52 | 0 | 2 | 6 | 2 |
| | 1 | 61 | 51 | 0 | 2 | 6 | 2 |
| Right | 2 | 60 | 52 | 0 | 2 | 6 | 0 |
| | 3 | 60 | 52 | 0 | 2 | 6 | 0 |
| Bottom | 4 | 63 | 47 | 6 | 2 | 6 | 2 |
| | 5 | 61 | 45 | 6 | 2 | 6 | 2 |
| Left | 6 | 60 | 52 | 0 | 2 | 6 | 0 |
| | 7 | 60 | 52 | 0 | 2 | 6 | 0 |

Table 31: User I/Os Per Bank for XC3S2000 in FG676 Package

| Edge | I/O Bank | Maximum I/O | All Possible I/O Pins by Type | | | | |
|--------|----------|-------------|-------------------------------|------|-----|------|------|
| | | | I/O | DUAL | DCI | VREF | GCLK |
| Top | 0 | 62 | 52 | 0 | 2 | 6 | 2 |
| | 1 | 61 | 51 | 0 | 2 | 6 | 2 |
| Right | 2 | 61 | 53 | 0 | 2 | 6 | 0 |
| | 3 | 60 | 52 | 0 | 2 | 6 | 0 |
| Bottom | 4 | 63 | 47 | 6 | 2 | 6 | 2 |
| | 5 | 61 | 45 | 6 | 2 | 6 | 2 |
| Left | 6 | 61 | 53 | 0 | 2 | 6 | 0 |
| | 7 | 60 | 52 | 0 | 2 | 6 | 0 |

FG676 Footprint

Left Half of Package (top view)

XC3S1000

(391 max. user I/O)

315 I/O: Unrestricted,
general-purpose user I/O

40 VREF: User I/O or input
voltage reference for bank

98 N.C.: Unconnected pins for
XC3S1000 (◆)

XC3S1500

(487 max user I/O)

403 I/O: Unrestricted,
general-purpose user I/O

48 VREF: User I/O or input
voltage reference for bank

2 N.C.: Unconnected pins for
XC3S1500 (■)

XC3S2000

(489 max user I/O)

405 I/O: Unrestricted,
general-purpose user I/O

48 VREF: User I/O or input
voltage reference for bank

0 N.C.: No unconnected pins

All devices

12 DUAL: Configuration pin,
then possible user I/O

8 GCLK: User I/O or global
clock buffer input

16 DCI: User I/O or reference
resistor input for bank

7 CONFIG: Dedicated
configuration pins

4 JTAG: Dedicated JTAG
port pins

20 VCCINT: Internal core
voltage supply (+1.2V)

64 VCCO: Output voltage
supply for bank

16 VCCAUX: Auxiliary voltage
supply (+2.5V)

76 GND: Ground

| | Bank 0 | | | | | | | | | | | | |
|---|----------------------|----------------------|----------------------|----------------------|----------------------|---------------------|----------------------|----------------------|------------|----------------------|----------------------|----------------------|----------------------|
| | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 10 | 11 | 12 | 13 |
| A | GND | VCCAUX | I/O | I/O L05P_0 VREF_0 | I/O | I/O | I/O L10P_0 | I/O L15P_0 | VCCAUX | I/O L26P_0 VREF_0 | I/O L26P_0 VREF_0 | I/O L29P_0 | I/O L32P_0 GCLK6 |
| B | VCCAUX | GND | I/O VREF_0 | I/O L05N_0 | I/O L06P_0 | I/O L08P_0 | I/O L10N_0 | I/O L15N_0 | I/O L18P_0 | I/O L23N_0 | I/O L26N_0 | I/O L29N_0 | I/O L32N_0 GCLK7 |
| C | TDI | HSWAP_EN | GND | I/O | I/O L06N_0 | I/O L08N_0 | VCCO_0 | I/O | I/O L18N_0 | I/O L22P_0 | VCCO_0 | I/O | I/O L31P_0 VREF_0 |
| D | I/O L03N_7 VREF_7 | I/O L03P_7 | PROG_B | GND | I/O L01P_0 VRN_0 | I/O L07P_0 | I/O L09P_0 | I/O L12P_0 | I/O L17P_0 | I/O L22N_0 | I/O L25P_0 | GND | I/O L31N_0 |
| E | I/O L06N_7 | I/O L06P_7 | I/O L02N_7 | I/O L02P_7 | I/O L01N_0 VRP_0 | I/O L07N_0 | I/O L09N_0 | I/O L12N_0 | I/O L17N_0 | I/O L19P_0 | I/O L25N_0 | I/O L28P_0 | I/O |
| F | I/O L09N_7 | I/O L09P_7 | I/O L07N_7 | I/O L07P_7 | I/O L01N_7 VRP_7 | I/O L01P_7 VRN_7 | I/O VREF_0 | I/O L11P_0 | I/O L16P_0 | I/O L19N_0 | I/O L24P_0 | I/O L28N_0 | I/O L30P_0 |
| G | I/O L14N_7 | I/O L14P_7 | VCCO_7 | I/O L08N_7 | I/O L08P_7 | I/O L05N_7 | I/O L05P_7 | I/O L11N_0 | I/O L16N_0 | I/O VREF_0 | I/O L24N_0 | I/O L27N_0 | I/O L30N_0 |
| H | I/O L19N_7 VREF_7 | I/O L19P_7 | I/O L17N_7 | I/O L17P_7 | I/O L16P_7 VREF_7 | I/O L10N_7 | I/O L10P_7 VREF_7 | VCCINT | VCCO_0 | VCCO_0 | I/O | I/O | I/O L27P_0 |
| J | VCCAUX | I/O L22N_7 | I/O L22P_7 | I/O L21N_7 | I/O L21P_7 | I/O L16N_7 | I/O L20P_7 | VCCO_7 | VCCINT | VCCINT | VCCO_0 | VCCO_0 | VCCO_0 |
| K | I/O L26N_7 | I/O L26P_7 | I/O L24N_7 | I/O L24P_7 | I/O L23N_7 | I/O L23P_7 | I/O L20N_7 | VCCO_7 | VCCINT | VCCINT | GND | GND | VCCO_0 |
| L | I/O L29N_7 | I/O L29P_7 | VCCO_7 | I/O L33P_7 | I/O L28N_7 | I/O L28P_7 | I/O L27N_7 | I/O L27P_7 VREF_7 | VCCO_7 | GND | GND | GND | GND |
| M | I/O L34N_7 | I/O L34P_7 | I/O L33N_7 | GND | I/O L32P_7 | I/O L32N_7 | I/O L31N_7 | I/O L31P_7 | VCCO_7 | GND | GND | GND | GND |
| N | I/O L40N_7 VREF_7 | I/O L40P_7 | I/O L39N_7 | I/O L39P_7 | I/O L38N_7 | I/O L38P_7 | I/O L35N_7 | I/O L35P_7 | VCCO_7 | VCCO_7 | GND | GND | GND |
| P | I/O L40P_6 VREF_6 | I/O L40N_6 | I/O L39P_6 | I/O L39N_6 | I/O L38P_6 | I/O L38N_6 | I/O L35P_6 | I/O L35N_6 | VCCO_6 | VCCO_6 | GND | GND | GND |
| R | I/O L34P_6 | I/O L34N_6 VREF_6 | I/O L33P_6 | GND | I/O L32P_6 | I/O L32N_6 | I/O L31P_6 | I/O L31N_6 | VCCO_6 | GND | GND | GND | GND |
| T | I/O L29P_6 | I/O L29N_6 | VCCO_6 | I/O L33N_6 | I/O L28P_6 | I/O L28N_6 | I/O L27P_6 | I/O L27N_6 | VCCO_6 | GND | GND | GND | GND |
| U | I/O L26P_6 | I/O L26N_6 | I/O L24P_6 | I/O L24N_6 VREF_6 | I/O L23P_6 | I/O L23N_6 | I/O L20P_6 | VCCO_6 | VCCINT | VCCINT | GND | GND | VCCO_5 |
| V | VCCAUX | I/O L22P_6 | I/O L22N_6 | I/O L21P_6 | I/O L21N_6 | I/O L16N_6 | I/O L20N_6 | VCCO_6 | VCCINT | VCCINT | VCCO_5 | VCCO_5 | VCCO_5 |
| W | I/O L19P_6 | I/O L19N_6 | I/O L17P_6 VREF_6 | I/O L17N_6 | I/O L16P_6 | I/O L14P_6 | I/O L14N_6 | VCCINT | VCCO_5 | VCCO_5 | I/O L24P_5 | I/O L27P_5 | I/O L30P_5 |
| Y | I/O L10P_6 | I/O L10N_6 | VCCO_6 | I/O L08P_6 | I/O L08N_6 | I/O L06P_6 | I/O L06N_6 | I/O | I/O L16P_5 | I/O L19P_5 VREF_5 | I/O L24N_5 | I/O L27N_5 VREF_5 | I/O L30N_5 |
| A | I/O L09P_6 | I/O L09N_6 VREF_6 | I/O L07P_6 | I/O L07N_6 | I/O | I/O L05P_5 | I/O | I/O L11P_5 | I/O L16N_5 | I/O L19N_5 | I/O L25P_5 | I/O L28P_5 D7 | I/O |
| A | I/O L05P_6 | I/O L05N_6 | I/O L02P_6 | I/O L02N_6 | I/O L01P_5 CS_B | I/O L05N_5 | I/O L09P_5 | I/O L11N_5 VREF_5 | I/O | I/O L22P_5 | I/O L25N_5 | I/O L28N_5 D6 | I/O L31P_5 D5 |
| A | I/O L03P_6 | I/O L03N_6 VREF_6 | M1 | GND | I/O L01N_5 RDWR_B | I/O L07P_5 | I/O L09N_5 | I/O L12P_5 | I/O | I/O L22N_5 | I/O | GND | I/O L31N_5 D4 |
| A | I/O L01P_6 VRN_6 | I/O L01N_6 VRP_6 | GND | I/O L04P_5 | I/O L06P_5 | I/O L07N_5 | VCCO_5 | I/O L12N_5 | I/O L18P_5 | I/O | VCCO_5 | I/O | I/O L32P_5 GCLK2 |
| A | VCCAUX | GND | M0 | I/O L04N_5 | I/O L06N_5 | I/O L08P_5 | I/O L10P_5 VRN_5 | I/O L15P_5 | I/O L18N_5 | I/O L23P_5 | I/O L26P_5 | I/O L29P_5 VREF_5 | I/O L32N_5 GCLK3 |
| A | GND | VCCAUX | M2 | I/O | I/O VREF_5 | I/O L08N_5 | I/O L10N_5 VRP_5 | I/O L15N_5 | VCCAUX | I/O L23N_5 | I/O L26N_5 | I/O L29N_5 | I/O VREF_5 |

Bank 5

DS099-4_12a_030203

Figure 13: FG676 Package Footprint (top view)

| Bank 1 | | | | | | | | | | | | | | | | Bank 2 | | |
|-------------------------|----------------------|----------------------|----------------------|-----------------|-----------------|----------------------|----------------------|----------------------|----------------------|----------------------|----------------------|----------------------|---|--|--|--------|--|--|
| 14 | 15 | 16 | 17 | 18 | 19 | 20 | 21 | 22 | 23 | 24 | 25 | 26 | | | | | | |
| I/O | I/O L29N_1 | I/O L26N_1 ◆ | I/O L23N_1 ◆ | VCCAUX | I/O L15N_1 | I/O L10N_1 VREF_1 | I/O L08N_1 | I/O | I/O | TMS | VCCAUX | GND | A | | | | | |
| I/O L32N_1 GCLK5 | I/O L29P_1 | I/O L26P_1 ◆ | I/O L23P_1 ◆ | I/O L18N_1 | I/O L15P_1 | I/O L10P_1 | I/O L08P_1 | I/O L06N_1 VREF_1 | I/O L04N_1 | TCK | GND | VCCAUX | B | | | | | |
| I/O L32P_1 GCLK4 | I/O VREF_1 | VCCO_1 | I/O VREF_1 | I/O L18P_1 ◆ | I/O L12N_1 ◆ | VCCO_1 | I/O L07N_1 | I/O L06P_1 | I/O L04P_1 | GND | I/O L01N_2 VRP_2 | I/O L01P_2 VRN_1 | C | | | | | |
| I/O L31N_1 VREF_1 | GND | I/O | I/O L22N_1 | I/O VREF_1 ◆ | I/O L12P_1 ◆ | I/O L09N_1 | I/O L07P_1 | I/O L01N_1 VRP_1 | GND | TDO | I/O L03N_2 VREF_2 | I/O L03P_2 | D | | | | | |
| I/O L31P_1 | I/O L28N_1 | I/O L25N_1 | I/O L22P_1 | I/O | I/O L11N_1 ◆ | I/O L09P_1 | I/O L05N_1 | I/O L01P_1 VRN_1 | I/O L02N_2 | I/O L02P_2 | I/O L05N_2 ◆ | I/O L05P_2 ◆ | E | | | | | |
| I/O | I/O L28P_1 | I/O L25P_1 | I/O L19N_1 | I/O L16N_1 | I/O L11P_1 ◆ | I/O | I/O L05P_1 | I/O | I/O L07N_2 ◆◆ | I/O L07P_2 ◆ | I/O L09N_2 VREF_2 | I/O L09P_2 ◆ | F | | | | | |
| I/O L30N_1 | I/O L27N_1 | I/O L24N_1 | I/O L19P_1 | I/O L16P_1 | I/O | I/O L06N_2 ◆ | I/O L06P_2 ◆ | I/O L08N_2 ◆ | I/O L08P_2 ◆ | VCCO_2 | I/O L10N_2 ◆ | I/O L10P_2 ◆ | G | | | | | |
| I/O L30P_1 | I/O L27P_1 | I/O L24P_1 | VCCO_1 | VCCO_1 | VCCINT | I/O L14N_2 | I/O L14P_2 | I/O L16N_2 | I/O L17N_2 | I/O L17P_2 VREF_2 | I/O L19N_2 | I/O L19P_2 | H | | | | | |
| VCCO_1 | VCCO_1 | VCCO_1 | VCCINT | VCCINT | VCCO_2 | I/O L20N_2 | I/O L16P_2 | I/O L21N_2 | I/O L21P_2 | I/O L22N_2 | I/O L22P_2 | VCCAUX | J | | | | | |
| VCCO_1 | GND | GND | VCCINT | VCCINT | VCCO_2 | I/O L20P_2 | I/O L23N_2 VREF_2 | I/O L23P_2 | I/O L24N_2 | I/O L24P_2 | I/O L26N_2 | I/O L26P_2 | K | | | | | |
| GND | GND | GND | GND | VCCO_2 | I/O L27N_2 | I/O L27P_2 | I/O L28N_2 | I/O L28P_2 | I/O L33N_2 | VCCO_2 | I/O L29N_2 | I/O L29P_2 | L | | | | | |
| GND | GND | GND | GND | VCCO_2 | I/O L31N_2 | I/O L31P_2 | I/O L32N_2 | I/O L32P_2 | GND | I/O L33P_2 | I/O L34N_2 VREF_2 | I/O L34P_2 | M | | | | | |
| GND | GND | GND | VCCO_2 | VCCO_2 | I/O L35N_2 | I/O L35P_2 | I/O L38N_2 | I/O L38P_2 | I/O L39N_2 | I/O L39P_2 | I/O L40N_2 | I/O L40P_2 VREF_2 | N | | | | | |
| GND | GND | GND | VCCO_3 | VCCO_3 | I/O L35P_3 | I/O L35N_3 | I/O L38P_3 | I/O L38N_3 | I/O L39P_3 | I/O L39N_3 | I/O L40P_3 | I/O L40N_3 VREF_3 | P | | | | | |
| GND | GND | GND | GND | VCCO_3 | I/O L31P_3 | I/O L31N_3 | I/O L32P_3 | I/O L32N_3 | GND | I/O L33N_3 | I/O L34P_3 VREF_3 | I/O L34N_3 | R | | | | | |
| GND | GND | GND | GND | VCCO_3 | I/O L27P_3 | I/O L27N_3 | I/O L28P_3 | I/O L28N_3 | I/O L33P_3 | VCCO_3 | I/O L29P_3 | I/O L29N_3 | T | | | | | |
| VCCO_4 | GND | GND | VCCINT | VCCINT | VCCO_3 | I/O L20N_3 | I/O L23P_3 VREF_3 | I/O L23N_3 | I/O L24P_3 | I/O L24N_3 | I/O L26P_3 | I/O L26N_3 | U | | | | | |
| VCCO_4 | VCCO_4 | VCCO_4 | VCCINT | VCCINT | VCCO_3 | I/O L20P_3 | I/O L16N_3 | I/O L21P_3 | I/O L21N_3 | I/O L22P_3 | I/O L22N_3 | VCCAUX | V | | | | | |
| I/O L27P_4 D1 | I/O | I/O | VCCO_4 | VCCO_4 | VCCINT | I/O L10P_3 ◆ | I/O L10N_3 ◆ | I/O L16P_3 | I/O L17P_3 VREF_3 | I/O L17N_3 | I/O L19P_3 | I/O L19N_3 | W | | | | | |
| I/O L30N_4 D2 | I/O L27N_4 DIN D0 | I/O L24N_4 | I/O VREF_4 | I/O L16N_4 | I/O L11N_4 ◆ | I/O L05P_3 ◆ | I/O L05N_3 | I/O L08P_3 ◆ | I/O L08N_3 ◆ | VCCO_3 | I/O L14P_3 | I/O L14N_3 | Y | | | | | |
| I/O L30P_4 D3 | I/O L28N_4 | I/O L24P_4 | I/O L19P_4 | I/O L16P_4 | I/O L11P_4 ◆ | I/O | I/O L01P_3 VRN_3 | I/O L01N_3 VRP_3 | I/O L07P_3 ◆ | I/O L07N_3 ◆ | I/O L09P_3 VREF_3 | I/O L09N_3 ◆ | A | | | | | |
| I/O VREF_4 | I/O L28P_4 | I/O L25N_4 | I/O L22P_4 | I/O L17N_4 ◆ | I/O L12N_4 ◆ | I/O L09N_4 | I/O L07N_4 | I/O L01N_4 VRP_4 | I/O L02P_3 | I/O L02N_3 VREF_3 | I/O L06P_3 ◆ | I/O L06N_3 ◆ | A | | | | | |
| I/O L31N_4 INIT_B | GND | I/O L25P_4 | I/O L19N_4 | I/O L17P_4 ◆ | I/O L12P_4 ◆ | I/O L09P_4 | I/O L07P_4 | I/O L01P_4 VRN_4 | GND | DONE | I/O L03P_3 | I/O L03N_3 | A | | | | | |
| I/O L31P_4 DOUT BUSY | I/O | VCCO_4 | I/O L22N_4 VREF_4 | I/O L18N_4 ◆ | I/O ◆ | VCCO_4 | I/O L08N_4 | I/O L06N_4 VREF_4 | I/O | GND | I/O VREF_4 | CCLK | A | | | | | |
| I/O L32N_4 GCLK1 | I/O L29N_4 | I/O L26N_4 ◆ | I/O L23N_4 | I/O L18P_4 ◆ | I/O L15N_4 | I/O L10N_4 | I/O L08P_4 | I/O L06P_4 | I/O L05N_4 | I/O L04N_4 | GND | VCCAUX | A | | | | | |
| I/O L32P_4 GCLK0 | I/O L29P_4 | I/O L26P_4 VREF_4 | I/O L23P_4 ◆ | VCCAUX | I/O L15P_4 | I/O L10P_4 | I/O | I/O | I/O L05P_4 | I/O L04P_4 | VCCAUX | GND | A | | | | | |
| Bank 4 | | | | | | | | | | | | | | | | | | |
| DS90C04-123-000003 | | | | | | | | | | | | | | | | | | |

Right Half of Package
(top view)

FG900: 900-lead Fine-pitch Ball Grid Array

The 900-lead fine-pitch ball grid array package, FG900, supports three different Spartan-3 devices, including the XC3S2000, the XC3S4000, and the XC3S5000. The footprints for the XC3S4000 and XC3S5000 are identical, as shown in [Table 32](#) and [Figure 14](#). The XC3S2000, however, has fewer I/O pins which consequently results in 68 unconnected pins on the FG900 package, labeled as “N.C.” In [Table 32](#) and [Figure 14](#), these unconnected pins are indicated with a black diamond symbol (◆).

All the package pins appear in [Table 32](#) and are sorted by bank number, then by pin name. Pairs of pins that form a differential I/O pair appear together in the table. The table also shows the pin number for each pin and the pin type, as defined earlier.

If there is a difference between the XC3S2000 pinout and the pinout for the XC3S4000 and XC3S5000, then that difference is highlighted in [Table 32](#). If the table entry is shaded, then there is an unconnected pin on the XC3S2000 that maps to a user-I/O pin on the XC3S4000 and XC3S5000.

Pinout Table

Table 32: FG900 Package Pinout

| Bank | XC3S2000 Pin Name | XC3S4000 XC3S5000 Pin Name | FG900 Pin Number | Type |
|------|----------------------|----------------------------------|------------------------|------|
| 0 | IO | IO | E15 | I/O |
| 0 | IO | IO | K15 | I/O |
| 0 | IO | IO | D13 | I/O |
| 0 | IO | IO | K13 | I/O |
| 0 | IO | IO | G8 | I/O |
| 0 | IO/VREF_0 | IO/VREF_0 | F9 | VREF |
| 0 | IO/VREF_0 | IO/VREF_0 | C4 | VREF |
| 0 | IO_L01N_0/ VRP_0 | IO_L01N_0/ VRP_0 | B4 | DCI |
| 0 | IO_L01P_0/ VRN_0 | IO_L01P_0/ VRN_0 | A4 | DCI |
| 0 | IO_L02N_0 | IO_L02N_0 | B5 | I/O |
| 0 | IO_L02P_0 | IO_L02P_0 | A5 | I/O |
| 0 | IO_L03N_0 | IO_L03N_0 | D5 | I/O |
| 0 | IO_L03P_0 | IO_L03P_0 | E6 | I/O |
| 0 | IO_L04N_0 | IO_L04N_0 | C6 | I/O |
| 0 | IO_L04P_0 | IO_L04P_0 | B6 | I/O |
| 0 | IO_L05N_0 | IO_L05N_0 | F6 | I/O |
| 0 | IO_L05P_0/ VREF_0 | IO_L05P_0/ VREF_0 | F7 | VREF |
| 0 | IO_L06N_0 | IO_L06N_0 | D7 | I/O |
| 0 | IO_L06P_0 | IO_L06P_0 | C7 | I/O |
| 0 | IO_L07N_0 | IO_L07N_0 | F8 | I/O |

Table 32: FG900 Package Pinout (Continued)

| Bank | XC3S2000 Pin Name | XC3S4000 XC3S5000 Pin Name | FG900 Pin Number | Type |
|------|----------------------|----------------------------------|------------------------|------|
| 0 | IO_L07P_0 | IO_L07P_0 | E8 | I/O |
| 0 | IO_L08N_0 | IO_L08N_0 | D8 | I/O |
| 0 | IO_L08P_0 | IO_L08P_0 | C8 | I/O |
| 0 | IO_L09N_0 | IO_L09N_0 | B8 | I/O |
| 0 | IO_L09P_0 | IO_L09P_0 | A8 | I/O |
| 0 | IO_L10N_0 | IO_L10N_0 | J9 | I/O |
| 0 | IO_L10P_0 | IO_L10P_0 | H9 | I/O |
| 0 | IO_L11N_0 | IO_L11N_0 | G10 | I/O |
| 0 | IO_L11P_0 | IO_L11P_0 | F10 | I/O |
| 0 | IO_L12N_0 | IO_L12N_0 | C10 | I/O |
| 0 | IO_L12P_0 | IO_L12P_0 | B10 | I/O |
| 0 | IO_L13N_0 | IO_L13N_0 | J10 | I/O |
| 0 | IO_L13P_0 | IO_L13P_0 | K11 | I/O |
| 0 | IO_L14N_0 | IO_L14N_0 | H11 | I/O |
| 0 | IO_L14P_0 | IO_L14P_0 | G11 | I/O |
| 0 | IO_L15N_0 | IO_L15N_0 | F11 | I/O |
| 0 | IO_L15P_0 | IO_L15P_0 | E11 | I/O |
| 0 | IO_L16N_0 | IO_L16N_0 | D11 | I/O |
| 0 | IO_L16P_0 | IO_L16P_0 | C11 | I/O |
| 0 | IO_L17N_0 | IO_L17N_0 | B11 | I/O |
| 0 | IO_L17P_0 | IO_L17P_0 | A11 | I/O |
| 0 | IO_L18N_0 | IO_L18N_0 | K12 | I/O |
| 0 | IO_L18P_0 | IO_L18P_0 | J12 | I/O |
| 0 | IO_L19N_0 | IO_L19N_0 | H12 | I/O |
| 0 | IO_L19P_0 | IO_L19P_0 | G12 | I/O |
| 0 | IO_L20N_0 | IO_L20N_0 | F12 | I/O |
| 0 | IO_L20P_0 | IO_L20P_0 | E12 | I/O |
| 0 | IO_L21N_0 | IO_L21N_0 | D12 | I/O |
| 0 | IO_L21P_0 | IO_L21P_0 | C12 | I/O |
| 0 | IO_L22N_0 | IO_L22N_0 | B12 | I/O |
| 0 | IO_L22P_0 | IO_L22P_0 | A12 | I/O |
| 0 | IO_L23N_0 | IO_L23N_0 | J13 | I/O |
| 0 | IO_L23P_0 | IO_L23P_0 | H13 | I/O |
| 0 | IO_L24N_0 | IO_L24N_0 | F13 | I/O |
| 0 | IO_L24P_0 | IO_L24P_0 | E13 | I/O |
| 0 | IO_L25N_0 | IO_L25N_0 | B13 | I/O |
| 0 | IO_L25P_0 | IO_L25P_0 | A13 | I/O |
| 0 | IO_L26N_0 | IO_L26N_0 | K14 | I/O |
| 0 | IO_L26P_0/ VREF_0 | IO_L26P_0/ VREF_0 | J14 | VREF |
| 0 | IO_L27N_0 | IO_L27N_0 | G14 | I/O |
| 0 | IO_L27P_0 | IO_L27P_0 | F14 | I/O |
| 0 | IO_L28N_0 | IO_L28N_0 | C14 | I/O |
| 0 | IO_L28P_0 | IO_L28P_0 | B14 | I/O |
| 0 | IO_L29N_0 | IO_L29N_0 | J15 | I/O |

Table 32: FG900 Package Pinout (Continued)

| Bank | XC3S2000 Pin Name | XC3S4000 XC3S5000 Pin Name | FG900 Pin Number | Type |
|------|----------------------|----------------------------------|------------------------|------|
| 0 | IO_L29P_0 | IO_L29P_0 | H15 | I/O |
| 0 | IO_L30N_0 | IO_L30N_0 | G15 | I/O |
| 0 | IO_L30P_0 | IO_L30P_0 | F15 | I/O |
| 0 | IO_L31N_0 | IO_L31N_0 | D15 | I/O |
| 0 | IO_L31P_0/ VREF_0 | IO_L31P_0/ VREF_0 | C15 | VREF |
| 0 | IO_L32N_0/ GCLK7 | IO_L32N_0/ GCLK7 | B15 | GCLK |
| 0 | IO_L32P_0/ GCLK6 | IO_L32P_0/ GCLK6 | A15 | GCLK |
| 0 | N.C. (◆) | IO_L35N_0 | B7 | I/O |
| 0 | N.C. (◆) | IO_L35P_0 | A7 | I/O |
| 0 | N.C. (◆) | IO_L36N_0 | G7 | I/O |
| 0 | N.C. (◆) | IO_L36P_0 | H8 | I/O |
| 0 | N.C. (◆) | IO_L37N_0 | E9 | I/O |
| 0 | N.C. (◆) | IO_L37P_0 | D9 | I/O |
| 0 | N.C. (◆) | IO_L38N_0 | B9 | I/O |
| 0 | N.C. (◆) | IO_L38P_0 | A9 | I/O |
| 0 | VCCO_0 | VCCO_0 | C5 | VCCO |
| 0 | VCCO_0 | VCCO_0 | E7 | VCCO |
| 0 | VCCO_0 | VCCO_0 | C9 | VCCO |
| 0 | VCCO_0 | VCCO_0 | G9 | VCCO |
| 0 | VCCO_0 | VCCO_0 | J11 | VCCO |
| 0 | VCCO_0 | VCCO_0 | L12 | VCCO |
| 0 | VCCO_0 | VCCO_0 | C13 | VCCO |
| 0 | VCCO_0 | VCCO_0 | G13 | VCCO |
| 0 | VCCO_0 | VCCO_0 | L13 | VCCO |
| 0 | VCCO_0 | VCCO_0 | L14 | VCCO |
| 1 | IO | IO | E25 | I/O |
| 1 | IO | IO | J21 | I/O |
| 1 | IO | IO | K20 | I/O |
| 1 | IO | IO | F18 | I/O |
| 1 | IO | IO | F16 | I/O |
| 1 | IO | IO | A16 | I/O |
| 1 | IO/VREF_1 | IO/VREF_1 | J17 | VREF |
| 1 | IO_L01N_1/ VRP_1 | IO_L01N_1/ VRP_1 | A27 | DCI |
| 1 | IO_L01P_1/ VRN_1 | IO_L01P_1/ VRN_1 | B27 | DCI |
| 1 | IO_L02N_1 | IO_L02N_1 | D26 | I/O |
| 1 | IO_L02P_1 | IO_L02P_1 | C27 | I/O |
| 1 | IO_L03N_1 | IO_L03N_1 | A26 | I/O |
| 1 | IO_L03P_1 | IO_L03P_1 | B26 | I/O |
| 1 | IO_L04N_1 | IO_L04N_1 | B25 | I/O |
| 1 | IO_L04P_1 | IO_L04P_1 | C25 | I/O |
| 1 | IO_L05N_1 | IO_L05N_1 | F24 | I/O |

Table 32: FG900 Package Pinout (Continued)

| Bank | XC3S2000 Pin Name | XC3S4000 XC3S5000 Pin Name | FG900 Pin Number | Type |
|------|----------------------|----------------------------------|------------------------|------|
| 1 | IO_L05P_1 | IO_L05P_1 | F25 | I/O |
| 1 | IO_L06N_1/ VREF_1 | IO_L06N_1/ VREF_1 | C24 | VREF |
| 1 | IO_L06P_1 | IO_L06P_1 | D24 | I/O |
| 1 | IO_L07N_1 | IO_L07N_1 | A24 | I/O |
| 1 | IO_L07P_1 | IO_L07P_1 | B24 | I/O |
| 1 | IO_L08N_1 | IO_L08N_1 | H23 | I/O |
| 1 | IO_L08P_1 | IO_L08P_1 | G24 | I/O |
| 1 | IO_L09N_1 | IO_L09N_1 | F23 | I/O |
| 1 | IO_L09P_1 | IO_L09P_1 | G23 | I/O |
| 1 | IO_L10N_1/ VREF_1 | IO_L10N_1/ VREF_1 | C23 | VREF |
| 1 | IO_L10P_1 | IO_L10P_1 | D23 | I/O |
| 1 | IO_L11N_1 | IO_L11N_1 | A23 | I/O |
| 1 | IO_L11P_1 | IO_L11P_1 | B23 | I/O |
| 1 | IO_L12N_1 | IO_L12N_1 | H22 | I/O |
| 1 | IO_L12P_1 | IO_L12P_1 | J22 | I/O |
| 1 | IO_L13N_1 | IO_L13N_1 | F22 | I/O |
| 1 | IO_L13P_1 | IO_L13P_1 | E23 | I/O |
| 1 | IO_L14N_1 | IO_L14N_1 | D22 | I/O |
| 1 | IO_L14P_1 | IO_L14P_1 | E22 | I/O |
| 1 | IO_L15N_1 | IO_L15N_1 | A22 | I/O |
| 1 | IO_L15P_1 | IO_L15P_1 | B22 | I/O |
| 1 | IO_L16N_1 | IO_L16N_1 | F21 | I/O |
| 1 | IO_L16P_1 | IO_L16P_1 | G21 | I/O |
| 1 | IO_L17N_1/ VREF_1 | IO_L17N_1/ VREF_1 | B21 | VREF |
| 1 | IO_L17P_1 | IO_L17P_1 | C21 | I/O |
| 1 | IO_L18N_1 | IO_L18N_1 | G20 | I/O |
| 1 | IO_L18P_1 | IO_L18P_1 | H20 | I/O |
| 1 | IO_L19N_1 | IO_L19N_1 | E20 | I/O |
| 1 | IO_L19P_1 | IO_L19P_1 | F20 | I/O |
| 1 | IO_L20N_1 | IO_L20N_1 | C20 | I/O |
| 1 | IO_L20P_1 | IO_L20P_1 | D20 | I/O |
| 1 | IO_L21N_1 | IO_L21N_1 | A20 | I/O |
| 1 | IO_L21P_1 | IO_L21P_1 | B20 | I/O |
| 1 | IO_L22N_1 | IO_L22N_1 | J19 | I/O |
| 1 | IO_L22P_1 | IO_L22P_1 | K19 | I/O |
| 1 | IO_L23N_1 | IO_L23N_1 | G19 | I/O |
| 1 | IO_L23P_1 | IO_L23P_1 | H19 | I/O |
| 1 | IO_L24N_1 | IO_L24N_1 | E19 | I/O |
| 1 | IO_L24P_1 | IO_L24P_1 | F19 | I/O |
| 1 | IO_L25N_1 | IO_L25N_1 | C19 | I/O |
| 1 | IO_L25P_1 | IO_L25P_1 | D19 | I/O |
| 1 | IO_L26N_1 | IO_L26N_1 | A19 | I/O |

Table 32: FG900 Package Pinout (Continued)

| Bank | XC3S2000 Pin Name | XC3S4000 XC3S5000 Pin Name | FG900 Pin Number | Type |
|------|----------------------|----------------------------------|------------------------|------|
| 1 | IO_L26P_1 | IO_L26P_1 | B19 | I/O |
| 1 | IO_L27N_1 | IO_L27N_1 | F17 | I/O |
| 1 | IO_L27P_1 | IO_L27P_1 | G17 | I/O |
| 1 | IO_L28N_1 | IO_L28N_1 | B17 | I/O |
| 1 | IO_L28P_1 | IO_L28P_1 | C17 | I/O |
| 1 | IO_L29N_1 | IO_L29N_1 | J16 | I/O |
| 1 | IO_L29P_1 | IO_L29P_1 | K16 | I/O |
| 1 | IO_L30N_1 | IO_L30N_1 | G16 | I/O |
| 1 | IO_L30P_1 | IO_L30P_1 | H16 | I/O |
| 1 | IO_L31N_1/ VREF_1 | IO_L31N_1/ VREF_1 | D16 | VREF |
| 1 | IO_L31P_1 | IO_L31P_1 | E16 | I/O |
| 1 | IO_L32N_1/ GCLK5 | IO_L32N_1/ GCLK5 | B16 | GCLK |
| 1 | IO_L32P_1/ GCLK4 | IO_L32P_1/ GCLK4 | C16 | GCLK |
| 1 | N.C. (◆) | IO_L37N_1 | H18 | I/O |
| 1 | N.C. (◆) | IO_L37P_1 | J18 | I/O |
| 1 | N.C. (◆) | IO_L38N_1 | D18 | I/O |
| 1 | N.C. (◆) | IO_L38P_1 | E18 | I/O |
| 1 | N.C. (◆) | IO_L39N_1 | A18 | I/O |
| 1 | N.C. (◆) | IO_L39P_1 | B18 | I/O |
| 1 | N.C. (◆) | IO_L40N_1 | K17 | I/O |
| 1 | N.C. (◆) | IO_L40P_1 | K18 | I/O |
| 1 | VCCO_1 | VCCO_1 | L17 | VCCO |
| 1 | VCCO_1 | VCCO_1 | C18 | VCCO |
| 1 | VCCO_1 | VCCO_1 | G18 | VCCO |
| 1 | VCCO_1 | VCCO_1 | L18 | VCCO |
| 1 | VCCO_1 | VCCO_1 | L19 | VCCO |
| 1 | VCCO_1 | VCCO_1 | J20 | VCCO |
| 1 | VCCO_1 | VCCO_1 | C22 | VCCO |
| 1 | VCCO_1 | VCCO_1 | G22 | VCCO |
| 1 | VCCO_1 | VCCO_1 | E24 | VCCO |
| 1 | VCCO_1 | VCCO_1 | C26 | VCCO |
| 2 | IO | IO | J25 | I/O |
| 2 | IO_L01N_2/ VRP_2 | IO_L01N_2/ VRP_2 | C29 | DCI |
| 2 | IO_L01P_2/ VRN_2 | IO_L01P_2/ VRN_2 | C30 | DCI |
| 2 | IO_L02N_2 | IO_L02N_2 | D27 | I/O |
| 2 | IO_L02P_2 | IO_L02P_2 | D28 | I/O |
| 2 | IO_L03N_2/ VREF_2 | IO_L03N_2/ VREF_2 | D29 | VREF |
| 2 | IO_L03P_2 | IO_L03P_2 | D30 | I/O |
| 2 | IO_L04N_2 | IO_L04N_2 | E29 | I/O |
| 2 | IO_L04P_2 | IO_L04P_2 | E30 | I/O |

Table 32: FG900 Package Pinout (Continued)

| Bank | XC3S2000 Pin Name | XC3S4000 XC3S5000 Pin Name | FG900 Pin Number | Type |
|------|----------------------|----------------------------------|------------------------|------|
| 2 | IO_L05N_2 | IO_L05N_2 | F28 | I/O |
| 2 | IO_L05P_2 | IO_L05P_2 | F29 | I/O |
| 2 | IO_L06N_2 | IO_L06N_2 | G27 | I/O |
| 2 | IO_L06P_2 | IO_L06P_2 | G28 | I/O |
| 2 | IO_L07N_2 | IO_L07N_2 | G29 | I/O |
| 2 | IO_L07P_2 | IO_L07P_2 | G30 | I/O |
| 2 | IO_L08N_2 | IO_L08N_2 | G25 | I/O |
| 2 | IO_L08P_2 | IO_L08P_2 | H24 | I/O |
| 2 | IO_L09N_2/ VREF_2 | IO_L09N_2/ VREF_2 | H25 | VREF |
| 2 | IO_L09P_2 | IO_L09P_2 | H26 | I/O |
| 2 | IO_L10N_2 | IO_L10N_2 | H27 | I/O |
| 2 | IO_L10P_2 | IO_L10P_2 | H28 | I/O |
| 2 | IO_L12N_2 | IO_L12N_2 | H29 | I/O |
| 2 | IO_L12P_2 | IO_L12P_2 | H30 | I/O |
| 2 | IO_L13N_2 | IO_L13N_2 | J26 | I/O |
| 2 | IO_L13P_2/ VREF_2 | IO_L13P_2/ VREF_2 | J27 | VREF |
| 2 | IO_L14N_2 | IO_L14N_2 | J29 | I/O |
| 2 | IO_L14P_2 | IO_L14P_2 | J30 | I/O |
| 2 | IO_L15N_2 | IO_L15N_2 | J23 | I/O |
| 2 | IO_L15P_2 | IO_L15P_2 | K22 | I/O |
| 2 | IO_L16N_2 | IO_L16N_2 | K24 | I/O |
| 2 | IO_L16P_2 | IO_L16P_2 | K25 | I/O |
| 2 | IO_L19N_2 | IO_L19N_2 | L25 | I/O |
| 2 | IO_L19P_2 | IO_L19P_2 | L26 | I/O |
| 2 | IO_L20N_2 | IO_L20N_2 | L27 | I/O |
| 2 | IO_L20P_2 | IO_L20P_2 | L28 | I/O |
| 2 | IO_L21N_2 | IO_L21N_2 | L29 | I/O |
| 2 | IO_L21P_2 | IO_L21P_2 | L30 | I/O |
| 2 | IO_L22N_2 | IO_L22N_2 | M22 | I/O |
| 2 | IO_L22P_2 | IO_L22P_2 | M23 | I/O |
| 2 | IO_L23N_2/ VREF_2 | IO_L23N_2/ VREF_2 | M24 | VREF |
| 2 | IO_L23P_2 | IO_L23P_2 | M25 | I/O |
| 2 | IO_L24N_2 | IO_L24N_2 | M27 | I/O |
| 2 | IO_L24P_2 | IO_L24P_2 | M28 | I/O |
| 2 | IO_L26N_2 | IO_L26N_2 | M21 | I/O |
| 2 | IO_L26P_2 | IO_L26P_2 | N21 | I/O |
| 2 | IO_L27N_2 | IO_L27N_2 | N22 | I/O |
| 2 | IO_L27P_2 | IO_L27P_2 | N23 | I/O |
| 2 | IO_L28N_2 | IO_L28N_2 | M26 | I/O |
| 2 | IO_L28P_2 | IO_L28P_2 | N25 | I/O |
| 2 | IO_L29N_2 | IO_L29N_2 | N26 | I/O |
| 2 | IO_L29P_2 | IO_L29P_2 | N27 | I/O |

Table 32: FG900 Package Pinout (Continued)

| Bank | XC3S2000 Pin Name | XC3S4000 XC3S5000 Pin Name | FG900 Pin Number | Type |
|------|----------------------|----------------------------------|------------------------|------|
| 2 | IO_L31N_2 | IO_L31N_2 | N29 | I/O |
| 2 | IO_L31P_2 | IO_L31P_2 | N30 | I/O |
| 2 | IO_L32N_2 | IO_L32N_2 | P21 | I/O |
| 2 | IO_L32P_2 | IO_L32P_2 | P22 | I/O |
| 2 | IO_L33N_2 | IO_L33N_2 | P24 | I/O |
| 2 | IO_L33P_2 | IO_L33P_2 | P25 | I/O |
| 2 | IO_L34N_2/ VREF_2 | IO_L34N_2/ VREF_2 | P28 | VREF |
| 2 | IO_L34P_2 | IO_L34P_2 | P29 | I/O |
| 2 | IO_L35N_2 | IO_L35N_2 | R21 | I/O |
| 2 | IO_L35P_2 | IO_L35P_2 | R22 | I/O |
| 2 | IO_L37N_2 | IO_L37N_2 | R23 | I/O |
| 2 | IO_L37P_2 | IO_L37P_2 | R24 | I/O |
| 2 | IO_L38N_2 | IO_L38N_2 | R25 | I/O |
| 2 | IO_L38P_2 | IO_L38P_2 | R26 | I/O |
| 2 | IO_L39N_2 | IO_L39N_2 | R27 | I/O |
| 2 | IO_L39P_2 | IO_L39P_2 | R28 | I/O |
| 2 | IO_L40N_2 | IO_L40N_2 | R29 | I/O |
| 2 | IO_L40P_2/ VREF_2 | IO_L40P_2/ VREF_2 | R30 | VREF |
| 2 | N.C. (◆) | IO_L41N_2 | E27 | I/O |
| 2 | N.C. (◆) | IO_L41P_2 | F26 | I/O |
| 2 | N.C. (◆) | IO_L45N_2 | K28 | I/O |
| 2 | N.C. (◆) | IO_L45P_2 | K29 | I/O |
| 2 | N.C. (◆) | IO_L46N_2 | K21 | I/O |
| 2 | N.C. (◆) | IO_L46P_2 | L21 | I/O |
| 2 | N.C. (◆) | IO_L47N_2 | L23 | I/O |
| 2 | N.C. (◆) | IO_L47P_2 | L24 | I/O |
| 2 | N.C. (◆) | IO_L50N_2 | M29 | I/O |
| 2 | N.C. (◆) | IO_L50P_2 | M30 | I/O |
| 2 | VCCO_2 | VCCO_2 | M20 | VCCO |
| 2 | VCCO_2 | VCCO_2 | N20 | VCCO |
| 2 | VCCO_2 | VCCO_2 | P20 | VCCO |
| 2 | VCCO_2 | VCCO_2 | L22 | VCCO |
| 2 | VCCO_2 | VCCO_2 | J24 | VCCO |
| 2 | VCCO_2 | VCCO_2 | N24 | VCCO |
| 2 | VCCO_2 | VCCO_2 | G26 | VCCO |
| 2 | VCCO_2 | VCCO_2 | E28 | VCCO |
| 2 | VCCO_2 | VCCO_2 | J28 | VCCO |
| 2 | VCCO_2 | VCCO_2 | N28 | VCCO |
| 3 | IO | IO | AB25 | I/O |
| 3 | IO_L01N_3/ VRP_3 | IO_L01N_3/ VRP_3 | AH30 | DCI |
| 3 | IO_L01P_3/ VRN_3 | IO_L01P_3/ VRN_3 | AH29 | DCI |

Table 32: FG900 Package Pinout (Continued)

| Bank | XC3S2000 Pin Name | XC3S4000 XC3S5000 Pin Name | FG900 Pin Number | Type |
|------|----------------------|----------------------------------|------------------------|------|
| 3 | IO_L02N_3/ VREF_3 | IO_L02N_3/ VREF_3 | AG28 | VREF |
| 3 | IO_L02P_3 | IO_L02P_3 | AG27 | I/O |
| 3 | IO_L03N_3 | IO_L03N_3 | AG30 | I/O |
| 3 | IO_L03P_3 | IO_L03P_3 | AG29 | I/O |
| 3 | IO_L04N_3 | IO_L04N_3 | AF30 | I/O |
| 3 | IO_L04P_3 | IO_L04P_3 | AF29 | I/O |
| 3 | IO_L05N_3 | IO_L05N_3 | AE26 | I/O |
| 3 | IO_L05P_3 | IO_L05P_3 | AF27 | I/O |
| 3 | IO_L06N_3 | IO_L06N_3 | AE29 | I/O |
| 3 | IO_L06P_3 | IO_L06P_3 | AE28 | I/O |
| 3 | IO_L07N_3 | IO_L07N_3 | AD28 | I/O |
| 3 | IO_L07P_3 | IO_L07P_3 | AD27 | I/O |
| 3 | IO_L08N_3 | IO_L08N_3 | AD30 | I/O |
| 3 | IO_L08P_3 | IO_L08P_3 | AD29 | I/O |
| 3 | IO_L09N_3 | IO_L09N_3 | AC24 | I/O |
| 3 | IO_L09P_3/ VREF_3 | IO_L09P_3/ VREF_3 | AD25 | VREF |
| 3 | IO_L10N_3 | IO_L10N_3 | AC26 | I/O |
| 3 | IO_L10P_3 | IO_L10P_3 | AC25 | I/O |
| 3 | IO_L11N_3 | IO_L11N_3 | AC28 | I/O |
| 3 | IO_L11P_3 | IO_L11P_3 | AC27 | I/O |
| 3 | IO_L13N_3/ VREF_3 | IO_L13N_3/ VREF_3 | AC30 | VREF |
| 3 | IO_L13P_3 | IO_L13P_3 | AC29 | I/O |
| 3 | IO_L14N_3 | IO_L14N_3 | AB27 | I/O |
| 3 | IO_L14P_3 | IO_L14P_3 | AB26 | I/O |
| 3 | IO_L15N_3 | IO_L15N_3 | AB30 | I/O |
| 3 | IO_L15P_3 | IO_L15P_3 | AB29 | I/O |
| 3 | IO_L16N_3 | IO_L16N_3 | AA22 | I/O |
| 3 | IO_L16P_3 | IO_L16P_3 | AB23 | I/O |
| 3 | IO_L17N_3 | IO_L17N_3 | AA25 | I/O |
| 3 | IO_L17P_3/ VREF_3 | IO_L17P_3/ VREF_3 | AA24 | VREF |
| 3 | IO_L19N_3 | IO_L19N_3 | AA29 | I/O |
| 3 | IO_L19P_3 | IO_L19P_3 | AA28 | I/O |
| 3 | IO_L20N_3 | IO_L20N_3 | Y21 | I/O |
| 3 | IO_L20P_3 | IO_L20P_3 | AA21 | I/O |
| 3 | IO_L21N_3 | IO_L21N_3 | Y24 | I/O |
| 3 | IO_L21P_3 | IO_L21P_3 | Y23 | I/O |
| 3 | IO_L22N_3 | IO_L22N_3 | Y26 | I/O |
| 3 | IO_L22P_3 | IO_L22P_3 | Y25 | I/O |
| 3 | IO_L23N_3 | IO_L23N_3 | Y28 | I/O |
| 3 | IO_L23P_3/ VREF_3 | IO_L23P_3/ VREF_3 | Y27 | VREF |
| 3 | IO_L24N_3 | IO_L24N_3 | Y30 | I/O |

Table 32: FG900 Package Pinout (Continued)

| Bank | XC3S2000 Pin Name | XC3S4000 XC3S5000 Pin Name | FG900 Pin Number | Type |
|------|----------------------|----------------------------------|------------------------|------|
| 3 | IO_L24P_3 | IO_L24P_3 | Y29 | I/O |
| 3 | IO_L26N_3 | IO_L26N_3 | W30 | I/O |
| 3 | IO_L26P_3 | IO_L26P_3 | W29 | I/O |
| 3 | IO_L27N_3 | IO_L27N_3 | V21 | I/O |
| 3 | IO_L27P_3 | IO_L27P_3 | W21 | I/O |
| 3 | IO_L28N_3 | IO_L28N_3 | V23 | I/O |
| 3 | IO_L28P_3 | IO_L28P_3 | V22 | I/O |
| 3 | IO_L29N_3 | IO_L29N_3 | V25 | I/O |
| 3 | IO_L29P_3 | IO_L29P_3 | W26 | I/O |
| 3 | IO_L31N_3 | IO_L31N_3 | V30 | I/O |
| 3 | IO_L31P_3 | IO_L31P_3 | V29 | I/O |
| 3 | IO_L32N_3 | IO_L32N_3 | U22 | I/O |
| 3 | IO_L32P_3 | IO_L32P_3 | U21 | I/O |
| 3 | IO_L33N_3 | IO_L33N_3 | U25 | I/O |
| 3 | IO_L33P_3 | IO_L33P_3 | U24 | I/O |
| 3 | IO_L34N_3 | IO_L34N_3 | U29 | I/O |
| 3 | IO_L34P_3/ VREF_3 | IO_L34P_3/ VREF_3 | U28 | VREF |
| 3 | IO_L35N_3 | IO_L35N_3 | T22 | I/O |
| 3 | IO_L35P_3 | IO_L35P_3 | T21 | I/O |
| 3 | IO_L37N_3 | IO_L37N_3 | T24 | I/O |
| 3 | IO_L37P_3 | IO_L37P_3 | T23 | I/O |
| 3 | IO_L38N_3 | IO_L38N_3 | T26 | I/O |
| 3 | IO_L38P_3 | IO_L38P_3 | T25 | I/O |
| 3 | IO_L39N_3 | IO_L39N_3 | T28 | I/O |
| 3 | IO_L39P_3 | IO_L39P_3 | T27 | I/O |
| 3 | IO_L40N_3/ VREF_3 | IO_L40N_3/ VREF_3 | T30 | VREF |
| 3 | IO_L40P_3 | IO_L40P_3 | T29 | I/O |
| 3 | N.C. (◆) | IO_L46N_3 | W23 | I/O |
| 3 | N.C. (◆) | IO_L46P_3 | W22 | I/O |
| 3 | N.C. (◆) | IO_L47N_3 | W25 | I/O |
| 3 | N.C. (◆) | IO_L47P_3 | W24 | I/O |
| 3 | N.C. (◆) | IO_L48N_3 | W28 | I/O |
| 3 | N.C. (◆) | IO_L48P_3 | W27 | I/O |
| 3 | N.C. (◆) | IO_L50N_3 | V27 | I/O |
| 3 | N.C. (◆) | IO_L50P_3 | V26 | I/O |
| 3 | VCCO_3 | VCCO_3 | U20 | VCCO |
| 3 | VCCO_3 | VCCO_3 | V20 | VCCO |
| 3 | VCCO_3 | VCCO_3 | W20 | VCCO |
| 3 | VCCO_3 | VCCO_3 | Y22 | VCCO |
| 3 | VCCO_3 | VCCO_3 | V24 | VCCO |
| 3 | VCCO_3 | VCCO_3 | AB24 | VCCO |
| 3 | VCCO_3 | VCCO_3 | AD26 | VCCO |
| 3 | VCCO_3 | VCCO_3 | V28 | VCCO |

Table 32: FG900 Package Pinout (Continued)

| Bank | XC3S2000 Pin Name | XC3S4000 XC3S5000 Pin Name | FG900 Pin Number | Type |
|------|----------------------|----------------------------------|------------------------|------|
| 3 | VCCO_3 | VCCO_3 | AB28 | VCCO |
| 3 | VCCO_3 | VCCO_3 | AF28 | VCCO |
| 4 | IO | IO | AA16 | I/O |
| 4 | IO | IO | AG18 | I/O |
| 4 | IO | IO | AA18 | I/O |
| 4 | IO | IO | AE22 | I/O |
| 4 | IO | IO | AD23 | I/O |
| 4 | IO | IO | AH27 | I/O |
| 4 | IO/VREF_4 | IO/VREF_4 | AF16 | VREF |
| 4 | IO/VREF_4 | IO/VREF_4 | AK28 | VREF |
| 4 | IO_L01N_4/ VRP_4 | IO_L01N_4/ VRP_4 | AJ27 | DCI |
| 4 | IO_L01P_4/ VRN_4 | IO_L01P_4/ VRN_4 | AK27 | DCI |
| 4 | IO_L02N_4 | IO_L02N_4 | AJ26 | I/O |
| 4 | IO_L02P_4 | IO_L02P_4 | AK26 | I/O |
| 4 | IO_L03N_4 | IO_L03N_4 | AG26 | I/O |
| 4 | IO_L03P_4 | IO_L03P_4 | AF25 | I/O |
| 4 | IO_L04N_4 | IO_L04N_4 | AD24 | I/O |
| 4 | IO_L04P_4 | IO_L04P_4 | AC23 | I/O |
| 4 | IO_L05N_4 | IO_L05N_4 | AE23 | I/O |
| 4 | IO_L05P_4 | IO_L05P_4 | AF23 | I/O |
| 4 | IO_L06N_4/ VREF_4 | IO_L06N_4/ VREF_4 | AG23 | VREF |
| 4 | IO_L06P_4 | IO_L06P_4 | AH23 | I/O |
| 4 | IO_L07N_4 | IO_L07N_4 | AJ23 | I/O |
| 4 | IO_L07P_4 | IO_L07P_4 | AK23 | I/O |
| 4 | IO_L08N_4 | IO_L08N_4 | AB22 | I/O |
| 4 | IO_L08P_4 | IO_L08P_4 | AC22 | I/O |
| 4 | IO_L09N_4 | IO_L09N_4 | AF22 | I/O |
| 4 | IO_L09P_4 | IO_L09P_4 | AG22 | I/O |
| 4 | IO_L10N_4 | IO_L10N_4 | AJ22 | I/O |
| 4 | IO_L10P_4 | IO_L10P_4 | AK22 | I/O |
| 4 | IO_L11N_4 | IO_L11N_4 | AD21 | I/O |
| 4 | IO_L11P_4 | IO_L11P_4 | AE21 | I/O |
| 4 | IO_L12N_4 | IO_L12N_4 | AH21 | I/O |
| 4 | IO_L12P_4 | IO_L12P_4 | AJ21 | I/O |
| 4 | IO_L13N_4 | IO_L13N_4 | AB21 | I/O |
| 4 | IO_L13P_4 | IO_L13P_4 | AA20 | I/O |
| 4 | IO_L14N_4 | IO_L14N_4 | AC20 | I/O |
| 4 | IO_L14P_4 | IO_L14P_4 | AD20 | I/O |
| 4 | IO_L15N_4 | IO_L15N_4 | AE20 | I/O |
| 4 | IO_L15P_4 | IO_L15P_4 | AF20 | I/O |
| 4 | IO_L16N_4 | IO_L16N_4 | AG20 | I/O |
| 4 | IO_L16P_4 | IO_L16P_4 | AH20 | I/O |

Table 32: FG900 Package Pinout (Continued)

| Bank | XC3S2000 Pin Name | XC3S4000 XC3S5000 Pin Name | FG900 Pin Number | Type |
|------|-------------------------|----------------------------------|------------------------|------|
| 4 | IO_L17N_4 | IO_L17N_4 | AJ20 | I/O |
| 4 | IO_L17P_4 | IO_L17P_4 | AK20 | I/O |
| 4 | IO_L18N_4 | IO_L18N_4 | AA19 | I/O |
| 4 | IO_L18P_4 | IO_L18P_4 | AB19 | I/O |
| 4 | IO_L19N_4 | IO_L19N_4 | AC19 | I/O |
| 4 | IO_L19P_4 | IO_L19P_4 | AD19 | I/O |
| 4 | IO_L20N_4 | IO_L20N_4 | AE19 | I/O |
| 4 | IO_L20P_4 | IO_L20P_4 | AF19 | I/O |
| 4 | IO_L21N_4 | IO_L21N_4 | AG19 | I/O |
| 4 | IO_L21P_4 | IO_L21P_4 | AH19 | I/O |
| 4 | IO_L22N_4/ VREF_4 | IO_L22N_4/ VREF_4 | AJ19 | VREF |
| 4 | IO_L22P_4 | IO_L22P_4 | AK19 | I/O |
| 4 | IO_L23N_4 | IO_L23N_4 | AB18 | I/O |
| 4 | IO_L23P_4 | IO_L23P_4 | AC18 | I/O |
| 4 | IO_L24N_4 | IO_L24N_4 | AE18 | I/O |
| 4 | IO_L24P_4 | IO_L24P_4 | AF18 | I/O |
| 4 | IO_L25N_4 | IO_L25N_4 | AJ18 | I/O |
| 4 | IO_L25P_4 | IO_L25P_4 | AK18 | I/O |
| 4 | IO_L26N_4 | IO_L26N_4 | AA17 | I/O |
| 4 | IO_L26P_4/ VREF_4 | IO_L26P_4/ VREF_4 | AB17 | VREF |
| 4 | IO_L27N_4/ DIN/D0 | IO_L27N_4/ DIN/D0 | AD17 | DUAL |
| 4 | IO_L27P_4/ D1 | IO_L27P_4/ D1 | AE17 | DUAL |
| 4 | IO_L28N_4 | IO_L28N_4 | AH17 | I/O |
| 4 | IO_L28P_4 | IO_L28P_4 | AJ17 | I/O |
| 4 | IO_L29N_4 | IO_L29N_4 | AB16 | I/O |
| 4 | IO_L29P_4 | IO_L29P_4 | AC16 | I/O |
| 4 | IO_L30N_4/ D2 | IO_L30N_4/ D2 | AD16 | DUAL |
| 4 | IO_L30P_4/ D3 | IO_L30P_4/ D3 | AE16 | DUAL |
| 4 | IO_L31N_4/ INIT_B | IO_L31N_4/ INIT_B | AG16 | DUAL |
| 4 | IO_L31P_4/ DOUT/BUSY | IO_L31P_4/ DOUT/BUSY | AH16 | DUAL |
| 4 | IO_L32N_4/ GCLK1 | IO_L32N_4/ GCLK1 | AJ16 | GCLK |
| 4 | IO_L32P_4/ GCLK0 | IO_L32P_4/ GCLK0 | AK16 | GCLK |
| 4 | N.C. (◆) | IO_L33N_4 | AH25 | I/O |
| 4 | N.C. (◆) | IO_L33P_4 | AJ25 | I/O |
| 4 | N.C. (◆) | IO_L34N_4 | AE25 | I/O |
| 4 | N.C. (◆) | IO_L34P_4 | AE24 | I/O |
| 4 | N.C. (◆) | IO_L35N_4 | AG24 | I/O |

Table 32: FG900 Package Pinout (Continued)

| Bank | XC3S2000 Pin Name | XC3S4000 XC3S5000 Pin Name | FG900 Pin Number | Type |
|------|----------------------|----------------------------------|------------------------|------|
| 4 | N.C. (◆) | IO_L35P_4 | AH24 | I/O |
| 4 | N.C. (◆) | IO_L38N_4 | AJ24 | I/O |
| 4 | N.C. (◆) | IO_L38P_4 | AK24 | I/O |
| 4 | VCCO_4 | VCCO_4 | Y17 | VCCO |
| 4 | VCCO_4 | VCCO_4 | Y18 | VCCO |
| 4 | VCCO_4 | VCCO_4 | AD18 | VCCO |
| 4 | VCCO_4 | VCCO_4 | AH18 | VCCO |
| 4 | VCCO_4 | VCCO_4 | Y19 | VCCO |
| 4 | VCCO_4 | VCCO_4 | AB20 | VCCO |
| 4 | VCCO_4 | VCCO_4 | AD22 | VCCO |
| 4 | VCCO_4 | VCCO_4 | AH22 | VCCO |
| 4 | VCCO_4 | VCCO_4 | AF24 | VCCO |
| 4 | VCCO_4 | VCCO_4 | AH26 | VCCO |
| 5 | IO | IO | AE6 | I/O |
| 5 | IO | IO | AB10 | I/O |
| 5 | IO | IO | AA11 | I/O |
| 5 | IO | IO | AA15 | I/O |
| 5 | IO | IO | AE15 | I/O |
| 5 | IO/VREF_5 | IO/VREF_5 | AH4 | VREF |
| 5 | IO/VREF_5 | IO/VREF_5 | AK15 | VREF |
| 5 | IO_L01N_5/ RDWR_B | IO_L01N_5/ RDWR_B | AK4 | DUAL |
| 5 | IO_L01P_5/ CS_B | IO_L01P_5/ CS_B | AJ4 | DUAL |
| 5 | IO_L02N_5 | IO_L02N_5 | AK5 | I/O |
| 5 | IO_L02P_5 | IO_L02P_5 | AJ5 | I/O |
| 5 | IO_L03N_5 | IO_L03N_5 | AF6 | I/O |
| 5 | IO_L03P_5 | IO_L03P_5 | AG5 | I/O |
| 5 | IO_L04N_5 | IO_L04N_5 | AJ6 | I/O |
| 5 | IO_L04P_5 | IO_L04P_5 | AH6 | I/O |
| 5 | IO_L05N_5 | IO_L05N_5 | AE7 | I/O |
| 5 | IO_L05P_5 | IO_L05P_5 | AD7 | I/O |
| 5 | IO_L06N_5 | IO_L06N_5 | AH7 | I/O |
| 5 | IO_L06P_5 | IO_L06P_5 | AG7 | I/O |
| 5 | IO_L07N_5 | IO_L07N_5 | AK8 | I/O |
| 5 | IO_L07P_5 | IO_L07P_5 | AJ8 | I/O |
| 5 | IO_L08N_5 | IO_L08N_5 | AC9 | I/O |
| 5 | IO_L08P_5 | IO_L08P_5 | AB9 | I/O |
| 5 | IO_L09N_5 | IO_L09N_5 | AG9 | I/O |
| 5 | IO_L09P_5 | IO_L09P_5 | AF9 | I/O |
| 5 | IO_L10N_5/ VRP_5 | IO_L10N_5/ VRP_5 | AK9 | DCI |
| 5 | IO_L10P_5/ VRN_5 | IO_L10P_5/ VRN_5 | AJ9 | DCI |
| 5 | IO_L11N_5/ VREF_5 | IO_L11N_5/ VREF_5 | AE10 | VREF |

Table 32: FG900 Package Pinout (Continued)

| Bank | XC3S2000 Pin Name | XC3S4000 XC3S5000 Pin Name | FG900 Pin Number | Type |
|------|----------------------|----------------------------------|------------------------|------|
| 5 | IO_L11P_5 | IO_L11P_5 | AE9 | I/O |
| 5 | IO_L12N_5 | IO_L12N_5 | AJ10 | I/O |
| 5 | IO_L12P_5 | IO_L12P_5 | AH10 | I/O |
| 5 | IO_L13N_5 | IO_L13N_5 | AD11 | I/O |
| 5 | IO_L13P_5 | IO_L13P_5 | AD10 | I/O |
| 5 | IO_L14N_5 | IO_L14N_5 | AF11 | I/O |
| 5 | IO_L14P_5 | IO_L14P_5 | AE11 | I/O |
| 5 | IO_L15N_5 | IO_L15N_5 | AH11 | I/O |
| 5 | IO_L15P_5 | IO_L15P_5 | AG11 | I/O |
| 5 | IO_L16N_5 | IO_L16N_5 | AK11 | I/O |
| 5 | IO_L16P_5 | IO_L16P_5 | AJ11 | I/O |
| 5 | IO_L17N_5 | IO_L17N_5 | AB12 | I/O |
| 5 | IO_L17P_5 | IO_L17P_5 | AC11 | I/O |
| 5 | IO_L18N_5 | IO_L18N_5 | AD12 | I/O |
| 5 | IO_L18P_5 | IO_L18P_5 | AC12 | I/O |
| 5 | IO_L19N_5 | IO_L19N_5 | AF12 | I/O |
| 5 | IO_L19P_5/ VREF_5 | IO_L19P_5/ VREF_5 | AE12 | VREF |
| 5 | IO_L20N_5 | IO_L20N_5 | AH12 | I/O |
| 5 | IO_L20P_5 | IO_L20P_5 | AG12 | I/O |
| 5 | IO_L21N_5 | IO_L21N_5 | AK12 | I/O |
| 5 | IO_L21P_5 | IO_L21P_5 | AJ12 | I/O |
| 5 | IO_L22N_5 | IO_L22N_5 | AA13 | I/O |
| 5 | IO_L22P_5 | IO_L22P_5 | AA12 | I/O |
| 5 | IO_L23N_5 | IO_L23N_5 | AC13 | I/O |
| 5 | IO_L23P_5 | IO_L23P_5 | AB13 | I/O |
| 5 | IO_L24N_5 | IO_L24N_5 | AG13 | I/O |
| 5 | IO_L24P_5 | IO_L24P_5 | AF13 | I/O |
| 5 | IO_L25N_5 | IO_L25N_5 | AK13 | I/O |
| 5 | IO_L25P_5 | IO_L25P_5 | AJ13 | I/O |
| 5 | IO_L26N_5 | IO_L26N_5 | AB14 | I/O |
| 5 | IO_L26P_5 | IO_L26P_5 | AA14 | I/O |
| 5 | IO_L27N_5/ VREF_5 | IO_L27N_5/ VREF_5 | AE14 | VREF |
| 5 | IO_L27P_5 | IO_L27P_5 | AE13 | I/O |
| 5 | IO_L28N_5/ D6 | IO_L28N_5/ D6 | AJ14 | DUAL |
| 5 | IO_L28P_5/ D7 | IO_L28P_5/ D7 | AH14 | DUAL |
| 5 | IO_L29N_5 | IO_L29N_5 | AC15 | I/O |
| 5 | IO_L29P_5/ VREF_5 | IO_L29P_5/ VREF_5 | AB15 | VREF |
| 5 | IO_L30N_5 | IO_L30N_5 | AD15 | I/O |
| 5 | IO_L30P_5 | IO_L30P_5 | AD14 | I/O |
| 5 | IO_L31N_5/ D4 | IO_L31N_5/ D4 | AG15 | DUAL |

Table 32: FG900 Package Pinout (Continued)

| Bank | XC3S2000 Pin Name | XC3S4000 XC3S5000 Pin Name | FG900 Pin Number | Type |
|------|----------------------|----------------------------------|------------------------|------|
| 5 | IO_L31P_5/ D5 | IO_L31P_5/ D5 | AF15 | DUAL |
| 5 | IO_L32N_5/ GCLK3 | IO_L32N_5/ GCLK3 | AJ15 | GCLK |
| 5 | IO_L32P_5/ GCLK2 | IO_L32P_5/ GCLK2 | AH15 | GCLK |
| 5 | N.C. (◆) | IO_L35N_5 | AK7 | I/O |
| 5 | N.C. (◆) | IO_L35P_5 | AJ7 | I/O |
| 5 | N.C. (◆) | IO_L36N_5 | AD8 | I/O |
| 5 | N.C. (◆) | IO_L36P_5 | AC8 | I/O |
| 5 | N.C. (◆) | IO_L37N_5 | AF8 | I/O |
| 5 | N.C. (◆) | IO_L37P_5 | AE8 | I/O |
| 5 | N.C. (◆) | IO_L38N_5 | AH8 | I/O |
| 5 | N.C. (◆) | IO_L38P_5 | AG8 | I/O |
| 5 | VCCO_5 | VCCO_5 | AH5 | VCCO |
| 5 | VCCO_5 | VCCO_5 | AF7 | VCCO |
| 5 | VCCO_5 | VCCO_5 | AD9 | VCCO |
| 5 | VCCO_5 | VCCO_5 | AH9 | VCCO |
| 5 | VCCO_5 | VCCO_5 | AB11 | VCCO |
| 5 | VCCO_5 | VCCO_5 | Y12 | VCCO |
| 5 | VCCO_5 | VCCO_5 | Y13 | VCCO |
| 5 | VCCO_5 | VCCO_5 | AD13 | VCCO |
| 5 | VCCO_5 | VCCO_5 | AH13 | VCCO |
| 5 | VCCO_5 | VCCO_5 | Y14 | VCCO |
| 6 | IO | IO | AB6 | I/O |
| 6 | IO_L01N_6/ VRP_6 | IO_L01N_6/ VRP_6 | AH2 | DCI |
| 6 | IO_L01P_6/ VRN_6 | IO_L01P_6/ VRN_6 | AH1 | DCI |
| 6 | IO_L02N_6 | IO_L02N_6 | AG4 | I/O |
| 6 | IO_L02P_6 | IO_L02P_6 | AG3 | I/O |
| 6 | IO_L03N_6/ VREF_6 | IO_L03N_6/ VREF_6 | AG2 | VREF |
| 6 | IO_L03P_6 | IO_L03P_6 | AG1 | I/O |
| 6 | IO_L04N_6 | IO_L04N_6 | AF2 | I/O |
| 6 | IO_L04P_6 | IO_L04P_6 | AF1 | I/O |
| 6 | IO_L05N_6 | IO_L05N_6 | AF4 | I/O |
| 6 | IO_L05P_6 | IO_L05P_6 | AE5 | I/O |
| 6 | IO_L06N_6 | IO_L06N_6 | AE3 | I/O |
| 6 | IO_L06P_6 | IO_L06P_6 | AE2 | I/O |
| 6 | IO_L07N_6 | IO_L07N_6 | AD4 | I/O |
| 6 | IO_L07P_6 | IO_L07P_6 | AD3 | I/O |
| 6 | IO_L08N_6 | IO_L08N_6 | AD2 | I/O |
| 6 | IO_L08P_6 | IO_L08P_6 | AD1 | I/O |
| 6 | IO_L09N_6/ VREF_6 | IO_L09N_6/ VREF_6 | AD6 | VREF |

Table 32: FG900 Package Pinout (Continued)

| Bank | XC3S2000 Pin Name | XC3S4000 XC3S5000 Pin Name | FG900 Pin Number | Type |
|------|----------------------|----------------------------------|------------------------|------|
| 6 | IO_L09P_6 | IO_L09P_6 | AC7 | I/O |
| 6 | IO_L10N_6 | IO_L10N_6 | AC6 | I/O |
| 6 | IO_L10P_6 | IO_L10P_6 | AC5 | I/O |
| 6 | IO_L11N_6 | IO_L11N_6 | AC4 | I/O |
| 6 | IO_L11P_6 | IO_L11P_6 | AC3 | I/O |
| 6 | IO_L13N_6 | IO_L13N_6 | AC2 | I/O |
| 6 | IO_L13P_6/ VREF_6 | IO_L13P_6/ VREF_6 | AC1 | VREF |
| 6 | IO_L14N_6 | IO_L14N_6 | AB5 | I/O |
| 6 | IO_L14P_6 | IO_L14P_6 | AB4 | I/O |
| 6 | IO_L15N_6 | IO_L15N_6 | AB2 | I/O |
| 6 | IO_L15P_6 | IO_L15P_6 | AB1 | I/O |
| 6 | IO_L16N_6 | IO_L16N_6 | AB8 | I/O |
| 6 | IO_L16P_6 | IO_L16P_6 | AA9 | I/O |
| 6 | IO_L17N_6 | IO_L17N_6 | AA7 | I/O |
| 6 | IO_L17P_6/ VREF_6 | IO_L17P_6/ VREF_6 | AA6 | VREF |
| 6 | IO_L19N_6 | IO_L19N_6 | AA3 | I/O |
| 6 | IO_L19P_6 | IO_L19P_6 | AA2 | I/O |
| 6 | IO_L20N_6 | IO_L20N_6 | AA10 | I/O |
| 6 | IO_L20P_6 | IO_L20P_6 | Y10 | I/O |
| 6 | IO_L21N_6 | IO_L21N_6 | Y8 | I/O |
| 6 | IO_L21P_6 | IO_L21P_6 | Y7 | I/O |
| 6 | IO_L22N_6 | IO_L22N_6 | Y6 | I/O |
| 6 | IO_L22P_6 | IO_L22P_6 | Y5 | I/O |
| 6 | IO_L24N_6/ VREF_6 | IO_L24N_6/ VREF_6 | Y2 | VREF |
| 6 | IO_L24P_6 | IO_L24P_6 | Y1 | I/O |
| 6 | N.C. (◆) | IO_L25N_6 | W9 | I/O |
| 6 | N.C. (◆) | IO_L25P_6 | W8 | I/O |
| 6 | IO_L26N_6 | IO_L26N_6 | W7 | I/O |
| 6 | IO_L26P_6 | IO_L26P_6 | W6 | I/O |
| 6 | IO_L27N_6 | IO_L27N_6 | W4 | I/O |
| 6 | IO_L27P_6 | IO_L27P_6 | W3 | I/O |
| 6 | IO_L28N_6 | IO_L28N_6 | W2 | I/O |
| 6 | IO_L28P_6 | IO_L28P_6 | W1 | I/O |
| 6 | IO_L29N_6 | IO_L29N_6 | W10 | I/O |
| 6 | IO_L29P_6 | IO_L29P_6 | V10 | I/O |
| 6 | N.C. (◆) | IO_L30N_6 | V9 | I/O |
| 6 | N.C. (◆) | IO_L30P_6 | V8 | I/O |
| 6 | IO_L31N_6 | IO_L31N_6 | W5 | I/O |
| 6 | IO_L31P_6 | IO_L31P_6 | V6 | I/O |
| 6 | IO_L32N_6 | IO_L32N_6 | V5 | I/O |
| 6 | IO_L32P_6 | IO_L32P_6 | V4 | I/O |
| 6 | IO_L33N_6 | IO_L33N_6 | V2 | I/O |

Table 32: FG900 Package Pinout (Continued)

| Bank | XC3S2000 Pin Name | XC3S4000 XC3S5000 Pin Name | FG900 Pin Number | Type |
|------|----------------------|----------------------------------|------------------------|------|
| 6 | IO_L33P_6 | IO_L33P_6 | V1 | I/O |
| 6 | IO_L34N_6/ VREF_6 | IO_L34N_6/ VREF_6 | U10 | VREF |
| 6 | IO_L34P_6 | IO_L34P_6 | U9 | I/O |
| 6 | IO_L35N_6 | IO_L35N_6 | U7 | I/O |
| 6 | IO_L35P_6 | IO_L35P_6 | U6 | I/O |
| 6 | N.C. (◆) | IO_L36N_6 | U3 | I/O |
| 6 | N.C. (◆) | IO_L36P_6 | U2 | I/O |
| 6 | IO_L37N_6 | IO_L37N_6 | T10 | I/O |
| 6 | IO_L37P_6 | IO_L37P_6 | T9 | I/O |
| 6 | IO_L38N_6 | IO_L38N_6 | T6 | I/O |
| 6 | IO_L38P_6 | IO_L38P_6 | T5 | I/O |
| 6 | IO_L39N_6 | IO_L39N_6 | T4 | I/O |
| 6 | IO_L39P_6 | IO_L39P_6 | T3 | I/O |
| 6 | IO_L40N_6 | IO_L40N_6 | T2 | I/O |
| 6 | IO_L40P_6/ VREF_6 | IO_L40P_6/ VREF_6 | T1 | VREF |
| 6 | N.C. (◆) | IO_L45N_6 | Y4 | I/O |
| 6 | N.C. (◆) | IO_L45P_6 | Y3 | I/O |
| 6 | N.C. (◆) | IO_L52N_6 | T8 | I/O |
| 6 | N.C. (◆) | IO_L52P_6 | T7 | I/O |
| 6 | VCCO_6 | VCCO_6 | V3 | VCCO |
| 6 | VCCO_6 | VCCO_6 | AB3 | VCCO |
| 6 | VCCO_6 | VCCO_6 | AF3 | VCCO |
| 6 | VCCO_6 | VCCO_6 | AD5 | VCCO |
| 6 | VCCO_6 | VCCO_6 | V7 | VCCO |
| 6 | VCCO_6 | VCCO_6 | AB7 | VCCO |
| 6 | VCCO_6 | VCCO_6 | Y9 | VCCO |
| 6 | VCCO_6 | VCCO_6 | U11 | VCCO |
| 6 | VCCO_6 | VCCO_6 | V11 | VCCO |
| 6 | VCCO_6 | VCCO_6 | W11 | VCCO |
| 7 | IO | IO | J6 | I/O |
| 7 | IO_L01N_7/ VRP_7 | IO_L01N_7/ VRP_7 | C1 | DCI |
| 7 | IO_L01P_7/ VRN_7 | IO_L01P_7/ VRN_7 | C2 | DCI |
| 7 | IO_L02N_7 | IO_L02N_7 | D3 | I/O |
| 7 | IO_L02P_7 | IO_L02P_7 | D4 | I/O |
| 7 | IO_L03N_7/ VREF_7 | IO_L03N_7/ VREF_7 | D1 | VREF |
| 7 | IO_L03P_7 | IO_L03P_7 | D2 | I/O |
| 7 | IO_L04N_7 | IO_L04N_7 | E1 | I/O |
| 7 | IO_L04P_7 | IO_L04P_7 | E2 | I/O |
| 7 | IO_L05N_7 | IO_L05N_7 | F5 | I/O |
| 7 | IO_L05P_7 | IO_L05P_7 | E4 | I/O |
| 7 | IO_L06N_7 | IO_L06N_7 | F2 | I/O |

Table 32: FG900 Package Pinout (Continued)

| Bank | XC3S2000 Pin Name | XC3S4000 XC3S5000 Pin Name | FG900 Pin Number | Type |
|------|----------------------|----------------------------------|------------------------|------|
| 7 | IO_L06P_7 | IO_L06P_7 | F3 | I/O |
| 7 | IO_L07N_7 | IO_L07N_7 | G3 | I/O |
| 7 | IO_L07P_7 | IO_L07P_7 | G4 | I/O |
| 7 | IO_L08N_7 | IO_L08N_7 | G1 | I/O |
| 7 | IO_L08P_7 | IO_L08P_7 | G2 | I/O |
| 7 | IO_L09N_7 | IO_L09N_7 | H7 | I/O |
| 7 | IO_L09P_7 | IO_L09P_7 | G6 | I/O |
| 7 | IO_L10N_7 | IO_L10N_7 | H5 | I/O |
| 7 | IO_L10P_7/ VREF_7 | IO_L10P_7/ VREF_7 | H6 | VREF |
| 7 | IO_L11N_7 | IO_L11N_7 | H3 | I/O |
| 7 | IO_L11P_7 | IO_L11P_7 | H4 | I/O |
| 7 | IO_L13N_7 | IO_L13N_7 | H1 | I/O |
| 7 | IO_L13P_7 | IO_L13P_7 | H2 | I/O |
| 7 | IO_L14N_7 | IO_L14N_7 | J4 | I/O |
| 7 | IO_L14P_7 | IO_L14P_7 | J5 | I/O |
| 7 | IO_L15N_7 | IO_L15N_7 | J1 | I/O |
| 7 | IO_L15P_7 | IO_L15P_7 | J2 | I/O |
| 7 | IO_L16N_7 | IO_L16N_7 | K9 | I/O |
| 7 | IO_L16P_7/ VREF_7 | IO_L16P_7/ VREF_7 | J8 | VREF |
| 7 | IO_L17N_7 | IO_L17N_7 | K6 | I/O |
| 7 | IO_L17P_7 | IO_L17P_7 | K7 | I/O |
| 7 | IO_L19N_7/ VREF_7 | IO_L19N_7/ VREF_7 | K2 | VREF |
| 7 | IO_L19P_7 | IO_L19P_7 | K3 | I/O |
| 7 | IO_L20N_7 | IO_L20N_7 | L10 | I/O |
| 7 | IO_L20P_7 | IO_L20P_7 | K10 | I/O |
| 7 | IO_L21N_7 | IO_L21N_7 | L7 | I/O |
| 7 | IO_L21P_7 | IO_L21P_7 | L8 | I/O |
| 7 | IO_L22N_7 | IO_L22N_7 | L5 | I/O |
| 7 | IO_L22P_7 | IO_L22P_7 | L6 | I/O |
| 7 | IO_L23N_7 | IO_L23N_7 | L3 | I/O |
| 7 | IO_L23P_7 | IO_L23P_7 | L4 | I/O |
| 7 | IO_L24N_7 | IO_L24N_7 | L1 | I/O |
| 7 | IO_L24P_7 | IO_L24P_7 | L2 | I/O |
| 7 | N.C. (◆) | IO_L25N_7 | M6 | I/O |
| 7 | N.C. (◆) | IO_L25P_7 | M7 | I/O |
| 7 | IO_L26N_7 | IO_L26N_7 | M3 | I/O |
| 7 | IO_L26P_7 | IO_L26P_7 | M4 | I/O |
| 7 | IO_L27N_7 | IO_L27N_7 | M1 | I/O |
| 7 | IO_L27P_7/ VREF_7 | IO_L27P_7/ VREF_7 | M2 | VREF |
| 7 | IO_L28N_7 | IO_L28N_7 | N10 | I/O |
| 7 | IO_L28P_7 | IO_L28P_7 | M10 | I/O |
| 7 | IO_L29N_7 | IO_L29N_7 | N8 | I/O |

Table 32: FG900 Package Pinout (Continued)

| Bank | XC3S2000 Pin Name | XC3S4000 XC3S5000 Pin Name | FG900 Pin Number | Type |
|------|----------------------|----------------------------------|------------------------|------|
| 7 | IO_L29P_7 | IO_L29P_7 | N9 | I/O |
| 7 | IO_L31N_7 | IO_L31N_7 | N1 | I/O |
| 7 | IO_L31P_7 | IO_L31P_7 | N2 | I/O |
| 7 | IO_L32N_7 | IO_L32N_7 | P9 | I/O |
| 7 | IO_L32P_7 | IO_L32P_7 | P10 | I/O |
| 7 | IO_L33N_7 | IO_L33N_7 | P6 | I/O |
| 7 | IO_L33P_7 | IO_L33P_7 | P7 | I/O |
| 7 | IO_L34N_7 | IO_L34N_7 | P2 | I/O |
| 7 | IO_L34P_7 | IO_L34P_7 | P3 | I/O |
| 7 | IO_L35N_7 | IO_L35N_7 | R9 | I/O |
| 7 | IO_L35P_7 | IO_L35P_7 | R10 | I/O |
| 7 | IO_L37N_7 | IO_L37N_7 | R7 | I/O |
| 7 | IO_L37P_7/ VREF_7 | IO_L37P_7/ VREF_7 | R8 | VREF |
| 7 | IO_L38N_7 | IO_L38N_7 | R5 | I/O |
| 7 | IO_L38P_7 | IO_L38P_7 | R6 | I/O |
| 7 | IO_L39N_7 | IO_L39N_7 | R3 | I/O |
| 7 | IO_L39P_7 | IO_L39P_7 | R4 | I/O |
| 7 | IO_L40N_7/ VREF_7 | IO_L40N_7/ VREF_7 | R1 | VREF |
| 7 | IO_L40P_7 | IO_L40P_7 | R2 | I/O |
| 7 | N.C. (◆) | IO_L46N_7 | M8 | I/O |
| 7 | N.C. (◆) | IO_L46P_7 | M9 | I/O |
| 7 | N.C. (◆) | IO_L49N_7 | N6 | I/O |
| 7 | N.C. (◆) | IO_L49P_7 | M5 | I/O |
| 7 | N.C. (◆) | IO_L50N_7 | N4 | I/O |
| 7 | N.C. (◆) | IO_L50P_7 | N5 | I/O |
| 7 | VCCO_7 | VCCO_7 | E3 | VCCO |
| 7 | VCCO_7 | VCCO_7 | J3 | VCCO |
| 7 | VCCO_7 | VCCO_7 | N3 | VCCO |
| 7 | VCCO_7 | VCCO_7 | G5 | VCCO |
| 7 | VCCO_7 | VCCO_7 | J7 | VCCO |
| 7 | VCCO_7 | VCCO_7 | N7 | VCCO |
| 7 | VCCO_7 | VCCO_7 | L9 | VCCO |
| 7 | VCCO_7 | VCCO_7 | M11 | VCCO |
| 7 | VCCO_7 | VCCO_7 | N11 | VCCO |
| 7 | VCCO_7 | VCCO_7 | P11 | VCCO |
| N/A | GND | GND | A1 | GND |
| N/A | GND | GND | B1 | GND |
| N/A | GND | GND | F1 | GND |
| N/A | GND | GND | K1 | GND |
| N/A | GND | GND | P1 | GND |
| N/A | GND | GND | U1 | GND |
| N/A | GND | GND | AA1 | GND |
| N/A | GND | GND | AE1 | GND |

Table 32: FG900 Package Pinout (Continued)

| Bank | XC3S2000 Pin Name | XC3S4000 XC3S5000 Pin Name | FG900 Pin Number | Type |
|------|----------------------|----------------------------------|------------------------|------|
| N/A | GND | GND | AJ1 | GND |
| N/A | GND | GND | AK1 | GND |
| N/A | GND | GND | A2 | GND |
| N/A | GND | GND | B2 | GND |
| N/A | GND | GND | AJ2 | GND |
| N/A | GND | GND | E5 | GND |
| N/A | GND | GND | K5 | GND |
| N/A | GND | GND | P5 | GND |
| N/A | GND | GND | U5 | GND |
| N/A | GND | GND | AA5 | GND |
| N/A | GND | GND | AF5 | GND |
| N/A | GND | GND | A6 | GND |
| N/A | GND | GND | AK6 | GND |
| N/A | GND | GND | K8 | GND |
| N/A | GND | GND | P8 | GND |
| N/A | GND | GND | U8 | GND |
| N/A | GND | GND | AA8 | GND |
| N/A | GND | GND | A10 | GND |
| N/A | GND | GND | E10 | GND |
| N/A | GND | GND | H10 | GND |
| N/A | GND | GND | AC10 | GND |
| N/A | GND | GND | AF10 | GND |
| N/A | GND | GND | AK10 | GND |
| N/A | GND | GND | R12 | GND |
| N/A | GND | GND | T12 | GND |
| N/A | GND | GND | N13 | GND |
| N/A | GND | GND | P13 | GND |
| N/A | GND | GND | R13 | GND |
| N/A | GND | GND | T13 | GND |
| N/A | GND | GND | U13 | GND |
| N/A | GND | GND | V13 | GND |
| N/A | GND | GND | A14 | GND |
| N/A | GND | GND | E14 | GND |
| N/A | GND | GND | H14 | GND |
| N/A | GND | GND | N14 | GND |
| N/A | GND | GND | P14 | GND |
| N/A | GND | GND | R14 | GND |
| N/A | GND | GND | T14 | GND |
| N/A | GND | GND | U14 | GND |
| N/A | GND | GND | V14 | GND |
| N/A | GND | GND | AC14 | GND |
| N/A | GND | GND | AF14 | GND |
| N/A | GND | GND | AK14 | GND |
| N/A | GND | GND | M15 | GND |
| N/A | GND | GND | N15 | GND |

Table 32: FG900 Package Pinout (Continued)

| Bank | XC3S2000 Pin Name | XC3S4000 XC3S5000 Pin Name | FG900 Pin Number | Type |
|------|----------------------|----------------------------------|------------------------|------|
| N/A | GND | GND | P15 | GND |
| N/A | GND | GND | R15 | GND |
| N/A | GND | GND | T15 | GND |
| N/A | GND | GND | U15 | GND |
| N/A | GND | GND | V15 | GND |
| N/A | GND | GND | W15 | GND |
| N/A | GND | GND | M16 | GND |
| N/A | GND | GND | N16 | GND |
| N/A | GND | GND | P16 | GND |
| N/A | GND | GND | R16 | GND |
| N/A | GND | GND | T16 | GND |
| N/A | GND | GND | U16 | GND |
| N/A | GND | GND | V16 | GND |
| N/A | GND | GND | W16 | GND |
| N/A | GND | GND | A17 | GND |
| N/A | GND | GND | E17 | GND |
| N/A | GND | GND | H17 | GND |
| N/A | GND | GND | N17 | GND |
| N/A | GND | GND | P17 | GND |
| N/A | GND | GND | R17 | GND |
| N/A | GND | GND | T17 | GND |
| N/A | GND | GND | U17 | GND |
| N/A | GND | GND | V17 | GND |
| N/A | GND | GND | AC17 | GND |
| N/A | GND | GND | AF17 | GND |
| N/A | GND | GND | AK17 | GND |
| N/A | GND | GND | N18 | GND |
| N/A | GND | GND | P18 | GND |
| N/A | GND | GND | R18 | GND |
| N/A | GND | GND | T18 | GND |
| N/A | GND | GND | U18 | GND |
| N/A | GND | GND | V18 | GND |
| N/A | GND | GND | R19 | GND |
| N/A | GND | GND | T19 | GND |
| N/A | GND | GND | A21 | GND |
| N/A | GND | GND | E21 | GND |
| N/A | GND | GND | H21 | GND |
| N/A | GND | GND | AC21 | GND |
| N/A | GND | GND | AF21 | GND |
| N/A | GND | GND | AK21 | GND |
| N/A | GND | GND | K23 | GND |
| N/A | GND | GND | P23 | GND |
| N/A | GND | GND | U23 | GND |
| N/A | GND | GND | AA23 | GND |
| N/A | GND | GND | A25 | GND |

Table 32: FG900 Package Pinout (Continued)

| Bank | XC3S2000 Pin Name | XC3S4000 XC3S5000 Pin Name | FG900 Pin Number | Type |
|------|----------------------|----------------------------------|------------------------|--------|
| N/A | GND | GND | AK25 | GND |
| N/A | GND | GND | E26 | GND |
| N/A | GND | GND | K26 | GND |
| N/A | GND | GND | P26 | GND |
| N/A | GND | GND | U26 | GND |
| N/A | GND | GND | AA26 | GND |
| N/A | GND | GND | AF26 | GND |
| N/A | GND | GND | A29 | GND |
| N/A | GND | GND | B29 | GND |
| N/A | GND | GND | AJ29 | GND |
| N/A | GND | GND | AK29 | GND |
| N/A | GND | GND | A30 | GND |
| N/A | GND | GND | B30 | GND |
| N/A | GND | GND | F30 | GND |
| N/A | GND | GND | K30 | GND |
| N/A | GND | GND | P30 | GND |
| N/A | GND | GND | U30 | GND |
| N/A | GND | GND | AA30 | GND |
| N/A | GND | GND | AE30 | GND |
| N/A | GND | GND | AJ30 | GND |
| N/A | GND | GND | AK30 | GND |
| N/A | GND | GND | AK2 | GND |
| N/A | VCCAUX | VCCAUX | F4 | VCCAUX |
| N/A | VCCAUX | VCCAUX | K4 | VCCAUX |
| N/A | VCCAUX | VCCAUX | P4 | VCCAUX |
| N/A | VCCAUX | VCCAUX | U4 | VCCAUX |
| N/A | VCCAUX | VCCAUX | AA4 | VCCAUX |
| N/A | VCCAUX | VCCAUX | AE4 | VCCAUX |
| N/A | VCCAUX | VCCAUX | D6 | VCCAUX |
| N/A | VCCAUX | VCCAUX | AG6 | VCCAUX |
| N/A | VCCAUX | VCCAUX | D10 | VCCAUX |
| N/A | VCCAUX | VCCAUX | AG10 | VCCAUX |
| N/A | VCCAUX | VCCAUX | D14 | VCCAUX |
| N/A | VCCAUX | VCCAUX | AG14 | VCCAUX |
| N/A | VCCAUX | VCCAUX | D17 | VCCAUX |
| N/A | VCCAUX | VCCAUX | AG17 | VCCAUX |
| N/A | VCCAUX | VCCAUX | D21 | VCCAUX |
| N/A | VCCAUX | VCCAUX | AG21 | VCCAUX |
| N/A | VCCAUX | VCCAUX | D25 | VCCAUX |
| N/A | VCCAUX | VCCAUX | AG25 | VCCAUX |
| N/A | VCCAUX | VCCAUX | F27 | VCCAUX |
| N/A | VCCAUX | VCCAUX | K27 | VCCAUX |
| N/A | VCCAUX | VCCAUX | P27 | VCCAUX |
| N/A | VCCAUX | VCCAUX | U27 | VCCAUX |
| N/A | VCCAUX | VCCAUX | AA27 | VCCAUX |

Table 32: FG900 Package Pinout (Continued)

| Bank | XC3S2000 Pin Name | XC3S4000 XC3S5000 Pin Name | FG900 Pin Number | Type |
|--------|----------------------|----------------------------------|------------------------|--------|
| N/A | VCCAUX | VCCAUX | AE27 | VCCAUX |
| N/A | VCCINT | VCCINT | L11 | VCCINT |
| N/A | VCCINT | VCCINT | R11 | VCCINT |
| N/A | VCCINT | VCCINT | T11 | VCCINT |
| N/A | VCCINT | VCCINT | Y11 | VCCINT |
| N/A | VCCINT | VCCINT | M12 | VCCINT |
| N/A | VCCINT | VCCINT | N12 | VCCINT |
| N/A | VCCINT | VCCINT | P12 | VCCINT |
| N/A | VCCINT | VCCINT | U12 | VCCINT |
| N/A | VCCINT | VCCINT | V12 | VCCINT |
| N/A | VCCINT | VCCINT | W12 | VCCINT |
| N/A | VCCINT | VCCINT | M13 | VCCINT |
| N/A | VCCINT | VCCINT | W13 | VCCINT |
| N/A | VCCINT | VCCINT | M14 | VCCINT |
| N/A | VCCINT | VCCINT | W14 | VCCINT |
| N/A | VCCINT | VCCINT | L15 | VCCINT |
| N/A | VCCINT | VCCINT | Y15 | VCCINT |
| N/A | VCCINT | VCCINT | L16 | VCCINT |
| N/A | VCCINT | VCCINT | Y16 | VCCINT |
| N/A | VCCINT | VCCINT | M17 | VCCINT |
| N/A | VCCINT | VCCINT | W17 | VCCINT |
| N/A | VCCINT | VCCINT | M18 | VCCINT |
| N/A | VCCINT | VCCINT | W18 | VCCINT |
| N/A | VCCINT | VCCINT | M19 | VCCINT |
| N/A | VCCINT | VCCINT | N19 | VCCINT |
| N/A | VCCINT | VCCINT | P19 | VCCINT |
| N/A | VCCINT | VCCINT | U19 | VCCINT |
| N/A | VCCINT | VCCINT | V19 | VCCINT |
| N/A | VCCINT | VCCINT | W19 | VCCINT |
| N/A | VCCINT | VCCINT | L20 | VCCINT |
| N/A | VCCINT | VCCINT | R20 | VCCINT |
| N/A | VCCINT | VCCINT | T20 | VCCINT |
| N/A | VCCINT | VCCINT | Y20 | VCCINT |
| VCCAUX | CCLK | CCLK | AH28 | CONFIG |
| VCCAUX | DONE | DONE | AJ28 | CONFIG |
| VCCAUX | HSWAP_EN | HSWAP_EN | A3 | CONFIG |
| VCCAUX | M0 | M0 | AJ3 | CONFIG |
| VCCAUX | M1 | M1 | AH3 | CONFIG |
| VCCAUX | M2 | M2 | AK3 | CONFIG |
| VCCAUX | PROG_B | PROG_B | B3 | CONFIG |
| VCCAUX | TCK | TCK | B28 | JTAG |
| VCCAUX | TDI | TDI | C3 | JTAG |
| VCCAUX | TDO | TDO | C28 | JTAG |
| VCCAUX | TMS | TMS | A28 | JTAG |

User I/Os by Bank

Table 33 indicates how the available user-I/O pins are distributed between the eight I/O banks for the XC3S2000 in the FG900 package. Similarly, Table 34 shows how the

available user-I/O pins are distributed between the eight I/O banks for the XC3S4000 and XC3S5000 in the FG900 package.

Table 33: User I/Os Per Bank for XC3S2000 in FG900 Package

| Edge | I/O Bank | Maximum I/O | All Possible I/O Pins by Type | | | | |
|--------|----------|-------------|-------------------------------|------|-----|------|------|
| | | | I/O | DUAL | DCI | VREF | GCLK |
| Top | 0 | 71 | 62 | 0 | 2 | 5 | 2 |
| | 1 | 71 | 62 | 0 | 2 | 5 | 2 |
| Right | 2 | 69 | 61 | 0 | 2 | 6 | 0 |
| | 3 | 71 | 62 | 0 | 2 | 7 | 0 |
| Bottom | 4 | 72 | 57 | 6 | 2 | 5 | 2 |
| | 5 | 71 | 55 | 6 | 2 | 6 | 2 |
| Left | 6 | 69 | 60 | 0 | 2 | 7 | 0 |
| | 7 | 71 | 62 | 0 | 2 | 7 | 0 |

Table 34: User I/Os Per Bank for XC3S4000 and XC3S5000 in FG900 Package

| Edge | I/O Bank | Maximum I/O | All Possible I/O Pins by Type | | | | |
|--------|----------|-------------|-------------------------------|------|-----|------|------|
| | | | I/O | DUAL | DCI | VREF | GCLK |
| Top | 0 | 79 | 70 | 0 | 2 | 5 | 2 |
| | 1 | 79 | 70 | 0 | 2 | 5 | 2 |
| Right | 2 | 79 | 71 | 0 | 2 | 6 | 0 |
| | 3 | 79 | 70 | 0 | 2 | 7 | 0 |
| Bottom | 4 | 80 | 65 | 6 | 2 | 5 | 2 |
| | 5 | 79 | 63 | 6 | 2 | 6 | 2 |
| Left | 6 | 79 | 70 | 0 | 2 | 7 | 0 |
| | 7 | 79 | 70 | 0 | 2 | 7 | 0 |

| Bank 1 | | | | | | | | | | | | | | | Bank 2 | | | | | | | | | | | | | | |
|-------------------------|----------------------|-----------------|----------------------|------------|----------------------|-----------------|----------------------|----------------------|----------------------|-----------------|----------------------|----------------------|----------------------|----------------------|--------|--|--|--|--|--|--|--|--|--|--|--|--|--|--|
| 16 | 17 | 18 | 19 | 20 | 21 | 22 | 23 | 24 | 25 | 26 | 27 | 28 | 29 | 30 | | | | | | | | | | | | | | | |
| I/O | GND | I/O L39N_1 ◆ | I/O L26N_1 | I/O L21N_1 | GND | I/O L15N_1 | I/O L11N_1 | I/O L07N_1 | GND | I/O L03N_1 | I/O L01N_1 VRP_1 | TMS | GND | GND | A | | | | | | | | | | | | | | |
| I/O L32N_1 GCLK5 | I/O L28N_1 | I/O L39P_1 ◆ | I/O L26P_1 | I/O L21P_1 | I/O L17N_1 VREF_1 | I/O L15P_1 | I/O L11P_1 | I/O L07P_1 | I/O L04N_1 | I/O L03P_1 | I/O L01P_1 VRN_1 | TCK | GND | GND | B | | | | | | | | | | | | | | |
| I/O L32P_1 GCLK4 | I/O L28P_1 | VCCO_1 | I/O L25N_1 | I/O L20N_1 | I/O L17P_1 | VCCO_1 | I/O L10N_1 VREF_1 | I/O L06N_1 VREF_1 | I/O L04P_1 | VCCO_1 | I/O L02P_1 | TDO | I/O L01N_2 VRP_2 | I/O L01P_2 VRN_2 | C | | | | | | | | | | | | | | |
| I/O L31N_1 VREF_1 | VCCAUX | I/O L38N_1 ◆ | I/O L25P_1 | I/O L20P_1 | VCCAUX | I/O L14N_1 | I/O L10P_1 | I/O L06P_1 | VCCAUX | I/O L02N_1 | I/O L02N_2 | I/O L02P_2 | I/O L03N_2 VREF_2 | I/O L03P_2 | D | | | | | | | | | | | | | | |
| I/O L31P_1 | GND | I/O L38P_1 ◆ | I/O L24N_1 | I/O L19N_1 | GND | I/O L14P_1 | I/O L13P_1 | VCCO_1 | I/O | GND | I/O L41N_2 ◆ | VCCO_2 | I/O L04N_2 | I/O L04P_2 | E | | | | | | | | | | | | | | |
| I/O | I/O L27N_1 | I/O | I/O L24P_1 | I/O L19P_1 | I/O L16N_1 | I/O L13N_1 | I/O L09N_1 | I/O L05N_1 | I/O L05P_1 | I/O L41P_2 ◆ | VCCAUX | I/O L05N_2 | I/O L05P_2 | GND | F | | | | | | | | | | | | | | |
| I/O L30N_1 | I/O L27P_1 | VCCO_1 | I/O L23N_1 | I/O L18N_1 | I/O L16P_1 | VCCO_1 | I/O L09P_1 | I/O L08P_1 | I/O L08N_2 | VCCO_2 | I/O L06N_2 | I/O L06P_2 | I/O L07N_2 | I/O L07P_2 | G | | | | | | | | | | | | | | |
| I/O L30P_1 | GND | I/O L37N_1 ◆ | I/O L23P_1 | I/O L18P_1 | GND | I/O L12N_1 | I/O L08N_1 | I/O L08P_2 | I/O L09N_2 VREF_2 | I/O L09P_2 | I/O L10N_2 | I/O L10P_2 | I/O L12N_2 | I/O L12P_2 | H | | | | | | | | | | | | | | |
| I/O L29N_1 | I/O VREF_1 | I/O L37P_1 ◆ | I/O L22N_1 | VCCO_1 | I/O | I/O L12P_1 | I/O L15N_2 | VCCO_2 | I/O | I/O L13N_2 | I/O L13P_2 VREF_2 | VCCO_2 | I/O L14N_2 | I/O L14P_2 | J | | | | | | | | | | | | | | |
| I/O L29P_1 | I/O L40N_1 ◆ | I/O L40P_1 ◆ | I/O L22P_1 | I/O | I/O L46N_2 ◆ | I/O L15P_2 | GND | I/O L16N_2 | I/O L16P_2 | GND | VCCAUX | I/O L45N_2 ◆ | I/O L45P_2 ◆ | GND | K | | | | | | | | | | | | | | |
| VCCINT | VCCO_1 | VCCO_1 | VCCO_1 | VCCINT | I/O L46P_2 ◆ | VCCO_2 | I/O L47N_2 ◆ | I/O L47P_2 ◆ | I/O L19N_2 | I/O L19P_2 | I/O L20N_2 | I/O L20P_2 | I/O L21N_2 | I/O L21P_2 | L | | | | | | | | | | | | | | |
| GND | VCCINT | VCCINT | VCCINT | VCCO_2 | I/O L26N_2 | I/O L22N_2 | I/O L22P_2 | I/O L23N_2 VREF_2 | I/O L23P_2 | I/O L28N_2 | I/O L24N_2 | I/O L24P_2 | I/O L50N_2 ◆ | I/O L50P_2 ◆ | M | | | | | | | | | | | | | | |
| GND | GND | GND | VCCINT | VCCO_2 | I/O L26P_2 | I/O L27N_2 | I/O L27P_2 | VCCO_2 | I/O L28P_2 | I/O L29N_2 | I/O L29P_2 | VCCO_2 | I/O L31N_2 | I/O L31P_2 | N | | | | | | | | | | | | | | |
| GND | GND | GND | VCCINT | VCCO_2 | I/O L32N_2 | I/O L32P_2 | GND | I/O L33N_2 | I/O L33P_2 | GND | VCCAUX | I/O L34N_2 VREF_2 | I/O L34P_2 | GND | P | | | | | | | | | | | | | | |
| GND | GND | GND | GND | VCCINT | I/O L35N_2 | I/O L35P_2 | I/O L37N_2 | I/O L37P_2 | I/O L38N_2 | I/O L38P_2 | I/O L39N_2 | I/O L39P_2 | I/O L40N_2 | I/O L40P_2 VREF_2 | R | | | | | | | | | | | | | | |
| GND | GND | GND | GND | VCCINT | I/O L35P_3 | I/O L35N_3 | I/O L37P_3 | I/O L37N_3 | I/O L38P_3 | I/O L38N_3 | I/O L39P_3 | I/O L39N_3 | I/O L40P_3 | I/O L40N_3 VREF_3 | T | | | | | | | | | | | | | | |
| GND | GND | GND | VCCINT | VCCO_3 | I/O L32P_3 | I/O L32N_3 | GND | I/O L33P_3 | I/O L33N_3 | GND | VCCAUX | I/O L34P_3 VREF_3 | I/O L34N_3 | GND | U | | | | | | | | | | | | | | |
| GND | GND | GND | VCCINT | VCCO_3 | I/O L27N_3 | I/O L28P_3 | I/O L28N_3 | VCCO_3 | I/O L29N_3 | I/O L50P_3 ◆ | I/O L50N_3 ◆ | VCCO_3 | I/O L31P_3 | I/O L31N_3 | V | | | | | | | | | | | | | | |
| GND | VCCINT | VCCINT | VCCINT | VCCO_3 | I/O L27P_3 | I/O L46P_3 ◆ | I/O L46N_3 ◆ | I/O L47P_3 ◆ | I/O L47N_3 ◆ | I/O L29P_3 | I/O L48P_3 ◆ | I/O L48N_3 ◆ | I/O L26P_3 | I/O L26N_3 | W | | | | | | | | | | | | | | |
| VCCINT | VCCO_4 | VCCO_4 | VCCO_4 | VCCINT | I/O L20N_3 | VCCO_3 | I/O L21P_3 | I/O L21N_3 | I/O L22P_3 | I/O L22N_3 | I/O L23P_3 VREF_3 | I/O L23N_3 | I/O L24P_3 | I/O L24N_3 | Y | | | | | | | | | | | | | | |
| I/O | I/O L26N_4 | I/O | I/O L18N_4 | I/O L13P_4 | I/O L20P_3 | I/O L16N_3 | GND | I/O L17P_3 VREF_3 | I/O L17N_3 | GND | VCCAUX | I/O L19P_3 | I/O L19N_3 | GND | A | | | | | | | | | | | | | | |
| I/O L29N_4 | I/O L26P_4 VREF_4 | I/O L23N_4 | I/O L18P_4 | VCCO_4 | I/O L13N_4 | I/O L08N_4 | I/O L16P_3 | VCCO_3 | I/O | I/O L14P_3 | I/O L14N_3 | VCCO_3 | I/O L15P_3 | I/O L15N_3 | B | | | | | | | | | | | | | | |
| I/O L29P_4 | GND | I/O L23P_4 | I/O L19N_4 | I/O L14N_4 | GND | I/O L08P_4 | I/O L04P_4 | I/O L09N_3 | I/O L10P_3 | I/O L10N_3 | I/O L11P_3 | I/O L11N_3 | I/O L13P_3 | I/O L13N_3 VREF_3 | C | | | | | | | | | | | | | | |
| I/O L31P_4 D2 | I/O L27N_4 DIN D0 | VCCO_4 | I/O L19P_4 | I/O L14P_4 | I/O L11N_4 | VCCO_4 | I/O | I/O L04N_4 | I/O L09P_3 VREF_3 | VCCO_3 | I/O L07P_3 | I/O L07N_3 | I/O L08P_3 | I/O L08N_3 | D | | | | | | | | | | | | | | |
| I/O L30P_4 D3 | I/O L27P_4 D1 | I/O L24N_4 | I/O L20N_4 | I/O L15N_4 | I/O L11P_4 | I/O | I/O L05N_4 | I/O L34P_4 ◆ | I/O L34N_4 ◆ | I/O L05N_3 | VCCAUX | I/O L06P_3 | I/O L06N_3 | GND | E | | | | | | | | | | | | | | |
| I/O VREF_4 | GND | I/O L24P_4 | I/O L20P_4 | I/O L15P_4 | GND | I/O L09N_4 | I/O L05P_4 | VCCO_4 | I/O L03P_4 | GND | I/O L05P_3 | VCCO_3 | I/O L04P_3 | I/O L04N_3 | F | | | | | | | | | | | | | | |
| I/O L31N_4 INIT_B | VCCAUX | I/O | I/O L21N_4 | I/O L16N_4 | VCCAUX | I/O L09P_4 | I/O L06N_4 VREF_4 | I/O L35N_4 ◆ | VCCAUX | I/O L03N_4 | I/O L02P_3 | I/O L02N_3 VREF_3 | I/O L03P_3 | I/O L03N_3 | G | | | | | | | | | | | | | | |
| I/O L31P_4 DOUT BUSY | I/O L28N_4 | VCCO_4 | I/O L21P_4 | I/O L16P_4 | I/O L12N_4 | VCCO_4 | I/O L06P_4 | I/O L35P_4 ◆ | I/O L33N_4 ◆ | VCCO_4 | I/O | CCLK | I/O L01P_3 VRN_3 | I/O L01N_3 VRP_3 | H | | | | | | | | | | | | | | |
| I/O L32N_4 GCLK1 | I/O L28P_4 | I/O L25N_4 | I/O L22N_4 VREF_4 | I/O L17N_4 | I/O L12P_4 | I/O L10N_4 | I/O L07N_4 | I/O L38N_4 ◆ | I/O L33P_4 ◆ | I/O L02N_4 | I/O L01N_4 VRP_4 | DONE | GND | GND | A | | | | | | | | | | | | | | |
| I/O L32P_4 GCLK0 | GND | I/O L25P_4 | I/O L22P_4 | I/O L17P_4 | GND | I/O L10P_4 | I/O L07P_4 | I/O L38P_4 ◆ | GND | I/O L02P_4 | I/O L01P_4 VRN_4 | I/O VREF_4 | GND | GND | K | | | | | | | | | | | | | | |
| Bank 4 | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |

FG1156: 1156-lead Fine-pitch Ball Grid Array

The 1,156-lead fine-pitch ball grid array package, FG1156, supports two different Spartan-3 devices, namely the XC3S4000, and the XC3S5000. The XC3S2000, however, has fewer I/O pins, which consequently results in 73 unconnected pins on the FG1156 package, labeled as “N.C.” In [Table 35](#) and [Figure 15](#), these unconnected pins are indicated with a black diamond symbol (◆).

The XC3S5000 has a single unconnected package pin, ball AK31, which is also unconnected for the XC3S4000.

All the package pins appear in [Table 35](#) and are sorted by bank number, then by pin name. Pairs of pins that form a differential I/O pair appear together in the table. The table also shows the pin number for each pin and the pin type, as defined earlier.

If there is a difference between the XC3S2000 and XC3S5000 pinouts, then that difference is highlighted in [Table 35](#). If the table entry is shaded grey, then there is an unconnected pin on the XC3S2000 that maps to a user-I/O pin on the XC3S4000 and XC3S5000. If the table entry is shaded tan, which only occurs on ball L29 in I/O Bank 2, then the unconnected pin on XC3S4000 maps to a VREF-type pin on the XC3S5000. If the other VREF_2 pins all connect to a voltage reference to support a special I/O standard, then also connect the N.C. pin on the XC3S4000 to the same VREF_2 voltage. This provides maximum flexibility as you could potentially migrate a design from the XC3S4000 to the XC3S5000 FPGA without changing the printed circuit board.

Pinout Table

Table 35: FG1156 Package Pinout

| Bank | XC3S4000 Pin Name | XC3S5000 Pin Name | FG1156 Pin Number | Type |
|------|----------------------|----------------------|-------------------------|------|
| 0 | IO | IO | B9 | I/O |
| 0 | IO | IO | E17 | I/O |
| 0 | IO | IO | F6 | I/O |
| 0 | IO | IO | F8 | I/O |
| 0 | IO | IO | G12 | I/O |
| 0 | IO | IO | H8 | I/O |
| 0 | IO | IO | H9 | I/O |
| 0 | IO | IO | J11 | I/O |
| 0 | N.C. (◆) | IO | J9 | I/O |
| 0 | N.C. (◆) | IO | K11 | I/O |
| 0 | IO | IO | K13 | I/O |
| 0 | IO | IO | K16 | I/O |
| 0 | IO | IO | K17 | I/O |
| 0 | IO | IO | L13 | I/O |

Table 35: FG1156 Package Pinout (Continued)

| Bank | XC3S4000 Pin Name | XC3S5000 Pin Name | FG1156 Pin Number | Type |
|------|----------------------|----------------------|-------------------------|------|
| 0 | IO | IO | L16 | I/O |
| 0 | IO | IO | L17 | I/O |
| 0 | IO/VREF_0 | IO/VREF_0 | D5 | VREF |
| 0 | IO/VREF_0 | IO/VREF_0 | E10 | VREF |
| 0 | IO/VREF_0 | IO/VREF_0 | J14 | VREF |
| 0 | IO/VREF_0 | IO/VREF_0 | L15 | VREF |
| 0 | IO_L01N_0/ VRP_0 | IO_L01N_0/ VRP_0 | B3 | DCI |
| 0 | IO_L01P_0/ VRN_0 | IO_L01P_0/ VRN_0 | A3 | DCI |
| 0 | IO_L02N_0 | IO_L02N_0 | B4 | I/O |
| 0 | IO_L02P_0 | IO_L02P_0 | A4 | I/O |
| 0 | IO_L03N_0 | IO_L03N_0 | C5 | I/O |
| 0 | IO_L03P_0 | IO_L03P_0 | B5 | I/O |
| 0 | IO_L04N_0 | IO_L04N_0 | D6 | I/O |
| 0 | IO_L04P_0 | IO_L04P_0 | C6 | I/O |
| 0 | IO_L05N_0 | IO_L05N_0 | B6 | I/O |
| 0 | IO_L05P_0/ VREF_0 | IO_L05P_0/ VREF_0 | A6 | VREF |
| 0 | IO_L06N_0 | IO_L06N_0 | F7 | I/O |
| 0 | IO_L06P_0 | IO_L06P_0 | E7 | I/O |
| 0 | IO_L07N_0 | IO_L07N_0 | G9 | I/O |
| 0 | IO_L07P_0 | IO_L07P_0 | F9 | I/O |
| 0 | IO_L08N_0 | IO_L08N_0 | D9 | I/O |
| 0 | IO_L08P_0 | IO_L08P_0 | C9 | I/O |
| 0 | IO_L09N_0 | IO_L09N_0 | J10 | I/O |
| 0 | IO_L09P_0 | IO_L09P_0 | H10 | I/O |
| 0 | IO_L10N_0 | IO_L10N_0 | G10 | I/O |
| 0 | IO_L10P_0 | IO_L10P_0 | F10 | I/O |
| 0 | IO_L11N_0 | IO_L11N_0 | L12 | I/O |
| 0 | IO_L11P_0 | IO_L11P_0 | K12 | I/O |
| 0 | IO_L12N_0 | IO_L12N_0 | J12 | I/O |
| 0 | IO_L12P_0 | IO_L12P_0 | H12 | I/O |
| 0 | IO_L13N_0 | IO_L13N_0 | F12 | I/O |
| 0 | IO_L13P_0 | IO_L13P_0 | E12 | I/O |
| 0 | IO_L14N_0 | IO_L14N_0 | D12 | I/O |
| 0 | IO_L14P_0 | IO_L14P_0 | C12 | I/O |
| 0 | IO_L15N_0 | IO_L15N_0 | B12 | I/O |
| 0 | IO_L15P_0 | IO_L15P_0 | A12 | I/O |
| 0 | IO_L16N_0 | IO_L16N_0 | H13 | I/O |
| 0 | IO_L16P_0 | IO_L16P_0 | G13 | I/O |
| 0 | IO_L17N_0 | IO_L17N_0 | D13 | I/O |

Table 35: FG1156 Package Pinout (Continued)

| Bank | XC3S4000 Pin Name | XC3S5000 Pin Name | FG1156 Pin Number | Type |
|------|----------------------|----------------------|-------------------------|------|
| 0 | IO_L17P_0 | IO_L17P_0 | C13 | I/O |
| 0 | IO_L18N_0 | IO_L18N_0 | L14 | I/O |
| 0 | IO_L18P_0 | IO_L18P_0 | K14 | I/O |
| 0 | IO_L19N_0 | IO_L19N_0 | H14 | I/O |
| 0 | IO_L19P_0 | IO_L19P_0 | G14 | I/O |
| 0 | IO_L20N_0 | IO_L20N_0 | F14 | I/O |
| 0 | IO_L20P_0 | IO_L20P_0 | E14 | I/O |
| 0 | IO_L21N_0 | IO_L21N_0 | D14 | I/O |
| 0 | IO_L21P_0 | IO_L21P_0 | C14 | I/O |
| 0 | IO_L22N_0 | IO_L22N_0 | B14 | I/O |
| 0 | IO_L22P_0 | IO_L22P_0 | A14 | I/O |
| 0 | IO_L23N_0 | IO_L23N_0 | K15 | I/O |
| 0 | IO_L23P_0 | IO_L23P_0 | J15 | I/O |
| 0 | IO_L24N_0 | IO_L24N_0 | G15 | I/O |
| 0 | IO_L24P_0 | IO_L24P_0 | F15 | I/O |
| 0 | IO_L25N_0 | IO_L25N_0 | D15 | I/O |
| 0 | IO_L25P_0 | IO_L25P_0 | C15 | I/O |
| 0 | IO_L26N_0 | IO_L26N_0 | B15 | I/O |
| 0 | IO_L26P_0/ VREF_0 | IO_L26P_0/ VREF_0 | A15 | VREF |
| 0 | IO_L27N_0 | IO_L27N_0 | G16 | I/O |
| 0 | IO_L27P_0 | IO_L27P_0 | F16 | I/O |
| 0 | IO_L28N_0 | IO_L28N_0 | C16 | I/O |
| 0 | IO_L28P_0 | IO_L28P_0 | B16 | I/O |
| 0 | IO_L29N_0 | IO_L29N_0 | J17 | I/O |
| 0 | IO_L29P_0 | IO_L29P_0 | H17 | I/O |
| 0 | IO_L30N_0 | IO_L30N_0 | G17 | I/O |
| 0 | IO_L30P_0 | IO_L30P_0 | F17 | I/O |
| 0 | IO_L31N_0 | IO_L31N_0 | D17 | I/O |
| 0 | IO_L31P_0/ VREF_0 | IO_L31P_0/ VREF_0 | C17 | VREF |
| 0 | IO_L32N_0/ GCLK7 | IO_L32N_0/ GCLK7 | B17 | GCLK |
| 0 | IO_L32P_0/ GCLK6 | IO_L32P_0/ GCLK6 | A17 | GCLK |
| 0 | N.C. (◆) | IO_L33N_0 | D7 | I/O |
| 0 | N.C. (◆) | IO_L33P_0 | C7 | I/O |
| 0 | N.C. (◆) | IO_L34N_0 | B7 | I/O |
| 0 | N.C. (◆) | IO_L34P_0 | A7 | I/O |
| 0 | IO_L35N_0 | IO_L35N_0 | E8 | I/O |
| 0 | IO_L35P_0 | IO_L35P_0 | D8 | I/O |
| 0 | IO_L36N_0 | IO_L36N_0 | B8 | I/O |

Table 35: FG1156 Package Pinout (Continued)

| Bank | XC3S4000 Pin Name | XC3S5000 Pin Name | FG1156 Pin Number | Type |
|------|----------------------|----------------------|-------------------------|------|
| 0 | IO_L36P_0 | IO_L36P_0 | A8 | I/O |
| 0 | IO_L37N_0 | IO_L37N_0 | D10 | I/O |
| 0 | IO_L37P_0 | IO_L37P_0 | C10 | I/O |
| 0 | IO_L38N_0 | IO_L38N_0 | B10 | I/O |
| 0 | IO_L38P_0 | IO_L38P_0 | A10 | I/O |
| 0 | N.C. (◆) | IO_L39N_0 | G11 | I/O |
| 0 | N.C. (◆) | IO_L39P_0 | F11 | I/O |
| 0 | N.C. (◆) | IO_L40N_0 | B11 | I/O |
| 0 | N.C. (◆) | IO_L40P_0 | A11 | I/O |
| 0 | VCCO_0 | VCCO_0 | B13 | VCCO |
| 0 | VCCO_0 | VCCO_0 | C4 | VCCO |
| 0 | VCCO_0 | VCCO_0 | C8 | VCCO |
| 0 | VCCO_0 | VCCO_0 | D11 | VCCO |
| 0 | VCCO_0 | VCCO_0 | D16 | VCCO |
| 0 | VCCO_0 | VCCO_0 | F13 | VCCO |
| 0 | VCCO_0 | VCCO_0 | G8 | VCCO |
| 0 | VCCO_0 | VCCO_0 | H11 | VCCO |
| 0 | VCCO_0 | VCCO_0 | H15 | VCCO |
| 0 | VCCO_0 | VCCO_0 | M13 | VCCO |
| 0 | VCCO_0 | VCCO_0 | M14 | VCCO |
| 0 | VCCO_0 | VCCO_0 | M15 | VCCO |
| 0 | VCCO_0 | VCCO_0 | M16 | VCCO |
| 1 | IO | IO | B26 | I/O |
| 1 | IO | IO | A18 | I/O |
| 1 | IO | IO | C23 | I/O |
| 1 | IO | IO | E21 | I/O |
| 1 | IO | IO | E25 | I/O |
| 1 | IO | IO | F18 | I/O |
| 1 | IO | IO | F27 | I/O |
| 1 | IO | IO | F29 | I/O |
| 1 | IO | IO | H23 | I/O |
| 1 | IO | IO | H26 | I/O |
| 1 | N.C. (◆) | IO | J26 | I/O |
| 1 | IO | IO | K19 | I/O |
| 1 | IO | IO | L19 | I/O |
| 1 | IO | IO | L20 | I/O |
| 1 | IO | IO | L21 | I/O |
| 1 | N.C. (◆) | IO | L23 | I/O |
| 1 | IO | IO | L24 | I/O |
| 1 | IO/VREF_1 | IO/VREF_1 | D30 | VREF |
| 1 | IO/VREF_1 | IO/VREF_1 | K21 | VREF |

Table 35: FG1156 Package Pinout (Continued)

| Bank | XC3S4000 Pin Name | XC3S5000 Pin Name | FG1156 Pin Number | Type |
|------|----------------------|----------------------|-------------------------|------|
| 1 | IO/VREF_1 | IO/VREF_1 | L18 | VREF |
| 1 | IO_L01N_1/ VRP_1 | IO_L01N_1/ VRP_1 | A32 | DCI |
| 1 | IO_L01P_1/ VRN_1 | IO_L01P_1/ VRN_1 | B32 | DCI |
| 1 | IO_L02N_1 | IO_L02N_1 | A31 | I/O |
| 1 | IO_L02P_1 | IO_L02P_1 | B31 | I/O |
| 1 | IO_L03N_1 | IO_L03N_1 | B30 | I/O |
| 1 | IO_L03P_1 | IO_L03P_1 | C30 | I/O |
| 1 | IO_L04N_1 | IO_L04N_1 | C29 | I/O |
| 1 | IO_L04P_1 | IO_L04P_1 | D29 | I/O |
| 1 | IO_L05N_1 | IO_L05N_1 | A29 | I/O |
| 1 | IO_L05P_1 | IO_L05P_1 | B29 | I/O |
| 1 | IO_L06N_1/ VREF_1 | IO_L06N_1/ VREF_1 | E28 | VREF |
| 1 | IO_L06P_1 | IO_L06P_1 | F28 | I/O |
| 1 | IO_L07N_1 | IO_L07N_1 | D27 | I/O |
| 1 | IO_L07P_1 | IO_L07P_1 | E27 | I/O |
| 1 | IO_L08N_1 | IO_L08N_1 | A27 | I/O |
| 1 | IO_L08P_1 | IO_L08P_1 | B27 | I/O |
| 1 | IO_L09N_1 | IO_L09N_1 | F26 | I/O |
| 1 | IO_L09P_1 | IO_L09P_1 | G26 | I/O |
| 1 | IO_L10N_1/ VREF_1 | IO_L10N_1/ VREF_1 | C26 | VREF |
| 1 | IO_L10P_1 | IO_L10P_1 | D26 | I/O |
| 1 | IO_L11N_1 | IO_L11N_1 | H25 | I/O |
| 1 | IO_L11P_1 | IO_L11P_1 | J25 | I/O |
| 1 | IO_L12N_1 | IO_L12N_1 | F25 | I/O |
| 1 | IO_L12P_1 | IO_L12P_1 | G25 | I/O |
| 1 | IO_L13N_1 | IO_L13N_1 | C25 | I/O |
| 1 | IO_L13P_1 | IO_L13P_1 | D25 | I/O |
| 1 | IO_L14N_1 | IO_L14N_1 | A25 | I/O |
| 1 | IO_L14P_1 | IO_L14P_1 | B25 | I/O |
| 1 | IO_L15N_1 | IO_L15N_1 | A24 | I/O |
| 1 | IO_L15P_1 | IO_L15P_1 | B24 | I/O |
| 1 | IO_L16N_1 | IO_L16N_1 | J23 | I/O |
| 1 | IO_L16P_1 | IO_L16P_1 | K23 | I/O |
| 1 | IO_L17N_1/ VREF_1 | IO_L17N_1/ VREF_1 | F23 | VREF |
| 1 | IO_L17P_1 | IO_L17P_1 | G23 | I/O |
| 1 | IO_L18N_1 | IO_L18N_1 | D23 | I/O |
| 1 | IO_L18P_1 | IO_L18P_1 | E23 | I/O |

Table 35: FG1156 Package Pinout (Continued)

| Bank | XC3S4000 Pin Name | XC3S5000 Pin Name | FG1156 Pin Number | Type |
|------|----------------------|----------------------|-------------------------|------|
| 1 | IO_L19N_1 | IO_L19N_1 | A23 | I/O |
| 1 | IO_L19P_1 | IO_L19P_1 | B23 | I/O |
| 1 | IO_L20N_1 | IO_L20N_1 | K22 | I/O |
| 1 | IO_L20P_1 | IO_L20P_1 | L22 | I/O |
| 1 | IO_L21N_1 | IO_L21N_1 | G22 | I/O |
| 1 | IO_L21P_1 | IO_L21P_1 | H22 | I/O |
| 1 | IO_L22N_1 | IO_L22N_1 | C22 | I/O |
| 1 | IO_L22P_1 | IO_L22P_1 | D22 | I/O |
| 1 | IO_L23N_1 | IO_L23N_1 | H21 | I/O |
| 1 | IO_L23P_1 | IO_L23P_1 | J21 | I/O |
| 1 | IO_L24N_1 | IO_L24N_1 | F21 | I/O |
| 1 | IO_L24P_1 | IO_L24P_1 | G21 | I/O |
| 1 | IO_L25N_1 | IO_L25N_1 | C21 | I/O |
| 1 | IO_L25P_1 | IO_L25P_1 | D21 | I/O |
| 1 | IO_L26N_1 | IO_L26N_1 | A21 | I/O |
| 1 | IO_L26P_1 | IO_L26P_1 | B21 | I/O |
| 1 | IO_L27N_1 | IO_L27N_1 | F19 | I/O |
| 1 | IO_L27P_1 | IO_L27P_1 | G19 | I/O |
| 1 | IO_L28N_1 | IO_L28N_1 | B19 | I/O |
| 1 | IO_L28P_1 | IO_L28P_1 | C19 | I/O |
| 1 | IO_L29N_1 | IO_L29N_1 | J18 | I/O |
| 1 | IO_L29P_1 | IO_L29P_1 | K18 | I/O |
| 1 | IO_L30N_1 | IO_L30N_1 | G18 | I/O |
| 1 | IO_L30P_1 | IO_L30P_1 | H18 | I/O |
| 1 | IO_L31N_1/ VREF_1 | IO_L31N_1/ VREF_1 | D18 | VREF |
| 1 | IO_L31P_1 | IO_L31P_1 | E18 | I/O |
| 1 | IO_L32N_1/ GCLK5 | IO_L32N_1/ GCLK5 | B18 | GCLK |
| 1 | IO_L32P_1/ GCLK4 | IO_L32P_1/ GCLK4 | C18 | GCLK |
| 1 | N.C. (◆) | IO_L33N_1 | C28 | I/O |
| 1 | N.C. (◆) | IO_L33P_1 | D28 | I/O |
| 1 | N.C. (◆) | IO_L34N_1 | A28 | I/O |
| 1 | N.C. (◆) | IO_L34P_1 | B28 | I/O |
| 1 | N.C. (◆) | IO_L35N_1 | J24 | I/O |
| 1 | N.C. (◆) | IO_L35P_1 | K24 | I/O |
| 1 | N.C. (◆) | IO_L36N_1 | F24 | I/O |
| 1 | N.C. (◆) | IO_L36P_1 | G24 | I/O |
| 1 | IO_L37N_1 | IO_L37N_1 | J20 | I/O |
| 1 | IO_L37P_1 | IO_L37P_1 | K20 | I/O |
| 1 | IO_L38N_1 | IO_L38N_1 | F20 | I/O |

Table 35: FG1156 Package Pinout (Continued)

| Bank | XC3S4000 Pin Name | XC3S5000 Pin Name | FG1156 Pin Number | Type |
|------|----------------------|----------------------|-------------------------|------|
| 1 | IO_L38P_1 | IO_L38P_1 | G20 | I/O |
| 1 | IO_L39N_1 | IO_L39N_1 | C20 | I/O |
| 1 | IO_L39P_1 | IO_L39P_1 | D20 | I/O |
| 1 | IO_L40N_1 | IO_L40N_1 | A20 | I/O |
| 1 | IO_L40P_1 | IO_L40P_1 | B20 | I/O |
| 1 | VCCO_1 | VCCO_1 | B22 | VCCO |
| 1 | VCCO_1 | VCCO_1 | C27 | VCCO |
| 1 | VCCO_1 | VCCO_1 | C31 | VCCO |
| 1 | VCCO_1 | VCCO_1 | D19 | VCCO |
| 1 | VCCO_1 | VCCO_1 | D24 | VCCO |
| 1 | VCCO_1 | VCCO_1 | F22 | VCCO |
| 1 | VCCO_1 | VCCO_1 | G27 | VCCO |
| 1 | VCCO_1 | VCCO_1 | H20 | VCCO |
| 1 | VCCO_1 | VCCO_1 | H24 | VCCO |
| 1 | VCCO_1 | VCCO_1 | M19 | VCCO |
| 1 | VCCO_1 | VCCO_1 | M20 | VCCO |
| 1 | VCCO_1 | VCCO_1 | M21 | VCCO |
| 1 | VCCO_1 | VCCO_1 | M22 | VCCO |
| 2 | IO | IO | G33 | I/O |
| 2 | IO | IO | G34 | I/O |
| 2 | IO | IO | U25 | I/O |
| 2 | IO | IO | U26 | I/O |
| 2 | IO_L01N_2/ VRP_2 | IO_L01N_2/ VRP_2 | C33 | DCI |
| 2 | IO_L01P_2/ VRN_2 | IO_L01P_2/ VRN_2 | C34 | DCI |
| 2 | IO_L02N_2 | IO_L02N_2 | D33 | I/O |
| 2 | IO_L02P_2 | IO_L02P_2 | D34 | I/O |
| 2 | IO_L03N_2/ VREF_2 | IO_L03N_2/ VREF_2 | E32 | VREF |
| 2 | IO_L03P_2 | IO_L03P_2 | E33 | I/O |
| 2 | IO_L04N_2 | IO_L04N_2 | F31 | I/O |
| 2 | IO_L04P_2 | IO_L04P_2 | F32 | I/O |
| 2 | IO_L05N_2 | IO_L05N_2 | G29 | I/O |
| 2 | IO_L05P_2 | IO_L05P_2 | G30 | I/O |
| 2 | IO_L06N_2 | IO_L06N_2 | H29 | I/O |
| 2 | IO_L06P_2 | IO_L06P_2 | H30 | I/O |
| 2 | IO_L07N_2 | IO_L07N_2 | H33 | I/O |
| 2 | IO_L07P_2 | IO_L07P_2 | H34 | I/O |
| 2 | IO_L08N_2 | IO_L08N_2 | J28 | I/O |
| 2 | IO_L08P_2 | IO_L08P_2 | J29 | I/O |

Table 35: FG1156 Package Pinout (Continued)

| Bank | XC3S4000 Pin Name | XC3S5000 Pin Name | FG1156 Pin Number | Type |
|------|----------------------|----------------------|-------------------------|------|
| 2 | IO_L09N_2/ VREF_2 | IO_L09N_2/ VREF_2 | H31 | VREF |
| 2 | IO_L09P_2 | IO_L09P_2 | J31 | I/O |
| 2 | IO_L10N_2 | IO_L10N_2 | J32 | I/O |
| 2 | IO_L10P_2 | IO_L10P_2 | J33 | I/O |
| 2 | IO_L11N_2 | IO_L11N_2 | J27 | I/O |
| 2 | IO_L11P_2 | IO_L11P_2 | K26 | I/O |
| 2 | IO_L12N_2 | IO_L12N_2 | K27 | I/O |
| 2 | IO_L12P_2 | IO_L12P_2 | K28 | I/O |
| 2 | IO_L13N_2 | IO_L13N_2 | K29 | I/O |
| 2 | IO_L13P_2/ VREF_2 | IO_L13P_2/ VREF_2 | K30 | VREF |
| 2 | IO_L14N_2 | IO_L14N_2 | K31 | I/O |
| 2 | IO_L14P_2 | IO_L14P_2 | K32 | I/O |
| 2 | IO_L15N_2 | IO_L15N_2 | K33 | I/O |
| 2 | IO_L15P_2 | IO_L15P_2 | K34 | I/O |
| 2 | IO_L16N_2 | IO_L16N_2 | L25 | I/O |
| 2 | IO_L16P_2 | IO_L16P_2 | L26 | I/O |
| 2 | N.C. (◆) | IO_L17N_2 | L28 | I/O |
| 2 | N.C. (◆) | IO_L17P_2/ VREF_2 | L29 | VREF |
| 2 | IO_L19N_2 | IO_L19N_2 | M29 | I/O |
| 2 | IO_L19P_2 | IO_L19P_2 | M30 | I/O |
| 2 | IO_L20N_2 | IO_L20N_2 | M31 | I/O |
| 2 | IO_L20P_2 | IO_L20P_2 | M32 | I/O |
| 2 | IO_L21N_2 | IO_L21N_2 | M26 | I/O |
| 2 | IO_L21P_2 | IO_L21P_2 | N25 | I/O |
| 2 | IO_L22N_2 | IO_L22N_2 | N27 | I/O |
| 2 | IO_L22P_2 | IO_L22P_2 | N28 | I/O |
| 2 | IO_L23N_2/ VREF_2 | IO_L23N_2/ VREF_2 | N31 | VREF |
| 2 | IO_L23P_2 | IO_L23P_2 | N32 | I/O |
| 2 | IO_L24N_2 | IO_L24N_2 | N24 | I/O |
| 2 | IO_L24P_2 | IO_L24P_2 | P24 | I/O |
| 2 | IO_L26N_2 | IO_L26N_2 | P29 | I/O |
| 2 | IO_L26P_2 | IO_L26P_2 | P30 | I/O |
| 2 | IO_L27N_2 | IO_L27N_2 | P31 | I/O |
| 2 | IO_L27P_2 | IO_L27P_2 | P32 | I/O |
| 2 | IO_L28N_2 | IO_L28N_2 | P33 | I/O |
| 2 | IO_L28P_2 | IO_L28P_2 | P34 | I/O |
| 2 | IO_L29N_2 | IO_L29N_2 | R24 | I/O |
| 2 | IO_L29P_2 | IO_L29P_2 | R25 | I/O |

Table 35: FG1156 Package Pinout (Continued)

| Bank | XC3S4000 Pin Name | XC3S5000 Pin Name | FG1156 Pin Number | Type |
|------|----------------------|----------------------|-------------------------|------|
| 2 | IO_L30N_2 | IO_L30N_2 | R28 | I/O |
| 2 | IO_L30P_2 | IO_L30P_2 | R29 | I/O |
| 2 | IO_L31N_2 | IO_L31N_2 | R31 | I/O |
| 2 | IO_L31P_2 | IO_L31P_2 | R32 | I/O |
| 2 | IO_L32N_2 | IO_L32N_2 | R33 | I/O |
| 2 | IO_L32P_2 | IO_L32P_2 | R34 | I/O |
| 2 | IO_L33N_2 | IO_L33N_2 | R26 | I/O |
| 2 | IO_L33P_2 | IO_L33P_2 | T25 | I/O |
| 2 | IO_L34N_2/ VREF_2 | IO_L34N_2/ VREF_2 | T28 | VREF |
| 2 | IO_L34P_2 | IO_L34P_2 | T29 | I/O |
| 2 | IO_L35N_2 | IO_L35N_2 | T32 | I/O |
| 2 | IO_L35P_2 | IO_L35P_2 | T33 | I/O |
| 2 | IO_L37N_2 | IO_L37N_2 | U27 | I/O |
| 2 | IO_L37P_2 | IO_L37P_2 | U28 | I/O |
| 2 | IO_L38N_2 | IO_L38N_2 | U29 | I/O |
| 2 | IO_L38P_2 | IO_L38P_2 | U30 | I/O |
| 2 | IO_L39N_2 | IO_L39N_2 | U31 | I/O |
| 2 | IO_L39P_2 | IO_L39P_2 | U32 | I/O |
| 2 | IO_L40N_2 | IO_L40N_2 | U33 | I/O |
| 2 | IO_L40P_2/ VREF_2 | IO_L40P_2/ VREF_2 | U34 | VREF |
| 2 | IO_L41N_2 | IO_L41N_2 | F33 | I/O |
| 2 | IO_L41P_2 | IO_L41P_2 | F34 | I/O |
| 2 | N.C. (◆) | IO_L42N_2 | G31 | I/O |
| 2 | N.C. (◆) | IO_L42P_2 | G32 | I/O |
| 2 | IO_L45N_2 | IO_L45N_2 | L33 | I/O |
| 2 | IO_L45P_2 | IO_L45P_2 | L34 | I/O |
| 2 | IO_L46N_2 | IO_L46N_2 | M24 | I/O |
| 2 | IO_L46P_2 | IO_L46P_2 | M25 | I/O |
| 2 | IO_L47N_2 | IO_L47N_2 | M27 | I/O |
| 2 | IO_L47P_2 | IO_L47P_2 | M28 | I/O |
| 2 | IO_L48N_2 | IO_L48N_2 | M33 | I/O |
| 2 | IO_L48P_2 | IO_L48P_2 | M34 | I/O |
| 2 | N.C. (◆) | IO_L49N_2 | P25 | I/O |
| 2 | N.C. (◆) | IO_L49P_2 | P26 | I/O |
| 2 | IO_L50N_2 | IO_L50N_2 | P27 | I/O |
| 2 | IO_L50P_2 | IO_L50P_2 | P28 | I/O |
| 2 | N.C. (◆) | IO_L51N_2 | T24 | I/O |
| 2 | N.C. (◆) | IO_L51P_2 | U24 | I/O |
| 2 | VCCO_2 | VCCO_2 | D32 | VCCO |
| 2 | VCCO_2 | VCCO_2 | H28 | VCCO |

Table 35: FG1156 Package Pinout (Continued)

| Bank | XC3S4000 Pin Name | XC3S5000 Pin Name | FG1156 Pin Number | Type |
|------|----------------------|----------------------|-------------------------|------|
| 2 | VCCO_2 | VCCO_2 | H32 | VCCO |
| 2 | VCCO_2 | VCCO_2 | L27 | VCCO |
| 2 | VCCO_2 | VCCO_2 | L31 | VCCO |
| 2 | VCCO_2 | VCCO_2 | N23 | VCCO |
| 2 | VCCO_2 | VCCO_2 | N29 | VCCO |
| 2 | VCCO_2 | VCCO_2 | N33 | VCCO |
| 2 | VCCO_2 | VCCO_2 | P23 | VCCO |
| 2 | VCCO_2 | VCCO_2 | R23 | VCCO |
| 2 | VCCO_2 | VCCO_2 | R27 | VCCO |
| 2 | VCCO_2 | VCCO_2 | T23 | VCCO |
| 2 | VCCO_2 | VCCO_2 | T31 | VCCO |
| 3 | IO | IO | AH33 | I/O |
| 3 | IO | IO | AH34 | I/O |
| 3 | IO | IO | V25 | I/O |
| 3 | IO | IO | V26 | I/O |
| 3 | IO_L01N_3/ VRP_3 | IO_L01N_3/ VRP_3 | AM34 | DCI |
| 3 | IO_L01P_3/ VRN_3 | IO_L01P_3/ VRN_3 | AM33 | DCI |
| 3 | IO_L02N_3/ VREF_3 | IO_L02N_3/ VREF_3 | AL34 | VREF |
| 3 | IO_L02P_3 | IO_L02P_3 | AL33 | I/O |
| 3 | IO_L03N_3 | IO_L03N_3 | AK33 | I/O |
| 3 | IO_L03P_3 | IO_L03P_3 | AK32 | I/O |
| 3 | IO_L04N_3 | IO_L04N_3 | AJ32 | I/O |
| 3 | IO_L04P_3 | IO_L04P_3 | AJ31 | I/O |
| 3 | IO_L05N_3 | IO_L05N_3 | AJ34 | I/O |
| 3 | IO_L05P_3 | IO_L05P_3 | AJ33 | I/O |
| 3 | IO_L06N_3 | IO_L06N_3 | AH30 | I/O |
| 3 | IO_L06P_3 | IO_L06P_3 | AH29 | I/O |
| 3 | IO_L07N_3 | IO_L07N_3 | AG30 | I/O |
| 3 | IO_L07P_3 | IO_L07P_3 | AG29 | I/O |
| 3 | IO_L08N_3 | IO_L08N_3 | AG34 | I/O |
| 3 | IO_L08P_3 | IO_L08P_3 | AG33 | I/O |
| 3 | IO_L09N_3 | IO_L09N_3 | AF29 | I/O |
| 3 | IO_L09P_3/ VREF_3 | IO_L09P_3/ VREF_3 | AF28 | VREF |
| 3 | IO_L10N_3 | IO_L10N_3 | AF31 | I/O |
| 3 | IO_L10P_3 | IO_L10P_3 | AG31 | I/O |
| 3 | IO_L11N_3 | IO_L11N_3 | AF33 | I/O |
| 3 | IO_L11P_3 | IO_L11P_3 | AF32 | I/O |
| 3 | IO_L12N_3 | IO_L12N_3 | AE26 | I/O |

Table 35: FG1156 Package Pinout (Continued)

| Bank | XC3S4000 Pin Name | XC3S5000 Pin Name | FG1156 Pin Number | Type |
|------|----------------------|----------------------|-------------------------|------|
| 3 | IO_L12P_3 | IO_L12P_3 | AF27 | I/O |
| 3 | IO_L13N_3/ VREF_3 | IO_L13N_3/ VREF_3 | AE28 | VREF |
| 3 | IO_L13P_3 | IO_L13P_3 | AE27 | I/O |
| 3 | IO_L14N_3 | IO_L14N_3 | AE30 | I/O |
| 3 | IO_L14P_3 | IO_L14P_3 | AE29 | I/O |
| 3 | IO_L15N_3 | IO_L15N_3 | AE32 | I/O |
| 3 | IO_L15P_3 | IO_L15P_3 | AE31 | I/O |
| 3 | IO_L16N_3 | IO_L16N_3 | AE34 | I/O |
| 3 | IO_L16P_3 | IO_L16P_3 | AE33 | I/O |
| 3 | IO_L17N_3 | IO_L17N_3 | AD26 | I/O |
| 3 | IO_L17P_3/ VREF_3 | IO_L17P_3/ VREF_3 | AD25 | VREF |
| 3 | IO_L19N_3 | IO_L19N_3 | AD34 | I/O |
| 3 | IO_L19P_3 | IO_L19P_3 | AD33 | I/O |
| 3 | IO_L20N_3 | IO_L20N_3 | AC25 | I/O |
| 3 | IO_L20P_3 | IO_L20P_3 | AC24 | I/O |
| 3 | IO_L21N_3 | IO_L21N_3 | AC28 | I/O |
| 3 | IO_L21P_3 | IO_L21P_3 | AC27 | I/O |
| 3 | IO_L22N_3 | IO_L22N_3 | AC30 | I/O |
| 3 | IO_L22P_3 | IO_L22P_3 | AC29 | I/O |
| 3 | IO_L23N_3 | IO_L23N_3 | AC32 | I/O |
| 3 | IO_L23P_3/ VREF_3 | IO_L23P_3/ VREF_3 | AC31 | VREF |
| 3 | IO_L24N_3 | IO_L24N_3 | AB25 | I/O |
| 3 | IO_L24P_3 | IO_L24P_3 | AC26 | I/O |
| 3 | IO_L26N_3 | IO_L26N_3 | AA28 | I/O |
| 3 | IO_L26P_3 | IO_L26P_3 | AA27 | I/O |
| 3 | IO_L27N_3 | IO_L27N_3 | AA30 | I/O |
| 3 | IO_L27P_3 | IO_L27P_3 | AA29 | I/O |
| 3 | IO_L28N_3 | IO_L28N_3 | AA32 | I/O |
| 3 | IO_L28P_3 | IO_L28P_3 | AA31 | I/O |
| 3 | IO_L29N_3 | IO_L29N_3 | AA34 | I/O |
| 3 | IO_L29P_3 | IO_L29P_3 | AA33 | I/O |
| 3 | IO_L30N_3 | IO_L30N_3 | Y29 | I/O |
| 3 | IO_L30P_3 | IO_L30P_3 | Y28 | I/O |
| 3 | IO_L31N_3 | IO_L31N_3 | Y32 | I/O |
| 3 | IO_L31P_3 | IO_L31P_3 | Y31 | I/O |
| 3 | IO_L32N_3 | IO_L32N_3 | Y34 | I/O |
| 3 | IO_L32P_3 | IO_L32P_3 | Y33 | I/O |
| 3 | IO_L33N_3 | IO_L33N_3 | W25 | I/O |
| 3 | IO_L33P_3 | IO_L33P_3 | Y26 | I/O |

Table 35: FG1156 Package Pinout (Continued)

| Bank | XC3S4000 Pin Name | XC3S5000 Pin Name | FG1156 Pin Number | Type |
|------|----------------------|----------------------|-------------------------|------|
| 3 | IO_L34N_3 | IO_L34N_3 | W29 | I/O |
| 3 | IO_L34P_3/ VREF_3 | IO_L34P_3/ VREF_3 | W28 | VREF |
| 3 | IO_L35N_3 | IO_L35N_3 | W33 | I/O |
| 3 | IO_L35P_3 | IO_L35P_3 | W32 | I/O |
| 3 | IO_L37N_3 | IO_L37N_3 | V28 | I/O |
| 3 | IO_L37P_3 | IO_L37P_3 | V27 | I/O |
| 3 | IO_L38N_3 | IO_L38N_3 | V30 | I/O |
| 3 | IO_L38P_3 | IO_L38P_3 | V29 | I/O |
| 3 | IO_L39N_3 | IO_L39N_3 | V32 | I/O |
| 3 | IO_L39P_3 | IO_L39P_3 | V31 | I/O |
| 3 | IO_L40N_3/ VREF_3 | IO_L40N_3/ VREF_3 | V34 | VREF |
| 3 | IO_L40P_3 | IO_L40P_3 | V33 | I/O |
| 3 | N.C. (◆) | IO_L41N_3 | AH32 | I/O |
| 3 | N.C. (◆) | IO_L41P_3 | AH31 | I/O |
| 3 | N.C. (◆) | IO_L44N_3 | AD29 | I/O |
| 3 | N.C. (◆) | IO_L44P_3 | AD28 | I/O |
| 3 | IO_L45N_3 | IO_L45N_3 | AC34 | I/O |
| 3 | IO_L45P_3 | IO_L45P_3 | AC33 | I/O |
| 3 | IO_L46N_3 | IO_L46N_3 | AB28 | I/O |
| 3 | IO_L46P_3 | IO_L46P_3 | AB27 | I/O |
| 3 | IO_L47N_3 | IO_L47N_3 | AB32 | I/O |
| 3 | IO_L47P_3 | IO_L47P_3 | AB31 | I/O |
| 3 | IO_L48N_3 | IO_L48N_3 | AA24 | I/O |
| 3 | IO_L48P_3 | IO_L48P_3 | AB24 | I/O |
| 3 | N.C. (◆) | IO_L49N_3 | AA26 | I/O |
| 3 | N.C. (◆) | IO_L49P_3 | AA25 | I/O |
| 3 | IO_L50N_3 | IO_L50N_3 | Y25 | I/O |
| 3 | IO_L50P_3 | IO_L50P_3 | Y24 | I/O |
| 3 | N.C. (◆) | IO_L51N_3 | V24 | I/O |
| 3 | N.C. (◆) | IO_L51P_3 | W24 | I/O |
| 3 | VCCO_3 | VCCO_3 | AA23 | VCCO |
| 3 | VCCO_3 | VCCO_3 | AB23 | VCCO |
| 3 | VCCO_3 | VCCO_3 | AB29 | VCCO |
| 3 | VCCO_3 | VCCO_3 | AB33 | VCCO |
| 3 | VCCO_3 | VCCO_3 | AD27 | VCCO |
| 3 | VCCO_3 | VCCO_3 | AD31 | VCCO |
| 3 | VCCO_3 | VCCO_3 | AG28 | VCCO |
| 3 | VCCO_3 | VCCO_3 | AG32 | VCCO |
| 3 | VCCO_3 | VCCO_3 | AL32 | VCCO |
| 3 | VCCO_3 | VCCO_3 | W23 | VCCO |

Table 35: FG1156 Package Pinout (Continued)

| Bank | XC3S4000 Pin Name | XC3S5000 Pin Name | FG1156 Pin Number | Type |
|------|----------------------|----------------------|-------------------------|------|
| 3 | VCCO_3 | VCCO_3 | W31 | VCCO |
| 3 | VCCO_3 | VCCO_3 | Y23 | VCCO |
| 3 | VCCO_3 | VCCO_3 | Y27 | VCCO |
| 4 | IO | IO | AD18 | I/O |
| 4 | IO | IO | AD19 | I/O |
| 4 | IO | IO | AD20 | I/O |
| 4 | IO | IO | AD22 | I/O |
| 4 | IO | IO | AE18 | I/O |
| 4 | IO | IO | AE19 | I/O |
| 4 | IO | IO | AE22 | I/O |
| 4 | N.C. (◆) | IO | AE24 | I/O |
| 4 | IO | IO | AF24 | I/O |
| 4 | N.C. (◆) | IO | AF26 | I/O |
| 4 | IO | IO | AG26 | I/O |
| 4 | IO | IO | AG27 | I/O |
| 4 | IO | IO | AJ27 | I/O |
| 4 | IO | IO | AJ29 | I/O |
| 4 | IO | IO | AK25 | I/O |
| 4 | IO | IO | AN26 | I/O |
| 4 | IO/VREF_4 | IO/VREF_4 | AF21 | VREF |
| 4 | IO/VREF_4 | IO/VREF_4 | AH23 | VREF |
| 4 | IO/VREF_4 | IO/VREF_4 | AK18 | VREF |
| 4 | IO/VREF_4 | IO/VREF_4 | AL30 | VREF |
| 4 | IO_L01N_4/ VRP_4 | IO_L01N_4/ VRP_4 | AN32 | DCI |
| 4 | IO_L01P_4/ VRN_4 | IO_L01P_4/ VRN_4 | AP32 | DCI |
| 4 | IO_L02N_4 | IO_L02N_4 | AN31 | I/O |
| 4 | IO_L02P_4 | IO_L02P_4 | AP31 | I/O |
| 4 | IO_L03N_4 | IO_L03N_4 | AM30 | I/O |
| 4 | IO_L03P_4 | IO_L03P_4 | AN30 | I/O |
| 4 | IO_L04N_4 | IO_L04N_4 | AN27 | I/O |
| 4 | IO_L04P_4 | IO_L04P_4 | AP27 | I/O |
| 4 | IO_L05N_4 | IO_L05N_4 | AH26 | I/O |
| 4 | IO_L05P_4 | IO_L05P_4 | AJ26 | I/O |
| 4 | IO_L06N_4/ VREF_4 | IO_L06N_4/ VREF_4 | AL26 | VREF |
| 4 | IO_L06P_4 | IO_L06P_4 | AM26 | I/O |
| 4 | IO_L07N_4 | IO_L07N_4 | AF25 | I/O |
| 4 | IO_L07P_4 | IO_L07P_4 | AG25 | I/O |
| 4 | IO_L08N_4 | IO_L08N_4 | AH25 | I/O |
| 4 | IO_L08P_4 | IO_L08P_4 | AJ25 | I/O |

Table 35: FG1156 Package Pinout (Continued)

| Bank | XC3S4000 Pin Name | XC3S5000 Pin Name | FG1156 Pin Number | Type |
|------|----------------------|----------------------|-------------------------|------|
| 4 | IO_L09N_4 | IO_L09N_4 | AL25 | I/O |
| 4 | IO_L09P_4 | IO_L09P_4 | AM25 | I/O |
| 4 | IO_L10N_4 | IO_L10N_4 | AN25 | I/O |
| 4 | IO_L10P_4 | IO_L10P_4 | AP25 | I/O |
| 4 | IO_L11N_4 | IO_L11N_4 | AD23 | I/O |
| 4 | IO_L11P_4 | IO_L11P_4 | AE23 | I/O |
| 4 | IO_L12N_4 | IO_L12N_4 | AF23 | I/O |
| 4 | IO_L12P_4 | IO_L12P_4 | AG23 | I/O |
| 4 | IO_L13N_4 | IO_L13N_4 | AJ23 | I/O |
| 4 | IO_L13P_4 | IO_L13P_4 | AK23 | I/O |
| 4 | IO_L14N_4 | IO_L14N_4 | AL23 | I/O |
| 4 | IO_L14P_4 | IO_L14P_4 | AM23 | I/O |
| 4 | IO_L15N_4 | IO_L15N_4 | AN23 | I/O |
| 4 | IO_L15P_4 | IO_L15P_4 | AP23 | I/O |
| 4 | IO_L16N_4 | IO_L16N_4 | AG22 | I/O |
| 4 | IO_L16P_4 | IO_L16P_4 | AH22 | I/O |
| 4 | IO_L17N_4 | IO_L17N_4 | AL22 | I/O |
| 4 | IO_L17P_4 | IO_L17P_4 | AM22 | I/O |
| 4 | IO_L18N_4 | IO_L18N_4 | AD21 | I/O |
| 4 | IO_L18P_4 | IO_L18P_4 | AE21 | I/O |
| 4 | IO_L19N_4 | IO_L19N_4 | AG21 | I/O |
| 4 | IO_L19P_4 | IO_L19P_4 | AH21 | I/O |
| 4 | IO_L20N_4 | IO_L20N_4 | AJ21 | I/O |
| 4 | IO_L20P_4 | IO_L20P_4 | AK21 | I/O |
| 4 | IO_L21N_4 | IO_L21N_4 | AL21 | I/O |
| 4 | IO_L21P_4 | IO_L21P_4 | AM21 | I/O |
| 4 | IO_L22N_4/ VREF_4 | IO_L22N_4/ VREF_4 | AN21 | VREF |
| 4 | IO_L22P_4 | IO_L22P_4 | AP21 | I/O |
| 4 | IO_L23N_4 | IO_L23N_4 | AE20 | I/O |
| 4 | IO_L23P_4 | IO_L23P_4 | AF20 | I/O |
| 4 | IO_L24N_4 | IO_L24N_4 | AH20 | I/O |
| 4 | IO_L24P_4 | IO_L24P_4 | AJ20 | I/O |
| 4 | IO_L25N_4 | IO_L25N_4 | AL20 | I/O |
| 4 | IO_L25P_4 | IO_L25P_4 | AM20 | I/O |
| 4 | IO_L26N_4 | IO_L26N_4 | AN20 | I/O |
| 4 | IO_L26P_4/ VREF_4 | IO_L26P_4/ VREF_4 | AP20 | VREF |
| 4 | IO_L27N_4/ DIN/D0 | IO_L27N_4/ DIN/D0 | AH19 | DUAL |
| 4 | IO_L27P_4/ D1 | IO_L27P_4/ D1 | AJ19 | DUAL |

Table 35: FG1156 Package Pinout (Continued)

| Bank | XC3S4000 Pin Name | XC3S5000 Pin Name | FG1156 Pin Number | Type |
|------|-------------------------|-------------------------|-------------------------|------|
| 4 | IO_L28N_4 | IO_L28N_4 | AM19 | I/O |
| 4 | IO_L28P_4 | IO_L28P_4 | AN19 | I/O |
| 4 | IO_L29N_4 | IO_L29N_4 | AF18 | I/O |
| 4 | IO_L29P_4 | IO_L29P_4 | AG18 | I/O |
| 4 | IO_L30N_4/ D2 | IO_L30N_4/ D2 | AH18 | DUAL |
| 4 | IO_L30P_4/ D3 | IO_L30P_4/ D3 | AJ18 | DUAL |
| 4 | IO_L31N_4/ INIT_B_B | IO_L31N_4/ INIT_B_B | AL18 | DUAL |
| 4 | IO_L31P_4/ DOUT/BUSY | IO_L31P_4/ DOUT/BUSY | AM18 | DUAL |
| 4 | IO_L32N_4/ GCLK1 | IO_L32N_4/ GCLK1 | AN18 | GCLK |
| 4 | IO_L32P_4/ GCLK0 | IO_L32P_4/ GCLK0 | AP18 | GCLK |
| 4 | IO_L33N_4 | IO_L33N_4 | AL29 | I/O |
| 4 | IO_L33P_4 | IO_L33P_4 | AM29 | I/O |
| 4 | IO_L34N_4 | IO_L34N_4 | AN29 | I/O |
| 4 | IO_L34P_4 | IO_L34P_4 | AP29 | I/O |
| 4 | IO_L35N_4 | IO_L35N_4 | AJ28 | I/O |
| 4 | IO_L35P_4 | IO_L35P_4 | AK28 | I/O |
| 4 | N.C. (◆) | IO_L36N_4 | AL28 | I/O |
| 4 | N.C. (◆) | IO_L36P_4 | AM28 | I/O |
| 4 | N.C. (◆) | IO_L37N_4 | AN28 | I/O |
| 4 | N.C. (◆) | IO_L37P_4 | AP28 | I/O |
| 4 | IO_L38N_4 | IO_L38N_4 | AK27 | I/O |
| 4 | IO_L38P_4 | IO_L38P_4 | AL27 | I/O |
| 4 | N.C. (◆) | IO_L39N_4 | AH24 | I/O |
| 4 | N.C. (◆) | IO_L39P_4 | AJ24 | I/O |
| 4 | N.C. (◆) | IO_L40N_4 | AN24 | I/O |
| 4 | N.C. (◆) | IO_L40P_4 | AP24 | I/O |
| 4 | VCCO_4 | VCCO_4 | AC19 | VCCO |
| 4 | VCCO_4 | VCCO_4 | AC20 | VCCO |
| 4 | VCCO_4 | VCCO_4 | AC21 | VCCO |
| 4 | VCCO_4 | VCCO_4 | AC22 | VCCO |
| 4 | VCCO_4 | VCCO_4 | AG20 | VCCO |
| 4 | VCCO_4 | VCCO_4 | AG24 | VCCO |
| 4 | VCCO_4 | VCCO_4 | AH27 | VCCO |
| 4 | VCCO_4 | VCCO_4 | AJ22 | VCCO |
| 4 | VCCO_4 | VCCO_4 | AL19 | VCCO |
| 4 | VCCO_4 | VCCO_4 | AL24 | VCCO |
| 4 | VCCO_4 | VCCO_4 | AM27 | VCCO |

Table 35: FG1156 Package Pinout (Continued)

| Bank | XC3S4000 Pin Name | XC3S5000 Pin Name | FG1156 Pin Number | Type |
|------|----------------------|----------------------|-------------------------|------|
| 4 | VCCO_4 | VCCO_4 | AM31 | VCCO |
| 4 | VCCO_4 | VCCO_4 | AN22 | VCCO |
| 5 | IO | IO | AD11 | I/O |
| 5 | N.C. (◆) | IO | AD12 | I/O |
| 5 | IO | IO | AD14 | I/O |
| 5 | IO | IO | AD15 | I/O |
| 5 | IO | IO | AD16 | I/O |
| 5 | IO | IO | AD17 | I/O |
| 5 | IO | IO | AE14 | I/O |
| 5 | IO | IO | AE16 | I/O |
| 5 | N.C. (◆) | IO | AF9 | I/O |
| 5 | IO | IO | AG9 | I/O |
| 5 | IO | IO | AG12 | I/O |
| 5 | IO | IO | AJ6 | I/O |
| 5 | IO | IO | AJ17 | I/O |
| 5 | IO | IO | AK10 | I/O |
| 5 | IO | IO | AK14 | I/O |
| 5 | IO | IO | AM12 | I/O |
| 5 | IO | IO | AN9 | I/O |
| 5 | IO/VREF_5 | IO/VREF_5 | AJ8 | VREF |
| 5 | IO/VREF_5 | IO/VREF_5 | AL5 | VREF |
| 5 | IO/VREF_5 | IO/VREF_5 | AP17 | VREF |
| 5 | IO_L01N_5/ RDWR_B | IO_L01N_5/ RDWR_B | AP3 | DUAL |
| 5 | IO_L01P_5/ CS_B | IO_L01P_5/ CS_B | AN3 | DUAL |
| 5 | IO_L02N_5 | IO_L02N_5 | AP4 | I/O |
| 5 | IO_L02P_5 | IO_L02P_5 | AN4 | I/O |
| 5 | IO_L03N_5 | IO_L03N_5 | AN5 | I/O |
| 5 | IO_L03P_5 | IO_L03P_5 | AM5 | I/O |
| 5 | IO_L04N_5 | IO_L04N_5 | AM6 | I/O |
| 5 | IO_L04P_5 | IO_L04P_5 | AL6 | I/O |
| 5 | IO_L05N_5 | IO_L05N_5 | AP6 | I/O |
| 5 | IO_L05P_5 | IO_L05P_5 | AN6 | I/O |
| 5 | IO_L06N_5 | IO_L06N_5 | AK7 | I/O |
| 5 | IO_L06P_5 | IO_L06P_5 | AJ7 | I/O |
| 5 | IO_L07N_5 | IO_L07N_5 | AG10 | I/O |
| 5 | IO_L07P_5 | IO_L07P_5 | AF10 | I/O |
| 5 | IO_L08N_5 | IO_L08N_5 | AJ10 | I/O |
| 5 | IO_L08P_5 | IO_L08P_5 | AH10 | I/O |
| 5 | IO_L09N_5 | IO_L09N_5 | AM10 | I/O |
| 5 | IO_L09P_5 | IO_L09P_5 | AL10 | I/O |

Table 35: FG1156 Package Pinout (Continued)

| Bank | XC3S4000 Pin Name | XC3S5000 Pin Name | FG1156 Pin Number | Type |
|------|----------------------|----------------------|-------------------------|------|
| 5 | IO_L10N_5/ VRP_5 | IO_L10N_5/ VRP_5 | AP10 | DCI |
| 5 | IO_L10P_5/ VRN_5 | IO_L10P_5/ VRN_5 | AN10 | DCI |
| 5 | IO_L11N_5/ VREF_5 | IO_L11N_5/ VREF_5 | AP11 | VREF |
| 5 | IO_L11P_5 | IO_L11P_5 | AN11 | I/O |
| 5 | IO_L12N_5 | IO_L12N_5 | AF12 | I/O |
| 5 | IO_L12P_5 | IO_L12P_5 | AE12 | I/O |
| 5 | IO_L13N_5 | IO_L13N_5 | AJ12 | I/O |
| 5 | IO_L13P_5 | IO_L13P_5 | AH12 | I/O |
| 5 | IO_L14N_5 | IO_L14N_5 | AL12 | I/O |
| 5 | IO_L14P_5 | IO_L14P_5 | AK12 | I/O |
| 5 | IO_L15N_5 | IO_L15N_5 | AP12 | I/O |
| 5 | IO_L15P_5 | IO_L15P_5 | AN12 | I/O |
| 5 | IO_L16N_5 | IO_L16N_5 | AE13 | I/O |
| 5 | IO_L16P_5 | IO_L16P_5 | AD13 | I/O |
| 5 | IO_L17N_5 | IO_L17N_5 | AH13 | I/O |
| 5 | IO_L17P_5 | IO_L17P_5 | AG13 | I/O |
| 5 | IO_L18N_5 | IO_L18N_5 | AM13 | I/O |
| 5 | IO_L18P_5 | IO_L18P_5 | AL13 | I/O |
| 5 | IO_L19N_5 | IO_L19N_5 | AG14 | I/O |
| 5 | IO_L19P_5/ VREF_5 | IO_L19P_5/ VREF_5 | AF14 | VREF |
| 5 | IO_L20N_5 | IO_L20N_5 | AJ14 | I/O |
| 5 | IO_L20P_5 | IO_L20P_5 | AH14 | I/O |
| 5 | IO_L21N_5 | IO_L21N_5 | AM14 | I/O |
| 5 | IO_L21P_5 | IO_L21P_5 | AL14 | I/O |
| 5 | IO_L22N_5 | IO_L22N_5 | AP14 | I/O |
| 5 | IO_L22P_5 | IO_L22P_5 | AN14 | I/O |
| 5 | IO_L23N_5 | IO_L23N_5 | AF15 | I/O |
| 5 | IO_L23P_5 | IO_L23P_5 | AE15 | I/O |
| 5 | IO_L24N_5 | IO_L24N_5 | AJ15 | I/O |
| 5 | IO_L24P_5 | IO_L24P_5 | AH15 | I/O |
| 5 | IO_L25N_5 | IO_L25N_5 | AM15 | I/O |
| 5 | IO_L25P_5 | IO_L25P_5 | AL15 | I/O |
| 5 | IO_L26N_5 | IO_L26N_5 | AP15 | I/O |
| 5 | IO_L26P_5 | IO_L26P_5 | AN15 | I/O |
| 5 | IO_L27N_5/ VREF_5 | IO_L27N_5/ VREF_5 | AJ16 | VREF |
| 5 | IO_L27P_5 | IO_L27P_5 | AH16 | I/O |
| 5 | IO_L28N_5/ D6 | IO_L28N_5/ D6 | AN16 | DUAL |

Table 35: FG1156 Package Pinout (Continued)

| Bank | XC3S4000 Pin Name | XC3S5000 Pin Name | FG1156 Pin Number | Type |
|------|----------------------|----------------------|-------------------------|------|
| 5 | IO_L28P_5/ D7 | IO_L28P_5/ D7 | AM16 | DUAL |
| 5 | IO_L29N_5 | IO_L29N_5 | AF17 | I/O |
| 5 | IO_L29P_5/ VREF_5 | IO_L29P_5/ VREF_5 | AE17 | VREF |
| 5 | IO_L30N_5 | IO_L30N_5 | AH17 | I/O |
| 5 | IO_L30P_5 | IO_L30P_5 | AG17 | I/O |
| 5 | IO_L31N_5/ D4 | IO_L31N_5/ D4 | AL17 | DUAL |
| 5 | IO_L31P_5/ D5 | IO_L31P_5/ D5 | AK17 | DUAL |
| 5 | IO_L32N_5/ GCLK3 | IO_L32N_5/ GCLK3 | AN17 | GCLK |
| 5 | IO_L32P_5/ GCLK2 | IO_L32P_5/ GCLK2 | AM17 | GCLK |
| 5 | N.C. (◆) | IO_L33N_5 | AM7 | I/O |
| 5 | N.C. (◆) | IO_L33P_5 | AL7 | I/O |
| 5 | N.C. (◆) | IO_L34N_5 | AP7 | I/O |
| 5 | N.C. (◆) | IO_L34P_5 | AN7 | I/O |
| 5 | IO_L35N_5 | IO_L35N_5 | AL8 | I/O |
| 5 | IO_L35P_5 | IO_L35P_5 | AK8 | I/O |
| 5 | IO_L36N_5 | IO_L36N_5 | AP8 | I/O |
| 5 | IO_L36P_5 | IO_L36P_5 | AN8 | I/O |
| 5 | IO_L37N_5 | IO_L37N_5 | AJ9 | I/O |
| 5 | IO_L37P_5 | IO_L37P_5 | AH9 | I/O |
| 5 | IO_L38N_5 | IO_L38N_5 | AM9 | I/O |
| 5 | IO_L38P_5 | IO_L38P_5 | AL9 | I/O |
| 5 | N.C. (◆) | IO_L39N_5 | AF11 | I/O |
| 5 | N.C. (◆) | IO_L39P_5 | AE11 | I/O |
| 5 | N.C. (◆) | IO_L40N_5 | AJ11 | I/O |
| 5 | N.C. (◆) | IO_L40P_5 | AH11 | I/O |
| 5 | VCCO_5 | VCCO_5 | AC13 | VCCO |
| 5 | VCCO_5 | VCCO_5 | AC14 | VCCO |
| 5 | VCCO_5 | VCCO_5 | AC15 | VCCO |
| 5 | VCCO_5 | VCCO_5 | AC16 | VCCO |
| 5 | VCCO_5 | VCCO_5 | AG11 | VCCO |
| 5 | VCCO_5 | VCCO_5 | AG15 | VCCO |
| 5 | VCCO_5 | VCCO_5 | AH8 | VCCO |
| 5 | VCCO_5 | VCCO_5 | AJ13 | VCCO |
| 5 | VCCO_5 | VCCO_5 | AL11 | VCCO |
| 5 | VCCO_5 | VCCO_5 | AL16 | VCCO |
| 5 | VCCO_5 | VCCO_5 | AM4 | VCCO |
| 5 | VCCO_5 | VCCO_5 | AM8 | VCCO |

Table 35: FG1156 Package Pinout (Continued)

| Bank | XC3S4000 Pin Name | XC3S5000 Pin Name | FG1156 Pin Number | Type |
|------|----------------------|----------------------|-------------------------|------|
| 5 | VCCO_5 | VCCO_5 | AN13 | VCCO |
| 6 | IO | IO | AH1 | I/O |
| 6 | IO | IO | AH2 | I/O |
| 6 | IO | IO | V9 | I/O |
| 6 | IO | IO | V10 | I/O |
| 6 | IO_L01N_6/ VRP_6 | IO_L01N_6/ VRP_6 | AM2 | DCI |
| 6 | IO_L01P_6/ VRN_6 | IO_L01P_6/ VRN_6 | AM1 | DCI |
| 6 | IO_L02N_6 | IO_L02N_6 | AL2 | I/O |
| 6 | IO_L02P_6 | IO_L02P_6 | AL1 | I/O |
| 6 | IO_L03N_6/ VREF_6 | IO_L03N_6/ VREF_6 | AK3 | VREF |
| 6 | IO_L03P_6 | IO_L03P_6 | AK2 | I/O |
| 6 | IO_L04N_6 | IO_L04N_6 | AJ4 | I/O |
| 6 | IO_L04P_6 | IO_L04P_6 | AJ3 | I/O |
| 6 | IO_L05N_6 | IO_L05N_6 | AJ2 | I/O |
| 6 | IO_L05P_6 | IO_L05P_6 | AJ1 | I/O |
| 6 | IO_L06N_6 | IO_L06N_6 | AH6 | I/O |
| 6 | IO_L06P_6 | IO_L06P_6 | AH5 | I/O |
| 6 | IO_L07N_6 | IO_L07N_6 | AG6 | I/O |
| 6 | IO_L07P_6 | IO_L07P_6 | AG5 | I/O |
| 6 | IO_L08N_6 | IO_L08N_6 | AG2 | I/O |
| 6 | IO_L08P_6 | IO_L08P_6 | AG1 | I/O |
| 6 | IO_L09N_6/ VREF_6 | IO_L09N_6/ VREF_6 | AF7 | VREF |
| 6 | IO_L09P_6 | IO_L09P_6 | AF6 | I/O |
| 6 | IO_L10N_6 | IO_L10N_6 | AG4 | I/O |
| 6 | IO_L10P_6 | IO_L10P_6 | AF4 | I/O |
| 6 | IO_L11N_6 | IO_L11N_6 | AF3 | I/O |
| 6 | IO_L11P_6 | IO_L11P_6 | AF2 | I/O |
| 6 | IO_L12N_6 | IO_L12N_6 | AF8 | I/O |
| 6 | IO_L12P_6 | IO_L12P_6 | AE9 | I/O |
| 6 | IO_L13N_6 | IO_L13N_6 | AE8 | I/O |
| 6 | IO_L13P_6/ VREF_6 | IO_L13P_6/ VREF_6 | AE7 | VREF |
| 6 | IO_L14N_6 | IO_L14N_6 | AE6 | I/O |
| 6 | IO_L14P_6 | IO_L14P_6 | AE5 | I/O |
| 6 | IO_L15N_6 | IO_L15N_6 | AE4 | I/O |
| 6 | IO_L15P_6 | IO_L15P_6 | AE3 | I/O |
| 6 | IO_L16N_6 | IO_L16N_6 | AE2 | I/O |
| 6 | IO_L16P_6 | IO_L16P_6 | AE1 | I/O |

Table 35: FG1156 Package Pinout (Continued)

| Bank | XC3S4000 Pin Name | XC3S5000 Pin Name | FG1156 Pin Number | Type |
|------|----------------------|----------------------|-------------------------|------|
| 6 | IO_L17N_6 | IO_L17N_6 | AD10 | I/O |
| 6 | IO_L17P_6/ VREF_6 | IO_L17P_6/ VREF_6 | AD9 | VREF |
| 6 | IO_L19N_6 | IO_L19N_6 | AD2 | I/O |
| 6 | IO_L19P_6 | IO_L19P_6 | AD1 | I/O |
| 6 | IO_L20N_6 | IO_L20N_6 | AC11 | I/O |
| 6 | IO_L20P_6 | IO_L20P_6 | AC10 | I/O |
| 6 | IO_L21N_6 | IO_L21N_6 | AC8 | I/O |
| 6 | IO_L21P_6 | IO_L21P_6 | AC7 | I/O |
| 6 | IO_L22N_6 | IO_L22N_6 | AC6 | I/O |
| 6 | IO_L22P_6 | IO_L22P_6 | AC5 | I/O |
| 6 | IO_L23N_6 | IO_L23N_6 | AC2 | I/O |
| 6 | IO_L23P_6 | IO_L23P_6 | AC1 | I/O |
| 6 | IO_L24N_6/ VREF_6 | IO_L24N_6/ VREF_6 | AC9 | VREF |
| 6 | IO_L24P_6 | IO_L24P_6 | AB10 | I/O |
| 6 | IO_L25N_6 | IO_L25N_6 | AB8 | I/O |
| 6 | IO_L25P_6 | IO_L25P_6 | AB7 | I/O |
| 6 | IO_L26N_6 | IO_L26N_6 | AB4 | I/O |
| 6 | IO_L26P_6 | IO_L26P_6 | AB3 | I/O |
| 6 | IO_L27N_6 | IO_L27N_6 | AB11 | I/O |
| 6 | IO_L27P_6 | IO_L27P_6 | AA11 | I/O |
| 6 | IO_L28N_6 | IO_L28N_6 | AA8 | I/O |
| 6 | IO_L28P_6 | IO_L28P_6 | AA7 | I/O |
| 6 | IO_L29N_6 | IO_L29N_6 | AA6 | I/O |
| 6 | IO_L29P_6 | IO_L29P_6 | AA5 | I/O |
| 6 | IO_L30N_6 | IO_L30N_6 | AA4 | I/O |
| 6 | IO_L30P_6 | IO_L30P_6 | AA3 | I/O |
| 6 | IO_L31N_6 | IO_L31N_6 | AA2 | I/O |
| 6 | IO_L31P_6 | IO_L31P_6 | AA1 | I/O |
| 6 | IO_L32N_6 | IO_L32N_6 | Y11 | I/O |
| 6 | IO_L32P_6 | IO_L32P_6 | Y10 | I/O |
| 6 | IO_L33N_6 | IO_L33N_6 | Y4 | I/O |
| 6 | IO_L33P_6 | IO_L33P_6 | Y3 | I/O |
| 6 | IO_L34N_6/ VREF_6 | IO_L34N_6/ VREF_6 | Y2 | VREF |
| 6 | IO_L34P_6 | IO_L34P_6 | Y1 | I/O |
| 6 | IO_L35N_6 | IO_L35N_6 | Y9 | I/O |
| 6 | IO_L35P_6 | IO_L35P_6 | W10 | I/O |
| 6 | IO_L36N_6 | IO_L36N_6 | W7 | I/O |
| 6 | IO_L36P_6 | IO_L36P_6 | W6 | I/O |
| 6 | IO_L37N_6 | IO_L37N_6 | W3 | I/O |

Table 35: FG1156 Package Pinout (Continued)

| Bank | XC3S4000 Pin Name | XC3S5000 Pin Name | FG1156 Pin Number | Type |
|------|----------------------|----------------------|-------------------------|------|
| 6 | IO_L37P_6 | IO_L37P_6 | W2 | I/O |
| 6 | IO_L38N_6 | IO_L38N_6 | V6 | I/O |
| 6 | IO_L38P_6 | IO_L38P_6 | V5 | I/O |
| 6 | IO_L39N_6 | IO_L39N_6 | V4 | I/O |
| 6 | IO_L39P_6 | IO_L39P_6 | V3 | I/O |
| 6 | IO_L40N_6 | IO_L40N_6 | V2 | I/O |
| 6 | IO_L40P_6/ VREF_6 | IO_L40P_6/ VREF_6 | V1 | VREF |
| 6 | N.C. (◆) | IO_L41N_6 | AH4 | I/O |
| 6 | N.C. (◆) | IO_L41P_6 | AH3 | I/O |
| 6 | N.C. (◆) | IO_L44N_6 | AD7 | I/O |
| 6 | N.C. (◆) | IO_L44P_6 | AD6 | I/O |
| 6 | IO_L45N_6 | IO_L45N_6 | AC4 | I/O |
| 6 | IO_L45P_6 | IO_L45P_6 | AC3 | I/O |
| 6 | N.C. (◆) | IO_L46N_6 | AA10 | I/O |
| 6 | N.C. (◆) | IO_L46P_6 | AA9 | I/O |
| 6 | IO_L48N_6 | IO_L48N_6 | Y7 | I/O |
| 6 | IO_L48P_6 | IO_L48P_6 | Y6 | I/O |
| 6 | N.C. (◆) | IO_L49N_6 | W11 | I/O |
| 6 | N.C. (◆) | IO_L49P_6 | V11 | I/O |
| 6 | IO_L52N_6 | IO_L52N_6 | V8 | I/O |
| 6 | IO_L52P_6 | IO_L52P_6 | V7 | I/O |
| 6 | VCCO_6 | VCCO_6 | AA12 | VCCO |
| 6 | VCCO_6 | VCCO_6 | AB12 | VCCO |
| 6 | VCCO_6 | VCCO_6 | AB2 | VCCO |
| 6 | VCCO_6 | VCCO_6 | AB6 | VCCO |
| 6 | VCCO_6 | VCCO_6 | AD4 | VCCO |
| 6 | VCCO_6 | VCCO_6 | AD8 | VCCO |
| 6 | VCCO_6 | VCCO_6 | AG3 | VCCO |
| 6 | VCCO_6 | VCCO_6 | AG7 | VCCO |
| 6 | VCCO_6 | VCCO_6 | AL3 | VCCO |
| 6 | VCCO_6 | VCCO_6 | W12 | VCCO |
| 6 | VCCO_6 | VCCO_6 | W4 | VCCO |
| 6 | VCCO_6 | VCCO_6 | Y12 | VCCO |
| 6 | VCCO_6 | VCCO_6 | Y8 | VCCO |
| 7 | IO | IO | G1 | I/O |
| 7 | IO | IO | G2 | I/O |
| 7 | IO | IO | U10 | I/O |
| 7 | IO | IO | U9 | I/O |
| 7 | IO_L01N_7/ VRP_7 | IO_L01N_7/ VRP_7 | C1 | DCI |

Table 35: FG1156 Package Pinout (Continued)

| Bank | XC3S4000 Pin Name | XC3S5000 Pin Name | FG1156 Pin Number | Type |
|------|----------------------|----------------------|-------------------------|------|
| 7 | IO_L01P_7/ VRN_7 | IO_L01P_7/ VRN_7 | C2 | DCI |
| 7 | IO_L02N_7 | IO_L02N_7 | D1 | I/O |
| 7 | IO_L02P_7 | IO_L02P_7 | D2 | I/O |
| 7 | IO_L03N_7/ VREF_7 | IO_L03N_7/ VREF_7 | E2 | VREF |
| 7 | IO_L03P_7 | IO_L03P_7 | E3 | I/O |
| 7 | IO_L04N_7 | IO_L04N_7 | F3 | I/O |
| 7 | IO_L04P_7 | IO_L04P_7 | F4 | I/O |
| 7 | IO_L05N_7 | IO_L05N_7 | F1 | I/O |
| 7 | IO_L05P_7 | IO_L05P_7 | F2 | I/O |
| 7 | IO_L06N_7 | IO_L06N_7 | G5 | I/O |
| 7 | IO_L06P_7 | IO_L06P_7 | G6 | I/O |
| 7 | IO_L07N_7 | IO_L07N_7 | H5 | I/O |
| 7 | IO_L07P_7 | IO_L07P_7 | H6 | I/O |
| 7 | IO_L08N_7 | IO_L08N_7 | H1 | I/O |
| 7 | IO_L08P_7 | IO_L08P_7 | H2 | I/O |
| 7 | IO_L09N_7 | IO_L09N_7 | J6 | I/O |
| 7 | IO_L09P_7 | IO_L09P_7 | J7 | I/O |
| 7 | IO_L10N_7 | IO_L10N_7 | J4 | I/O |
| 7 | IO_L10P_7/ VREF_7 | IO_L10P_7/ VREF_7 | H4 | VREF |
| 7 | IO_L11N_7 | IO_L11N_7 | J2 | I/O |
| 7 | IO_L11P_7 | IO_L11P_7 | J3 | I/O |
| 7 | IO_L12N_7 | IO_L12N_7 | K9 | I/O |
| 7 | IO_L12P_7 | IO_L12P_7 | J8 | I/O |
| 7 | IO_L13N_7 | IO_L13N_7 | K7 | I/O |
| 7 | IO_L13P_7 | IO_L13P_7 | K8 | I/O |
| 7 | IO_L14N_7 | IO_L14N_7 | K5 | I/O |
| 7 | IO_L14P_7 | IO_L14P_7 | K6 | I/O |
| 7 | IO_L15N_7 | IO_L15N_7 | K3 | I/O |
| 7 | IO_L15P_7 | IO_L15P_7 | K4 | I/O |
| 7 | IO_L16N_7 | IO_L16N_7 | K1 | I/O |
| 7 | IO_L16P_7/ VREF_7 | IO_L16P_7/ VREF_7 | K2 | VREF |
| 7 | IO_L17N_7 | IO_L17N_7 | L9 | I/O |
| 7 | IO_L17P_7 | IO_L17P_7 | L10 | I/O |
| 7 | IO_L19N_7/ VREF_7 | IO_L19N_7/ VREF_7 | L1 | VREF |
| 7 | IO_L19P_7 | IO_L19P_7 | L2 | I/O |
| 7 | IO_L20N_7 | IO_L20N_7 | M10 | I/O |
| 7 | IO_L20P_7 | IO_L20P_7 | M11 | I/O |

Table 35: FG1156 Package Pinout (Continued)

| Bank | XC3S4000 Pin Name | XC3S5000 Pin Name | FG1156 Pin Number | Type |
|------|----------------------|----------------------|-------------------------|------|
| 7 | IO_L21N_7 | IO_L21N_7 | M7 | I/O |
| 7 | IO_L21P_7 | IO_L21P_7 | M8 | I/O |
| 7 | IO_L22N_7 | IO_L22N_7 | M5 | I/O |
| 7 | IO_L22P_7 | IO_L22P_7 | M6 | I/O |
| 7 | IO_L23N_7 | IO_L23N_7 | M3 | I/O |
| 7 | IO_L23P_7 | IO_L23P_7 | M4 | I/O |
| 7 | IO_L24N_7 | IO_L24N_7 | N10 | I/O |
| 7 | IO_L24P_7 | IO_L24P_7 | M9 | I/O |
| 7 | IO_L25N_7 | IO_L25N_7 | N3 | I/O |
| 7 | IO_L25P_7 | IO_L25P_7 | N4 | I/O |
| 7 | IO_L26N_7 | IO_L26N_7 | P11 | I/O |
| 7 | IO_L26P_7 | IO_L26P_7 | N11 | I/O |
| 7 | IO_L27N_7 | IO_L27N_7 | P7 | I/O |
| 7 | IO_L27P_7/ VREF_7 | IO_L27P_7/ VREF_7 | P8 | VREF |
| 7 | IO_L28N_7 | IO_L28N_7 | P5 | I/O |
| 7 | IO_L28P_7 | IO_L28P_7 | P6 | I/O |
| 7 | IO_L29N_7 | IO_L29N_7 | P3 | I/O |
| 7 | IO_L29P_7 | IO_L29P_7 | P4 | I/O |
| 7 | IO_L30N_7 | IO_L30N_7 | R6 | I/O |
| 7 | IO_L30P_7 | IO_L30P_7 | R7 | I/O |
| 7 | IO_L31N_7 | IO_L31N_7 | R3 | I/O |
| 7 | IO_L31P_7 | IO_L31P_7 | R4 | I/O |
| 7 | IO_L32N_7 | IO_L32N_7 | R1 | I/O |
| 7 | IO_L32P_7 | IO_L32P_7 | R2 | I/O |
| 7 | IO_L33N_7 | IO_L33N_7 | T10 | I/O |
| 7 | IO_L33P_7 | IO_L33P_7 | R9 | I/O |
| 7 | IO_L34N_7 | IO_L34N_7 | T6 | I/O |
| 7 | IO_L34P_7 | IO_L34P_7 | T7 | I/O |
| 7 | IO_L35N_7 | IO_L35N_7 | T2 | I/O |
| 7 | IO_L35P_7 | IO_L35P_7 | T3 | I/O |
| 7 | IO_L37N_7 | IO_L37N_7 | U7 | I/O |
| 7 | IO_L37P_7/ VREF_7 | IO_L37P_7/ VREF_7 | U8 | VREF |
| 7 | IO_L38N_7 | IO_L38N_7 | U5 | I/O |
| 7 | IO_L38P_7 | IO_L38P_7 | U6 | I/O |
| 7 | IO_L39N_7 | IO_L39N_7 | U3 | I/O |
| 7 | IO_L39P_7 | IO_L39P_7 | U4 | I/O |
| 7 | IO_L40N_7/ VREF_7 | IO_L40N_7/ VREF_7 | U1 | VREF |
| 7 | IO_L40P_7 | IO_L40P_7 | U2 | I/O |
| 7 | N.C. (◆) | IO_L41N_7 | G3 | I/O |

Table 35: FG1156 Package Pinout (Continued)

| Bank | XC3S4000 Pin Name | XC3S5000 Pin Name | FG1156 Pin Number | Type |
|------|----------------------|----------------------|-------------------------|------|
| 7 | N.C. (◆) | IO_L41P_7 | G4 | I/O |
| 7 | N.C. (◆) | IO_L44N_7 | L6 | I/O |
| 7 | N.C. (◆) | IO_L44P_7 | L7 | I/O |
| 7 | IO_L45N_7 | IO_L45N_7 | M1 | I/O |
| 7 | IO_L45P_7 | IO_L45P_7 | M2 | I/O |
| 7 | IO_L46N_7 | IO_L46N_7 | N7 | I/O |
| 7 | IO_L46P_7 | IO_L46P_7 | N8 | I/O |
| 7 | N.C. (◆) | IO_L47N_7 | P9 | I/O |
| 7 | N.C. (◆) | IO_L47P_7 | P10 | I/O |
| 7 | IO_L49N_7 | IO_L49N_7 | P1 | I/O |
| 7 | IO_L49P_7 | IO_L49P_7 | P2 | I/O |
| 7 | IO_L50N_7 | IO_L50N_7 | R10 | I/O |
| 7 | IO_L50P_7 | IO_L50P_7 | R11 | I/O |
| 7 | N.C. (◆) | IO_L51N_7 | U11 | I/O |
| 7 | N.C. (◆) | IO_L51P_7 | T11 | I/O |
| 7 | VCCO_7 | VCCO_7 | D3 | VCCO |
| 7 | VCCO_7 | VCCO_7 | H3 | VCCO |
| 7 | VCCO_7 | VCCO_7 | H7 | VCCO |
| 7 | VCCO_7 | VCCO_7 | L4 | VCCO |
| 7 | VCCO_7 | VCCO_7 | L8 | VCCO |
| 7 | VCCO_7 | VCCO_7 | N12 | VCCO |
| 7 | VCCO_7 | VCCO_7 | N2 | VCCO |
| 7 | VCCO_7 | VCCO_7 | N6 | VCCO |
| 7 | VCCO_7 | VCCO_7 | P12 | VCCO |
| 7 | VCCO_7 | VCCO_7 | R12 | VCCO |
| 7 | VCCO_7 | VCCO_7 | R8 | VCCO |
| 7 | VCCO_7 | VCCO_7 | T12 | VCCO |
| 7 | VCCO_7 | VCCO_7 | T4 | VCCO |
| N/A | GND | GND | A1 | GND |
| N/A | GND | GND | A13 | GND |
| N/A | GND | GND | A16 | GND |
| N/A | GND | GND | A19 | GND |
| N/A | GND | GND | A2 | GND |
| N/A | GND | GND | A22 | GND |
| N/A | GND | GND | A26 | GND |
| N/A | GND | GND | A30 | GND |
| N/A | GND | GND | A33 | GND |
| N/A | GND | GND | A34 | GND |
| N/A | GND | GND | A5 | GND |
| N/A | GND | GND | A9 | GND |
| N/A | GND | GND | AA14 | GND |

Table 35: FG1156 Package Pinout (Continued)

| Bank | XC3S4000 Pin Name | XC3S5000 Pin Name | FG1156 Pin Number | Type |
|------|----------------------|----------------------|-------------------------|------|
| N/A | GND | GND | AA15 | GND |
| N/A | GND | GND | AA16 | GND |
| N/A | GND | GND | AA17 | GND |
| N/A | GND | GND | AA18 | GND |
| N/A | GND | GND | AA19 | GND |
| N/A | GND | GND | AA20 | GND |
| N/A | GND | GND | AA21 | GND |
| N/A | GND | GND | AB1 | GND |
| N/A | GND | GND | AB17 | GND |
| N/A | GND | GND | AB18 | GND |
| N/A | GND | GND | AB26 | GND |
| N/A | GND | GND | AB30 | GND |
| N/A | GND | GND | AB34 | GND |
| N/A | GND | GND | AB5 | GND |
| N/A | GND | GND | AB9 | GND |
| N/A | GND | GND | AD3 | GND |
| N/A | GND | GND | AD32 | GND |
| N/A | GND | GND | AE10 | GND |
| N/A | GND | GND | AE25 | GND |
| N/A | GND | GND | AF1 | GND |
| N/A | GND | GND | AF13 | GND |
| N/A | GND | GND | AF16 | GND |
| N/A | GND | GND | AF19 | GND |
| N/A | GND | GND | AF22 | GND |
| N/A | GND | GND | AF30 | GND |
| N/A | GND | GND | AF34 | GND |
| N/A | GND | GND | AF5 | GND |
| N/A | GND | GND | AH28 | GND |
| N/A | GND | GND | AH7 | GND |
| N/A | GND | GND | AK1 | GND |
| N/A | GND | GND | AK13 | GND |
| N/A | GND | GND | AK16 | GND |
| N/A | GND | GND | AK19 | GND |
| N/A | GND | GND | AK22 | GND |
| N/A | GND | GND | AK26 | GND |
| N/A | GND | GND | AK30 | GND |
| N/A | GND | GND | AK34 | GND |
| N/A | GND | GND | AK5 | GND |
| N/A | GND | GND | AK9 | GND |
| N/A | GND | GND | AM11 | GND |
| N/A | GND | GND | AM24 | GND |

Table 35: FG1156 Package Pinout (Continued)

| Bank | XC3S4000 Pin Name | XC3S5000 Pin Name | FG1156 Pin Number | Type |
|------|----------------------|----------------------|-------------------------|------|
| N/A | GND | GND | AM3 | GND |
| N/A | GND | GND | AM32 | GND |
| N/A | GND | GND | AN1 | GND |
| N/A | GND | GND | AN2 | GND |
| N/A | GND | GND | AN33 | GND |
| N/A | GND | GND | AN34 | GND |
| N/A | GND | GND | AP1 | GND |
| N/A | GND | GND | AP13 | GND |
| N/A | GND | GND | AP16 | GND |
| N/A | GND | GND | AP19 | GND |
| N/A | GND | GND | AP2 | GND |
| N/A | GND | GND | AP22 | GND |
| N/A | GND | GND | AP26 | GND |
| N/A | GND | GND | AP30 | GND |
| N/A | GND | GND | AP33 | GND |
| N/A | GND | GND | AP34 | GND |
| N/A | GND | GND | AP5 | GND |
| N/A | GND | GND | AP9 | GND |
| N/A | GND | GND | B1 | GND |
| N/A | GND | GND | B2 | GND |
| N/A | GND | GND | B33 | GND |
| N/A | GND | GND | B34 | GND |
| N/A | GND | GND | C11 | GND |
| N/A | GND | GND | C24 | GND |
| N/A | GND | GND | C3 | GND |
| N/A | GND | GND | C32 | GND |
| N/A | GND | GND | E1 | GND |
| N/A | GND | GND | E13 | GND |
| N/A | GND | GND | E16 | GND |
| N/A | GND | GND | E19 | GND |
| N/A | GND | GND | E22 | GND |
| N/A | GND | GND | E26 | GND |
| N/A | GND | GND | E30 | GND |
| N/A | GND | GND | E34 | GND |
| N/A | GND | GND | E5 | GND |
| N/A | GND | GND | E9 | GND |
| N/A | GND | GND | G28 | GND |
| N/A | GND | GND | G7 | GND |
| N/A | GND | GND | J1 | GND |
| N/A | GND | GND | J13 | GND |
| N/A | GND | GND | J16 | GND |

Table 35: FG1156 Package Pinout (Continued)

| Bank | XC3S4000 Pin Name | XC3S5000 Pin Name | FG1156 Pin Number | Type |
|------|----------------------|----------------------|-------------------------|------|
| N/A | GND | GND | J19 | GND |
| N/A | GND | GND | J22 | GND |
| N/A | GND | GND | J30 | GND |
| N/A | GND | GND | J34 | GND |
| N/A | GND | GND | J5 | GND |
| N/A | GND | GND | K10 | GND |
| N/A | GND | GND | K25 | GND |
| N/A | GND | GND | L3 | GND |
| N/A | GND | GND | L32 | GND |
| N/A | GND | GND | N1 | GND |
| N/A | GND | GND | N17 | GND |
| N/A | GND | GND | N18 | GND |
| N/A | GND | GND | N26 | GND |
| N/A | GND | GND | N30 | GND |
| N/A | GND | GND | N34 | GND |
| N/A | GND | GND | N5 | GND |
| N/A | GND | GND | N9 | GND |
| N/A | GND | GND | P14 | GND |
| N/A | GND | GND | P15 | GND |
| N/A | GND | GND | P16 | GND |
| N/A | GND | GND | P17 | GND |
| N/A | GND | GND | P18 | GND |
| N/A | GND | GND | P19 | GND |
| N/A | GND | GND | P20 | GND |
| N/A | GND | GND | P21 | GND |
| N/A | GND | GND | R14 | GND |
| N/A | GND | GND | R15 | GND |
| N/A | GND | GND | R16 | GND |
| N/A | GND | GND | R17 | GND |
| N/A | GND | GND | R18 | GND |
| N/A | GND | GND | R19 | GND |
| N/A | GND | GND | R20 | GND |
| N/A | GND | GND | R21 | GND |
| N/A | GND | GND | T1 | GND |
| N/A | GND | GND | T14 | GND |
| N/A | GND | GND | T15 | GND |
| N/A | GND | GND | T16 | GND |
| N/A | GND | GND | T17 | GND |
| N/A | GND | GND | T18 | GND |
| N/A | GND | GND | T19 | GND |
| N/A | GND | GND | T20 | GND |

Table 35: FG1156 Package Pinout (Continued)

| Bank | XC3S4000 Pin Name | XC3S5000 Pin Name | FG1156 Pin Number | Type |
|------|----------------------|----------------------|-------------------------|------|
| N/A | GND | GND | T21 | GND |
| N/A | GND | GND | T26 | GND |
| N/A | GND | GND | T30 | GND |
| N/A | GND | GND | T34 | GND |
| N/A | GND | GND | T5 | GND |
| N/A | GND | GND | T9 | GND |
| N/A | GND | GND | U13 | GND |
| N/A | GND | GND | U14 | GND |
| N/A | GND | GND | U15 | GND |
| N/A | GND | GND | U16 | GND |
| N/A | GND | GND | U17 | GND |
| N/A | GND | GND | U18 | GND |
| N/A | GND | GND | U19 | GND |
| N/A | GND | GND | U20 | GND |
| N/A | GND | GND | U21 | GND |
| N/A | GND | GND | U22 | GND |
| N/A | GND | GND | V13 | GND |
| N/A | GND | GND | V14 | GND |
| N/A | GND | GND | V15 | GND |
| N/A | GND | GND | V16 | GND |
| N/A | GND | GND | V17 | GND |
| N/A | GND | GND | V18 | GND |
| N/A | GND | GND | V19 | GND |
| N/A | GND | GND | V20 | GND |
| N/A | GND | GND | V21 | GND |
| N/A | GND | GND | V22 | GND |
| N/A | GND | GND | W1 | GND |
| N/A | GND | GND | W14 | GND |
| N/A | GND | GND | W15 | GND |
| N/A | GND | GND | W16 | GND |
| N/A | GND | GND | W17 | GND |
| N/A | GND | GND | W18 | GND |
| N/A | GND | GND | W19 | GND |
| N/A | GND | GND | W20 | GND |
| N/A | GND | GND | W21 | GND |
| N/A | GND | GND | W26 | GND |
| N/A | GND | GND | W30 | GND |
| N/A | GND | GND | W34 | GND |
| N/A | GND | GND | W5 | GND |
| N/A | GND | GND | W9 | GND |
| N/A | GND | GND | Y14 | GND |

Table 35: FG1156 Package Pinout (Continued)

| Bank | XC3S4000 Pin Name | XC3S5000 Pin Name | FG1156 Pin Number | Type |
|------|----------------------|----------------------|-------------------------|--------|
| N/A | GND | GND | Y15 | GND |
| N/A | GND | GND | Y16 | GND |
| N/A | GND | GND | Y17 | GND |
| N/A | GND | GND | Y18 | GND |
| N/A | GND | GND | Y19 | GND |
| N/A | GND | GND | Y20 | GND |
| N/A | GND | GND | Y21 | GND |
| N/A | N.C. (◆) | N.C. (■) | AK31 | N.C. |
| N/A | VCCAUX | VCCAUX | AD30 | VCCAUX |
| N/A | VCCAUX | VCCAUX | AD5 | VCCAUX |
| N/A | VCCAUX | VCCAUX | AG16 | VCCAUX |
| N/A | VCCAUX | VCCAUX | AG19 | VCCAUX |
| N/A | VCCAUX | VCCAUX | AJ30 | VCCAUX |
| N/A | VCCAUX | VCCAUX | AJ5 | VCCAUX |
| N/A | VCCAUX | VCCAUX | AK11 | VCCAUX |
| N/A | VCCAUX | VCCAUX | AK15 | VCCAUX |
| N/A | VCCAUX | VCCAUX | AK20 | VCCAUX |
| N/A | VCCAUX | VCCAUX | AK24 | VCCAUX |
| N/A | VCCAUX | VCCAUX | AK29 | VCCAUX |
| N/A | VCCAUX | VCCAUX | AK6 | VCCAUX |
| N/A | VCCAUX | VCCAUX | E11 | VCCAUX |
| N/A | VCCAUX | VCCAUX | E15 | VCCAUX |
| N/A | VCCAUX | VCCAUX | E20 | VCCAUX |
| N/A | VCCAUX | VCCAUX | E24 | VCCAUX |
| N/A | VCCAUX | VCCAUX | E29 | VCCAUX |
| N/A | VCCAUX | VCCAUX | E6 | VCCAUX |
| N/A | VCCAUX | VCCAUX | F30 | VCCAUX |
| N/A | VCCAUX | VCCAUX | F5 | VCCAUX |
| N/A | VCCAUX | VCCAUX | H16 | VCCAUX |
| N/A | VCCAUX | VCCAUX | H19 | VCCAUX |
| N/A | VCCAUX | VCCAUX | L30 | VCCAUX |
| N/A | VCCAUX | VCCAUX | L5 | VCCAUX |
| N/A | VCCAUX | VCCAUX | R30 | VCCAUX |
| N/A | VCCAUX | VCCAUX | R5 | VCCAUX |
| N/A | VCCAUX | VCCAUX | T27 | VCCAUX |
| N/A | VCCAUX | VCCAUX | T8 | VCCAUX |
| N/A | VCCAUX | VCCAUX | W27 | VCCAUX |
| N/A | VCCAUX | VCCAUX | W8 | VCCAUX |
| N/A | VCCAUX | VCCAUX | Y30 | VCCAUX |
| N/A | VCCAUX | VCCAUX | Y5 | VCCAUX |
| N/A | VCCINT | VCCINT | AA13 | VCCINT |

Table 35: FG1156 Package Pinout (Continued)

| Bank | XC3S4000 Pin Name | XC3S5000 Pin Name | FG1156 Pin Number | Type |
|--------|----------------------|----------------------|-------------------------|--------|
| N/A | VCCINT | VCCINT | AA22 | VCCINT |
| N/A | VCCINT | VCCINT | AB13 | VCCINT |
| N/A | VCCINT | VCCINT | AB14 | VCCINT |
| N/A | VCCINT | VCCINT | AB15 | VCCINT |
| N/A | VCCINT | VCCINT | AB16 | VCCINT |
| N/A | VCCINT | VCCINT | AB19 | VCCINT |
| N/A | VCCINT | VCCINT | AB20 | VCCINT |
| N/A | VCCINT | VCCINT | AB21 | VCCINT |
| N/A | VCCINT | VCCINT | AB22 | VCCINT |
| N/A | VCCINT | VCCINT | AC12 | VCCINT |
| N/A | VCCINT | VCCINT | AC17 | VCCINT |
| N/A | VCCINT | VCCINT | AC18 | VCCINT |
| N/A | VCCINT | VCCINT | AC23 | VCCINT |
| N/A | VCCINT | VCCINT | M12 | VCCINT |
| N/A | VCCINT | VCCINT | M17 | VCCINT |
| N/A | VCCINT | VCCINT | M18 | VCCINT |
| N/A | VCCINT | VCCINT | M23 | VCCINT |
| N/A | VCCINT | VCCINT | N13 | VCCINT |
| N/A | VCCINT | VCCINT | N14 | VCCINT |
| N/A | VCCINT | VCCINT | N15 | VCCINT |
| N/A | VCCINT | VCCINT | N16 | VCCINT |
| N/A | VCCINT | VCCINT | N19 | VCCINT |
| N/A | VCCINT | VCCINT | N20 | VCCINT |
| N/A | VCCINT | VCCINT | N21 | VCCINT |
| N/A | VCCINT | VCCINT | N22 | VCCINT |
| N/A | VCCINT | VCCINT | P13 | VCCINT |
| N/A | VCCINT | VCCINT | P22 | VCCINT |
| N/A | VCCINT | VCCINT | R13 | VCCINT |
| N/A | VCCINT | VCCINT | R22 | VCCINT |
| N/A | VCCINT | VCCINT | T13 | VCCINT |
| N/A | VCCINT | VCCINT | T22 | VCCINT |
| N/A | VCCINT | VCCINT | U12 | VCCINT |
| N/A | VCCINT | VCCINT | U23 | VCCINT |
| N/A | VCCINT | VCCINT | V12 | VCCINT |
| N/A | VCCINT | VCCINT | V23 | VCCINT |
| N/A | VCCINT | VCCINT | W13 | VCCINT |
| N/A | VCCINT | VCCINT | W22 | VCCINT |
| N/A | VCCINT | VCCINT | Y13 | VCCINT |
| N/A | VCCINT | VCCINT | Y22 | VCCINT |
| VCCAUX | CCLK | CCLK | AL31 | CONFIG |
| VCCAUX | DONE | DONE | AD24 | CONFIG |

Table 35: FG1156 Package Pinout (Continued)

| Bank | XC3S4000 Pin Name | XC3S5000 Pin Name | FG1156 Pin Number | Type |
|--------|----------------------|----------------------|-------------------------|--------|
| VCCAUX | HSWAP_EN | HSWAP_EN | L11 | CONFIG |
| VCCAUX | M0 | M0 | AL4 | CONFIG |
| VCCAUX | M1 | M1 | AK4 | CONFIG |
| VCCAUX | M2 | M2 | AG8 | CONFIG |
| VCCAUX | PROG_B | PROG_B | D4 | CONFIG |
| VCCAUX | TCK | TCK | D31 | JTAG |
| VCCAUX | TDI | TDI | E4 | JTAG |
| VCCAUX | TDO | TDO | E31 | JTAG |
| VCCAUX | TMS | TMS | H27 | JTAG |

User I/Os by Bank

Table 36 indicates how the available user-I/O pins are distributed between the eight I/O banks for the XC3S4000 in the FG1156 package. Similarly, Table 37 shows how the available user-I/O pins are distributed between the eight I/O banks for the XC3S5000 in the FG1156 package.

Table 36: User I/Os Per Bank for XC3S4000 in FG1156 Package

| Package Edge | I/O Bank | Maximum I/O | All Possible I/O Pins by Type | | | | |
|--------------|-------------|----------------|-------------------------------|------|-----|------|------|
| | | | I/O | DUAL | DCI | VREF | GCLK |
| Top | 0 | 90 | 79 | 0 | 2 | 7 | 2 |
| | 1 | 90 | 79 | 0 | 2 | 7 | 2 |
| Right | 2 | 88 | 80 | 0 | 2 | 6 | 0 |
| | 3 | 88 | 79 | 0 | 2 | 7 | 0 |
| Bottom | 4 | 90 | 73 | 6 | 2 | 7 | 2 |
| | 5 | 90 | 73 | 6 | 2 | 7 | 2 |
| Left | 6 | 88 | 79 | 0 | 2 | 7 | 0 |
| | 7 | 88 | 79 | 0 | 2 | 7 | 0 |

Table 37: User I/Os Per Bank for XC3S5000 in FG1156 Package

| Package Edge | I/O Bank | Maximum I/O | All Possible I/O Pins by Type | | | | |
|--------------|-------------|----------------|-------------------------------|------|-----|------|------|
| | | | I/O | DUAL | DCI | VREF | GCLK |
| Top | 0 | 100 | 89 | 0 | 2 | 7 | 2 |
| | 1 | 100 | 89 | 0 | 2 | 7 | 2 |
| Right | 2 | 96 | 87 | 0 | 2 | 7 | 0 |
| | 3 | 96 | 87 | 0 | 2 | 7 | 0 |
| Bottom | 4 | 100 | 83 | 6 | 2 | 7 | 2 |
| | 5 | 100 | 83 | 6 | 2 | 7 | 2 |
| Left | 6 | 96 | 87 | 0 | 2 | 7 | 0 |
| | 7 | 96 | 87 | 0 | 2 | 7 | 0 |

FG1156 Footprint

Top Left Corner of Package (top view)

XC3S4000

(712 max. user I/O)

621

 I/O: Unrestricted,
general-purpose user I/O

55

 VREF: User I/O or input voltage
reference for bank

73

 N.C.: Unconnected pins for
XC3S4000 (◆)

XC3S5000

(784 max. user I/O)

692

 I/O: Unrestricted,
general-purpose user I/O

56

 VREF: User I/O or input voltage
reference for bank

1

 N.C.: Unconnected pins for
XC3S5000 (■)

Figure 15: FG1156 Package Footprint (top view)

| Bank 0 | | | | | | | | | | | | | | | | | | |
|--------|---|----------------------|----------------------|---------------------|----------------------|------------|----------------------|-----------------|----------------------|-----------------|-----------------|-----------------|------------|------------|------------|----------------------|------------|----------------------|
| | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 10 | 11 | 12 | 13 | 14 | 15 | 16 | 17 | |
| Bank 7 | A | GND | GND | I/O L01P_0 VRN_0 | I/O L02P_0 | GND | I/O L05P_0 VREF_0 | I/O L34P_0 ◆ | I/O L36P_0 | GND | I/O L38P_0 | I/O L40P_0 ◆ | I/O L15P_0 | GND | I/O L22P_0 | I/O L26P_0 VREF_0 | GND | I/O L32P_0 GCLK6 |
| | B | GND | GND | I/O L01N_0 VRP_0 | I/O L02N_0 | I/O L03P_0 | I/O L05N_0 | I/O L34N_0 ◆ | I/O L36N_0 | I/O | I/O L38N_0 | I/O L40N_0 ◆ | I/O L15N_0 | VCCO_0 | I/O L22N_0 | I/O L26N_0 | I/O L28P_0 | I/O L32N_0 GCLK7 |
| | C | I/O L01N_7 VRP_7 | I/O L01P_7 VRN_7 | GND | VCCO_0 | I/O L03N_0 | I/O L04P_0 | I/O L33P_0 ◆ | VCCO_0 | I/O L08P_0 | I/O L37P_0 | GND | I/O L14P_0 | I/O L17P_0 | I/O L21P_0 | I/O L25P_0 | I/O L28N_0 | I/O L31P_0 VREF_0 |
| | D | I/O L02N_7 | I/O L02P_7 | VCCO_7 | PROG_B | IO VREF_0 | I/O L04N_0 | I/O L33N_0 ◆ | I/O L35P_0 | I/O L08N_0 | I/O L37N_0 | VCCO_0 | I/O L14N_0 | I/O L17N_0 | I/O L21N_0 | I/O L25N_0 | VCCO_0 | I/O L31N_0 |
| | E | GND | I/O L03N_7 VREF_7 | I/O L03P_7 | TDI | GND | VCCAUX | I/O L06P_0 | I/O L35N_0 | GND | IO VREF_0 | VCCAUX | I/O L13P_0 | GND | I/O L20P_0 | VCCAUX | GND | I/O |
| | F | I/O L05N_7 | I/O L05P_7 | I/O L04N_7 | I/O L04P_7 | VCCAUX | I/O | I/O L06N_0 | I/O | I/O L07P_0 | I/O L10P_0 | I/O L39P_0 ◆ | I/O L13N_0 | VCCO_0 | I/O L20N_0 | I/O L24P_0 | I/O L27P_0 | I/O L30P_0 |
| | G | I/O | I/O | I/O L41N_7 ◆ | I/O L41P_7 ◆ | I/O L06N_7 | I/O L06P_7 | GND | VCCO_0 | I/O L07N_0 | I/O L10N_0 | I/O L39N_0 ◆ | I/O | I/O L16P_0 | I/O L19P_0 | I/O L24N_0 | I/O L27N_0 | I/O L30N_0 |
| | H | I/O L08N_7 | I/O L08P_7 | VCCO_7 | I/O L10P_7 VREF_7 | I/O L07N_7 | I/O L07P_7 | VCCO_7 | I/O | I/O | I/O L09P_0 | VCCO_0 | I/O L12P_0 | I/O L16N_0 | I/O L19N_0 | VCCO_0 | VCCAUX | I/O L29P_0 |
| | J | GND | I/O L11N_7 | I/O L11P_7 | I/O L10N_7 | GND | I/O L09N_7 | I/O L09P_7 | I/O L12P_7 | I/O ◆ | I/O L09N_0 | I/O | I/O L12N_0 | GND | IO VREF_0 | I/O L23P_0 | GND | I/O L29N_0 |
| | K | I/O L16N_7 | I/O L16P_7 VREF_7 | I/O L15N_7 | I/O L15P_7 | I/O L14N_7 | I/O L14P_7 | I/O L13N_7 | I/O L13P_7 | I/O L12N_7 | GND | I/O ◆ | I/O L11P_0 | I/O | I/O L18P_0 | I/O L23N_0 | I/O | I/O |
| | L | I/O L19N_7 VREF_7 | I/O L19P_7 | GND | VCCO_7 | VCCAUX | I/O L44N_7 ◆ | I/O L44P_7 ◆ | VCCO_7 | I/O L17N_7 | I/O L17P_7 | HSWAP_EN | I/O L11N_0 | I/O | I/O L18N_0 | IO VREF_0 | I/O | I/O |
| | M | I/O L45N_7 | I/O L45P_7 | I/O L23N_7 | I/O L23P_7 | I/O L22N_7 | I/O L22P_7 | I/O L21N_7 | I/O L21P_7 | I/O L24P_7 | I/O L20N_7 | I/O L20P_7 | VCCINT | VCCO_0 | VCCO_0 | VCCO_0 | VCCO_0 | VCCINT |
| | N | GND | VCCO_7 | I/O L25N_7 | I/O L25P_7 | GND | VCCO_7 | I/O L46N_7 | I/O L46P_7 | GND | I/O L24N_7 | I/O L26P_7 | VCCO_7 | VCCINT | VCCINT | VCCINT | VCCINT | GND |
| | P | I/O L49N_7 | I/O L49P_7 | I/O L29N_7 | I/O L29P_7 | I/O L28N_7 | I/O L28P_7 | I/O L27N_7 | I/O L27P_7 VREF_7 | I/O L47N_7 ◆ | I/O L47P_7 ◆ | I/O L26N_7 | VCCO_7 | VCCINT | GND | GND | GND | GND |
| | R | I/O L32N_7 | I/O L32P_7 | I/O L31N_7 | I/O L31P_7 | VCCAUX | I/O L30N_7 | I/O L30P_7 | VCCO_7 | I/O L33P_7 | I/O L50N_7 | I/O L50P_7 | VCCO_7 | VCCINT | GND | GND | GND | GND |
| | T | GND | I/O L35N_7 | I/O L35P_7 | VCCO_7 | GND | I/O L34N_7 | I/O L34P_7 | VCCAUX | GND | I/O L33N_7 | I/O L51P_7 ◆ | VCCO_7 | VCCINT | GND | GND | GND | GND |
| | U | I/O L40N_7 VREF_7 | I/O L40P_7 | I/O L39N_7 | I/O L39P_7 | I/O L38N_7 | I/O L38P_7 | I/O L37N_7 | I/O L37P_7 VREF_7 | I/O | I/O | I/O L51N_7 ◆ | VCCINT | GND | GND | GND | GND | GND |

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All Devices

Top Right Corner of Package (top view)

| | | |
|--|---|---|
| 12 DUAL: Configuration pin, then possible user I/O | 16 DCI: User I/O or reference resistor input for bank | 8 GCLK: User I/O or global clock buffer input |
| 7 CONFIG: Dedicated configuration pins | 4 JTAG: Dedicated JTAG port pins | 104 VCCO: Output voltage supply for bank |
| 40 VCCINT: Internal core voltage supply (+1.2V) | 32 VCCAUX: Auxiliary voltage supply (+2.5V) | 184 GND: Ground |

| Bank 1 | | | | | | | | | | | | | | | | | |
|----------------------|------------|------------|------------|------------|----------------------|-----------------|-----------------|----------------------|------------|----------------------|---------------------------|----------------------|----------------------|----------------------|---------------------|----------------------|---|
| 18 | 19 | 20 | 21 | 22 | 23 | 24 | 25 | 26 | 27 | 28 | 29 | 30 | 31 | 32 | 33 | 34 | |
| I/O | GND | I/O L40N_1 | I/O L26N_1 | GND | I/O L19N_1 | I/O L15N_1 | I/O L14N_1 | GND | I/O L08N_1 | I/O L34N_1 ♦ | I/O L05N_1 | GND | I/O L02N_1 | I/O L01N_1 VRP_1 | GND | GND | A |
| I/O L32N_1 GCLK5 | I/O L28N_1 | I/O L40P_1 | I/O L26P_1 | VCCO_1 | I/O L19P_1 | I/O L15P_1 | I/O L14P_1 | I/O | I/O L08P_1 | I/O L34P_1 ♦ | I/O L05P_1 | I/O L03N_1 | I/O L02P_1 | I/O L01P_1 VRN_1 | GND | GND | B |
| I/O L32P_1 GCLK4 | I/O L28P_1 | I/O L39N_1 | I/O L25N_1 | I/O L22N_1 | I/O | GND | I/O L13N_1 | I/O L10N_1 VREF_1 | VCCO_1 | I/O L33N_1 ♦ | I/O L04N_1 | I/O L03P_1 | VCCO_1 | GND | I/O L01N_2 VRP_2 | I/O L01P_2 VRN_2 | C |
| I/O L31N_1 VREF_1 | VCCO_1 | I/O L39P_1 | I/O L25P_1 | I/O L22P_1 | I/O L18N_1 | VCCO_1 | I/O L13P_1 | I/O L10P_1 | I/O L07N_1 | I/O L33P_1 ♦ | I/O L04P_1 | I/O VREF_1 | TCK | VCCO_2 | I/O L02N_2 | I/O L02P_2 | D |
| I/O L31P_1 | GND | VCCAUX | I/O | GND | I/O L18P_1 | VCCAUX | I/O | GND | I/O L07P_1 | I/O L06N_1 VREF_1 | VCCAUX | GND | TDO | I/O L03N_2 VREF_2 | I/O L03P_2 | GND | E |
| I/O | I/O L27N_1 | I/O L38N_1 | I/O L24N_1 | VCCO_1 | I/O L17N_1 VREF_1 | I/O L36N_1 ♦ | I/O L12N_1 | I/O L09N_1 | I/O | I/O L06P_1 | I/O | VCCAUX | I/O L04N_2 | I/O L04P_2 | I/O L41N_2 | I/O L41P_2 | F |
| I/O L30N_1 | I/O L27P_1 | I/O L38P_1 | I/O L24P_1 | I/O L21N_1 | I/O L17P_1 | I/O L36P_1 ♦ | I/O L12P_1 | I/O L09P_1 | VCCO_1 | GND | I/O L05N_2 | I/O L05P_2 | I/O L42N_2 ♦ | I/O L42P_2 ♦ | I/O | I/O | G |
| I/O L30P_1 | VCCAUX | VCCO_1 | I/O L23N_1 | I/O L21P_1 | I/O | VCCO_1 | I/O L11N_1 | I/O | TMS | VCCO_2 | I/O L06N_2 | I/O L06P_2 | I/O L09N_2 VREF_2 | VCCO_2 | I/O L07N_2 | I/O L07P_2 | H |
| I/O L29N_1 | GND | I/O L37N_1 | I/O L23P_1 | GND | I/O L16N_1 | I/O L35N_1 ♦ | I/O L11P_1 | I/O | I/O L11N_2 | I/O L08N_2 | I/O L08P_2 | GND | I/O L09P_2 | I/O L10N_2 | I/O L10P_2 | GND | J |
| I/O L29P_1 | I/O | I/O L37P_1 | I/O VREF_1 | I/O L20N_1 | I/O L16P_1 | I/O L35P_1 ♦ | GND | I/O L11P_2 | I/O L12N_2 | I/O L12P_2 | I/O L13N_2 | I/O L13P_2 VREF_2 | I/O L14N_2 | I/O L14P_2 | I/O L15N_2 | I/O L15P_2 | K |
| I/O VREF_1 | I/O | I/O | I/O | I/O L20P_1 | I/O | I/O | I/O L16N_2 | I/O L16P_2 | VCCO_2 | I/O L17N_2 ♦ | I/O L17P_2 VREF_2 ♦ | VCCAUX | VCCO_2 | GND | I/O L45N_2 | I/O L45P_2 | L |
| VCCINT | VCCO_1 | VCCO_1 | VCCO_1 | VCCO_1 | VCCINT | I/O L46N_2 | I/O L46P_2 | I/O L21N_2 | I/O L47N_2 | I/O L47P_2 | I/O L19N_2 | I/O L19P_2 | I/O L20N_2 | I/O L20P_2 | I/O L48N_2 | I/O L48P_2 | M |
| GND | VCCINT | VCCINT | VCCINT | VCCINT | VCCO_2 | I/O L24N_2 | I/O L21P_2 | GND | I/O L22N_2 | I/O L22P_2 | VCCO_2 | GND | I/O L23N_2 VREF_2 | I/O L23P_2 | VCCO_2 | GND | N |
| GND | GND | GND | GND | VCCINT | VCCO_2 | I/O L24P_2 ♦ | I/O L49N_2 ♦ | I/O L49P_2 ♦ | I/O L50N_2 | I/O L50P_2 | I/O L26N_2 | I/O L26P_2 | I/O L27N_2 | I/O L27P_2 | I/O L28N_2 | I/O L28P_2 | P |
| GND | GND | GND | GND | VCCINT | VCCO_2 | I/O L29N_2 | I/O L29P_2 | I/O L33N_2 | VCCO_2 | I/O L30N_2 | I/O L30P_2 | VCCAUX | I/O L31N_2 | I/O L31P_2 | I/O L32N_2 | I/O L32P_2 | R |
| GND | GND | GND | GND | VCCINT | VCCO_2 | I/O L51N_2 ♦ | I/O L33P_2 | GND | VCCAUX | I/O L34N_2 VREF_2 | I/O L34P_2 | GND | VCCO_2 | I/O L35N_2 | I/O L35P_2 | GND | T |
| GND | GND | GND | GND | GND | VCCINT | I/O L51P_2 ♦ | I/O | I/O | I/O L37N_2 | I/O L37P_2 | I/O L38N_2 | I/O L38P_2 | I/O L39N_2 | I/O L39P_2 | I/O L40N_2 | I/O L40P_2 VREF_2 | U |

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**Bottom Left Corner of
Package (top view)**

| 18 | 19 | 20 | 21 | 22 | 23 | 24 | 25 | 26 | 27 | 28 | 29 | 30 | 31 | 32 | 33 | 34 | |
|----------------------------|-------------------------|----------------------|---------------------|------------|------------|-----------------|----------------------|----------------------|------------|----------------------|-----------------|------------|----------------------|---------------------|---------------------|----------------------|---|
| GND | GND | GND | GND | GND | VCCINT | I/O L51N_3 ◆ | I/O | I/O | I/O L37P_3 | I/O L37N_3 | I/O L38P_3 | I/O L38N_3 | I/O L39P_3 | I/O L39N_3 | I/O L40P_3 | I/O L40N_3 VREF_3 | V |
| GND | GND | GND | GND | VCCINT | VCCO_3 | I/O L51P_3 ◆ | I/O L33N_3 | GND | VCCAUX | I/O L34P_3 VREF_3 | I/O L34N_3 | GND | VCCO_3 | I/O L35P_3 | I/O L35N_3 | GND | W |
| GND | GND | GND | GND | VCCINT | VCCO_3 | I/O L50P_3 | I/O L50N_3 | I/O L33P_3 | VCCO_3 | I/O L30P_3 | I/O L30N_3 | VCCAUX | I/O L31P_3 | I/O L31N_3 | I/O L32P_3 | I/O L32N_3 | Y |
| GND | GND | GND | GND | VCCINT | VCCO_3 | I/O L48N_3 | I/O L49P_3 ◆ | I/O L49N_3 ◆ | I/O L26P_3 | I/O L26N_3 | I/O L27P_3 | I/O L27N_3 | I/O L28P_3 | I/O L28N_3 | I/O L29P_3 | I/O L29N_3 | A |
| GND | VCCINT | VCCINT | VCCINT | VCCINT | VCCO_3 | I/O L48P_3 | I/O L24N_3 | GND | I/O L46P_3 | I/O L46N_3 | VCCO_3 | GND | I/O L47P_3 | I/O L47N_3 | VCCO_3 | GND | A |
| VCCINT | VCCO_4 | VCCO_4 | VCCO_4 | VCCO_4 | VCCINT | I/O L20P_3 | I/O L20N_3 | I/O L24P_3 | I/O L21P_3 | I/O L21N_3 | I/O L22P_3 | I/O L22N_3 | I/O L23P_3 VREF_3 | I/O L23N_3 | I/O L45P_3 | I/O L45N_3 | A |
| I/O | I/O | I/O | I/O L18N_4 | I/O | I/O L11N_4 | DONE | I/O L17P_3 VREF_3 | I/O L17N_3 | VCCO_3 | I/O L44P_3 ◆ | I/O L44N_3 ◆ | VCCAUX | VCCO_3 | GND | I/O L19P_3 | I/O L19N_3 | A |
| I/O | I/O | I/O L23N_4 | I/O L18P_4 | I/O | I/O L11P_4 | I/O ◆ | GND | I/O L12N_3 | I/O L13P_3 | I/O L13N_3 VREF_3 | I/O L14P_3 | I/O L14N_3 | I/O L15P_3 | I/O L15N_3 | I/O L16P_3 | I/O L16N_3 | A |
| I/O L29N_4 | GND | I/O L23P_4 | IO VREF_4 | GND | I/O L12N_4 | I/O | I/O L07N_4 | I/O ◆ | I/O L12P_3 | I/O L09P_3 VREF_3 | I/O L09N_3 | GND | I/O L10N_3 | I/O L11P_3 | I/O L11N_3 | GND | F |
| I/O L29P_4 | VCCAUX | VCCO_4 | I/O L19N_4 | I/O L16N_4 | I/O L12P_4 | VCCO_4 | I/O L07P_4 | I/O | I/O | VCCO_3 | I/O L07P_3 | I/O L07N_3 | I/O L10P_3 | VCCO_3 | I/O L08P_3 | I/O L08N_3 | G |
| I/O L30N_4 D2 | I/O L27N_4 DIN D0 | I/O L24N_4 | I/O L19P_4 | I/O L16P_4 | IO VREF_4 | I/O L39N_4 ◆ | I/O L08N_4 | I/O L05N_4 | VCCO_4 | GND | I/O L06P_3 | I/O L06N_3 | I/O L41P_3 ◆ | I/O L41N_3 ◆ | I/O | I/O | H |
| I/O L30P_4 D3 | I/O L27P_4 D1 | I/O L24P_4 | I/O L20N_4 | VCCO_4 | I/O L13N_4 | I/O L39P_4 ◆ | I/O L08P_4 | I/O L05P_4 | I/O | I/O L35N_4 | I/O | VCCAUX | I/O L04P_3 | I/O L04N_3 | I/O L05P_3 | I/O L05N_3 | J |
| IO VREF_4 | GND | VCCAUX | I/O L20P_4 | GND | I/O L13P_4 | VCCAUX | I/O | GND | I/O L38N_4 | I/O L35P_4 | VCCAUX | GND | N.C. ◆ ■ | I/O L03P_3 | I/O L03N_3 | GND | K |
| I/O L31N_4 INIT_B | VCCO_4 | I/O L25N_4 | I/O L21N_4 | I/O L17N_4 | I/O L14N_4 | VCCO_4 | I/O L09N_4 | I/O L06N_4 VREF_4 | I/O L38P_4 | I/O L36N_4 ◆ | I/O L33N_4 | IO VREF_4 | CCLK | VCCO_3 | I/O L02P_3 | I/O L02N_3 VREF_3 | L |
| I/O L31P_4 DOUT BUSY | I/O L28N_4 | I/O L25P_4 | I/O L21P_4 | I/O L17P_4 | I/O L14P_4 | GND | I/O L09P_4 | I/O L06P_4 | VCCO_4 | I/O L36P_4 ◆ | I/O L33P_4 | I/O L03N_4 | VCCO_4 | GND | I/O L01P_3 VRN_3 | I/O L01N_3 VRP_3 | M |
| I/O L32N_4 GCLK1 | I/O L28P_4 | I/O L26N_4 | IO L22N_4 VREF_4 | VCCO_4 | I/O L15N_4 | I/O L40N_4 ◆ | I/O L10N_4 | I/O | I/O L04N_4 | I/O L37N_4 ◆ | I/O L34N_4 | I/O L03P_4 | I/O L02N_4 | I/O L01N_4 VRP_4 | GND | GND | N |
| I/O L32P_4 GCLK0 | GND | I/O L26P_4 VREF_4 | I/O L22P_4 | GND | I/O L15P_4 | I/O L40P_4 ◆ | I/O L10P_4 | GND | I/O L04P_4 | I/O L37P_4 ◆ | I/O L34P_4 | GND | I/O L02P_4 | I/O L01P_4 VRN_4 | GND | GND | P |

Bank 4

DS099-4_14d_072903

Bottom Right Corner
of Package (top view)

Revision History

| Date | Version No. | Description |
|----------|-------------|---|
| 04/03/03 | 1.0 | Initial Xilinx release. |
| 04/21/03 | 1.1 | <p>Added information on the VQ100 package footprint, including a complete pinout table (Table 16) and footprint diagram (Figure 8).</p> <p>Updated Table 15 with final I/O counts for the VQ100 package. Also added final differential I/O pair counts for the TQ144 package.</p> <p>Added clarifying comments to HSWAP_EN pin description on page 13.</p> <p>Updated the footprint diagram for the FG900 package shown in Figure 14a and Figure 14b. Some thick lines separating I/O banks were incorrect.</p> <p>Made cosmetic changes to Figure 1, Figure 3, and Figure 4.</p> <p>Updated Xilinx hypertext links.</p> <p>Added XC3S200 and XC3S400 to Pin Name column in Table 18.</p> |
| 05/12/03 | 1.1.1 | AM32 pin was missing GND label in FG1156 package diagram (Figure 15). |
| 07/11/03 | 1.1.2 | Corrected misspellings of GCLK in Table 1 and Table 2 . Changed CMOS25 to LVCMOS25 in Dual-Purpose Pin I/O Standard During Configuration section. Clarified references to Module 2. For XC3S5000 in FG1156 package, corrected N.C. symbol to a black square in Table 35 , key, and package drawing. |
| 07/29/03 | 1.2 | <p>Corrected pin names on FG1156 package. Some package balls incorrectly included LVDS pair names. The affected balls on the FG1156 package include G1, G2, G33, G34, U9, U10, U25, U26, V9, V10, V25, V26, AH1, AH2, AH33, AH34. The number of LVDS pairs is unaffected.</p> <p>Modified affected balls and re-sorted rows in Table 35. Updated affected balls in Figure 15.</p> <p>Also updated ASCII and Excel electronic versions of FG1156 pinout.</p> |
| 08/19/03 | 1.2.1 | <p>Removed 100 MHz ConfigRate option in CCLK: Configuration Clock section and in Table 11.</p> <p>Added note that TDO is a totem-pole output in Table 9.</p> |
| 10/09/03 | 1.2.2 | <p>Some pins had incorrect bank designations and were improperly sorted in Table 20. No pin names or functions changed. Renamed DCI_IN to DCI and added black diamond to N.C. pins in Table 20. In Figure 10, removed some extraneous text from pin 106 and corrected spelling of pins 45, 48, and 81.</p> |

The Spartan-3 Family Data Sheet

DS099-1, *Spartan-3 1.2V FPGA Family: [Introduction and Ordering Information](#)* (Module 1)

DS099-2, *Spartan-3 1.2V FPGA Family: [Functional Description](#)* (Module 2)

DS099-3, *Spartan-3 1.2V FPGA Family: [DC and Switching Characteristics](#)* (Module 3)

DS099-4, *Spartan-3 1.2V FPGA Family: [Pinout Descriptions](#)* (Module 4)